

PIC24FJ128GL306 FAMILY

16-Bit eXtreme Low-Power Microcontrollers with LCD Controller in Low Pin Count Packages

High-Performance CPU

- Modified Harvard Architecture
- 128 Kbytes Flash Memory
- 8 Kbytes SRAM
- Up to 16 MIPS Operation @ 32 MHz
- 17-Bit x 17-Bit Single-Cycle Hardware Fractional/Integer Multiplier
- 32-Bit by 16-Bit Hardware Divider
- 16-Bit x 16-Bit Working Register Array
- · C Compiler Optimized Instruction Set Architecture
- Two Address Generation Units (AGUs) for Separate Read and Write Addressing of Data Memory

LCD Display Controller

- · 32x8 with Up to 256 Pixels
- LCD Charge Pump
- Core-Independent LCD Animation
- · Operation in Sleep mode

Analog Features

- Up to 17-Channel, Software-Selectable, 10/12-Bit Analog-to-Digital Converter:
 - 12-bit, 350K samples/second conversion rate (single Sample-and-Hold)
 - 10-bit, 400K samples/second conversion rate (single Sample-and-Hold)
 - Sleep mode operation
 - Low-voltage boost for input
 - Band gap reference input feature
 - Core-independent windowed threshold compare feature
 - Auto-scan feature
- Three Analog Comparators with Input Multiplexing:
- Programmable reference voltage for comparators

eXtreme Low-Power Features

- Sleep and Idle modes Selectively Shut Down Peripherals and/or Core for Substantial Power Reduction and Fast Wake-up
- Doze mode Allows CPU to Run at a Lower Clock Speed than Peripherals
- Alternate Clock modes Allow On-the-Fly Switching to a Lower Clock Speed for Selective Power Reduction
- Retention Sleep with On-Chip Ultra Low-Power Retention Regulator

Functional Safety and Security Peripherals

- · Fail-Safe Clock Monitor Operation:
 - Detects clock failure and switches to on-chip, low-power RC oscillator
- Power-on Reset (POR), Brown-out Reset (BOR)
- Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- Programmable High/Low-Voltage Detect (HLVD)
- Flexible Watchdog Timer (WDT) with RC Oscillator for Reliable Operation
- Deadman Timer (DMT) for Monitoring Health
 of Software
- Programmable 32-Bit Cyclic Redundancy Check (CRC) Generator
- Flash OTP by ICSP™ Write Inhibit
- CodeGuard[™] Security
- ECC Flash Memory (128 Kbytes) with Fault Injection:
 - Single Error Correction (SEC)
 - Double Error Detection (DED)
- Customer OTP Memory
- Unique Device Identifier (UDID)

Special Microcontroller Features

- Supply Voltage Range of 2.0V to 3.6V
- Operating Ambient Temperature Range of -40°C to +125°C
- On-Chip Voltage Regulators (1.8V) for Low-Power Operation
- Flash Memory:
 - 10,000 erase/write cycle endurance, typical
 - Data retention: 20 years minimum
 - Self-programmable under software controlFlash OTP emulation
- 8 MHz Fast RC Internal Oscillator:
 - Multiple clock divide options
 - Fast start-up
- 96 MHz PLL Option
- Programmable Reference Clock Output
- In-Circuit Serial Programming™ (ICSP™) and In-Circuit Emulation (ICE) via Two Pins
- JTAG Boundary Scan Support

Peripheral Features

- Independent, Low-Power 32 kHz Timer Oscillator
- Six-Channel DMA Controller:
 - Minimizes CPU overhead and increases data throughput
- Timer1: 16-Bit Timer/Counter with External Crystal Oscillator; Timer1 can Provide an A/D Trigger
- Timer2,3,4,5: 16-Bit Timer/Counter can Create 32-Bit Timer; Timer3 and Timer5 can Provide an A/D Trigger
- Five MCCP modules, Each with a Dedicated 16/32-Bit Timer:
 - One 6-output MCCP module
 - Four 2-output MCCP modules
- Two Variable Width, Serial Peripheral Interface (SPI) Ports on All Devices; Three Operation modes:
 - 3-wire SPI (supports all four SPI modes)
 - Up to 32-byte deep FIFO buffer
 - I²S mode
 - Speed up to 25 MHz
- Two I²C Master and Slave w/Address Masking, PMBus[™] and IPMI Support

- Four UART modules:
 - LIN/J2602 bus support (auto-wake-up, Auto-Baud Detect, Break character support)
 - RS-232 and RS-485 support
 - IrDA[®] mode (hardware encoder/decoder functions)
- Five External Interrupt Pins
- Hardware Real-Time Clock and Calendar (RTCC)
- Peripheral Pin Select (PPS) allows Independent I/O Mapping of Many Peripherals
- Configurable Interrupt-on-Change on All I/O Pins:
 - Each pin is independently configurable for rising edge or falling edge change detection
- Reference Clock Output with Programmable Divider
- Four Configurable Logic Cell (CLC) Blocks:
 - Two inputs and one output, all mappable to peripherals or I/O pins
 - AND/OR/XOR logic and D/JK flip-flop functions

Qualification

• AEC-Q100 REVG (Grade 1: -40°C to +125°C) Compliant

	Men	nory			_		Peripherals											
Device	Program (bytes)	SRAM (bytes)	Pins	GPIO	Remappable I/O (PPS) (Output/Input)	DMA Channels	10/12-Bit A/D Channels	Comparators	CRC	MCCP 6-Output/2-Output	16-Bit Timers	I ² C	Variable Width SPI	UART w/IrDA [®]	CLC	RTCC	JTAG	LCD Pixels
PIC24FJ128GL306	128K	8K	64	54	32/33	6	17	3	Yes	1/4	5	2	2	4	4	Yes	Yes	256
PIC24FJ128GL305	128K	8K	48	39	24/25	6	12	3	Yes	1/4	5	2	2	4	4	Yes	Yes	152
PIC24FJ128GL303	128K	8K	36	29	15/16	6	11	3	Yes	1/4	5	2	2	4	4	Yes	Yes	80
PIC24FJ128GL302	128K	8K	28	21	13/14	6	9	3	Yes	1/4	5	2	2	4	4	Yes	Yes	42
PIC24FJ64GL306	64K	8K	64	54	32/33	6	17	3	Yes	1/4	5	2	2	4	4	Yes	Yes	256
PIC24FJ64GL305	64K	8K	48	39	24/25	6	12	3	Yes	1/4	5	2	2	4	4	Yes	Yes	152
PIC24FJ64GL303	64K	8K	36	29	15/16	6	11	3	Yes	1/4	5	2	2	4	4	Yes	Yes	80
PIC24FJ64GL302	64K	8K	28	21	13/14	6	9	3	Yes	1/4	5	2	2	4	4	Yes	Yes	42

TABLE 1: PIC24FJ128GL306 FAMILY DEVICES

Pin Diagrams

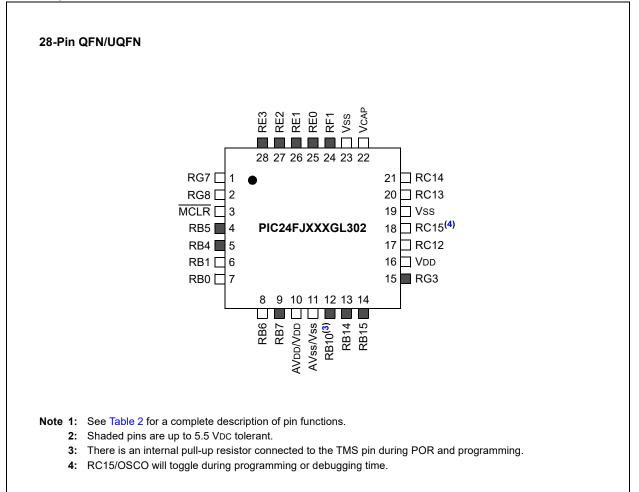


TABLE 2: 28-PIN QFN/UQFN COMPLETE PIN FUNCTION DESCRIPTIONS

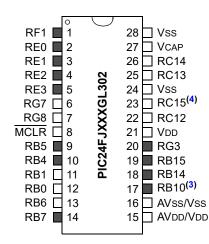
Pin	Function	Pin	Function
1	VLCAP1/C1INC/C2INC/C3INC/RP26/RG7	15	TDO/SEG47/RP31/SDA1/OCM1F/INT0/RG3
2	VLCAP2/C2IND/ RP19 /RG8	16	Vdd
3	MCLR	17	OSCI/CLKI/RC12
4	PGC3/SEG2/AN5/C1INA/ RP18 /ASCL1 ⁽¹⁾ /OCM1A/RB5	18	OSCO/CLKO/RC15
5	PGD3/SEG3/AN4/C1INB/ RP28 /ASDA1 ⁽¹⁾ /OCM1B/RB4	19	Vss
6	PGC1/SEG6/CVREF-/AN1/AN1-/C2INA/ RP1 /RB1	20	SOSCI/RC13
7	PGD1/SEG7/VREF+/CVREF+/AN0/C2INB/ RP0 /RB0	21	SOSCO/SCLKI/RPI37/PWRLCLK/RC14
8	PGC2/LCDBIAS3/AN6/ RP6 /RB6	22	VCAP
9	PGD2/AN7/ RP7 /T1CK/RB7	23	Vss
10	AVdd/Vdd	24	COM4/SEG48/ RP2/ SCL1/OCM1E/RF1
11	AVss/Vss	25	COM3/RE0
12	TMS/COM5/SEG29/CVREF/AN10/RP15/RB10	26	COM2/C3INA/RE1
13	TCK/SEG8/AN14/ RP14/ SDA2/OCM1C/RB14	27	COM1/C3IND/RE2
14	TDI/SEG9/AN15/ RP29 /SCL2/OCM1D/RB15	28	COM0/HLVDIN/RE3

Legend: RPn and RPIn represent remappable pins for Peripheral Pin Select (PPS) functions.

Note 1: Alternate pin assignments for I2C1 as determined by the ALTI2C1 Configuration bit.

Pin Diagrams (Continued)





Note 1: See Table 3 for a complete description of pin functions.

- 2: Shaded pins are up to 5.5 VDC tolerant.
- 3: There is an internal pull-up resistor connected to the TMS pin during POR and programming.
- 4: RC15/OSCO will toggle during programming or debugging time.

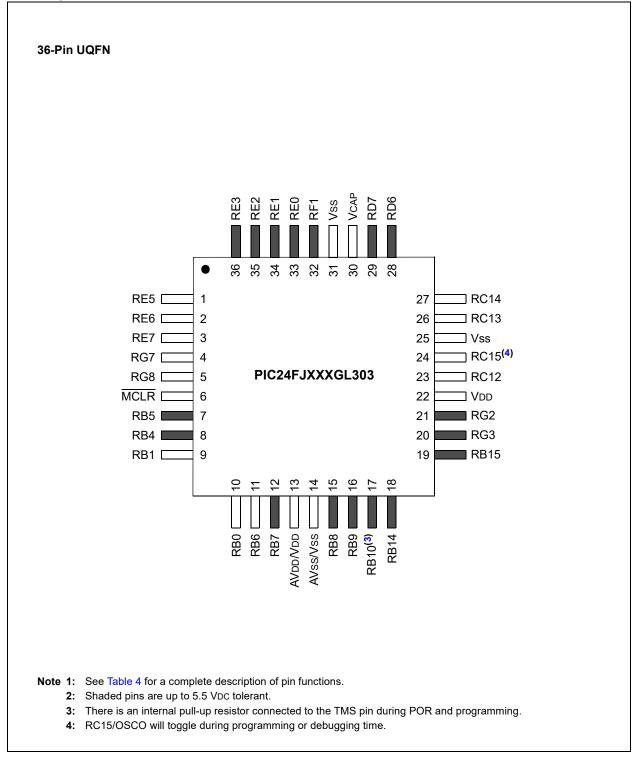
TABLE 3: 28-PIN SOIC/SSOP COMPLETE PIN FUNCTION DESCRIPTIONS

Pin	Function	Pin	Function
1	COM4/SEG48/RP2/SCL1/OCM1E/RF1	15	AVdd/Vdd
2	COM3/RE0	16	AVss/Vss
3	COM2/C3INA/RE1	17	TMS/COM5/SEG29/CVREF/AN10/RP15/RB10
4	COM1/C3IND/RE2	18	TCK/SEG8/AN14/ RP14 /SDA2/OCM1C/RB14
5	COM0/HLVDIN/RE3	19	TDI/SEG9/AN15/RP29/SCL2/OCM1D/RB15
6	VLCAP1/C1INC/C2INC/C3INC/RP26/RG7	20	TDO/SEG47/RP31/SDA1/OCM1F/INT0/RG3
7	VLCAP2/C2IND/ RP19 /RG8	21	Vdd
8	MCLR	22	OSCI/CLKI/RC12
9	PGC3/SEG2/AN5/C1INA/ RP18 /ASCL1 ⁽¹⁾ /OCM1A/RB5	23	OSCO/CLKO/RC15
10	PGD3/SEG3/AN4/C1INB/ RP28 /ASDA1 ⁽¹⁾ /OCM1B/RB4	24	Vss
11	PGC1/SEG6/CVREF-/AN1/AN1-/C2INA/ RP1 /RB1	25	SOSCI/RC13
12	PGD1/SEG7/VREF+/CVREF+/AN0/C2INB/ RP0 /RB0	26	SOSCO/SCLKI/RPI37/PWRLCLK/RC14
13	PGC2/LCDBIAS3/AN6/ RP6 /RB6	27	VCAP
14	PGD2/AN7/ RP7 /T1CK/RB7	28	Vss

Legend: RPn and RPIn represent remappable pins for Peripheral Pin Select (PPS) functions.

Note 1: Alternate pin assignments for I2C1 as determined by the ALTI2C1 Configuration bit.

Pin Diagrams (Continued)



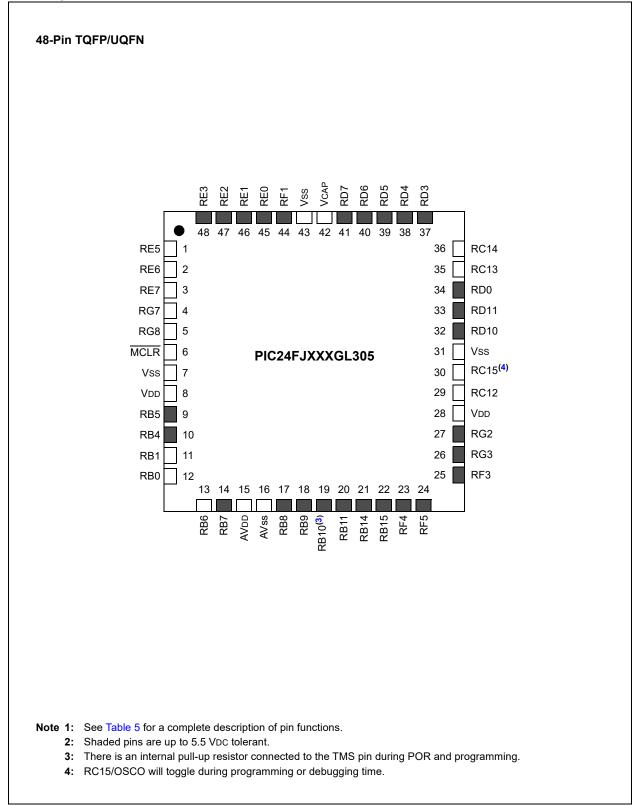
Pin	Function	Pin	Function
1	LCDBIAS2/RE5	19	TDI/SEG9/AN15/RP29/SCL2/OCM1D/RB15
2	LCDBIAS1/RE6	20	TDO/SEG47/RP31/SDA1/OCM1F/INT0/RG3
3	LCDBIAS0/RE7	21	SEG28/SCL1/RG2
4	VLCAP1/C1INC/C2INC/C3INC/RP26/RG7	22	Vdd
5	VLCAP2/C2IND/RP19/RG8	23	OSCI/CLKI/RC12
6	MCLR	24	OSCO/CLKO/RC15
7	PGC3/SEG2/AN5/C1INA/ RP18 /ASCL1 ⁽¹⁾ /OCM1A/RB5	25	Vss
8	PGD3/SEG3/AN4/C1INB/ RP28 /ASDA1 ⁽¹⁾ /OCM1B/RB4	26	SOSCI/RC13
9	PGC1/SEG6/CVREF-/AN1/AN1-/C2INA/RP1/RB1	27	SOSCO/SCLKI/RPI37/PWRLCLK/RC14
10	PGD1/SEG7/VREF+//CVREF+/AN0/C2INB/ RP0 /RB0	28	SEG25/C3INB/RD6
11	PGC2/LCDBIAS3/AN6/ RP6 /RB6	29	SEG26/C3INA/RD7
12	PGD2/AN7/ RP7 /T1CK/RB7	30	VCAP
13	AVdd/Vdd	31	Vss
14	AVss/Vss	32	COM4/SEG48/ RP2 /OCM1E/RF1
15	COM7/SEG31/AN8/ RP8 /RB8	33	COM3/RE0
16	COM6/SEG30/AN9/ RP9 /RB9	34	COM2/RE1
17	TMS/COM5/SEG29/CVREF/AN10/RP15/RB10	35	COM1/C3IND/RE2
18	TCK/SEG8/AN14/RP14/SDA2/OCM1C/RB14	36	COM0/HLVDIN/RE3

TABLE 4: 36-PIN UQFN COMPLETE PIN FUNCTION DESCRIPTIONS

Legend: RPn and RPIn represent remappable pins for Peripheral Pin Select (PPS) functions.

Note 1: Alternate pin assignments for I2C1 as determined by the ALTI2C1 Configuration bit.

Pin Diagrams (Continued)



Pin	Function	Pin	Function
1	LCDBIAS2/RE5	25	SEG12/ RP16 /RF3
2	LCDBIAS1/RE6	26	SEG47/RP31/SDA1/OCM1F/INT0/RG3
3	LCDBIAS0/RE7	27	SEG28/SCL1/RG2
4	VLCAP1/C1INC/C2INC/C3INC ⁽²⁾ /RP26/RG7	28	Vdd
5	VLCAP2/AN19/C2IND/RP19/RG8	29	OSCI/CLKI/RC12
6	MCLR	30	OSCO/CLKO/RC15
7	Vss	31	Vss
8	Vdd	32	SEG15/C3IND/RP3/RD10
9	PGC3/SEG2/AN5/C1INA/ RP18 /SCL1 ⁽¹⁾ /OCM1A/RB5	33	SEG16/C3INC/ RP12 /RD11
10	PGD3/SEG3/AN4/C1INB/ RP28 /SDA1 ⁽¹⁾ /OCM1B/RB4	34	SEG17/ RP11 /RD0
11	PGC1/SEG6/CVREF-/AN1/AN1-/C2INA/ RP1 /RB1	35	SOSCI/RC13
12	PGD1/SEG7/VREF+/CVREF+/AN0/C2INB/ RP0 /RB0	36	SOSCO/SCLKI/RPI37/PWRLCLK/RC14
13	PGC2/LCDBIAS3/AN6/C1IND/ RP6 /RB6	37	SEG22/ RP22 /RD3
14	PGD2/AN7/ RP7 /T1CK/RB7	38	SEG23/ RP25 /RD4
15	AVDD	39	SEG24/ RP20 /RD5
16	AVss	40	SEG25/C3INB/RD6
17	COM7/SEG31/AN8/ RP8 /RB8	41	SEG26/C3INA/RD7
18	COM6/SEG30/AN9/ RP9 /RB9	42	VCAP
19	TMS/COM5/SEG29/CVREF/AN10/RP15/RB10	43	Vss
20	TDO/AN11/RB11	44	COM4/SEG48/ RP2 /OCM1E/RF1
21	TCK/SEG8/AN14/ RP14 /OCM1C/RB14	45	COM3/RE0
22	TDI/SEG9/AN15/ RP29 /OCM1D/RB15	46	COM2/RE1
23	SEG10/ RP10 /SDA2/RF4	47	COM1/RE2
24	SEG11/ RP17 /SCL2/RF5	48	COM0/HLVDIN/RE3

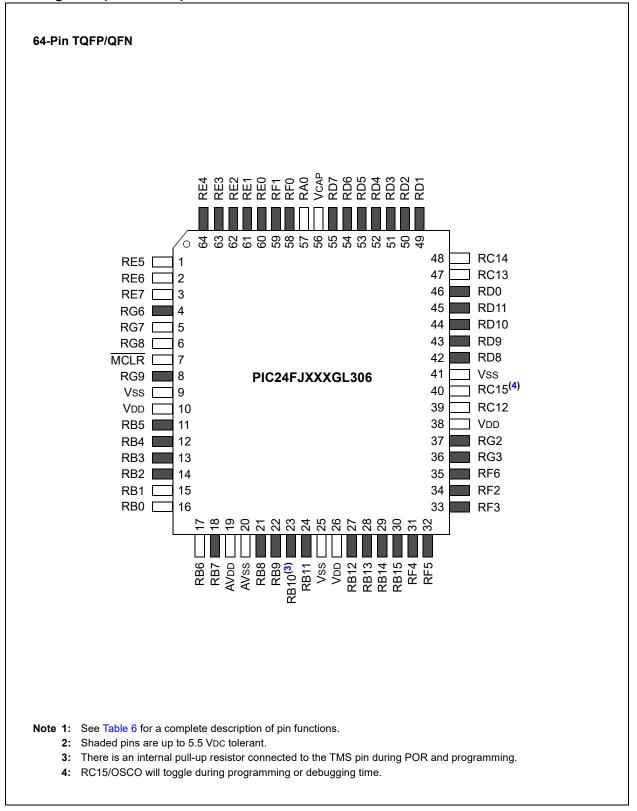
TABLE 5: 48-PIN TQFP/UQFN COMPLETE PIN FUNCTION DESCRIPTIONS

Legend: RPn and RPIn represent remappable pins for Peripheral Pin Select (PPS) functions.

Note 1: Alternate pin assignments for I2C1 as determined by the ALTI2C1 Configuration bit.

2: Alternate pin assignments for C3INC as determined by the ALTCMPI Configuration bit.

Pin Diagrams (Continued)



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Pin	Function	Pin	Function
1	LCDBIAS2/RE5	33	SEG12/ RP16 /RF3
2	LCDBIAS1/RE6	34	SEG40/ RP30 /RF2
3	LCDBIAS0/RE7	35	RP5/INT0/RF6
4	SEG0/C1IND/RP21/RG6	36	SEG47/ RP31 /SDA1/OCM1F/RG3
5	VLCAP1/C1INC/C2INC ⁽²⁾ /C3INC ⁽²⁾ /RP26/RG7	37	SEG28/SCL1/RG2
6	VLCAP2/C2IND/RP19/RG8	38	Vdd
7	MCLR	39	OSCI/CLKI/RC12
8	SEG1/C2INC/RP27/RG9	40	OSCO/CLKO/RC15
9	Vss	41	Vss
10	VDD	42	SEG13/ RP2 /RD8
11	PGC3/SEG2/AN5/C1INA/ RP18 /ASCL1 ⁽¹⁾ /OCM1A/RB5	43	SEG14/ RP4 /RD9
12	PGD3/SEG3/AN4/C1INB/ RP28 /ASDA1 ⁽¹⁾ /OCM1B/RB4	44	SEG15/C3IND/RP3/RD10
13	SEG4/AN3/C2INA/RB3	45	SEG16/C3INC/ RP12 /RD11
14	SEG5/AN2/C2INB/ RP13 /RB2	46	SEG17/ RP11 /RD0
15	PGC1/SEG6/CVREF-/AN1/AN1-/ RP1 /RB1	47	SOSCI/RC13
16	PGD1/SEG7/VREF+/CVREF+/AN0/ RP0 /RB0	48	SOSCO/SCLKI/RPI37/PWRLCLK/RC14
17	PGC2/LCDBIAS3/AN6/ RP6 /RB6	49	SEG20/ RP24 /RD1
18	PGD2/AN7/ RP7 /T1CK/RB7	50	SEG21/ RP23 /RD2
19	AVDD	51	SEG22/ RP22 /RD3
20	AVss	52	SEG23/ RP25 /RD4
21	COM7/SEG31/AN8/ RP8 /RB8	53	SEG24/ RP20 /RD5
22	COM6/SEG30/AN9/ RP9 /RB9	54	SEG25/C3INB/RD6
23	TMS/COM5/SEG29/CVREF/AN10/RP15/RB10	55	SEG26/C3INA/RD7
24	TDO/AN11/RB11	56	VCAP
25	Vss	57	AN16/RA0
26	VDD	58	SEG27/RF0
27	TCK/SEG18/AN12/RB12	59	COM4/SEG48/OCM1E/RF1
28	TDI/SEG19/AN13/RB13	60	COM3/RE0
29	SEG8/AN14/ RP14 /OCM1C/RB14	61	COM2/RE1
30	SEG9/AN15/ RP29 /OCM1D/RB15	62	COM1/RE2
31	SEG10/ RP10 /SDA2/RF4	63	COM0/RE3
32	SEG11/RP17/SCL2/RF5	64	SEG63/HLVDIN/RE4

Legend: RPn and RPIn represent remappable pins for Peripheral Pin Select (PPS) functions.

Note 1: Alternate pin assignments for I2C1 as determined by the ALTI2C1 Configuration bit.

2: Alternate pin assignments for C2INC and C3INC as determined by the ALTCMPI Configuration bit.

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Referenced Sources

This device data sheet is based on the following individual chapters of the *"dsPIC33/PIC24 Family Reference Manual"*. These documents should be considered as the general reference for the operation of a particular module or device feature.

Note 1: To access the documents listed below, browse to the documentation section of the PIC24FJ128GL306 product page of the Microchip website (www.microchip.com) or select a family reference manual section from the following list.

> In addition to parameters, features and other documentation, the resulting page provides links to the related family reference manual sections.

- "CPU with Extended Data Space (EDS)" (www.microchip.com/DS39732)
- "Direct Memory Access Controller (DMA)" (www.microchip.com/DS30009742)
- "PIC24F Flash Program Memory" (www.microchip.com/DS30009715)
- "Data Memory with Extended Data Space (EDS)" (www.microchip.com/DS39733)
- "Reset" (www.microchip.com/DS39712)
- "Interrupts" (www.microchip.com/DS70000600)
- "Oscillator" (www.microchip.com/DS39700)
- "Power-Saving Features with Deep Sleep" (www.microchip.com/DS39727)
- "I/O Ports with Peripheral Pin Select (PPS)" (www.microchip.com/DS30009711)
- "Timers" (www.microchip.com/DS39704)
- "Capture/Compare/PWM/Timer (MCCP and SCCP)" (www.microchip.com/DS30003035)
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- "Dual Comparator Module" (www.microchip.com/DS39710)
- "High-Level Integration with Programmable High/Low-Voltage Detect (HLVD)" (www.microchip.com/DS39725)
- "Watchdog Timer (WDT)" (www.microchip.com/DS39697)
- "CodeGuard™ Intermediate Security" (www.microchip.com/DS70005182)
- "High-Level Device Integration" (www.microchip.com/DS39719)
- "Programming and Diagnostics" (www.microchip.com/DS39716)
- "Comparator Voltage Reference Module" (www.microchip.com/DS39709)
- "Deadman Timer" (www.microchip.com/DS70005155)
- "Liquid Crystal Display (LCD)" (www.microchip.com/DS30009740)

NOTES:

1.0 DEVICE OVERVIEW

This document contains device-specific information for the following devices:

- PIC24FJ128GL306 PIC24FJ64GL306
- PIC24FJ128GL305 PIC24FJ64GL305
- PIC24FJ128GL303 PIC24FJ64GL303
- PIC24FJ128GL302 PIC24FJ64GL302

The PIC24FJ128GL306 family introduces eXtreme low-power microcontrollers with LCD controller in low pin count packages. This is a 16-bit microcontroller family with a broad peripheral feature set and enhanced computational performance. This family also offers a new migration option for those high-performance applications which may be outgrowing their 8-bit platforms, but do not require the numerical processing power of a Digital Signal Processor (DSP).

 Table 1-1 lists the functions of the various pins shown in the pinout diagrams.

1.1 Core Features

1.1.1 16-BIT ARCHITECTURE

Central to all PIC24F devices is the 16-bit modified Harvard architecture, first introduced with Microchip's dsPIC[®] Digital Signal Controllers (DSCs). The PIC24F CPU core offers a wide range of enhancements, such as:

- 16-bit data and 24-bit address paths with the ability to move information between data and memory spaces
- Linear addressing of up to 12 Mbytes (program space) and 32 Kbytes (data)
- A 16-element Working register array with built-in software stack support
- A 17 x 17 hardware multiplier with support for integer math
- Hardware support for 32 by 16-bit division
- An instruction set that supports multiple addressing modes and is optimized for high-level languages, such as 'C'
- Operational performance up to 16 MIPS

1.1.2 POWER-SAVING TECHNOLOGY

The PIC24FJ128GL306 family of devices includes Retention Sleep, a low-power mode with essential circuits being powered from a separate low-voltage regulator. This new low-power mode also supports the continuous operation of the low-power, on-chip Real-Time Clock/ Calendar (RTCC), making it possible for an application to keep time while the device is otherwise asleep.

Aside from this new feature, PIC24FJ128GL306 family devices also include all of the legacy power-saving features of previous PIC24F microcontrollers, such as:

- On-the-Fly Clock Switching, allowing the selection of a lower power clock during run time
- Doze Mode Operation, for maintaining peripheral clock speed while slowing the CPU clock
- Instruction-Based Power-Saving Modes, for quick invocation of the Idle and Sleep modes

1.1.3 OSCILLATOR OPTIONS AND FEATURES

All of the devices in the PIC24FJ128GL306 family offer six different oscillator options, allowing users a range of choices in developing application hardware. These include:

- · Two Crystal modes
- External Clock (EC) mode
- A Phase-Locked Loop (PLL) frequency multiplier, which allows processor speeds up to 32 MHz
- An internal Fast RC Oscillator (FRC), a nominal 8 MHz output with multiple frequency divider options
- A separate internal Low-Power RC Oscillator (LPRC), 32 kHz nominal for low-power, timing-insensitive applications.

The internal oscillator block also provides a stable reference source for the Fail-Safe Clock Monitor (FSCM). This option constantly monitors the main clock source against a reference signal provided by the internal oscillator and enables the controller to switch to the internal oscillator, allowing for continued low-speed operation or a safe application shutdown.

1.1.4 EASY MIGRATION

Regardless of the memory size, all devices share the same rich set of peripherals, allowing for a smooth migration path as applications grow and evolve. The consistent pinout scheme used throughout the entire family also aids in migrating from one device to the next larger device.

1.2 DMA Controller

PIC24FJ128GL306 family devices have a Direct Memory Access (DMA) Controller. This module acts in concert with the CPU, allowing data to move between data memory and peripherals without the intervention of the CPU, increasing data throughput and decreasing execution time overhead. Six independently programmable channels make it possible to service multiple peripherals at virtually the same time, with each channel peripheral performing a different operation. Many types of data transfer operations are supported.

1.3 LCD Controller

The versatile on-chip LCD controller includes many features that make the integration of displays in lowpower applications easier. These include an integrated voltage regulator with charge pump and an integrated internal resistor ladder that allows contrast control in software, and display operation above the device VDD.

Core-independent automatic display features:

- · Dual display memory
- Blink mode of individual pixels or the complete pixels
- · Blank of individual pixels or the complete pixels
- Timing schedule can be changed without core intervention, based on user configurations

1.4 Other Special Features

- **Peripheral Pin Select:** The Peripheral Pin Select (PPS) feature allows most digital peripherals to be mapped over a fixed set of digital I/O pins. Users may independently map the input and/or output of any one of the many digital peripherals to any one of the I/O pins.
- **Configurable Logic Cell:** The Configurable Logic Cell (CLC) module allows the user to specify combinations of signals as inputs to a logic function and to use the logic output to control other peripherals or I/O pins.
- **Timing Modules:** The PIC24FJ128GL306 family provides five independent, general purpose, 16-bit timers (four of which can be combined into two 32-bit timers). The devices also include five multiple output advanced Capture/Compare/PWM/Timer peripherals.

- **Communications:** The PIC24FJ128GL306 family incorporates a range of serial communication peripherals to handle a range of application requirements. There are two independent I²C modules that support both Master and Slave modes of operation. Devices also have, through the PPS feature, four independent UARTs with built-in IrDA[®] encoders/decoders, LIN support and two SPI modules.
- Analog Features: All members of the PIC24FJ128GL306 family include a 12-bit A/D Converter (A/D) module and a triple comparator module. The A/D module incorporates a range of new features that allow the converter to assess and make decisions on incoming data, reducing CPU overhead for routine A/D conversions. The comparator module includes three analog comparators that are configurable for a wide range of operations.
- Real-Time Clock and Calendar (RTCC): This module implements a full-featured clock and calendar with alarm functions in hardware, freeing up timer resources and program memory space for use of the core application.
- **Deadman Timer (DMT):** This module is provided to interrupt the processor in the event of a software malfunction.

1.5 Details of Individual Family Members

Devices in the PIC24FJ128GL306 family are available in 28-pin, 36-pin, 48-pin and 64-pin packages. The general block diagram for all devices is shown in Figure 1-1.

A list of the pin features available on the PIC24FJ128GL306 family devices, sorted by function, is shown in Table 1-1. Note that this table shows the pin location of individual peripheral features and not how they are multiplexed on the same pin. This information is provided in the "**Pin Diagrams**" section in the beginning of this data sheet. Multiplexed features are sorted by the priority given to a feature, with the highest priority peripheral being listed first.

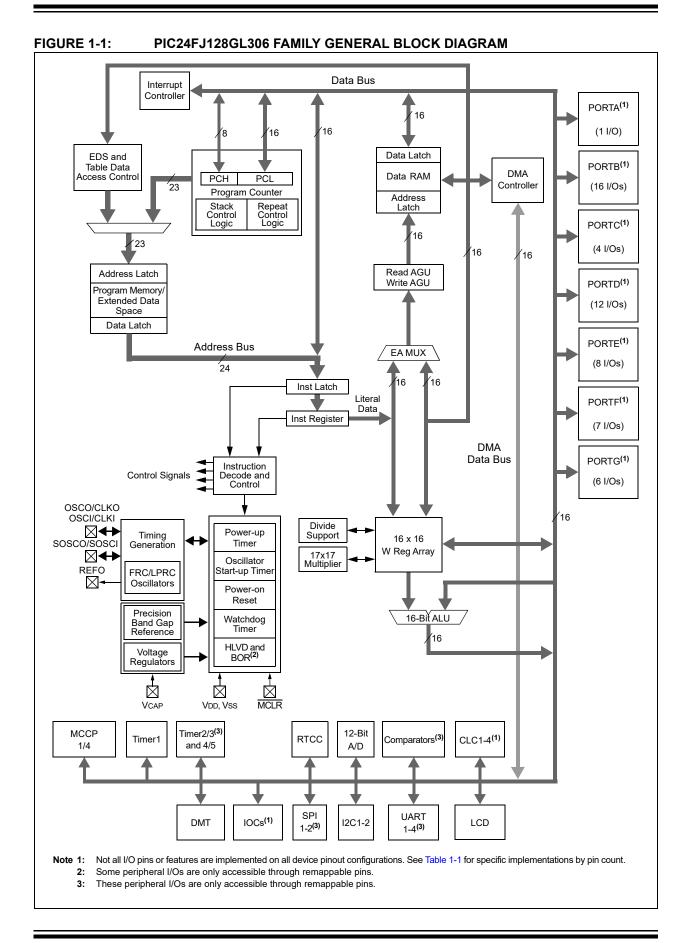


TABLE 1-1:	PIC24FJ128GL306 FAMILY PINOUT DESCRIPTION

Pin Name	Pin Type	Buffer Type	PPS	Description
AN0-AN16	I	Analog	No	A/D Analog Inputs
AVDD	Р	_	No	Positive Supply for Analog Modules
AVss	Р	_	No	Ground Reference for Analog Modules
C1INA-C1IND	Ι	Analog	No	Comparator 1 Inputs A through D
C1OUT	0	DIG	Yes	Comparator 1 Output
C2INA-C2IND	I	Analog	No	Comparator 2 Inputs A through D
C2OUT	0	DIG	Yes	Comparator 2 Output
C3INA-C3IND	I	Analog	No	Comparator 3 Inputs A through D
C3OUT	0	DIG	Yes	Comparator 3 Output
CLKI		_	No	Main Clock Input Connection
CLKO	0	DIG	No	System Clock Output
COM0-COM7	0	Analog	No	LCD Driver Common Outputs 0 through 7
LCDBIAS0-LCDBIAS3	0	Analog	No	Bias Inputs 0 through 3 for LCD Driver Charge Pump
VLCAP1	0	Analog	No	LCD Drive Charge Pump Capacitor Input 1
VLCAP2	0	Analog	No	LCD Drive Charge Pump Capacitor Input 2
SEG0-SEG31	0	Analog	No	LCD Driver Segment Outputs 0 through 31
SEG40	0	Analog	No	LCD Driver Segment Output 40
SEG47	0	Analog	No	LCD Driver Segment Output 47
SEG48	0	Analog	No	LCD Driver Segment Output 48
SEG63	0	Analog	No	LCD Driver Segment Output 63
CVREF	0	Analog	No	Comparator Voltage Reference Output
CVREF+	I	Analog	No	Comparator Voltage Reference (high) Input
CVREF-	I	Analog	No	Comparator Voltage Reference (low) Input
INT0	I	ST	No	External Interrupt Input 0
INT1-INT4	I	ST	Yes	External Interrupt Inputs 1 through 4
HLVDIN	Ι	Analog	No	High/Low-Voltage Detect Input
MCLR	Ι	ST	No	Master Clear (device Reset) Input
				This line is brought low to cause a Reset.
ICM1-ICM5	Ι	ST	Yes	MCCP Capture Inputs 1 through 5
TCKIA-TCKIB	I	ST	Yes	MCCP Timer Clock Inputs A through B
OCFA-OCFB	I	ST	Yes	MCCP Fault Inputs A through B
OCM1A-OCM1F	0	DIG	No	MCCP1 Outputs A through F
OCM2A-OCM2B	0	DIG	Yes	MCCP2 Outputs A through B
OCM3A-OCM3B	0	DIG		MCCP3 Outputs A through B
OCM4A-OCM4B	0	DIG		MCCP4 Outputs A through B
OCM5A-OCM5B	0	DIG	Yes	MCCP5 Outputs A through B
CLCINA-CLCIND	I	ST	Yes	CLC Inputs A through D
CLC10UT-CLC40UT	0	DIG	Yes	CLC Outputs 1 through 4
OSCI	I	Analog/ST	No	Main Oscillator Input Connection
OSCO	Ō	,		Main Oscillator Output Connection
REFO	0	_	Yes	Reference Clock Output
REFI	I	ST	Yes	
legend: TTI = TTI in				igger input buffer DIG = Digital input/output

Legend: TTL = TTL input buffer $I^2C = I^2C/SMBus$ input buffer ST = Schmitt Trigger input buffer Analog = Analog level input/output DIG = Digital input/output SMB3 = SMBus Version 3

TABLE 1-1: PIC2	1 1	GLJUO FAMILT FIN		
Pin Name	Pin Type	Buffer Type	PPS	Description
PGC1	Ι	ST	No	ICSP [™] Programming Clock 1
PGD1	I/O	DIG/ST	No	ICSP Programming Data 1
PGC2	I	ST	No	ICSP Programming Clock 2
PGD2	I/O	DIG/ST	No	ICSP Programming Data 2
PGC3	I	ST	No	ICSP Programming Clock 3
PGD3	I/O	DIG/ST	No	ICSP Programming Data 3
PWRLCLK	Ι	ST	No	Real-Time Clock 50/60 Hz Clock Input
TMPRN	I	ST	Yes	Tamper Detect
PWRGT	0	DIG	Yes	RTCC Power Control
RTCC	0	DIG	Yes	RTCC Clock Output
RA0	I/O	DIG/ST	No	PORTA Digital I/O
RB0-RB15	I/O	DIG/ST	No	PORTB Digital I/Os
RC12-RC15	I/O	DIG/ST	No	PORTC Digital I/Os
RD0-RD11	I/O	DIG/ST	No	PORTD Digital I/Os
RE0-RE7	I/O	DIG/ST	No	PORTE Digital I/Os
RF0-RF6	I/O	DIG/ST	No	PORTF Digital I/Os
RG2-RG3, RG6-RG9	I/O	DIG/ST	No	PORTG Digital I/Os
RP0-RP31	I/O	DIG/ST	No	Remappable Peripherals (input or output)
RPI37	Ι	ST	No	Remappable Peripheral (input only)
SCK1	I/O	ST	Yes	Synchronous Serial Clock Input/Output for SPI1
SDI1	I	ST	Yes	SPI1 Data In
SDO1	0	DIG	Yes	SPI1 Data Out
SS1	I/O	ST	Yes	SPI1 Slave Synchronization or Frame Pulse I/O
SCK2	I/O	ST	Yes	Synchronous Serial Clock Input/Output for SPI2
SDI2	I	ST	Yes	SPI2 Data In
SDO2	0	DIG	Yes	SPI2 Data Out
SS2	I/O	ST	Yes	SPI2 Slave Synchronization or Frame Pulse I/O
SCL1	I/O	DIG/I ² C/SMB3	No	I2C1 Synchronous Serial Clock Input/Output
SDA1				I2C1 Data Input/Output
ASCL1				Alternate I2C1 Synchronous Serial Clock Input/Output
ASDA1				Alternate I2C1 Data Input/Output
SCL2	I/O	DIG/I ² C/SMB3	No	I2C2 Synchronous Serial Clock Input/Output
SDA2				I2C2 Data Input/Output
U1CTS	I	ST	Yes	UART1 Clear-to-Send
U1RTS	0	DIG	Yes	UART1 Request-to-Send
U1RX	I	ST	Yes	UART1 Receive
U1TX	0	DIG	Yes	UART1 Transmit
U2CTS	Ι	ST	Yes	UART2 Clear-to-Send
U2RTS	0	DIG	Yes	UART2 Request-to-Send
U2RX	I	ST	Yes	UART2 Receive
U2TX	0	DIG	Yes	UART2 Transmit
U3CTS	I	ST	Yes	UART3 Clear-to-Send
U3RTS	0	DIG	Yes	UART3 Request-to-Send
U3RX	I	ST	Yes	UART3 Receive
U3TX	0	DIG	Yes	UART3 Transmit
Legend: TTL = TTL ir	nput buff	er ST = Sch	nmitt Tr	igger input buffer DIG = Digital input/output

gend: I I L = I I L input buffer $I^2C = I^2C/SMBus$ input buffer Analog = Analog level input/output

DIG = Digital input/output SMB3 = SMBus Version 3

Pin Name	Pin Type	Buffer Type	PPS	Description
U4CTS	I	ST	Yes	UART4 Clear-to-Send
U4RTS	0	DIG	Yes	UART4 Request-to-Send
U4RX	I	ST	Yes	UART4 Receive
U4TX	0	DIG	Yes	UART4 Transmit
SOSCI	_	_	—	Secondary Oscillator/Timer1 Clock Input
SOSCO	_	_	No	Secondary Oscillator/Timer1 Clock Output
SCLKI	I	ST	No	Secondary Clock Digital Input
T1CK	I	ST	No	Timer1 Clock
T2CK-T5CK	I	ST	Yes	Timer2 through Timer5 Clock
TxCK	I	ST	Yes	Timer External Clock
ТСК	I	ST	No	JTAG Test Clock/Programming Clock Input
TDI	I	ST	No	JTAG Test Data/Programming Data Input
TDO	0	DIG	No	JTAG Test Data Output
TMS	I	ST	No	JTAG Test Mode Select Input
VCAP	Р	_	No	External Filter Capacitor Connection (regulator enabled)
Vdd	Р	_	No	Positive Supply for Peripheral Digital Logic and I/O Pins
VREF+	I	Analog	No	Comparator and A/D Reference Voltage (high) Input
Vss	Р		No	Ground Reference for Peripheral Digital Logic and I/O Pins

TABLE 1-1: PIC24FJ128GL306 FAMILY PINOUT DESCRIPTION (CONTINUED)

Legend: TTL = TTL input buffer $I^2C = I^2C/SMBus$ input buffer ST = Schmitt Trigger input buffer Analog = Analog level input/output DIG = Digital input/output SMB3 = SMBus Version 3

2.0 GUIDELINES FOR GETTING STARTED WITH 16-BIT MICROCONTROLLERS

2.1 Basic Connection Requirements

Getting started with the PIC24FJ128GL306 family of 16-bit microcontrollers requires attention to a minimal set of device pin connections before proceeding with development.

The following pins must always be connected:

- All VDD and Vss pins (see Section 2.2 "Power Supply Pins")
- All AVDD and AVSS pins, regardless of whether or not the analog device features are used (see Section 2.2 "Power Supply Pins")
- MCLR pin (see Section 2.3 "Master Clear (MCLR) Pin")

 VCAP pin (see Section 2.4 "Voltage Regulator Pin (VCAP)")

These pins must also be connected if they are being used in the end application:

- PGCx/PGDx pins used for In-Circuit Serial Programming[™] (ICSP[™]) and debugging purposes (see Section 2.4.2 "ICSP Pins")
- OSCI and OSCO pins when an external oscillator source is used

(see Section 2.5 "External Oscillator Pins")

Additionally, the following pins may be required:

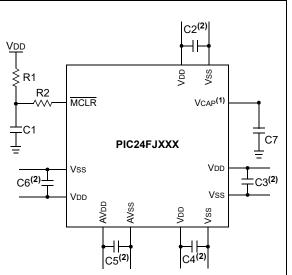
• VREF+ pin used when external voltage reference for analog modules is implemented

Note: The AVDD and AVss pins must always be connected, regardless of whether any of the analog modules are being used.

The minimum mandatory connections are shown in Figure 2-1.

FIGURE 2-1: RECOMMENDED

MINIMUM CONNECTIONS



Key (all values are recommendations):

C1 through C6: 0.1 µF, 50V ceramic

C7: 10 µF, 16V or greater, ceramic

R1: 10 kΩ

R2: 100Ω to 470Ω

- Note 1: See Section 2.4 "Voltage Regulator Pin (VCAP)" for an explanation of voltage regulator pin connections.
 - 2: The example shown is for a PIC24F device with five VDD/Vss and AVDD/AVss pairs. Other devices may have more or less pairs; adjust the number of decoupling capacitors appropriately.

2.2 Power Supply Pins

2.2.1 DECOUPLING CAPACITORS

The use of decoupling capacitors on every pair of power supply pins, such as VDD, VSS, AVDD and AVSS, is required.

Consider the following criteria when using decoupling capacitors:

- Value and type of capacitor: A 0.1 μF (100 nF), 25V-50V capacitor is recommended. The capacitor should be a low-ESR device with a self-resonance frequency in the range of 200 MHz and higher. Ceramic capacitors are recommended.
- Placement on the printed circuit board: The decoupling capacitors should be placed as close to the pins as possible. It is recommended to place the capacitors on the same side of the board as the device. If space is constricted, the capacitor can be placed on another layer on the PCB using a via; however, ensure that the trace length from the pin to the capacitor is no greater than 0.25 inch (6 mm).
- Handling high-frequency noise: If the board is experiencing high-frequency noise (upward of tens of MHz), add a second ceramic-type capacitor in parallel to the above described decoupling capacitor. The value of the second capacitor can be in the range of $0.01 \ \mu\text{F}$ to $0.001 \ \mu\text{F}$. Place this second capacitor next to each primary decoupling capacitor. In high-speed circuit designs, consider implementing a decade pair of capacitances as close to the power and ground pins as possible (e.g., $0.1 \ \mu\text{F}$ in parallel with $0.001 \ \mu\text{F}$).
- Maximizing performance: On the board layout from the power supply circuit, run the power and return traces to the decoupling capacitors first, and then to the device pins. This ensures that the decoupling capacitors are first in the power chain. Equally important is to keep the trace length between the capacitor and the power pins to a minimum, thereby reducing PCB trace inductance.

2.2.2 BULK CAPACITORS

On boards with power traces running longer than six inches in length, it is suggested to use a bulk capacitance of 10 μ F or greater located near the MCU. The value of the capacitor should be determined based on the trace resistance that connects the power supply source to the device, and the maximum current drawn by the device in the application. Typical values range from 10 μ F to 47 μ F. The capacitor should be ceramic and have a voltage rating of 25V or more to reduce DC bias effects (see Section 2.4.1 "Considerations for Ceramic Capacitors").

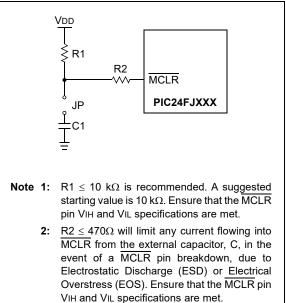
2.3 Master Clear (MCLR) Pin

The MCLR pin provides two specific device functions: device Reset, and device programming and debugging. If programming and debugging are not required in the end application, a direct connection to VDD may be all that is required. The addition of other components, to help increase the application's resistance to spurious Resets from voltage sags, may be beneficial. A typical configuration is shown in Figure 2-1. Other circuit designs may be implemented depending on the application's requirements.

During programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the $\overline{\text{MCLR}}$ pin. Consequently, specific voltage levels (VIH and VIL) and fast signal transitions must not be adversely affected. Therefore, specific values of R1 and C1 will need to be adjusted based on the application and PCB requirements. For example, it is recommended that the capacitor, C1, be isolated from the $\overline{\text{MCLR}}$ pin during programming and debugging operations by using a jumper (Figure 2-2). The jumper is replaced for normal run-time operations.

Any components associated with the $\overline{\text{MCLR}}$ pin should be placed within 0.25 inch (6 mm) of the pin.

FIGURE 2-2: EXAMPLE OF MCLR PIN CONNECTIONS



2.4 Voltage Regulator Pin (VCAP)

Note: This section applies only to PIC24FJ devices with an on-chip voltage regulator.

Refer to **Section 27.3 "On-Chip Voltage Regulator"** for details on connecting and using the on-chip regulator.

A low-ESR (< 5 Ω) capacitor is required on the VCAP pin to stabilize the voltage regulator output voltage. The VCAP pin must not be connected to VDD and must use a capacitor of 10 μ F connected to ground. The type can be ceramic or tantalum. Suitable examples of capacitors are shown in Table 2-1. Capacitors with equivalent specifications can be used.

Designers may use Figure 2-3 to evaluate the ESR equivalence of candidate devices.

The placement of this capacitor should be close to VCAP. It is recommended that the trace length not exceed 0.25 inch (6 mm). Refer to **Section 30.0** "**Electrical Characteristics**" for additional information.

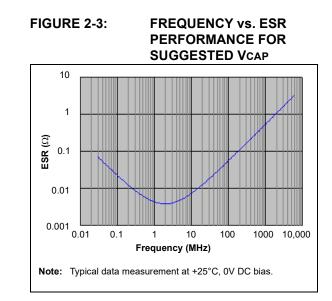


TABLE 2-1: SUITABLE CAPACITOR EQUIVALENTS (0805 CASE SIZE)

Make	Part #	Nominal Capacitance	Base Tolerance	Rated Voltage
TDK	C2012X5R1E106K085AC	10 µF	±10%	25V
TDK	C2012X5R1C106K085AC	10 µF	±10%	16V
Kemet	C0805C106M4PACTU	10 µF	±10%	16V
Murata	GRM21BR61E106KA3L	10 µF	±10%	25V
Murata	GRM21BR61C106KE15	10 µF	±10%	16V

2.4.1 CONSIDERATIONS FOR CERAMIC CAPACITORS

In recent years, large value, low-voltage, surface-mount ceramic capacitors have become very cost effective in sizes up to a few tens of microfarad. The low-ESR, small physical size and other properties make ceramic capacitors very attractive in many types of applications.

Ceramic capacitors are suitable for use with the internal voltage regulator of this microcontroller. However, some care is needed in selecting the capacitor to ensure that it maintains sufficient capacitance over the intended operating range of the application.

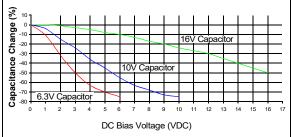
Typical low-cost, 10 μ F ceramic capacitors are available in X5R, X7R and Y5V dielectric ratings (other types are also available, but are less common). The initial tolerance specifications for these types of capacitors are often specified as ±10% to ±20% (X5R and X7R) or -20%/+80% (Y5V). However, the effective capacitance that these capacitors provide in an application circuit will also vary based on additional factors, such as the applied DC bias voltage and the temperature. The total in-circuit tolerance is, therefore, much wider than the initial tolerance specification.

The X5R and X7R capacitors typically exhibit satisfactory temperature stability (ex: $\pm 15\%$ over a wide temperature range, but consult the manufacturer's data sheets for exact specifications). However, Y5V capacitors typically have extreme temperature tolerance specifications of $\pm 22\%/-82\%$. Due to the extreme temperature tolerance, a 10 µF nominal rated Y5V type capacitor may not deliver enough total capacitance to meet minimum internal voltage regulator stability and transient response requirements. Therefore, Y5V capacitors are not recommended for use with the internal regulator if the application must operate over a wide temperature range.

In addition to temperature tolerance, the effective capacitance of large value ceramic capacitors can vary substantially, based on the amount of DC voltage applied to the capacitor. This effect can be very significant, but is often overlooked or is not always documented.

A typical DC bias voltage vs. capacitance graph for X7R type capacitors is shown in Figure 2-4.

FIGURE 2-4: DC BIAS VOLTAGE vs. CAPACITANCE CHARACTERISTICS



When selecting a ceramic capacitor to be used with the internal voltage regulator, it is suggested to select a high-voltage rating so that the operating voltage is a small percentage of the maximum rated capacitor voltage. For example, choose a ceramic capacitor rated at a minimum of 16V for the 1.8V core voltage. Suggested capacitors are shown in Table 2-1.

2.4.2 ICSP PINS

The PGCx and PGDx pins are used for In-Circuit Serial Programming (ICSP) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of ohms, not to exceed 100Ω .

Pull-up resistors, series diodes and capacitors on the PGCx and PGDx pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits, and pin Voltage Input High (VIH) and Voltage Input Low (VIL) requirements.

For device emulation, ensure that the "Communication Channel Select" pins (i.e., PGCx/PGDx) programmed into the device match the physical connections for the ICSP to the Microchip debugger/emulator tool.

For more information on available Microchip development tools connection requirements, refer to **Section 29.0 "Development Support"**.

2.5 External Oscillator Pins

Many microcontrollers have options for at least two oscillators: a high-frequency Primary Oscillator and a low-frequency Secondary Oscillator (refer to Section 9.0 "Oscillator Configuration" for details).

The oscillator circuit should be placed on the same side of the board as the device. Place the oscillator circuit close to the respective oscillator pins with no more than 0.5 inch (12 mm) between the circuit components and the pins. The load capacitors should be placed next to the oscillator itself, on the same side of the board.

Use a grounded copper pour around the oscillator circuit to isolate it from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed.

Layout suggestions are shown in Figure 2-5. In-line packages may be handled with a single-sided layout that completely encompasses the oscillator pins. With fine-pitch packages, it is not always possible to completely surround the pins and components. A suitable solution is to tie the broken guard sections to a mirrored ground layer. In all cases, the guard trace(s) must be returned to ground.

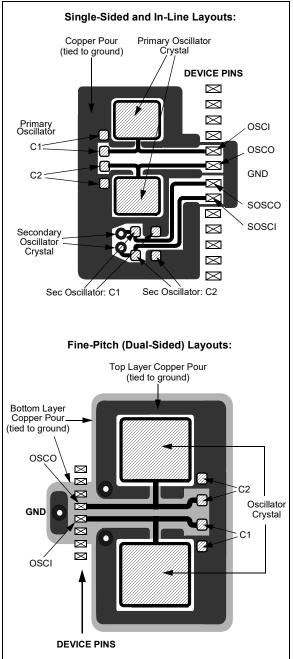
In planning the application's routing and I/O assignments, ensure that adjacent port pins, and other signals in close proximity to the oscillator, are benign (i.e., free of high frequencies, short rise and fall times, and other similar noise).

For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate website (www.microchip.com):

- AN943, "Practical PICmicro[®] Oscillator Analysis and Design"
- AN949, "Making Your Oscillator Work"
- AN1798, "Crystal Selection for Low-Power Secondary Oscillator"

FIGURE 2-5: SUGGESTED

PLACEMENT OF THE OSCILLATOR CIRCUIT



2.6 Configuration of Analog and Digital Pins During ICSP Operations

If an ICSP compliant emulator is selected as a debugger, it automatically initializes all of the A/D input pins (ANx) as "digital" pins. This is done by clearing all bits in the ANSELx registers. Refer to **Section 11.2 "Configuring Analog Port Pins (ANSELx)**" for more specific information.

The bits in these registers that correspond to the A/D pins that initialized the emulator must not be changed by the user application firmware; otherwise, communication errors will result between the debugger and the device.

If your application needs to use certain A/D pins as analog input pins during the debug session, the user application must modify the appropriate bits during initialization of the A/D module, as follows:

 Set the bits corresponding to the pin(s) to be configured as analog. Do not change any other bits, particularly those corresponding to the PGCx/PGDx pair, at any time. When a Microchip debugger/emulator is used as a programmer, the user application firmware must correctly configure the ANSELx registers. Automatic initialization of these registers is only done during debugger operation. Failure to correctly configure the register(s) will result in all A/D pins being recognized as analog input pins, resulting in the port value being read as a logic '0', which may affect user application functionality.

2.7 Unused I/Os

Unused I/O pins should be configured as outputs and driven to a logic low state. Alternatively, connect a 1 k Ω to 10 k Ω resistor to Vss on unused pins and drive the output to logic low.

3.0 CPU

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "CPU with Extended Data Space (EDS)" (www.microchip.com/ DS39732) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The PIC24F CPU has a 16-bit (data) modified Harvard architecture with an enhanced instruction set and a 24-bit instruction word with a variable length opcode field. The Program Counter (PC) is 23 bits wide and addresses up to 4M instructions of user program memory space. A single-cycle instruction prefetch mechanism is used to help maintain throughput and provides predictable execution. All instructions execute in a single cycle, with the exception of instructions that change the program flow, the double-word move (MOV.D) instruction and the table instructions. Overhead-free program loop constructs are supported using the REPEAT instructions, which are interruptible at any point.

PIC24F devices have sixteen, 16-bit Working registers in the programmer's model. Each of the Working registers can act as a Data, Address or Address Offset register. The 16th Working register (W15) operates as a Software Stack Pointer (SSP) for interrupts and calls.

The lower 32 Kbytes of the Data Space (DS) can be accessed linearly. The upper 32 Kbytes of the Data Space are referred to as Extended Data Space (EDS), to which the extended data RAM, EPMP memory space or program memory can be mapped.

The Instruction Set Architecture (ISA) has been significantly enhanced beyond that of the PIC18, but maintains an acceptable level of backward compatibility. All PIC18 instructions and addressing modes are supported, either directly, or through simple macros. Many of the ISA enhancements have been driven by compiler efficiency needs. The core supports Inherent (no operand), Relative, Literal, Memory Direct Addressing modes along with three groups of addressing modes. All modes support Register Direct and various Register Indirect modes. Each group offers up to seven addressing modes. Instructions are associated with predefined addressing modes depending upon their functional requirements.

For most instructions, the core is capable of executing a data (or program data) memory read, a Working register (data) read, a data memory write and a program (instruction) memory read per instruction cycle. As a result, three parameter instructions can be supported, allowing trinary operations (for example, A + B = C) to be executed in a single cycle.

A high-speed, 17-bit x 17-bit multiplier has been included to significantly enhance the core arithmetic capability and throughput. The multiplier supports Signed, Unsigned and Mixed mode, 16-bit x 16-bit or 8-bit x 8-bit, integer multiplication. All multiply instructions execute in a single cycle.

The 16-bit ALU has been enhanced with integer divide assist hardware that supports an iterative non-restoring divide algorithm. It operates in conjunction with the REPEAT instruction looping mechanism and a selection of iterative divide instructions to support 32-bit (or 16-bit), divided by 16-bit, integer signed and unsigned division. All divide operations require 19 cycles to complete but are interruptible at any cycle boundary.

The PIC24F has a vectored exception scheme with up to eight sources of non-maskable traps and up to 118 interrupt sources. Each interrupt source can be assigned to one of seven priority levels.

A block diagram of the CPU is shown in Figure 3-1.

3.1 Programmer's Model

The programmer's model for the PIC24F is shown in Figure 3-2. All registers in the programmer's model are memory-mapped and can be manipulated directly by instructions.

A description of each register is provided in Table 3-1. All registers associated with the programmer's model are memory-mapped.

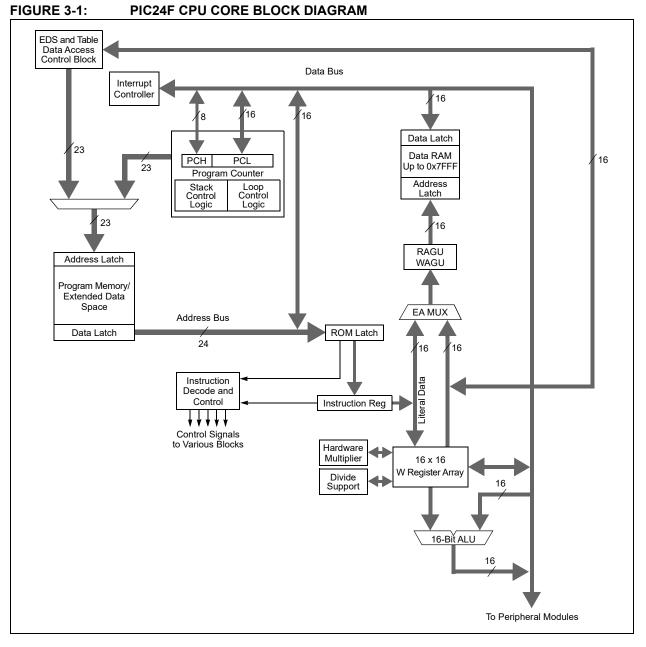
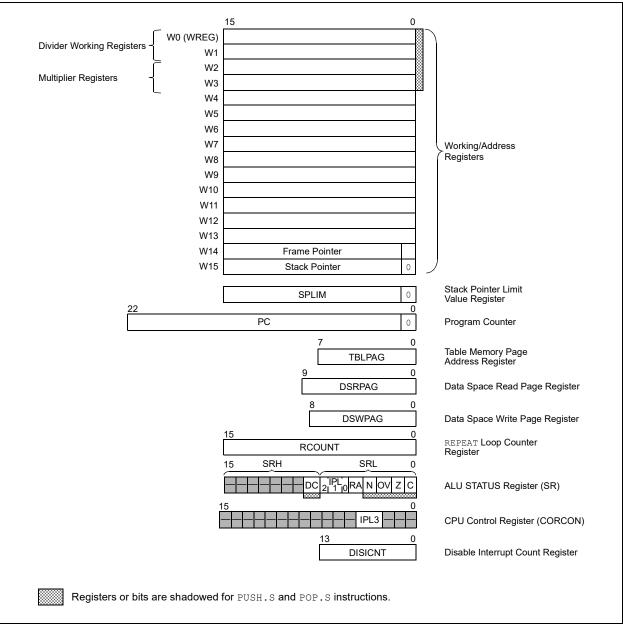


TABLE 3-1:	CPU CORE REGISTERS

Register(s) Name	Description		
W0 through W15	Working Register Array		
PC	23-Bit Program Counter		
SR	ALU STATUS Register		
SPLIM	Stack Pointer Limit Value Register		
TBLPAG	Table Memory Page Address Register		
RCOUNT	REPEAT Loop Counter Register		
CORCON	CPU Control Register		
DISICNT	Disable Interrupt Count Register		
DSRPAG	Data Space Read Page Register		
DSWPAG	Data Space Write Page Register		





3.2 CPU Control Registers

REGISTER 3-1: SR: ALU STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	_	—	_	_	_	DC
bit 15							bit
R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R-0	R/W-0	R/W-0	R/W-0	R/W-0
IPL2 ⁽²⁾	IPL1 ⁽²⁾	IPL0 ⁽²⁾	RA	N	OV	Z	C
bit 7		11 20	101			2	bit
Lonordi							
Legend: R = Readable	a hit	W = Writable b	it	II = I Inimplem	nented bit, rea	n, se p	
-n = Value at		'1' = Bit is set	it.	0 = Onimpien		x = Bit is unkr	
	TOR				areu		
bit 15-9	Unimplemen	ited: Read as '0'					
bit 8	-	f Carry/Borrow bi					
-		out from the 4 th lo		for byte-sized da	ata) or 8 th low-	order bit (for wo	ord-sized data
	of the res	sult occurred				,	
	•	out from the 4^{th}			sult has occurr	ed	
oit 7-5	IPL[2:0]: CP	U Interrupt Priori	ty Level Stat	us bits ^(1,2)			
		nterrupt Priority L			s are disabled		
		nterrupt Priority L					
		nterrupt Priority I					
		nterrupt Priority L nterrupt Priority L					
		nterrupt Priority L					
		nterrupt Priority L					
		nterrupt Priority L					
bit 4		Loop Active bit	()				
		oop is in progres					
		oop is not in pro	gress				
bit 3	N: ALU Nega	itive bit					
	1 = Result wa	0					
		as not negative (a	zero or posit	ive)			
bit 2	OV: ALU Ove						
		occurred for sigr ow has occurred	ned (2's com	plement) arithm	etic in this arith	nmetic operatio	n
bit 1	Z: ALU Zero	bit					
	1 = An operat	tion, which affect	s the Z bit, h	nas set it at some	e time in the pa	ast	
	0 = The most	recent operation	n, which affe	cts the Z bit, has	s cleared it (i.e	., a non-zero re	sult)
bit 0	C: ALU Carry	/Borrow bit					
		ut from the Most					
	0 = No carry	out from the Mos	t Significant	bit of the result	occurred		
Note 1: Th	o IPI v Statuc I	bits are read-only	when NGT		15]) = 1		
		bits are concater		• •) to form the C	OII Interrunt

2: The IPLx Status bits are concatenated with the IPL3 Status bit (CORCON[3]) to form the CPU Interrupt Priority Level (IPL). The value in parentheses indicates the IPL when IPL3 = 1.

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	_	—	—	—	—	_
bit 15							bit 8
U-0	U-0	U-0	U-0	R/C-0	R/W-1	U-0	U-0
_	—	—	—	IPL3 ⁽¹⁾	PSV ⁽²⁾	—	—
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-4	Unimplemented: Read as '0'
bit 3	IPL3: CPU Interrupt Priority Level Status bit ⁽¹⁾
	 1 = CPU Interrupt Priority Level is greater than 7 0 = CPU Interrupt Priority Level is 7 or less
bit 2	PSV: Program Space Visibility (PSV) in Data Space Enable bit ⁽²⁾
	1 = Program space is visible in Data Space0 = Program space is not visible in Data Space
bit 1-0	Unimplemented: Read as '0'

- **Note 1:** The IPL3 bit is concatenated with the IPL[2:0] bits (SR[7:5]) to form the CPU Interrupt Priority Level; see Register 3-1 for bit description.
 - 2: If PSV = 0, any reads from data memory at 0x8000 and above will cause an address trap error instead of reading from the PSV section of program memory. This bit is not individually addressable.

3.3 Arithmetic Logic Unit (ALU)

The PIC24F ALU is 16 bits wide and is capable of addition, subtraction, bit shifts and logic operations. Unless otherwise mentioned, arithmetic operations are 2's complement in nature. Depending on the operation, the ALU may affect the values of the Carry (C), Zero (Z), Negative (N), Overflow (OV) and Digit Carry (DC) Status bits in the SR register. The C and DC Status bits operate as Borrow and Digit Borrow bits, respectively, for subtraction operations.

The ALU can perform 8-bit or 16-bit operations, depending on the mode of the instruction that is used. Data for the ALU operation can come from the W register array, or data memory, depending on the addressing mode of the instruction. Likewise, output data from the ALU can be written to the W register array or a data memory location.

The PIC24F CPU incorporates hardware support for both multiplication and division. This includes a dedicated hardware multiplier and support hardware for 16-bit divisor division.

3.3.1 MULTIPLIER

The ALU contains a high-speed, 17-bit x 17-bit multiplier. It supports unsigned, signed or mixed sign operation in several multiplication modes:

- 16-bit x 16-bit signed
- 16-bit x 16-bit unsigned
- 16-bit signed x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit unsigned
- 16-bit unsigned x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit signed
- 8-bit unsigned x 8-bit unsigned

3.3.2 DIVIDER

The divide block supports 32-bit/16-bit and 16-bit/16-bit signed and unsigned integer divide operations with the following data sizes:

- 32-bit signed/16-bit signed divide
- 32-bit unsigned/16-bit unsigned divide
- 16-bit signed/16-bit signed divide
- 16-bit unsigned/16-bit unsigned divide

The quotient for all divide instructions ends up in W0 and the remainder in W1. The 16-bit signed and unsigned DIV instructions can specify any W register for both the 16-bit divisor (Wn), and any W register (aligned) pair (W(m + 1):Wm) for the 32-bit dividend. The divide algorithm takes one cycle per bit of divisor, so both 32-bit/16-bit and 16-bit/16-bit instructions take the same number of cycles to execute.

3.3.3 MULTIBIT SHIFT SUPPORT

The PIC24F ALU supports both single-bit and singlecycle, multibit arithmetic and logic shifts. Multibit shifts are implemented using a shifter block, capable of performing up to a 15-bit arithmetic right shift, or up to a 15-bit left shift, in a single cycle. All multibit shift instructions only support Register Direct Addressing for both the operand source and result destination.

A full summary of instructions that use the shift operation is provided in Table 3-2.

TABLE 3-2: INSTRUCTIONS THAT USE THE SINGLE-BIT AND MULTIBIT SHIFT OPERATION

Instruction	Description	
ASR	rithmetic Shift Right Source register by one or more bits.	
SL	Shift Left Source register by one or more bits.	
LSR	ogical Shift Right Source register by one or more bits.	

4.0 MEMORY ORGANIZATION

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "PIC24F Flash Program Memory" (www.microchip.com/DS30009715) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

As Harvard architecture devices, PIC24F microcontrollers feature separate program and data memory spaces and buses. This architecture also allows direct access of program memory from the Data Space (DS) during code execution.

4.1 Program Memory Space

The program address memory space of the PIC24FJ128GL306 family devices is 4M instructions. The space is addressable by a 24-bit value derived from either the 23-bit Program Counter (PC) during program execution, or from table operation or Data Space remapping, as described in Section 4.3 "Interfacing Program and Data Memory Spaces".

User access to the program memory space is restricted to the lower half of the address range (000000h to 7FFFFFh). The exception is the use of TBLRD/TBLWT operations, which use TBLPAG[7] to permit access to the Configuration bits and customer OTP sections of the configuration memory space.

The memory map for the PIC24FJ128GL306 family of devices is shown in Figure 4-1.

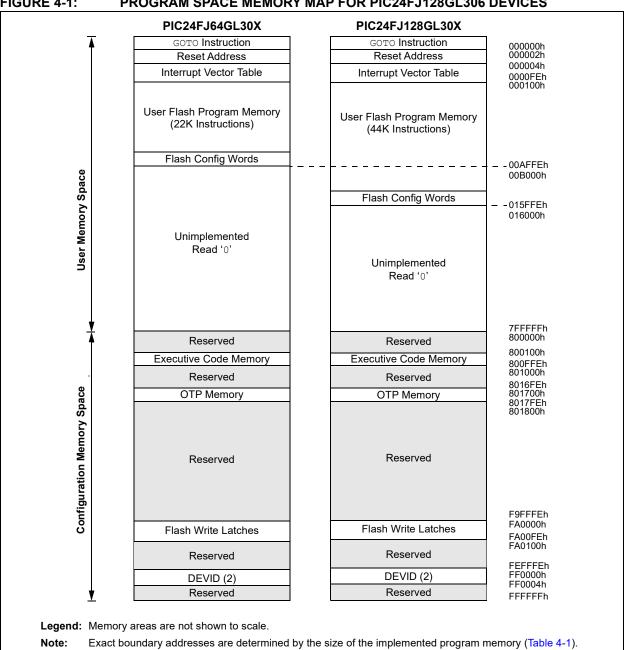


FIGURE 4-1: PROGRAM SPACE MEMORY MAP FOR PIC24FJ128GL306 DEVICES

PROGRAM MEMORY SIZES AND BOUNDARIES⁽²⁾ **TABLE 4-1**:

Device	Program Memory Upper Boundary (Instruction Words)	Write Blocks ⁽¹⁾	Erase Blocks ⁽¹⁾
PIC24FJ128GL30X	015FFEh (45,056 x 24)	352	44
PIC24FJ64GL30X	00AFFEh (22,528 x 24)	176	22

Note 1: One Write Block = 128 Instruction Words; One Erase Block (Page) = 1024 Instruction Words.

2: To maintain integer page sizes, the memory sizes are not exactly half of each other.

4.1.1 PROGRAM MEMORY ORGANIZATION

The program memory space is organized in wordaddressable blocks. Although it is treated as 24 bits wide, it is more appropriate to think of each address of the program memory as a lower and upper word, with the upper byte of the upper word being unimplemented. The lower word always has an even address, while the upper word has an odd address (Figure 4-2).

Program memory addresses are always word-aligned on the lower word and addresses are incremented or decremented by two during code execution. This arrangement also provides compatibility with data memory space addressing and makes it possible to access data in the program memory space.

4.1.2 HARD MEMORY VECTORS

All PIC24F devices reserve the addresses between 000000h and 000200h for hard-coded program execution vectors. A hardware Reset vector is provided to redirect code execution from the default value of the PC on a device Reset to the actual start of code. A GOTO instruction is programmed by the user at 000000h, with the actual address for the start of code at 000002h.

The PIC24FJ128GL306 devices can have up to two Interrupt Vector Tables (IVT). The first is located from addresses, 000004h to 0000FFh. The Alternate Interrupt Vector Table (AIVT) can be enabled by the AIVTDIS Configuration bit if the Boot Segment (BS) is present. If the user has configured a Boot Segment, the AIVT will be located at the address: (BSLIM[12:0] – 1) x 0x800. These vector tables allow each of the many device interrupt sources to be handled by separate ISRs. A more detailed discussion of the Interrupt Vector Tables is provided in Section 8.1 "Interrupt Vector Tables".

4.1.3 CONFIGURATION BITS OVERVIEW

The Configuration bits are stored in the last page location of implemented program memory. These bits can be set or cleared to select various device configurations. There are two types of Configuration bits: system operation bits and code-protect bits. The system operation bits determine the power-on settings for system-level components, such as the oscillator and the Watchdog Timer. The code-protect bits prevent program memory from being read and written.

Refer to **Section 27.0 "Special Features**" for the full Configuration register description for each specific device.

4.1.4 CODE-PROTECT CONFIGURATION BITS

The device implements intermediate security features defined by the FSEC register. The Boot Segment (BS) is the higher privileged segment and the General Segment (GS) is the lower privileged segment. The total user code memory can be split into BS or GS. The size of the segments is determined by the BSLIM[12:0] bits. The relative location of the segments within user space does not change, such that BS (if present) occupies the memory area just after the Interrupt Vector Table (IVT) and the GS occupies the space just after the BS (or if the Alternate IVT is enabled, just after it).

The Configuration Segment (CS) is a small segment (less than a page, typically just one row) within user Flash address space. It contains all user configuration data that are loaded by the NVM Controller during the Reset sequence.

4.2 Data Memory Space

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to "Data Memory with Extended Data Space (EDS)" (www.microchip.com/ DS39733) in the "dsPIC33/PIC24 Family Reference Manual", . The information in this data sheet supersedes the information in the FRM.

The PIC24F core has a 16-bit wide data memory space, addressable as a single linear range. The Data Space is accessed using two Address Generation Units (AGUs), one each for read and write operations. The Data Space memory map is shown in Figure 4-2. The 16-bit wide data addresses in the data memory space point to bytes within the Data Space (DS). This gives a DS address range of 64 Kbytes or 32K words. The lower half (0000h to 7FFFh) is used for implemented (on-chip) memory addresses.

The upper half of data memory address space (8000h to FFFFh) is used as a window into the Extended Data Space (EDS). This allows the microcontroller to directly access a greater range of data beyond the standard 16-bit address range. EDS is discussed in detail in **Section 4.2.5 "Extended Data Space (EDS)**".

4.2.1 DATA SPACE WIDTH

The data memory space is organized in byteaddressable, 16-bit wide blocks. Data are aligned in data memory and registers as 16-bit words, but all Data Space EAs resolve to bytes. The Least Significant Bytes (LSBs) of each word have even addresses, while the Most Significant Bytes (MSBs) have odd addresses.

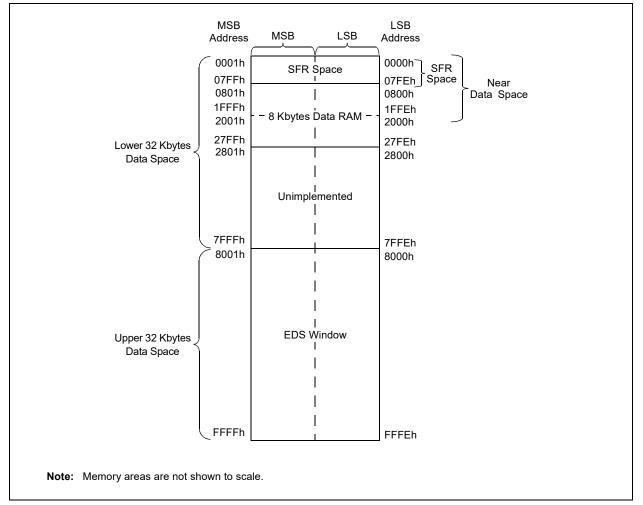


FIGURE 4-2: DATA SPACE MEMORY MAP FOR PIC24FJ128GL306 DEVICES

4.2.2 DATA MEMORY ORGANIZATION AND ALIGNMENT

To maintain backward compatibility with PIC[®] MCUs and improve Data Space memory usage efficiency, the PIC24F instruction set supports both word and byte operations. As a consequence of byte accessibility, all EA calculations are internally scaled to step through word-aligned memory. For example, the core recognizes that Post-Modified Register Indirect Addressing mode, [Ws++], will result in a value of Ws + 1 for byte operations and Ws + 2 for word operations.

Data byte reads will read the complete word, which contains the byte, using the LSB of any EA to determine which byte to select. The selected byte is placed onto the LSB of the data path. That is, data memory and registers are organized as two parallel, byte-wide entities with shared (word) address decode, but separate write lines. Data byte writes only write to the corresponding side of the array or register which matches the byte address.

All word accesses must be aligned to an even address. Misaligned word data fetches are not supported, so care must be taken when mixing byte and word operations or translating from 8-bit MCU code. If a misaligned read or write is attempted, an address error trap will be generated. If the error occurred on a read, the instruction underway is completed; if it occurred on a write, the instruction will be executed but the write will not occur. In either case, a trap is then executed, allowing the system and/or user to examine the machine state prior to execution of the address Fault.

All byte loads into any W register are loaded into the LSB. The Most Significant Byte (MSB) is not modified.

A Sign-Extend (SE) instruction is provided to allow users to translate 8-bit signed data to 16-bit signed values. Alternatively, for 16-bit unsigned data, users can clear the MSB of any W register by executing a Zero-Extend (ZE) instruction on the appropriate address.

Although most instructions are capable of operating on word or byte data sizes, it should be noted that some instructions operate only on words.

4.2.3 NEAR DATA SPACE

The 8-Kbyte area between 0000h and 1FFFh is referred to as the Near Data Space. Locations in this space are directly addressable via a 13-bit absolute address field within all memory direct instructions. The remainder of the Data Space is addressable indirectly. Additionally, the whole Data Space is addressable using MOV instructions, which support Memory Direct Addressing with a 16-bit address field.

4.2.4 SPECIAL FUNCTION REGISTER (SFR) SPACE

The first 2 Kbytes of the Near Data Space, from 0000h to 07FFh, are primarily occupied with Special Function Registers (SFRs). These are used by the PIC24F core and peripheral modules for controlling the operation of the device.

SFRs are distributed among the modules that they control and are generally grouped together by module. Much of the SFR space contains unused addresses; these are read as '0'. Each implemented area indicates a 32-byte region where at least one address is implemented as an SFR. A complete list of implemented SFRs, including their addresses, is shown in Table 4-2 through Table 4-9. These tables contain all registers applicable to the PIC24FJ128GL306 family. Not all registers are present on all device variants. Refer to Table 1 for peripheral availability. Refer to Table 11-3 through Table 11-9 for detailed port availability for the different package options.

Register	Address ⁽¹⁾	All Resets ⁽²⁾	Register	Address ⁽¹⁾	All Resets ⁽²⁾
CPU Core			Interrupt Con	troller (Continue	ed)
WREG0	0000h	000000000000000000	IFS3	008Eh	000-000000-
WREG1	0002h	00000000000000000	IFS4	0090h	00000
WREG2	0004h	000000000000000000	IFS5	0092h	00000-00000-
WREG3	0006h	000000000000000000	IFS6	0094h	-0-000000000
WREG4	0008h	00000000000000000	IFS7	0096h	0
WREG5	000Ah	00000000000000000	IEC0	0098h	000000000000000
WREG6	000Ch	000000000000000000	IEC1	009Ah	000000-00000
WREG7	000Eh	00000000000000000	IEC2	009Ch	00-0000-00
WREG8	0010h	00000000000000000	IEC3	009Eh	000-000000-
WREG9	0012h	00000000000000000	IEC4	00A0h	0000
WREG10	0014h	00000000000000000	IEC5	00A2h	00000-00000-
WREG11	0016h	00000000000000000	IEC6	00A4h	-0-000000000
WREG12	0018h	00000000000000000	IEC7	00A6h	0
WREG13	001Ah	00000000000000000	IPC0	00A8h	-100-100-100-100
WREG14	001Ch	00000000000000000	IPC1	00AAh	-100100
WREG15	001Eh	0000100000000000	IPC2	00ACh	-100-100-100-100
SPLIM	0020h	*****	IPC3	00AEh	-100-100-100-100
PCL	002Eh	00000000000000000	IPC4	00B0h	-100-100-100-100
РСН	0030h	00000000	IPC5	00B2h	100100
DSRPAG	0032h	0000000000	IPC6	00B4h	-100100
DSWPAG	0034h	000000000	IPC7	00B6h	-100-100-100-100
RCOUNT	0036h	*****	IPC8	00B8h	100-100
SR	0042h	000000000	IPC9	00BAh	100
CORCON	0044h	01	IPC10	00BCh	-100
DISICNT	0052h	xxxxxxxxxxxxx	IPC11	00BEh	-100-100100
TBLPAG	0054h	00000000	IPC12	00C0h	100-100
Deadman Timer			IPC13	00C2h	100-100
DMTCON	005Ch	000000000000000000	IPC14	00C4h	-100-100
DMTPRECLR	0060h	0000000	IPC15	00C6h	-100-100-100
DMTCLR	0064h	00000000000000000	IPC16	00C8h	-100-100-100-100
DMTSTAT	0068h	000000000000000000	IPC17	00CAh	
DMTCNTL	006Ch	00000000000000000	IPC18	00CCh	100
DMTCNTH	006Eh	00000000000000000	IPC19	00CEh	
DMTHOLDREG	0070h	000000000000000000	IPC20	00D0h	-100-100-100
DMTPSCNTL	0074h	00000000000000000	IPC21	00D2h	-100100-100
DMTPSCNTH	0076h	00000000000000000	IPC22	00D4h	100-100
DMTPSINTVL	0078h	00000000000000000	IPC23	00D6h	-100-100
DMTPSINTVH	007Ah	00000000000000000	IPC24	00D8h	-100-100-100-100
Interrupt Controlle	ər		IPC25	00DAh	100-100
INTCON1	0080h	00000-	IPC26	00DCh	-100-100
INTCON2	0082h	100000000	IPC27	00DEh	100100
INTCON3	0084h	000000000000000000000000000000000000000	IPC28	00E0h	
INTCON4	0086h	00	IPC29	00E2h	100
IFS0	0088h	0000000000000	INTTREG	00E4h	0-0-000000000000000
IFS1	008Ah	000000-0-00000		· ·	
IFS2	008Ch	00-0000-00	71		

TABLE 4-2: SFR MAP: 0000h BLOCK

Note 1: Address values are in hexadecimal.

IABLE 4-3:	SFR WAP	: 0100h BLOCK			
Register	Address ⁽¹⁾	All Resets ⁽²⁾	Register	Address ⁽¹⁾	All Resets ⁽²⁾
Oscillator and	Reset		Timers (Contin	ued)	
OSCCON	0100h	-ddd-ddd00d0000	TMR2	0196h	000000000000000000000000000000000000000
CLKDIV	0102h	0011000000q	TMR3HLD	0198h	000000000000000000000000000000000000000
OSCTUN	0106h	000000000000000000000000000000000000000	TMR3	019Ah	000000000000000000000000000000000000000
OSCDIV	010Ch	-0000000000000000	PR2	019Ch	11111111111111111
OSCFDIV	010Eh	00000000	PR3	019Eh	11111111111111111
RCON	0110h	00100000000011	T2CON	01A0h	0-0xx-0000-0-
HLVD			T3CON	01A2h	0-0xx-0000-
HLVDCON	0114h	0-0-xxxx0000	TMR4	01A4h	000000000000000000000000000000000000000
CRC			TMR5HLD	01A6h	000000000000000000000000000000000000000
CRCCON1	0158h	0-0000001x00	TMR5	01A8h	000000000000000000000000000000000000000
CRCCON2	015Ah	0000000000	PR4	01AAh	111111111111111111
CRCXORL	015Ch	0000000000000000-	PR5	01ACh	11111111111111111
CRCXORH	015Eh	000000000000000000000000000000000000000	T4CON	01AEh	0-0xx-0000-0-
CRCDATL	0160h	*****	T5CON	01B0h	0-0xx-0000-
CRCDATH	0162h	*****	Real-Time Cloc	k and Calendar (RTCC)
CRCWDATL	0164h	*****	RTCCON1L	01CCh	00
CRCWDATH	0166h	*****	RTCCON1H	01CEh	000000000000000
REFO			RTCCON2L	01D0h	10000000000
REFOCONL	0168h	0-000-000000	RTCCON2H	01D2h	0011111111111111
REFOCONH	016Ah	-0000000000000000	RTCCON3L	01D4h	000000000000000000000000000000000000000
PMD			RTCSTATL	01D8h	0-0000
PMD1	0178h	000000000000	TIMEL	01DCh	-000000
PMD2	017Ah		TIMEH	01DEh	000000-0000000
PMD3	017Ch	0-0-00-0-	DATEL	01E0h	000001110
PMD4	017Eh	000-	DATEH	01E2h	000000000001
PMD5	0180h	xxxxx	ALMTIMEL	01E4h	-0000000
PMD6	0182h	0	ALMTIMEH	01E6h	000000-0000000
PMD7	0184h	00	ALMDATEL	01E8h	000001110
PMD8	0186h	00	ALMDATEH	01EAh	000000000001
Timers	<u> </u>		TSATIMEL	01ECh	-0000000
TMR1	0190h	000000000000000000000000000000000000000	TSATIMEH	01EEh	000000-0000000
PR1	0192h	111111111111111111	TSADATEL	01F0h	000000000
T1CON	0194h	0-000-000-00-	TSADATEH	01F2h	000000000000

TABLE 4-3:	SFR MAP: 0100h BLOCK
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Legend: x = unknown or indeterminate value; - = unimplemented bits; q = value set by Configuration bits.

Note 1: Address values are in hexadecimal.

Register	Address ⁽¹⁾	All Resets ⁽²⁾	Register	Address ⁽¹⁾	All Resets ⁽²⁾
Multiple Output	Capture/Compa	re/PWM	Multiple Output C	apture/Compare/	PWM (Continued)
CCP1CON1L	026Ch	000000000000000000000000000000000000000	CCP2RBL	02ACh	000000000000000000000000000000000000000
CCP1CON1H	026Eh	000000000000000000000000000000000000000	CCP2BUFL	02B0h	000000000000000000000000000000000000000
CCP1CON2L	0270h	000000000000000000000000000000000000000	CCP2BUFH	02B2h	000000000000000000000000000000000000000
CCP1CON2H	0272h	00000010000000	CCP3CON1L	02B4h	000000000000000000000000000000000000000
CCP1CON3L	0274h	000000	CCP3CON1H	02B6h	000000000000000000000000000000000000000
CCP1CON3H	0276h	000000000000000000000000000000000000000	CCP3CON2L	02B8h	000000000000000000000000000000000000000
CCP1STATL	0278h	000000000000000000000000000000000000000	CCP3CON2H	02BAh	00000010000000
CCP1TMRL	027Ch	000000000000000000000000000000000000000	CCP3CON3L	02BCh	000000
CCP1TMRH	027Eh	000000000000000000000000000000000000000	CCP3CON3H	02BEh	000000000000000000000000000000000000000
CCP1PRL	0280h	111111111111111111	CCP3STATL	02C0h	000000000000000000000000000000000000000
CCP1PRH	0282h	111111111111111111	CCP3TMRL	02C4h	000000000000000000000000000000000000000
CCP1RAL	0284h	000000000000000000000000000000000000000	CCP3TMRH	02C6h	000000000000000000000000000000000000000
CCP1RBL	0288h	000000000000000000000000000000000000000	CCP3PRL	02C8h	000000000000000000000000000000000000000
CCP1BUFL	028Ch	000000000000000000000000000000000000000	CCP3PRH	02CAh	000000000000000000000000000000000000000
CCP1BUFH	028Eh	000000000000000000000000000000000000000	CCP3RAL	02CCh	000000000000000000000000000000000000000
CCP2CON1L	0290h	000000000000000000000000000000000000000	CCP3RBL	02D0h	000000000000000000000000000000000000000
CCP2CON1H	0292h	000000000000000000000000000000000000000	CCP3BUFL	02D4h	000000000000000000000000000000000000000
CCP2CON2L	0294h	000000000000000000000000000000000000000	CCP3BUFH	02D6h	000000000000000000000000000000000000000
CCP2CON2H	0296h	00000010000000	Comparator		
CCP2CON3L	0298h	000000	CMSTAT	02E6h	0000000
CCP2CON3H	029Ah	000000000000000000000000000000000000000	CVRCON	02E8h	00000000000000000000000000000000000
CCP2STATL	029Ch	000000000000000000000000000000000000000	CM1CON	02EAh	0000000-000
CCP2TMRL	02A0h	000000000000000000000000000000000000000	CM2CON	02ECh	0000000-000
CCP2TMRH	02A2h	000000000000000000000000000000000000000	CM3CON	02EEh	0000000-000
CCP2PRL	02A4h	000000000000000000000000000000000000000	ANCFG	02F4h	000
CCP2PRH	02A6h	000000000000000000000000000000000000000			
CCP2RAL	02A8h	000000000000000000000000000000000000000	1		

TABLE 4-4: SFR MAP: 0200h BLOCK

Legend: x = unknown or indeterminate value; - = unimplemented bits.

Note 1: Address values are in hexadecimal.

Register	Address ⁽¹⁾	All Resets ⁽²⁾	Register	Address ⁽¹⁾	All Resets ⁽²⁾
Multiple Output C	Capture/Compare	/PWM	UART		
CCP4CON1L	0300h	000000000000000000000000000000000000000	U1MODE	0398h	0-000-0000000000
CCP4CON1H	0302h	000000000000000000000000000000000000000	U1STA	039Ah	000000100010000
CCP4CON2L	0304h	000000000000000000000000000000000000000	U1TXREG	039Ch	xxxxxxxxxx
CCP4CON2H	0306h	00000010000000	U1RXREG	039Eh	000000000
CCP4CON3L	0308h	000000	U1BRG	03A0h	000000000000000000000000000000000000000
CCP4CON3H	030Ah	000000000000000000000000000000000000000	U1ADMD	03A2h	000000000000000000000000000000000000000
CCP4STATL	030Ch	000000000000000000000000000000000000000	U2MODE	03AEh	0-000-0000000000
CCP4TMRL	0310h	000000000000000000000000000000000000000	U2STA	03B0h	000000100010000
CCP4TMRH	0312h	000000000000000000000000000000000000000	U2TXREG	03B2h	xxxxxxxxxx
CCP4PRL	0314h	000000000000000000000000000000000000000	U2RXREG	03B4h	000000000
CCP4PRH	0316h	000000000000000000000000000000000000000	U2BRG	03B6h	000000000000000000000000000000000000000
CCP4RAL	0318h	000000000000000000000000000000000000000	U2ADMD	03B8h	000000000000000000000000000000000000000
CCP4RBL	031Ch	000000000000000000000000000000000000000	U3MODE	03C4h	0-000-0000000000
CCP4BUFL	0320h	000000000000000000000000000000000000000	U3STA	03C6h	000000100010000
CCP4BUFH	0322h	000000000000000000000000000000000000000	U3TXREG	03C8h	xxxxxxxxxx
CCP5CON1L	0324h	000000000000000000000000000000000000000	U3RXREG	03CAh	000000000
CCP5CON1H	0326h	000000000000000000	U3BRG	03CCh	000000000000000000000000000000000000000
CCP5CON2L	0328h	000000000000000000	U3ADMD	03CEh	000000000000000000000000000000000000000
CCP5CON2H	032Ah	00000010000000	U4MODE	03D0h	0-000-0000000000
CCP5CON3L	032Ch	000000	U4STA	03D2h	000000100010000
CCP5CON3H	032Eh	000000000000000000	U4TXREG	03D4h	xxxxxxxxxx
CCP5STATL	0330h	000000000000000000	U4RXREG	03D6h	0000000000
CCP5TMRL	0334h	000000000000000000000000000000000000000	U4BRG	03D8h	000000000000000000000000000000000000000
CCP5TMRH	0336h	000000000000000000	U4ADMD	03DAh	000000000000000000000000000000000000000
CCP5PRL	0338h	000000000000000000	SPI		
CCP5PRH	033Ah	000000000000000000	SPI1CON1L	03F4h	0-000000000000000
CCP5RAL	033Ch	000000000000000000	SPI1CON1H	03F6h	000000000000000000000000000000000000000
CCP5RBL	0340h	000000000000000000	SPI1CON2L	03F8h	00000
CCP5BUFL	0344h	000000000000000000	SPI1STATL	03FCh	000001-1-00
CCP5BUFH	0346h	00000000000000000	SPI1STATH	03FEh	000000000000

TABLE 4-5: SFR MAP: 0300h BLOCK

Legend: x = unknown or indeterminate value; - = unimplemented bits.

Note 1: Address values are in hexadecimal.

Register	Address ⁽¹⁾	All Resets ⁽²⁾	Register	Address ⁽¹⁾	All Resets ⁽²⁾
SPI (Continued)			I ² C (Continued)	I	
SPI1BUFL	0400h	000000000000000000000000000000000000000	I2C1CONL	049Ah	0-01000000000000
SPI1BUFH	0402h	000000000000000000	I2C1CONH	049Ch	0000000
SPI1BRGL	0404h	xxxxxxxxxxxxx	I2C1STAT	049Eh	00000000000000
SPI1IMSKL	0408h	000000-0-00	I2C1ADD	04A0h	0000000000
SPI1IMSKH	040Ah	0-000000-000000	I2C1MSK	04A2h	0000000000
SPI1URDTL	040Ch	000000000000000000000000000000000000000	I2C2RCV	04A4h	00000000
SPI1URDTH	040Eh	000000000000000000	I2C2TRN	04A6h	111111111
SPI2CON1L	0410h	0-000000000000000	I2C2BRG	04A8h	000000000000000000000000000000000000000
SPI2CON1H	0412h	000000000000000000000000000000000000000	I2C2CONL	04AAh	0-01000000000000
SPI2CON2L	0414h	00000	I2C2CONH	04ACh	0000000
SPI2STATL	0418h	000001-1-00	I2C2STAT	04AEh	00000000000000
SPI2STATH	041Ah	000000000000	I2C2ADD	04B0h	0000000000
SPI2BUFL	041Ch	000000000000000000	I2C2MSK	04B2h	0000000000
SPI2BUFH	041Eh	000000000000000000	DMA	1	
SPI2BRGL	0420h	xxxxxxxxxxxxx	DMACON	04C4h	00
SPI2IMSKL	0424h	000000-0-00	DMABUF	04C6h	000000000000000000000000000000000000000
SPI2IMSKH	0426h	0-000000-000000	DMAL	04C8h	000000000000000000000000000000000000000
SPI2URDTL	0428h	000000000000000000000000000000000000000	DMAH	04CAh	000000000000000000000000000000000000000
SPI2URDTH	042Ah	000000000000000000000000000000000000000	DMACH0	04CCh	0-00000000000
Configurable Log	ic Cell (CLC)		DMAINT0	04CEh	0000000000000000
CLC1CONL	0464h	000000000	DMASRC0	04D0h	000000000000000000000000000000000000000
CLC1CONH	0466h	0000	DMADST0	04D2h	000000000000000000000000000000000000000
CLC1SEL	0468h	-000-000-000-000	DMACNT0	04D4h	000000000000000000000000000000000000000
CLC1GLSL	046Ch	000000000000000000000000000000000000000	DMACH1	04D6h	0-00000000000
CLC1GLSH	046Eh	000000000000000000000000000000000000000	DMAINT1	04D8h	0000000000000000
CLC2CONL	0470h	000000000	DMASRC1	04DAh	000000000000000000000000000000000000000
CLC2CONH	0472h	0000	DMADST1	04DCh	000000000000000000000000000000000000000
CLC2SELL	0474h	-000-000-000-000	DMACNT1	04DEh	000000000000000000000000000000000000000
CLC2GLSL	0478h	000000000000000000	DMACH2	04E0h	0-00000000000
CLC2GLSH	047Ah	000000000000000000000000000000000000000	DMAINT2	04E2h	0000000000000000
CLC3CONL	047Ch	000000000	DMASRC2	04E4h	000000000000000000000000000000000000000
CLC3CONH	047Eh	0000	DMADST2	04E6h	000000000000000000000000000000000000000
CLC3SELL	0480h	-000-000-000-000	DMACNT2	04E8h	000000000000000000000000000000000000000
CLC3GLSL	0484h	000000000000000000000000000000000000000	DMACH3	04EAh	0-00000000000
CLC3GLSH	0486h	000000000000000000000000000000000000000	DMAINT3	04ECh	0000000000000000
CLC4CONL	0488h	000000000	DMASRC3	04EEh	000000000000000000000000000000000000000
CLC4CONH	048Ah	0000	DMADST3	04F0h	000000000000000000000000000000000000000
CLC4SELL	048Ch	-000-000-000-000	DMACNT3	04F2h	000000000000000000000000000000000000000
CLC4GLSL	0490h	000000000000000000000000000000000000000	DMACH4	04F4h	0-00000000000
CLC4GLSH	0492h	000000000000000000000000000000000000000	DMAINT4	04F6h	000000000000000000
I ² C			DMASRC4	04F8h	000000000000000000000000000000000000000
I2C1RCV	0494h	00000000	DMADST4	04FAh	000000000000000000000000000000000000000
12C1TRN	0496h	11111111	DMACNT4	04FCh	000000000000000000000000000000000000000
I2C1BRG	0498h	000000000000000000000000000000000000000	DMACH5	04FEh	0-000000000000

TABLE 4-6: SFR MAP: 0400h BLOCK

Legend: x = unknown or indeterminate value; - = unimplemented bits.

Note 1: Address values are in hexadecimal.

Register	Address ⁽¹⁾	All Resets ⁽²⁾	Register	Address ⁽¹⁾	All Resets ⁽²⁾
DMA (Continued)		LCD (Continued)		
DMAINT5	0500h	0000000000000000	LCDSE2	058Ah	*****
DMASRC5	0502h	000000000000000000	LCDSE3	058Ch	*****
DMADST5	0504h	000000000000000000	LCDREG	058Eh	000
DMACNT5	0506h	000000000000000000000000000000000000000	LCDACTRL	0590h	000000000000000000000000000000000000000
LCD	I		LCDASTAT	0592h	000000000000000000000000000000000000000
LCDCON	0540h	00000000000000000	LCDFC0	0594h	000000000000000000000000000000000000000
LCDREF	0542h	00000000000000000	LCDFC1	0596h	000000000000000000000000000000000000000
LCDPS	0544h	00000000000000000	LCDFC2	0598h	000000000000000000000000000000000000000
LCDDATA0	0546h	*****	LCDTEVNT	059Ah	000000000000000000000000000000000000000
LCDDATA1	0548h	*****	LCDSDATA0	059Ch	*****
LCDDATA2	054Ah	*****	LCDSDATA1	059Eh	*****
LCDDATA3	054Ch	*****	LCDSDATA2	05A0h	*****
LCDDATA4	054Eh	*****	LCDSDATA3	05A2h	*****
LCDDATA5	0550h	*****	LCDSDATA4	05A4h	*****
LCDDATA6	0552h	*****	LCDSDATA5	05A6h	*****
LCDDATA7	0554h	*****	LCDSDATA6	05A8h	*****
LCDDATA8	0556h	*****	LCDSDATA7	05AAh	*****
LCDDATA9	0558h	*****	LCDSDATA8	05ACh	*****
LCDDATA10	055Ah	*****	LCDSDATA9	05AEh	*****
LCDDATA11	055Ch	*****	LCDSDATA10	05B0h	*****
LCDDATA12	055Eh	*****	LCDSDATA11	05B2h	*****
LCDDATA13	0560h	*****	LCDSDATA12	05B4h	*****
LCDDATA14	0562h	*****	LCDSDATA13	05B6h	*****
LCDDATA15	0564h	*****	LCDSDATA14	05B8h	*****
LCDDATA16	0566h	*****	LCDSDATA15	05BAh	*****
LCDDATA17	0568h	*****	LCDSDATA16	05BCh	*****
LCDDATA18	056Ah	*****	LCDSDATA17	05BEh	*****
LCDDATA19	056Ch	*****	LCDSDATA18	05C0h	*****
LCDDATA20	056Eh	*****	LCDSDATA19	05C2h	*****
LCDDATA21	0570h	*****	LCDSDATA20	05C4h	*****
LCDDATA22	0572h	*****	LCDSDATA21	05C6h	*****
LCDDATA23	0574h	*****	LCDSDATA22	05C8h	*****
LCDDATA24	0576h	*****	LCDSDATA23	05CAh	*****
LCDDATA25	0578h	*****	LCDSDATA24	05CCh	*****
LCDDATA26	057Ah	*****	LCDSDATA25	05CEh	*****
LCDDATA27	057Ch	*****	LCDSDATA26	05D0h	*****
LCDDATA28	057Eh	******	LCDSDATA27	05D2h	******
LCDDATA29	0580h	XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX	LCDSDATA28	05D4h	*******
LCDDATA30	0582h	******	LCDSDATA29	05D6h	*******
LCDDATA31	0582h	******	LCDSDATA30	05D8h	*******
LCDSE0	0586h	*****	LCDSDATA31	05D0h	******
LCDSE1	0588h	*****		UUDAII	^^^^^

TABLE 4-7: SFR MAP: 0500h BLOCK

Legend: x = unknown or indeterminate value; - = unimplemented bits.

Note 1: Address values are in hexadecimal.

Register	Address ⁽¹⁾	All Resets ⁽²⁾	Register	Address ⁽¹⁾	All Resets ⁽²⁾
I/O			ODCD	06A2h	000000000000
PADCON	065Ch	0	ANSELD	06A4h	1111
IOCSTAT	065Eh	000000	IOCPD	06A6h	000000000000
PORTA			IOCND	06A8h	000000000000
TRISA	0660h	1	IOCFD	06AAh	000000000000
PORTA	0662h	0	IOCPUD	06ACh	0000000000000
LATA	0664h	0	IOCPDD	06AEh	0000000000000
ODCA	0666h	0	PORTE		
ANSELA	0668h	1	TRISE	06B0h	111111111
IOCPA	066Ah	0	PORTE	06B2h	00000000
IOCNA	066Ch	0	LATE	06B4h	00000000
IOCFA	066Eh	0	ODCE	06B6h	00000000
IOCPUA	0670h	0	ANSELE	06B8h	1111-
IOCPDA	0672h	0	IOCPE	06BAh	00000000
PORTB	· · ·		IOCNE	06BCh	00000000
TRISB	0674h	11111111111111111	IOCFE	06BEh	00000000
PORTB	0676h	00000000000000000	IOCPUE	06C0h	00000000
LATB	0678h	00000000000000000	IOCPDE	06C2h	00000000
ODCB	067Ah	00000000000000000	PORTF	•	
ANSELB	067Ch	111111111111111111	TRISF	06C4h	11111111
IOCPB	067Eh	00000000000000000	PORTF	06C6h	0000000
IOCNB	0680h	00000000000000000	LATF	06C8h	0000000
IOCFB	0682h	00000000000000000	ODCF	06CAh	0000000
IOCPUB	0684h	00000000000000000	ANSELF	06CCH	
IOCPDB	0686h	00000000000000000	IOCPF	06CEh	0000000
PORTC			IOCNF	06D0h	0000000
TRISC	0688h	1111	IOCFF	06D2h	0000000
PORTC	068Ah	0000	IOCPUF	06D4h	0000000
LATC	068Ch	0000	IOCPDF	06D6h	0000000
ODCC	068Eh	0000	PORTG		
ANSELC	0690h	1111	TRISG	06D8h	111111
IOCPC	0692h	0000	PORTG	06DAh	000000
IOCNC	0694h	0000	LATG	06DCh	000000
IOCFC	0696h	0000	ODCG	06DEh	000000
IOCPUC	0698h	0000	ANSELG	06E0h	1111
IOCPDC	069Ah	0000	IOCPG	06E2h	000000
PORTD			IOCNG	06E4h	000000
TRISD	069Ch	1111111111111	IOCFG	06E6h	000000
PORTD	069Eh	000000000000	IOCPUF	06E8h	000000
LATD	06A0h	0000000000000	IOCPDG	06EAh	000000

TABLE 4-8: SFR MAP: 0600h BLOCK

Legend: x = unknown or indeterminate value; - = unimplemented bits.

Note 1: Address values are in hexadecimal.

TABLE 4-9:	SFR MAP: U	700h BLOCK				
Register	Address ⁽¹⁾	All Resets ⁽²⁾	Register	Address ⁽¹⁾	All Resets ⁽²⁾	
ADC			Peripheral Pin Se	lect (PPS)		
ADC1BUF0	0700h	*****	RPINR0	0790h	111111	
ADC1BUF1	0702h	*****	RPINR1	0792h	111111111111	
ADC1BUF2	0704h	*****	RPINR2	0794h	111111	
ADC1BUF3	0706h	*****	RPINR3	0796h	xxxxx111111	
ADC1BUF4	0708h	*****	RPINR4	0798h	111111111111	
ADC1BUF5	070Ah	*****	RPINR5	079Ah	111111111111	
ADC1BUF6	070Ch	*****	RPINR6	079Ch	111111111111	
ADC1BUF7	070Eh	*****	RPINR11	07A6h	111111111111	
ADC1BUF8	0710h	*****	RPINR12	07A8h	111111111111	
ADC1BUF9	0712h	*****	RPINR13	07AAh	111111111111	
ADC1BUF10	0714h	*****	RPINR14	07ACh	1111111	
ADC1BUF11	0716h	*****	RPINR17	07B2h	111111	
ADC1BUF12	0718h	*****	RPINR18	07B4h	111111111111	
ADC1BUF13	071Ah	*****	RPINR19	07B6h	111111111111	
ADC1BUF14	071Ch	*****	RPINR20	07B8h	111111111111	
ADC1BUF15	071Eh	*****	RPINR21	07BAh	111111111111	
ADC1BUF16	0720h	*****	RPINR22	07BCh	111111111111	
AD1CON1	0734h	0-000000000000000	RPINR23	07BEh	111111111111	
AD1CON2	0736h	00000000000000	RPINR25	07C2h	111111111111	
AD1CON3	0738h	000000000000000000	RPINR26	07C4h	111111111111	
AD1CHS	073Ah	000000000000000000	RPINR27	07C6h	111111111111	
AD1CSSH	073Ch	-000	RPOR0	07D4h	-000000-0000000	
AD1CSSL	073Eh	000000000000000000	RPOR1	07D6h	-000000-0000000	
AD1CON4	0740h	000	RPOR2	07D8h	-000000-0000000	
AD1CON5	0742h	0000000000	RPOR3	07DAh	-000000-0000000	
AD1CHITH	0744h	000000000000000000	RPOR4	07DCh	-000000-000000	
AD1CHITL	0746h	00000000000000000	RPOR5	07DEh	-000000-0000000	
AD1RESDMA	074Ch	*****	RPOR6	07E0h	-000000-0000000	
NVM			RPOR7	07E2h	-000000-0000000	
NVMCON	0760h	0000000000	RPOR8	07E4h	-000000-0000000	
NVMADR	0762h	000000000000000000	RPOR9	07E6h	-000000-0000000	
NVMADRU	0764h	00000000	RPOR10	07E8h	-000000-0000000	
NVMKEY	0766h	00000000	RPOR11	07EAh	-000000-0000000	
ECC	·		RPOR12	07ECh	-000000-0000000	
ECCCONL	076Ch	000000000000000000	RPOR13	07EEh	-000000-000000	
ECCCONH	076Eh	000000000000000000	RPOR14	07F0h	-000000-0000000	
ECCADDRL	0770h	000000000000000000	RPOR15	07F2h	-000000-0000000	
ECCADDRH	0772h	000000000000000000				
ECCSTATL	0774h	000000000000000000				
ECCSTATH	0776h	000000000000000000				

TABLE 4-9: SFR MAP: 0700h BLOCK

Legend: x = unknown or indeterminate value; - = unimplemented bits.

Note 1: Address values are in hexadecimal.

4.2.5 EXTENDED DATA SPACE (EDS)

The Extended Data Space (EDS) allows PIC24F devices to address a much larger range of data than would otherwise be possible with a 16-bit address range.

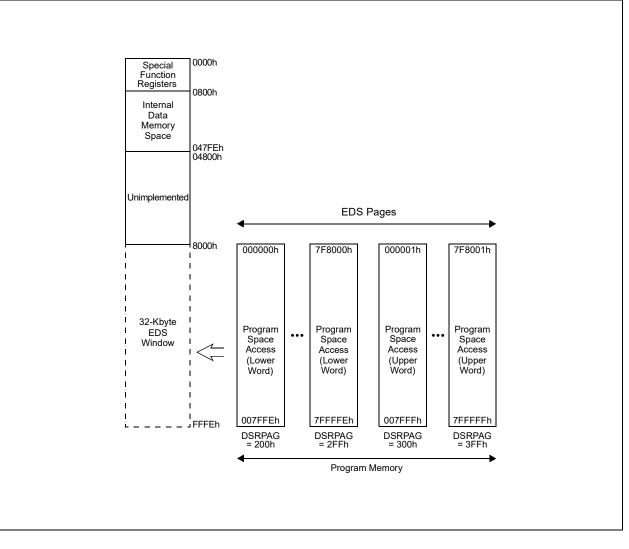
EDS allows read access to the program memory space. This feature is called Program Space Visibility (PSV) and is discussed in detail in Section 4.3.3 "Reading Data from Program Memory Using EDS".

Figure 4-3 displays the entire EDS space. The EDS is organized as pages, called EDS pages, with one page equal to the size of the EDS window (32 Kbytes). A



particular EDS page is selected through the Data Space Read Page register (DSRPAG) or the Data Space Write Page register (DSWPAG). For PSV, only the DSRPAG register is used. The combination of the DSRPAG register value and the 16-bit wide data address forms a 24-bit Effective Address (EA).

Note: Accessing Page 0 in the EDS window will generate an address error trap as Page 0 is the base data memory (data locations, 0800h to 7FFFh, in the lower Data Space).



4.2.6 SOFTWARE STACK

Apart from its use as a Working register, the W15 register in PIC24F devices is also used as a Software Stack Pointer (SSP). The pointer always points to the first available free word and grows from lower to higher addresses. It pre-decrements for stack pops and post-increments for stack pushes, as shown in Figure 4-4. Note that for a PC push during any CALL instruction, the MSB of the PC is zero-extended before the push, ensuring that the MSB is always clear.

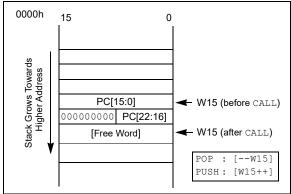
Note:	A PC push during exception processing
	will concatenate the SRL register to the
	MSB of the PC prior to the push.

The Stack Pointer Limit Value register (SPLIM), associated with the Stack Pointer, sets an upper address boundary for the stack. SPLIM is uninitialized at Reset. As is the case for the Stack Pointer, SPLIM[0] is forced to '0' as all stack operations must be word-aligned. Whenever an EA is generated using W15 as a source or destination pointer, the resulting address is compared with the value in SPLIM. If the contents of the Stack Pointer (W15) and the SPLIM register are equal, and a push operation is performed, a stack error trap will not occur. The stack error trap will occur on a subsequent push operation. Thus, for example, if it is desirable to cause a stack error trap when the stack grows beyond address 2000h in RAM, initialize the SPLIM with the value, 1FFEh.

Similarly, a Stack Pointer underflow (stack error) trap is generated when the Stack Pointer address is found to be less than 0800h. This prevents the stack from interfering with the SFR space.

A write to the SPLIM register should not be immediately followed by an indirect read operation using W15.

FIGURE 4-4: CALL STACK FRAME



4.3 Interfacing Program and Data Memory Spaces

The PIC24F architecture uses a 24-bit wide program space and 16-bit wide Data Space. The architecture is also a modified Harvard scheme, meaning that data can also be present in the program space. To use these data successfully, they must be accessed in a way that preserves the alignment of information in both spaces.

Aside from normal execution, the PIC24F architecture provides two methods by which program space can be accessed during operation:

- Using table instructions to access individual bytes or words anywhere in the program space
- Remapping a portion of the program space into the Data Space (Program Space Visibility)

Table instructions allow an application to read or write to small areas of the program memory. This makes the method ideal for accessing data tables that need to be updated from time to time. It also allows access to all bytes of the program word. The remapping method allows an application to access a large block of data on a read-only basis, which is ideal for look-ups from a large table of static data. It can only access the least significant word of the program word.

4.3.1 ADDRESSING PROGRAM SPACE

Since the address ranges for the data and program spaces are 16 and 24 bits, respectively, a method is needed to create a 23-bit or 24-bit program address from 16-bit data registers. The solution depends on the interface method to be used.

For table operations, the 8-bit Table Memory Page Address register (TBLPAG) is used to define a 32K word region within the program space. This is concatenated with a 16-bit EA to arrive at a full 24-bit program space address. In this format, the MSBs of TBLPAG are used to determine if the operation occurs in the user memory (TBLPAG[7] = 0) or the configuration memory (TBLPAG[7] = 1).

For remapping operations, the 10-bit Extended Data Space Read register (DSRPAG) is used to define a 16K word page in the program space. When the Most Significant bit (MSb) of the EA is '1', and the MSb (bit 9) of DSRPAG is '1', the lower 8 bits of DSRPAG are concatenated with the lower 15 bits of the EA to form a 23-bit program space address. The DSRPAG[8] bit decides whether the lower word (when the bit is '0') or the higher word (when the bit is '1') of program memory is mapped. Unlike table operations, this strictly limits remapping operations to the user memory area.

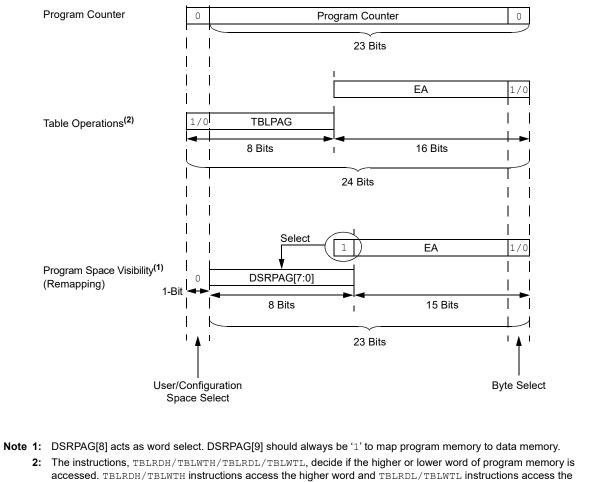
Table 4-10 and Figure 4-5 show how the program EA is created for table operations and remapping accesses from the data EA. Here, P[23:0] refers to a program space word, whereas D[15:0] refers to a Data Space word.

	Access	Program Space Address					
Access Type	Space	[23]	[22:16]	[15]	[14:1]	[0]	
Instruction Access	User	0		PC[22:1] 0 xxxx xxxx xxx0			
(Code Execution)			0xx xxxx x				
TBLRD/TBLWT	User	TBLPAG[7:0]		Data EA[15:0]			
(Byte/Word Read/Write)		0xxx xxxx		XXXX XXXX XXXX XXXX		XXX	
	Configuration	TBLPAG[7:0]		Data EA[15:0]			
		1:	XXX XXXX	XXXX XXXX XXXX XXXX			
Program Space Visibility	User	0 DSRPA		AG[7:0] ⁽²⁾ Data EA[14:0] ⁽¹⁾		:0] ⁽¹⁾	
(Block Remap/Read)		0	XXXX XXX	XX	XXX XXXX XXX	XX XXXX	

Note 1: Data EA[15] is always '1' in this case, but is not used in calculating the program space address. Bit 15 of the address is DSRPAG[0].

2: DSRPAG[9] is always '1' in this case. DSRPAG[8] decides whether the lower word or higher word of program memory is read. When DSRPAG[8] is '0', the lower word is read, and when it is '1', the higher word is read.

FIGURE 4-5: DATA ACCESS FROM PROGRAM SPACE ADDRESS GENERATION



lower word. Table Read operations are permitted in the configuration memory space.

4.3.2 DATA ACCESS FROM PROGRAM MEMORY USING TABLE INSTRUCTIONS

The TBLRDL and TBLWTL instructions offer a direct method of reading or writing the lower word of any address within the program space without going through Data Space. The TBLRDH and TBLWTH instructions are the only method to read or write the upper eight bits of a program space word as data.

The PC is incremented by two for each successive 24-bit program word. This allows program memory addresses to directly map to Data Space addresses. Program memory can thus be regarded as two, 16-bit word-wide address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space which contains the least significant data word, and TBLRDH and TBLWTH access the space which contains the upper data byte.

Two table instructions are provided to move byte or word-sized (16-bit) data to and from program space. Both function as either byte or word operations.

 TBLRDL (Table Read Low): In Word mode, it maps the lower word of the program space location (P[15:0]) to a data address (D[15:0]). In Byte mode, either the upper or lower byte of the lower program word is mapped to the lower byte of a data address. The upper byte is selected when byte select is '1'; the lower byte is selected when it is '0'. TBLRDH (Table Read High): In Word mode, it maps the entire upper word of a program address (P[23:16]) to a data address. Note that D[15:8], the 'phantom' byte, will always be '0'.

In Byte mode, it maps the upper or lower byte of the program word to D[7:0] of the data address, as above. Note that the data will always be '0' when the upper 'phantom' byte is selected (byte select = 1).

In a similar fashion, two table instructions, TBLWTH and TBLWTL, are used to write individual bytes or words to a program space address. The details of their operation are described in Section 6.0 "Flash Program Memory".

For all table operations, the area of program memory space to be accessed is determined by the Table Memory Page Address (TBLPAG) register. TBLPAG covers the entire program memory space of the device, including user and configuration spaces. When TBLPAG[7] = 0, the table page is located in the user memory space. When TBLPAG[7] = 1, the page is located in configuration space.

Note: Only Table Read operations will execute in the configuration memory space where Device IDs are located. Table Write operations are not allowed.

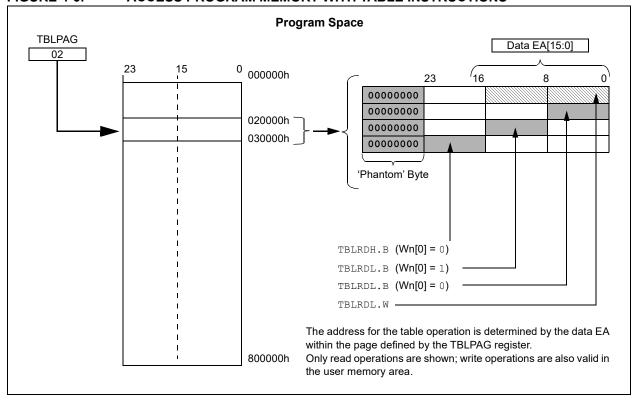


FIGURE 4-6: ACCESS PROGRAM MEMORY WITH TABLE INSTRUCTIONS

4.3.3 READING DATA FROM PROGRAM MEMORY USING EDS

The upper 32 Kbytes of Data Space may optionally be mapped into any 16K word page of the program space. This provides transparent access of stored constant data from the Data Space without the need to use special instructions (i.e., TBLRDL/H).

Program space access through the Data Space occurs when the MSb of EA is '1' and the DSRPAG[9] bit is also '1'. The lower eight bits of DSRPAG are concatenated to the Wn[14:0] bits to form a 23-bit EA to access program memory. The DSRPAG[8] decides which word should be addressed; when the bit is '0', the lower word, and when '1', the upper word of the program memory is accessed.

The entire program memory is divided into 512 EDS pages, from 200h to 3FFh, each consisting of 16K words of data. Pages, 200h to 2FFh, correspond to the lower words of the program memory, while 300h to 3FFh correspond to the upper words of the program memory.

Using this EDS technique, the entire program memory can be accessed. Previously, the access to the upper word of the program memory was not supported. Table 4-11 provides the corresponding 23-bit EDS address for program memory with EDS page and source addresses.

For operations that use PSV and are executed outside a REPEAT loop, the MOV and MOV. D instructions will require one instruction cycle in addition to the specified execution time. All other instructions will require two instruction cycles in addition to the specified execution time.

For operations that use PSV, which are executed inside a REPEAT loop, there will be some instances that require two instruction cycles in addition to the specified execution time of the instruction:

- · Execution in the first iteration
- · Execution in the last iteration
- Execution prior to exiting the loop due to an interrupt
- Execution upon re-entering the loop after an interrupt is serviced

Any other iteration of the REPEAT loop will allow the instruction accessing data, using PSV, to execute in a single cycle.

DSRPAG (Data Space Read Register)	Source Address while Indirect Addressing	23-Bit EA Pointing to EDS	Comment
200h		000000h to 007FFEh	Lower words of 4M program
•		•	instructions (8 Mbytes) for
•		•	read operations only.
•		•	
2FFh		7F8000h to 7FFFFEh	
300h	8000h to FFFFh	000001h to 007FFFh	Upper words of 4M program
•		•	instructions (4 Mbytes remaining;
•		•	4 Mbytes are phantom bytes) for
•		•	read operations only.
3FFh		7F8001h to 7FFFFFh	
000h		Invalid Address	Address error trap. ⁽¹⁾

TABLE 4-11: EDS PROGRAM ADDRESS WITH DIFFERENT PAGES AND ADDRESSES

Note 1: When the source/destination address is above 8000h and DSRPAG/DSWPAG is '0', an address error trap will occur.

EXAMPLE 4-1: EDS READ CODE FROM PROGRAM MEMORY IN ASSEMBLY

```
; Set the EDS page from where the data to be read
   mov #0x0202, w0
          w0, DSRPAG
                                        ;page 0x202, consisting lower words, is selected for read
   mov
   mov #0x000A, w1
                                       ;select the location (0x0A) to be read
                                        ;set the MSB of the base address, enable EDS mode
   bset w1, #15
;Read a byte from the selected location

        mov.b
        [w1++], w2
        ; read Low byte

        mov.b
        [w1++], w3
        ; read High byte

                                        ;read High byte
;Read a word from the selected location
   mov [w1], w2
;Read Double - word from the selected location
                                         ;two word read, stored in w2 and w3
   mov.d [w1], w2
```



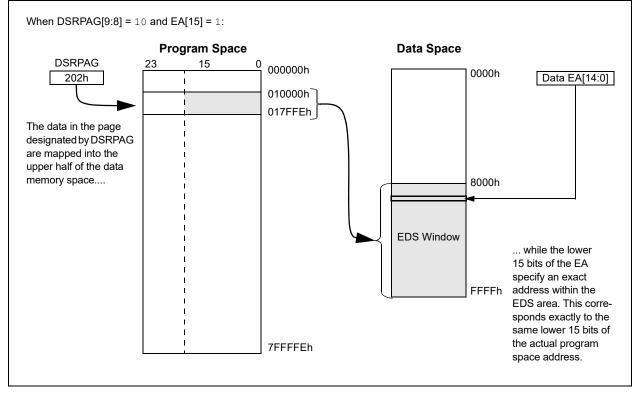
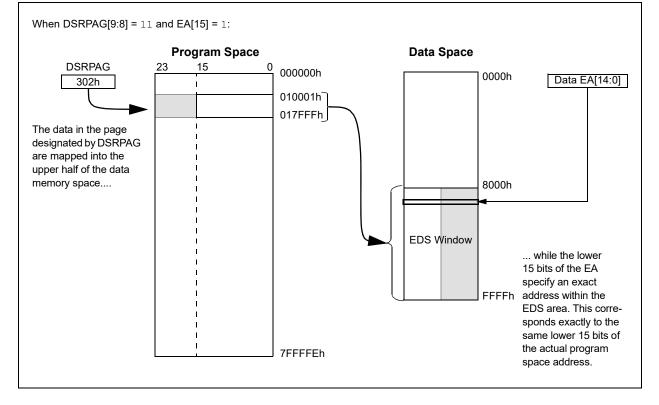


FIGURE 4-8: PROGRAM SPACE VISIBILITY OPERATION TO ACCESS UPPER WORD



NOTES:

5.0 DIRECT MEMORY ACCESS CONTROLLER (DMA)

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to "Direct Memory Access Controller (DMA)" (www.microchip.com/DS30009742) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The Direct Memory Access (DMA) Controller is designed to service high throughput data peripherals operating on the SFR bus, allowing them to access data memory directly and alleviating the need for CPU-intensive management. By allowing these data-intensive peripherals to share their own data path, the main data bus is also deloaded, resulting in additional power savings.

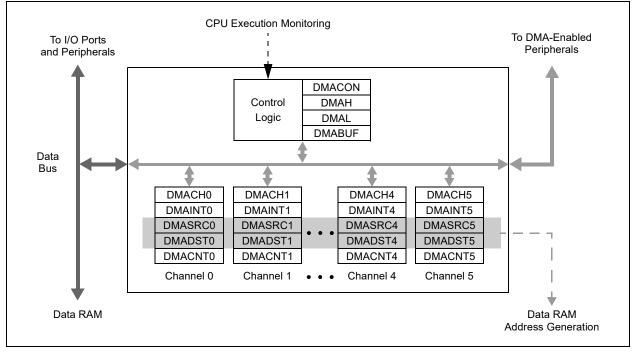
The DMA Controller functions both as a peripheral and a direct extension of the CPU. It is located on the microcontroller data bus, between the CPU and DMA-enabled peripherals, with direct access to SRAM. This partitions the SFR bus into two buses, allowing the DMA Controller access to the DMA-capable peripherals located on the new DMA SFR bus. The controller serves as a Master device on the DMA SFR bus, controlling data flow from DMA-capable peripherals. The controller also monitors CPU instruction processing directly, allowing it to be aware of when the CPU requires access to peripherals on the DMA bus and automatically relinquishing control to the CPU as needed. This increases the effective bandwidth for handling data without DMA operations causing a processor Stall. This makes the controller essentially transparent to the user.

The DMA Controller has these features:

- Six Independent and Independently
 Programmable Channels
- Concurrent Operation with the CPU (no DMA caused Wait states)
- DMA Bus Arbitration
- Five Programmable Address modes
- Four Programmable Transfer modes
- Four Flexible Internal Data Transfer modes
- · Byte or Word Support for Data Transfer
- 16-Bit Source and Destination Address Register for Each Channel, Dynamically Updated and Reloadable
- 16-Bit Transaction Count Register, Dynamically Updated and Reloadable
- Upper and Lower Address Limit Registers
- Counter Half-Full Level Interrupt
- Software Triggered Transfer
- Null Write mode for Symmetric Buffer Operations

A simplified block diagram of the DMA Controller is shown in Figure 5-1.

FIGURE 5-1: DMA FUNCTIONAL BLOCK DIAGRAM



5.1 Summary of DMA Operations

The DMA Controller is capable of moving data between addresses according to a number of different parameters. Each of these parameters can be independently configured for any transaction; in addition, any or all of the DMA channels can independently perform a different transaction at the same time. Transactions are classified by these parameters:

- Source and destination (SFRs and data RAM)
- · Data size (byte or word)
- Trigger source
- Transfer mode (One-Shot, Repeated or Continuous)
- Addressing modes (Fixed Address or Address Blocks, with or without Address Increment/ Decrement)

In addition, the DMA Controller provides channel priority arbitration for all channels.

5.1.1 SOURCE AND DESTINATION

Using the DMA Controller, data may be moved between any two addresses in the Data Space. The SFR space (0000h to 07FFh), or the data RAM space (0800h to FFFFh), can serve as either the source or the destination. Data can be moved between these areas in either direction or between addresses in either area. The four different combinations are shown in Figure 5-2.

If it is necessary to protect areas of data RAM, the DMA Controller allows the user to set upper and lower address boundaries for operations in the Data Space above the SFR space. The boundaries are set by the DMAH and DMAL Limit registers. If a DMA channel attempts an operation outside of the address boundaries, the transaction is terminated and an interrupt is generated.

5.1.2 DATA SIZE

The DMA Controller can handle both 8-bit and 16-bit transactions. Size is user-selectable using the SIZE bit (DMACHn[1]). By default, each channel is configured for word-sized transactions. When byte-sized transactions are chosen, the LSb of the source and/or destination address determines if the data represent the upper or lower byte of the data RAM location.

5.1.3 TRIGGER SOURCE

The DMA Controller can use any one of the device's interrupt sources to initiate a transaction. The DMA trigger sources are listed in reverse order of their natural interrupt priority and are shown in Table 5-1.

Since the source and destination addresses for any transaction can be programmed independently of the trigger source, the DMA Controller can use any trigger to perform an operation on any peripheral. This also allows DMA channels to be cascaded to perform more complex transfer operations.

5.1.4 TRANSFER MODE

The DMA Controller supports four types of data transfers, based on the volume of data to be moved for each trigger.

- One-Shot: A single transaction occurs for each trigger.
- Continuous: A series of back-to-back transactions occur for each trigger; the number of transactions is determined by the DMACNTn transaction counter.
- Repeated One-Shot: A single transaction is performed repeatedly, once per trigger, until the DMA channel is disabled.
- Repeated Continuous: A series of transactions are performed repeatedly, one cycle per trigger, until the DMA channel is disabled.

All transfer modes allow the option to have the source and destination addresses, and counter value, automatically reloaded after the completion of a transaction. Repeated mode transfers do this automatically.

5.1.5 ADDRESSING MODES

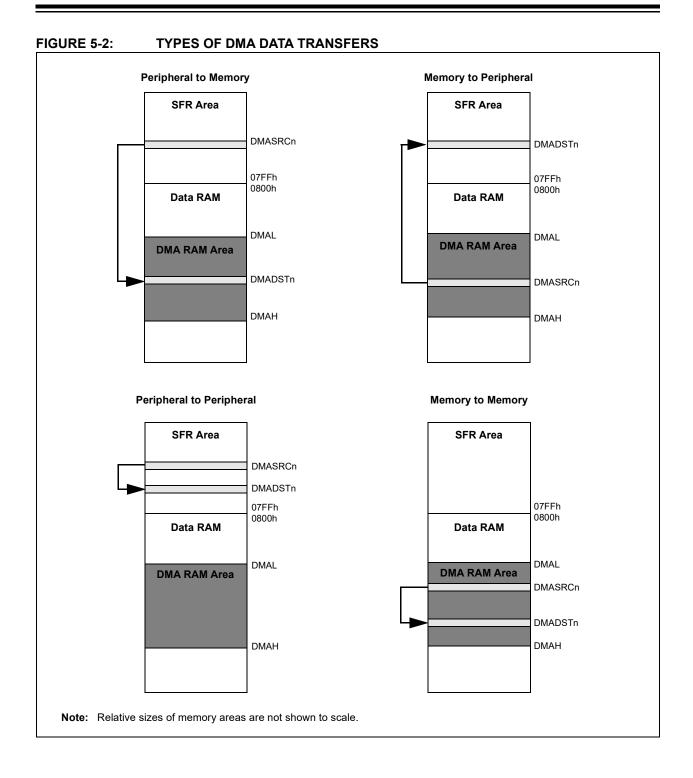
The DMA Controller also supports transfers between single addresses or address ranges. The four basic options are:

- Fixed-to-Fixed: Between two constant addresses
- Fixed-to-Block: From a constant source address to a range of destination addresses
- Block-to-Fixed: From a range of source addresses to a single, constant destination address
- Block-to-Block: From a range of source addresses to a range of destination addresses

The option to select auto-increment or auto-decrement of source and/or destination addresses is available for Block Addressing modes.

In addition to the four basic modes, the DMA Controller also supports Peripheral Indirect Addressing (PIA) mode, where the source or destination address is generated jointly by the DMA Controller and a PIA-capable peripheral. When enabled, the DMA channel provides a base source and/or destination address, while the peripheral provides a fixed range offset address.

For PIC24FJ128GL306 family devices, the 12-bit A/D Converter module is the only PIA-capable peripheral. Details for its use in PIA mode are provided in Section 22.0 "12-Bit A/D Converter with Threshold Detect".



5.1.6 CHANNEL PRIORITY

Each DMA channel functions independently of the others, but also competes with the others for access to the data and DMA buses. When access collisions occur, the DMA Controller arbitrates between the channels using a user-selectable priority scheme. Two schemes are available:

- Round-Robin: When two or more channels collide, the lower numbered channel receives priority on the first collision. On subsequent collisions, the higher numbered channels each receive priority, based on their channel number.
- Fixed: When two or more channels collide, the lowest numbered channel always receives priority, regardless of past history; however, any channel being actively processed is not available for an immediate retrigger. If a higher priority channel is continually requesting service, it will be scheduled for service after the next lower priority channel with a pending request.

5.2 Typical Setup

To set up a DMA channel for a basic data transfer:

- 1. Enable the DMA Controller (DMAEN = 1) and select an appropriate channel priority scheme by setting or clearing PRSSEL.
- 2. Program DMAH and DMAL with the appropriate upper and lower address boundaries for data RAM operations.
- 3. Select the DMA channel to be used and disable its operation (CHEN = 0).
- Program the appropriate source and destination addresses for the transaction into the channel's DMASRCn and DMADSTn registers. For PIA mode addressing, use the base address value.
- 5. Program the DMACNTn register for the number of triggers per transfer (One-Shot or Continuous modes) or the number of words (bytes) to be transferred (Repeated modes).
- 6. Set or clear the SIZE bit to select the data size.
- 7. Program the TRMODE[1:0] bits to select the Data Transfer mode.
- 8. Program the SAMODE[1:0] and DAMODE[1:0] bits to select the addressing mode.
- 9. Enable the DMA channel by setting CHEN.
- 10. Enable the trigger source interrupt.

5.3 Peripheral Module Disable

Unlike other peripheral modules, the channels of the DMA Controller cannot be individually powered down using the Peripheral Module Disable (PMD) registers. Instead, the channels are controlled as two groups. The DMA0MD bit (PMD7[4]) selectively controls DMACH0 through DMACH3. The DMA1MD bit (PMD7[5]) controls DMACH4 and DMACH5. Setting both bits effectively disables the DMA Controller.

5.4 DMA Registers

The DMA Controller uses a number of registers to control its operation. The number of registers depends on the number of channels implemented for a particular device.

There are always four module-level registers (one control and three buffer/address):

- DMACON: DMA Engine Control Register (Register 5-1)
- DMAH and DMAL: DMA High and Low Address Limit Registers
- DMABUF: DMA Data Buffer

Each of the DMA channels implements five registers (two control and three buffer/address):

- DMACHn: DMA Channel n Control Register (Register 5-2)
- DMAINTn: DMA Channel n Interrupt Register (Register 5-3)
- DMASRCn: DMA Data Source Address Pointer for Channel n
- DMADSTn: DMA Data Destination Address Pointer for Channel n
- DMACNTn: DMA Transaction Counter for Channel n

For PIC24FJ128GL306 family devices, there are a total of 34 registers.

R/W-0	U-0						
DMAEN	—	—	—	—	—	—	—
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	_	_	—	PRSSEL
bit 7							bit 0
[· ·							

REGISTER 5-1: DMACON: DMA ENGINE CONTROL REGISTER

Legend:

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 DMAEN: DMA Module Enable bit

1 = Enables module

0 = Disables module and terminates all active DMA operation(s)

bit 14-1 Unimplemented: Read as '0'

bit 0 PRSSEL: Channel Priority Scheme Selection bit

1 = Round-robin scheme

0 = Fixed priority scheme

REGISTER 5-2:	DMACHn: DMA CHANNEL n CONTROL REGISTER	

U-0	U-0	U-0	r-0	U-0	R/W-0	R/W-0	R/W-0				
_	—		_	—	NULLW	RELOAD ⁽¹⁾	CHREQ ⁽³⁾				
bit 15							bit 8				
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
SAMODE1	SAMODE0	DAMODE1	DAMODE0	TRMODE1	TRMODE0	SIZE	CHEN				
bit 7							bit (
Legend:		r = Reserved	bit								
R = Readabl	e bit	W = Writable	bit	U = Unimplen	nented bit, read	l as '0'					
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	iown				
bit 15-13	Unimplemen	ted: Read as '	כי								
bit 12	Reserved: Ma	aintain as '0'									
bit 11	Unimplemen	ted: Read as '	כ'								
bit 10	NULLW: Null	Write Mode bit									
		/ write is initiate ny write is initia		n for every writ	e to DMADSTr	ו					
bit 9		5)							
		RELOAD: Address and Count Reload bit ⁽¹⁾ 1 = DMASRCn, DMADSTn and DMACNTn registers are reloaded to their previous values upon the									
	 start of the next operation 0 = DMASRCn, DMADSTn and DMACNTn are not reloaded on the start of the next operation⁽²⁾ 										
L:1 0					led on the start	t of the next ope	eration(2)				
bit 8		A Channel Soft	-		cleared upon c	ompletion of a	DMA transfer				
		request is pend									
bit 7-6	SAMODE[1:0]: Source Addr	ess Mode Sele	ection bits							
				ect Addressing							
				the SIZE bit aff he SIZE bit afte							
				a transfer com		mpletion					
bit 5-4]: Destination	-	-							
	11 = DMADS	- Tn is used in P	eripheral Indire	ect Addressing	and remains u	nchanged					
	10 = DMADSTn is decremented based on the SIZE bit after a transfer completion 01 = DMADSTn is incremented based on the SIZE bit after a transfer completion										
				he SIZE bit afte a transfer comp		mpletion					
bit 3-2			•	•	Jetion						
	TRMODE[1:0]: Transfer Mode Selection bits 11 = Repeated Continuous mode										
	10 = Continuous mode										
	•	ed One-Shot mo	ode								
L 14 A	00 = One-Sho										
bit 1	-	ize Selection bi	IT								
	1 = Byte (8-bi 0 = Word (16-										
bit 0	•	, Channel Enable	e bit								
		sponding chan									
	0 = The corre	sponding chan	nel is disabled								
Note 1: O	nly the original [DMACNTn is re	equired to be st	tored to recove	r the original D	MASRCn and I	DMADSTn.				
2: DI	MASRCn, DMA	DSTn and DMA	ACNTn are alw	avs reloaded ir	n Repeated mo	de transfers					

2: DMASRCn, DMADSTn and DMACNTn are always reloaded in Repeated mode transfers (DMACHn[2] = 1), regardless of the state of the RELOAD bit.

3: The number of transfers executed while CHREQ is set depends on the configuration of TRMODE[1:0].

REGISTER 5-3: DMAINTn: DMA CHANNEL n INTERRUPT REGISTER

R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
DBUFWF ⁽¹⁾	CHSEL6	CHSEL5	CHSEL4	CHSEL3	CHSEL2	CHSEL1	CHSEL0
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0
HIGHIF ^(1,2)	LOWIF ^(1,2)	DONEIF ⁽¹⁾	HALFIF ⁽¹⁾	OVRUNIF ⁽¹⁾	—	—	HALFEN
bit 7							bit
Legend:							
R = Readabl	e bit	W = Writable I	oit	U = Unimplem	ented bit. read	l as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea		x = Bit is unkr	nown
	-			-			
bit 15	1 = The conte DMASRC	Cn in Null Write ent of the DMA	A buffer has n mode	bit ⁽¹⁾ lot been written n written to the lo			
bit 14-8		DMA Channel ⁻ for a complete		on bits			
bit 7		High Address		Flag bit ^(1,2)			
				cess an address	s higher than D	MAH or the up	per limit of th
	data RAM	/I space					•
				high address li	mit interrupt		
bit 6		Low Address L					
		v channel has a range (07FFh)	ittempted to a	ccess the DMA	SFR address	lower than DM	AL, but abov
			ot invoked the	low address lin	nit interrupt		
bit 5		A Complete Op			·		
	<u>If CHEN = 1:</u> 1 = The previ		on has ended	with completior	1		
	If CHEN = 0:		,	·			
	•			with completion			
	-			without comple	tion		
bit 4		A 50% Waterma					
		n has reached has not reac					
bit 3		MA Channel Ov		• •			
			-	s still completing	the operation	based on the p	revious trigge
		run condition ha			·	·	
bit 2-1	Unimplement	ted: Read as ')'				
bit 0	HALFEN: Hal	fway Completion	on Watermark	bit			
				n has reached i pletion of the tra	• •	nt and at compl	etion
Note 1: S	etting these flag	s in software do	pes not genera	ate an interrupt.			
	esting for addres		-	-			

CHSEL[6:0]	Trigger (Interrupt)	CHSEL[6:0	0]	Trigger (Interrupt)	
0000000	000 Oh Off 1000101 45		45h	UART1 RX Interrupt		
0000001	1h		1000110	46h	UART1 Error Interrupt	
		Reserved 1000111 47h				
0000110	6h				Reserved	
0000111	7h	MCCP5 IC/OC Interrupt	1001010	4Ah		
0001000	8h	MCCP5 Timer Interrupt	1001011	4Bh	DMACHA5 Interrupt	
0001001	9h	MCCP4 IC/OC Interrupt	1001100	4Ch	DMACHA4 Interrupt	
0001010	Ah	MCCP4 Timer Interrupt	1001101	4Dh	DMACHA3 Interrupt	
0001011	Bh	MCCP3 IC/OC Interrupt	1001110	4Eh	DMACHA2 Interrupt	
0001100	Ch	MCCP3 Timer Interrupt	1001111	4Fh	DMACHA1 Interrupt	
0001101	Dh	MCCP2 IC/OC Interrupt	1010000	50h	DMACHA0 Interrupt	
0001110	Eh	MCCP2 Timer Interrupt	1010001	51h	ADC Interrupt	
0001111	Fh	MCCP1 IC/OC Interrupt	1010010	52h		
0010000	10h	MCCP1 Timer Interrupt			Reserved	
0010001	11h		1010011	53h		
		Reserved	1010100	54h	HLVD Interrupt	
0100010	22h		1010101	55h	CRC Interrupt	
0100011	23h	SPI2 Receive Interrupt	1010110	56h	LCD Interrupt	
0100100	24h	SPI2 Transmit Interrupt	1010111	57h	LCD Automation Interrupt	
0100101	25h	SPI2 General Interrupt	1011000	58h	Reserved	
0100110	26h	SPI1 Receive Interrupt	1011001	59h	CLC4 Out	
0100111	27h	SPI1 Transmit Interrupt	1011010	5Ah	CLC3 Out	
0101000	28h	SPI1 General Interrupt	1011011	5Bh	CLC2 Out	
0101001	29h		1011100	5Ch	CLC1 Out	
		Reserved	1011101	5Dh	Reserved	
0101110	2Eh		1011110	5Eh	RTCC Alarm Interrupt	
0101111	2Fh	I2C2 Slave Interrupt	1011111	5Fh	TMR5 Interrupt	
0110000	30h	I2C2 Master Interrupt	1100000	60h	TMR4 Interrupt	
0110001	31h	I2C2 Collision Interrupt	1100001	61h	TMR3 Interrupt	
0110010	32h	I2C1 Slave Interrupt	1100010	62h	TMR2 Interrupt	
0110011	33h	I2C1 Master Interrupt	1100011	63h	TMR1 Interrupt	
0110100	34h	I2C1 Collision Interrupt	1100100	64h		
0110101	35h				Reserved	
		Reserved	1100110	66h	1	
0111010	3Ah		1100111	67h	Comparator Interrupt	
0111011	3Bh	UART4 TX Interrupt	1101000	68h	INT4 Interrupt	
0111100	3Ch	UART4 RX Interrupt	1101001	69h	INT3 Interrupt	
0111101	3Dh	UART4 Error Interrupt	1101010	6Ah	INT2 Interrupt	
0111110	3Eh	UART3 TX Interrupt	1101011	6Bh		
0111111	3Fh	UART3 RX Interrupt	1101100 6Ch		INT0 Interrupt	
1000000	40h	UART3 Error Interrupt			Interrupt-on-Change (IOC) Interrup	
1000001	41h	UART2 TX Interrupt	1101110	6Eh		
1000010	42h	UART2 RX Interrupt			Reserved	
1000011	43h	UART2 Error Interrupt	1111111	7Fh	1	
1000100	44h	UART1 TX Interrupt				

TABLE 5-1:DMA TRIGGER SOURCES

6.0 FLASH PROGRAM MEMORY

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "PIC24F Flash Program Memory" (www.microchip.com/DS30009715) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The PIC24FJ128GL306 family of devices contains internal Flash program memory for storing and executing application code. The program memory is readable, writable and erasable. The Flash memory can be programmed in four ways:

- In-Circuit Serial Programming[™] (ICSP[™])
- Run-Time Self-Programming (RTSP)
- JTAG
- Enhanced In-Circuit Serial Programming (Enhanced ICSP)

ICSP allows a PIC24FJ128GL306 family device to be serially programmed while in the end application circuit. This is simply done with two lines for the programming clock and programming data (named PGCx and PGDx, respectively), and three other lines for power (VDD), ground (Vss) and Master Clear (MCLR). This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed. RTSP is accomplished using TBLRD (Table Read) and TBLWT (Table Write) instructions. With RTSP, the user may write program memory data in blocks of 128 instructions (384 bytes) at a time and erase program memory in blocks of 1024 instructions (3072 bytes) at a time.

The device implements a 7-bit Error Correcting Code (ECC). The NVM block contains a logic to write and read ECC bits to and from the Flash memory. The Flash is programmed at the same time as the corresponding ECC parity bits. The ECC provides improved resistance to Flash errors. ECC single-bit errors can be transparently corrected; ECC double-bit errors generate an interrupt.

6.1 Table Instructions and Flash Programming

Regardless of the method used, all programming of Flash memory is done with the Table Read and Table Write instructions. These allow direct read and write access to the program memory space from the data memory while the device is in normal operating mode. The 24-bit target address in the program memory is formed using the TBLPAG[7:0] bits and the Effective Address (EA) from a W register, specified in the table instruction, as shown in Figure 6-1.

The TBLRDL and the TBLWTL instructions are used to read or write to bits[15:0] of program memory. TBLRDL and TBLWTL can access program memory in both Word and Byte modes.

The TBLRDH and TBLWTH instructions are used to read or write to bits[23:16] of program memory. TBLRDH and TBLWTH can also access program memory in Word or Byte mode.

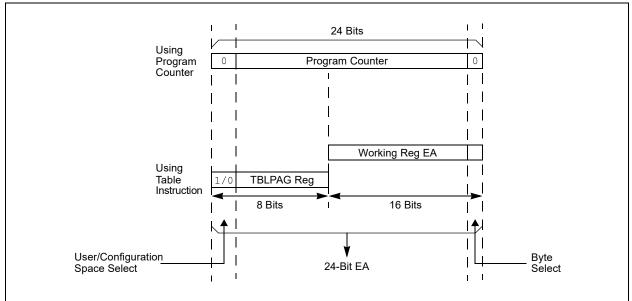


FIGURE 6-1: ADDRESSING FOR TABLE REGISTERS

6.2 RTSP Operation

The PIC24F Flash program memory array is organized into rows of 128 instructions or 384 bytes. RTSP allows the user to erase blocks of eight rows (1024 instructions) at a time and to program one row at a time. It is also possible to program two instruction word blocks.

The 8-row erase blocks and single row write blocks are edge-aligned, from the beginning of program memory, on boundaries of 3072 bytes and 384 bytes, respectively.

When data are written to program memory using TBLWT instructions, the data are not written directly to memory. Instead, data written using Table Writes are stored in holding latches until the programming sequence is executed.

Any number of TBLWT instructions can be executed and a write will be successfully performed. However, 128 TBLWT instructions are required to write the full row of memory.

To ensure that no data are corrupted during a write, any unused address should be programmed with FFFFFFh. This is because the holding latches reset to an unknown state, so if the addresses are left in the Reset state, they may overwrite the locations on rows which were not rewritten.

The basic sequence for RTSP programming is to set the Table Pointer to point to the programming latches, do a series of TBLWT instructions to load the buffers and set the NVMADRU/NVMADR registers to point to the destination. Programming is performed by setting the control bits in the NVMCON register.

Data can be loaded in any order and the holding registers can be written to multiple times before performing a write operation. Subsequent writes, however, will wipe out any previous writes.

Note: Writing to a location multiple times without erasing is *not* recommended.

All of the Table Write operations are single-word writes (two instruction cycles), because only the buffers are written. A programming cycle is required for programming each row.

6.2.1 PROGRAMMING OPERATIONS

A complete programming sequence is necessary for programming or erasing the internal Flash in RTSP mode. During a programming or erase operation, the processor stalls (waits) until the operation is finished. Setting the WR bit (NVMCON[15]) starts the operation and the WR bit is automatically cleared when the operation is finished.

6.2.2 PROGRAMMING ALGORITHM FOR FLASH PROGRAM MEMORY

The user can program one row of Flash program memory at a time. To do this, it is necessary to erase the 8-row erase block containing the desired row. The general process is:

- 1. Read eight rows of program memory (1024 instructions) and store in data RAM.
- 2. Update the program data in RAM with the desired new data.
- 3. Erase the block (see Example 6-1):
 - a) Set the NVMOP[3:0] bits (NVMCON[3:0]) to ⁽⁰⁰¹¹⁾ to configure for block erase. Set the WREN (NVMCON[14]) bit.
 - b) Write the starting address of the block to be erased into the NVMADRU/NVMADR registers.
 - c) Write 55h to NVMKEY.
 - d) Write AAh to NVMKEY.
 - e) Set the WR bit (NVMCON[15]). The erase cycle begins and the CPU stalls for the duration of the erase cycle. When the erase is done, the WR bit is cleared automatically.
- Update the TBLPAG register to point to the programming latches on the device. Update the NVMADRU/NVMADR registers to point to the destination in the program memory.
- 5. Write the first 128 instructions from data RAM into the program memory buffers (see Table 6-1).
- 6. Write the program block to Flash memory:
 - a) Set the NVMOPx bits to '0010' to configure for row programming. Set the WREN bit.
 - b) Write 55h to NVMKEY.
 - c) Write AAh to NVMKEY.
 - d) Set the WR bit. The programming cycle begins and the CPU stalls for the duration of the write cycle. When the write to Flash memory is done, the WR bit is cleared automatically.
- Repeat Steps 4 through 6, using the next available 128 instructions from the block in data RAM, by incrementing the value in NVMADRU/ NVMADR until all 1024 instructions are written back to Flash memory.

For protection against accidental operations, the write initiate sequence for NVMKEY must be used to allow any erase or program operation to proceed. After the programming command has been executed, the user must wait for the programming time until programming is complete. The two instructions following the start of the programming sequence should be NOPS, as shown in Example 6-2.

TABLE 6-1: EXAMPLE PAGE ERASE

04.0.0.4						
Step 1:	Set the NVMCON register to erase a page.					
MOV	#0x4003, W0					
MOV	W0, NVMCON					
Step 2:	Load the address of the page to be erased into the NVMADRU/NVMADR register pair.					
MOV	#PAGE_ADDR_LO, W0					
MOV	W0, NVMADR					
MOV	#PAGE_ADDR_HI, W0					
MOV	W0, NVMADRU					
Step 3:	: Set the WR bit.					
MOV	#0x55, WO					
MOV	W0, NVMKEY					
MOV	#OxAA, WO					
MOV	WO, NVMKEY					
BSET	NVMCON, #WR					
NOP						
NOP						
NOP						

EXAMPLE 6-1: ERASING A PROGRAM MEMORY BLOCK ('C' LANGUAGE CODE)

<pre>// C example using MPLAB XC16 unsigned long progAddr = 0xXXXXXX; unsigned int offset;</pre>	//	Address of row to write
//Set up pointer to the first memory location to	be	written
NVMADRU = progAddr>>16;	//	Initialize PM Page Boundary SFR
NVMADR = progAddr & 0xFFFF;	//	Initialize lower word of address
NVMCON = 0×4003 ;	//	Initialize NVMCON
asm("DISI #5");	//	Block all interrupts with priority <7
	//	for next 5 instructions
<pre>builtin write NVM();</pre>	//	check function to perform unlock
	//	sequence and set WR

Step 1: Se	et the NVMCON register to program 128 instruction words.
MOV	#0x4002, W0
MOV	WO, NVMCON
	itialize the TBLPAG register for writing to the latches.
MOV	#OxFA, W12
MOV	W12, TBLPAG
Step 3: Lo	bad W0:W5 with the next four instruction words to program.
MOV	# <lsw0>, W0</lsw0>
MOV	# <msb1:msb0>, W1</msb1:msb0>
MOV	# <lsw1>, W2</lsw1>
MOV	# <lsw2>, W3</lsw2>
MOV	# <msb3:msb2>, W4</msb3:msb2>
MOV	# <lsw3>, W5</lsw3>
Step 4: Se	et the Read Pointer (W6) and load the (next set of) write latches.
CLR	W6
CLR	W7
TBLWTL	[W6++], [W7]
TBLWTH.B	3 [W6++], [W7++]
TBLWTH.B	3 [W6++], [++W7]
TBLWTL	[W6++], [W7++]
TBLWTL	[W6++], [W7]
TBLWTH.B	3 [W6++], [W7++]
TBLWTH.B	3 [W6++], [++W7]
TBLWTL	[W6++], [W7++]
Step 5: Re	epeat Steps 4 and 5, for a total of 32 times, to load the write latches with 128 instructions.
Step 6: Se	et the NVMADRU/NVMADR register pair to point to the correct address.
MOV	<pre>#DestinationAddress[15:0], W3</pre>
MOV	#DestinationAddress[23:16], W4
MOV	W3, NVMADR
MOV	W4, NVMADRU
Step 7: E>	xecute the WR bit unlock sequence and initiate the write cycle.
MOV	#0x55, W0
MOV	W0, NVMKEY
MOV	#OXAA, WO
MOV	WO, NVMKEY
BSET	NVMCON, #WR
NOP	
NOP	
NOP	

EXAMPLE 6-2: ROW PROGRAMMING ('C' LANGUAGE CODE)

```
int varWord1L[128];
int varWord1H[128];
int targetWriteAddressL;
                                        // bits<15:0>
// bits<22:16>
int targetWriteAddressH;
int i;
NVMCON = 0 \times 4002;
                                        // Set WREN and row program mode
TBLPAG = 0xFA;
NVMADRL = targetWriteAddressL;
                                        // set target write address
NVMADRH = targetWriteAddressH;
for(i=0; i<128; i++)
                                        // load write latches with data
                                        // to be written
{
  __builtin_tblwtl( (i*2), varWordlL[i]);
__builtin_tblwth( (i*2), varWordlH[i]);
}
     _builtin_disi(5);
                                         //Disable interrupts for NVM unlock sequence
   ___builtin_write_NVM();
                                         // initiate write
```

6.2.3 PROGRAMMING A DOUBLE WORD OF FLASH PROGRAM MEMORY

If a Flash location has been erased, it can be programmed using Table Write instructions to write two instruction words (2 x 24-bit) into the write latch. The TBLPAG register is loaded with the address of the write latches and the NVMADRU/NVMADR registers are loaded with the address of the first of the two instruction

words to be programmed. The <code>TBLWTL</code> and <code>TBLWTH</code> instructions write the desired data into the write latches. To configure the NVMCON register for a two-word write, set the NVMOPx bits (NVMCON[3:0]) to '0001'. The write is performed by executing the unlock sequence and setting the WR bit. An equivalent procedure in 'C', using the MPLAB[®] XC16 compiler and built-in hardware functions, is shown in Example 6-3.

 TABLE 6-3:
 PROGRAMMING A DOUBLE WORD OF FLASH PROGRAM MEMORY

MOV W12, TBLPAG Step 2: Load W0:W2 with the next two packed instruction words to program. MOV # <lsw0>, W0 MOV #<lsw1>, W2 Step 3: Set the Read Pointer (W6) and Write Pointer (W7), and load the (next set of) write latches. CLR W6 CLR W7 TBLWTL [W6++1], [W7] TBLWTL [W6++1], [W7++1] TBLWTL.W [W6++1], [W7++1] TBLWTL.W [W6++1], [W7++1] Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[15:0], W4 MOV W3, NVMADR MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV #0x4001, w10 MOV W10, NVMCON MOP #0x4001, W10 MOV #0x55, W1 MOV #0x55, W1 MOV #1, NVMKEY MOV #1, NVMKEY MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP</lsw1></lsw0>	Step 1: Init	ialize the TBLPAG register for writing to the latches.
Step 2: Load W0:W2 with the next two packed instruction words to program. MOV # <lswd>, W0 MOV #<lswd>, W1 MOV #<lswd>, W1 MOV #<lswd>, W2 Step 3: Set the Read Pointer (W6) and Write Pointer (W7), and load the (next set of) write latches. CLR W6 CLR W6 CLR W7 TBLWTL [W6++], [W7] TBLWTL.W [W6++], [W7++1] Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV #0x4001, W10 MOV #0x4001, W10 MOV #0x4001, W10 MOV #0x55, W1 MOV #0x55, W1 MOV #0x401, W10 MOV #0xA0, W1 MOV #0xA0, W1</lswd></lswd></lswd></lswd>	MOV	#0xFA, W12
MOV # <lswd>, W0 MOV #<lswd>, W1 MOV #<lswd>, W2 Step 3: Set the Read Pointer (W6) and Write Pointer (W7), and load the (next set of) write latches. CLR W6 CLR W7 TBLWTL [W6++1], [W7] TBLWTL. [W6++1], [W7++1] TBLWTL.W [W6++1], [W7++1] TBLWTL.W [W6++1], [W7++1] Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV #0x4001, w10 MOV #0x4001, W10 MOV #0x4001, W10 MOV #0x55, w1 MOV #0x55, w1 MOV #0xA0, W1 MOV #0xA0, W1 MOV #0xA0, W1 MOV #0xA0, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP</lswd></lswd></lswd>	MOV	W12, TBLPAG
MOV # <msb1:msb0>, W1 MOV #<lsw1>, W2 Step 3: Set the Read Pointer (W6) and Write Pointer (W7), and load the (next set of) write latches. CLR W6 CLR W7 TBLWTL [W6++1], [W7] TBLWTL.B [W6++1], [W7++1] TBLWTL.W [W6++1], [W7++1] TStep 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV #0X MOV #0X4001, W10 MOV W6x4001, W10 MOV #10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV #0xAA, W1 MOV #1, NVMKEY MOV #0xAA, W1 MOV #0xAA, W1 MOV #1, NVMKEY BSET NVMCON, #WR NOP NOP</lsw1></msb1:msb0>	Step 2: Loa	ad W0:W2 with the next two packed instruction words to program.
MOV # <lsw1>, W2 Step 3: Set the Read Pointer (W6) and Write Pointer (W7), and load the (next set of) write latches. CLR W6 CLR W7 TBLWTL [W6++1], [W7] TBLWTL.B [W6++1], [W7+1] TBLWTL.W [W6++1], [W7++1] TBLWTL.W [W6++1], [W7++1] Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV #JestinationAddress[23:16], W4 MOV #0x4001, W10 MOV W3, NVMADR Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV #0x4001, W10 MOV #0x55, W1 MOV #0x55, W1 MOV #0xAA, W1 MOV #0xAA, W1 MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP</lsw1>	MOV	# <lsw0>, W0</lsw0>
Step 3: Set the Read Pointer (W6) and Write Pointer (W7), and load the (next set of) write latches. CLR W6 CLR W7 TBLWTL [W6++], [W7] TBLWTL.W [W6++], [W7++] TBLWTL.W [W6++], [W7++] TBLWTL.W [W6++], [W7++] Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV W4, NVMADRU Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV w10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x42, W1	MOV	# <msb1:msb0>, W1</msb1:msb0>
CLR W6 CLR W7 TBLWTL [W6++], [W7] TBLWTH.B [W6++], [W7++] TBLWTH.B [W6++], [W7++] Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV #0x4001, W10 MOV #0x4001, W10 MOV #0x55, W1 MOV #0x55, W1 MOV #0x25, W1 MOV #0xAA, W1 MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	MOV	# <lsw1>, W2</lsw1>
CLR W7 TBLWTL [W6++], [W7] TBLWTH.B [W6++], [W7++] TBLWTH.B [W6++], [++W7] TBLWTL.W [W6++], [W7++] Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV W4, NVMADR MOV #0x4001, W10 MOV W40x4001, W10 MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV #0xAA, W1 MOV #0xAA, W1 MOV W1, NVMKEY MOV W1, NVMKEY MOV W1, NVMKEY MOV W1, NVMKEY MOP W10, NVMCON, #WR NOP NVMCON, #WR	Step 3: Se	t the Read Pointer (W6) and Write Pointer (W7), and load the (next set of) write latches.
TBLWTL [W6++], [W7] TBLWTH.B [W6++], [W7++] TBLWTH.B [W6++], [++W7] TBLWTL.W [W6++], [W7++] Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV W4, NVMADRU Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV #0xAA, W1 MOV W1, NVMKEY MOV W1, NVMKEY MOV W1, NVMKEY MOV W1, NVMKEY MOV M1, NVMKEY MOV M1, NVMKEY MOV M1, NVMKEY MOV M2, NVMCON, #WR	CLR	W6
TBLWTH.B [W6++], [W7++] TBLWTH.B [W6++], [++W7] TBLWTL.W [W6++], [W7++] Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV W4, NVMADR Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV W1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	CLR	W7
TBLWTH.B [W6++], [++W7] TBLWTL.W [W6++], [W7++] Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV W4, NVMADRU Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV W1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	TBLWTL	[W6++], [W7]
TBLWTL.W [W6++], [W7++] Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV W4, NVMADRU Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #1, NVMKEY MOV W1, NVMKEY MOV W1, NVMKEY MOV W1, NVMKEY MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	TBLWTH.B	[W6++], [W7++]
Step 4: Set the NVMADRU/NVMADR register pair to point to the correct address. MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV W4, NVMADRU Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0xAA, W1 MOV W1, NVMKEY MOV W1, NVMKEY MOV W1, NVMKEY MOV W1, NVMKEY MOV W1, NVMCON, #WR NOP NOP	TBLWTH.B	[W6++], [++W7]
MOV #DestinationAddress[15:0], W3 MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV W4, NVMADRU Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	TBLWTL.W	[W6++], [W7++]
MOV #DestinationAddress[23:16], W4 MOV W3, NVMADR MOV W4, NVMADRU Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV W1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	Step 4: Se	t the NVMADRU/NVMADR register pair to point to the correct address.
MOV W3, NVMADR MOV W4, NVMADRU Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV #0xAA, W1 MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	MOV	<pre>#DestinationAddress[15:0], W3</pre>
MOV W4, NVMADRU Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV #0x55, W1 MOV #0xAA, W1 MOV #0xAA, W1 MOV W1, NVMKEY MOV W1, NVMKEY MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP NOP NOP	MOV	<pre>#DestinationAddress[23:16], W4</pre>
Step 5: Set the NVMCON register to program two instruction words. MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV W1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP NOP NOP	MOV	W3, NVMADR
MOV #0x4001, W10 MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV W1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	MOV	W4, NVMADRU
MOV W10, NVMCON NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV W1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	Step 5: Se	t the NVMCON register to program two instruction words.
NOP Step 6: Initiate the write cycle. MOV #0x55, W1 MOV W1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	MOV	#0x4001, W10
Step 6: Initiate the write cycle. MOV #0x55, W1 MOV W1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	MOV	W10, NVMCON
MOV #0x55, W1 MOV W1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	NOP	
MOV W1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	Step 6: Init	iate the write cycle.
MOV W1, NVMKEY MOV #0xAA, W1 MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	MOV	#0x55, W1
MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	MOV	
MOV W1, NVMKEY BSET NVMCON, #WR NOP NOP	MOV	,
BSET NVMCON, #WR NOP NOP	MOV	•
NOP	BSET	,
NOP	NOP	
	NOP	

EXAMPLE 6-3: PROGRAMMING A DOUBLE WORD OF FLASH PROGRAM MEMORY ('C' LANGUAGE CODE)

// C example using MPLAB XC16	
unsigned long progAddr = 0xXXXXXX;	// Address of word to program
unsigned int progData1L = 0xXXXX;	// Data to program lower word of word 1
unsigned char progData1H = 0xXX;	// Data to program upper byte of word 1
unsigned int progData2L = 0xXXXX;	<pre>// Data to program lower word of word 2</pre>
unsigned char progData2H = 0xXX;	<pre>// Data to program upper byte of word 2</pre>
//Set up NVMCON for word programming	
$NVMCON = 0 \times 4001;$	// Initialize NVMCON
TBLPAG = 0xFA;	// Point TBLPAG to the write latches
//Set up pointer to the first memory locati	on to be written
NVMADRU = progAddr>>16;	// Initialize PM Page Boundary SFR
NVMADR = progAddr & 0xFFFF;	<pre>// Initialize lower word of address</pre>
//Perform TBLWT instructions to write latch	es
builtin_tblwtl(0, progData1L);	// Write word 1 to address low word
builtin_tblwth(0, progData2H);	// Write word 1 to upper byte
builtin_tblwtl(1, progData2L);	// Write word 2 to address low word
builtin_tblwth(1, progData2H);	// Write word 2 to upper byte
asm("DISI #5");	// Block interrupts with priority <7 for next 5
	// instructions
builtin_write_NVM();	// XC16 function to perform unlock sequence and set WR $$

6.3 Control Registers

There are four SFRs used to read and write the Program Flash Memory (PFM): NVMCON, NVMADRU, NVMADR and NVMKEY.

The NVMCON register (Register 6-1) controls which blocks are to be erased, which memory type is to be programmed and when the programming cycle starts.

NVMKEY (Register 6-4) is a write-only register that is used for write protection. To start a programming or erase sequence, the user must consecutively write 55h and AAh to the NVMKEY register. Refer to **Section 6.2.1** "**Programming Operations**" for further details.

The NVMADRU/NVMADR registers contain the upper byte and lower word of the destination of the NVM write or erase operation. Some operations (chip erase) operate on fixed locations and do not require an address value.

REGISTER 6-1: NVMCON: NONVOLATILE FLASH MEMORY CONTROL REGISTER

HC/R/S-0 ^(1,3)	R/W-0 ⁽¹⁾	HSC/R-0 ⁽¹⁾	R/W-0	r-0	r-0	U-0	U-0
WR	WREN	WRERR	NVMSIDL	_	—	_	—
bit 15							bit 8

U-0	U-0	U-0	U-0	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾
—			_	NVMOP3 ⁽²⁾	NVMOP2 ⁽²⁾	NVMOP1 ⁽²⁾	NVMOP0 ⁽²⁾
bit 7							bit 0

Legend:	S = Settable bit	HC = Hardware Clearable bit	r = Reserved bit
R = Readable bit	W = Writable bit	'0' = Bit is cleared	x = Bit is unknown
-n = Value at POR	'1' = Bit is set	U = Unimplemented bit, read a	as 'O'
HSC = Hardware Settab	le/Clearable bit		

bit 15	WR: Write Control bit ^(1,3)
	 1 = Initiates a Flash memory program or erase operation; the operation is self-timed and the bit is cleared by hardware once the operation is complete
	0 = Program or erase operation is complete and inactive
bit 14	WREN: Write Enable bit ⁽¹⁾
	1 = Enables Flash program/erase operations0 = Inhibits Flash program/erase operations
bit 13	WRERR: Write Sequence Error Flag bit ⁽¹⁾
	 1 = An improper program or erase sequence attempt, or termination has occurred (bit is set automatically on any set attempt of the WR bit) 0 = The program or erase operation completed normally
bit 12	NVMSIDL: NVM Stop in Idle bit
	 1 = Removes power from the program memory when device enters Idle mode 0 = Powers program memory in Standby mode when the device enters Idle mode
bit 11-10	Reserved: Maintain as '0'
bit 9-4	Unimplemented: Read as '0'
bit 3-0	NVMOP[3:0]: NVM Operation Select bits ^(1,2)
	1110 = Chip erases user memory (does not erase Device ID, customer OTP or executive memory) 0100 = Unused
	0011 = Erases a page of program or executive memory
	0010 = Row programming operation
	0001 = Double-word programming operation
Note 1:	These bits can only be reset on a Power-on Reset.
2:	All other combinations of NVMOP[3:0] are unimplemented.

3: Unlock sequence must be executed before writing to this bit.

'1' = Bit is set

'1' = Bit is set

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
			N۷	/MADR[15:8]			
bit 15							bit 8
R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
			N	VMADR[7:0]			
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable b	bit	U = Unimplem	ented bit, read as	s 'O'	

REGISTER 6-2: NVMADR: NONVOLATILE MEMORY LOWER ADDRESS REGISTER

bit 15-0 **NVMADR[15:0]:** Nonvolatile Memory Lower Write Address bits Selects the lower 16 bits of the location to program or erase in Program Flash Memory. This register may be read or written to by the user application.

'0' = Bit is cleared

REGISTER 6-3: NVMADRU: NONVOLATILE MEMORY UPPER ADDRESS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	—	_	—	—		—
bit 15							bit 8
R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
			NVN	/ADRU[23:16]			
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit			bit	U = Unimpleme	nted bit, read as	s 'O'	

bit 15-8 Unimplemented: Read as '0'

bit 7-0 **NVMADRU[23:16]:** Nonvolatile Memory Upper Write Address bits Selects the upper eight bits of the location to program or erase in Program Flash Memory. This register may be read or written to by the user application.

'0' = Bit is cleared

-n = Value at POR

-n = Value at POR

x = Bit is unknown

x = Bit is unknown

Register 6-4: NVMKEY: NONVOLATILE MEMORY KEY REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_		—	_	—	_	—	—
bit 15							bit 8
W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0
			N	VMKEY[7:0]			
bit 7							bit 0
Legend:							
R = Readab	le bit	W = Writable	bit	U = Unimpleme	nted bit, read	as '0'	
-n = Value at POR '1' = Bit is set '0' = Bit is cleared			ed	x = Bit is unkn	own		

bit 15-8 Unimplemented: Read as '0'

bit 7-0 NVMKEY[7:0]: NVM Key Register bits (write-only)

6.4 Error Correcting Code (ECC)

In order to improve program memory performance and durability, these devices include Error Correcting Code (ECC) functionality as an integral part of the Flash memory controller. ECC can determine the presence of single-bit errors in program data, including which bit is in error, and correct the data automatically without user intervention. ECC cannot be disabled.

When data are written to program memory, ECC generates a 7-bit Hamming code parity value for every two (24-bit) instruction words. The data are stored in blocks of 48 data bits and seven parity bits; parity data are not memory-mapped and are inaccessible. When the data are read back, the ECC calculates the parity on them and compares it to the previously stored parity value. If a parity mismatch occurs, there are two possible outcomes:

- Single-bit error has occurred and has been automatically corrected on read-back
- Double-bit error has occurred and the read data are not changed

Single-bit error occurrence can be identified by the state of the ECCSBEIF (IFS6[12]) bit. An interrupt can be generated when the corresponding interrupt enable bit is set, ECCSBEIE (IEC6[12]). The ECCSTATL register contains the parity information for single-bit errors. The SECOUT[7:0] bits field contains the expected calculated SEC parity and the SECIN[7:0] bits contain the actual value from a Flash read operation. The SECSYNDx bits (ECCSTATH[7:0]) indicate the bit position of the single-bit error within the 48-bit pair of instruction words. When no error is present, SECINx equals SECOUTx and SECSYNDx is zero.

Double-bit error occurrences generate a generic hard trap and set the ECCDBE (INTCON4[1]) bit. If no Interrupt Service Routine is implemented for the hard trap, a device Reset will also occur. The ECCSTATH register contains double-bit error status information. The DEDOUT bit is the expected calculated Dual Bit Error Detection (DED) parity and DEDIN is the actual value from a Flash read operation. When no error is present, DEDIN equals DEDOUT.

6.4.1 ECC FAULT INJECTION

To test Fault handling, an ECC error can be generated. Both single and double-bit errors can be generated in both the read and write data paths. Read path Fault injection first reads the Flash data and then modifies them prior to entering the ECC logic. Write path Fault injection modifies the actual data prior to them being written into the target Flash and will cause an ECC error on a subsequent Flash read. The following procedure is used to inject a Fault:

- 1. Load the Flash target address into the ECCADDR register.
- 2. Select 1st Fault bit determined by the FLT1PTRx (ECCCONH[7:0]) bits. The target bit is inverted to create the Fault.
- If a double Fault is desired, select the 2nd Fault bit determined by the FLT2PTRx (ECCCONH[15:8]) bits; otherwise, set to all '1's.
- 4. Write the NVMKEY unlock sequence (see Section 6.3 "Control Registers").
- 5. Enable the ECC Fault injection logic by setting the FLTINJ bit (ECCCONL[0]).
- 6. Perform a read or write to the Flash target address.

6.4.2 ECC CONTROL REGISTERS

ECCCONL: ECC FAULT INJECTION CONFIGURATION REGISTER LOW **REGISTER 6-5:**

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	_	—	—
bit 15						•	bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	—	—	—	_	—	FLTINJ
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-1 Unimplemented: Read as '0'

bit 0 FLTINJ: Fault Injection Sequence Enable bit

- 1 = Enabled
- 0 = Disabled

ECCCONH: ECC FAULT INJECTION CONFIGURATION REGISTER HIGH **REGISTER 6-6:**

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			FL	T2PTR[7:0]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
1411 0	1411 0	1411 0		T1PTR[7:0]	1011 0	10110	
bit 7				L - J			bit (
Legend:							
R = Reada	ble bit	W = Writable	bit	U = Unimpleme	ented bit, read a	s '0'	
-n = Value	at POR	'1' = Bit is set	t	'0' = Bit is clear	ed	x = Bit is unkn	own
	00110111	= Fault injectior	n (bit inversio	n) occurs on bit 5	55 of ECC bit or	der	
				n) occurs on bit 1 n) occurs on bit (
bit 7-0		':0]: ECC Fault		,			
	11111111	-00111000 = N	lo Fault injec		order		
				it 1 of ECC bit or it 0 of ECC bit or			

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R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			EC	CADDR[15:8]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			EC	CCADDR[7:0]			
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable	e bit	U = Unimpleme	nted bit, read a	as '0'	
-n = Value at	POR	'1' = Bit is se	t	'0' = Bit is cleare	ed	x = Bit is unkn	own

ECCADDRL: ECC FAULT INJECT ADDRESS COMPARE REGISTER LOW **REGISTER 6-7:**

ECCADDR[15:0]: ECC Fault Injection NVM Address Match Compare bits bit 15-0

ECCADDRH: ECC FAULT INJECT ADDRESS COMPARE REGISTER HIGH **REGISTER 6-8:**

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ECCADDR[23:16]							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as	s 'O'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 Unimplemented: Read as '0'

bit 7-0 ECCADDR[23:16]: ECC Fault Injection NVM Address Match Compare bits

REGISTER 6-9: ECCSTATL: ECC SYSTEM STATUS DISPLAY REGISTER LOW

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			SE	COUT[7:0]			
bit 15							bit 8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			S	ECIN[7:0]			
bit 7							bit 0
Legend:							

R = Readable bit	W = Writable bit	U = Unimplemented bit, read a	is '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **SECOUT[7:0]:** Calculated Single Error Correction Parity Value bits

bit 7-0 SECIN[7:0]: Read Single Error Correction Parity Value bits

SECIN[7:0] bits are the actual parity value of a Flash read operation.

REGISTER 6-10: ECCSTATH: ECC SYSTEM STATUS DISPLAY REGISTER HIGH

U-0	U-0	U-0	U-0	U-0	U-0	R-0	R-0
—	—	—	-	—	—	DEDOUT	DEDIN
bit 15							bit 8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			SE	CSYND[7:0]			

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, r	read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 7

bit 9 **DEDOUT:** Calculated Dual Bit Error Detection Parity bit

bit 8 **DEDIN:** Read Dual Bit Error Detection Parity bit

DEDIN is the actual parity value of a Flash read operation.

bit 7-0 **SECSYND[7:0]:** Calculated ECC Syndrome Value bits Indicates the bit location that contains the error. bit 0

6.5 Flash OTP by ICSP[™] Write Inhibit

ICSP Write Inhibit is an access restriction feature, that when activated, restricts all of Flash memory. Once activated, ICSP Write Inhibit permanently prevents ICSP Flash programming and erase operations, and cannot be deactivated. This feature is intended to prevent alteration of Flash memory contents, with behavior similar to One-Time-Programmable (OTP) devices.

RTSP, including erase and programming operations, is not restricted when ICSP Write Inhibit is activated; however, code to perform these actions must be programmed into the device before ICSP Write Inhibit is activated. This allows for a bootloader-type application to alter Flash contents with ICSP Write Inhibit activated.

Entry into ICSP and Enhanced ICSP modes is not affected by ICSP Write Inhibit. In these modes, it will continue to be possible to read configuration memory space and any user memory space regions which are not code protected. With ICSP writes inhibited, an attempt to set WR (NVMCON[15]) = 1 will maintain WR = 0, and instead, set WRERR (NVMCON[13]) = 1. All Enhanced ICSP erase and programming commands will have no effect with self-checked programming commands returning a FAIL response opcode (PASS if the destination already exactly matched the requested programming data).

Once ICSP Write Inhibit is activated, it is not possible for a device executing in Debug mode to erase/write Flash, nor can a debug tool switch the device to Production mode. ICSP Write Inhibit should therefore, only be activated on devices programmed for production.

6.5.1 ACTIVATING FLASH OTP BY ICSP WRITE INHIBIT

Note: It is not possible to deactivate ICSP Write Inhibit.

ICSP Write Inhibit is activated by executing a pair of NVMCON double-word programming commands to save two 16-bit activation values in the configuration memory space. The target NVM addresses and values required for activation are shown in Table 6-4. Once both addresses contain their activation values, ICSP Write Inhibit will take permanent effect on the next device Reset.

Only the lower 16 data bits stored at the activation addresses are evaluated; the upper eight bits and second 24-bit word, written by the double-word programming (NVMOP[3:0]), should be written as '0's. The addresses can be programmed in any order and also during separate ICSP/Enhanced ICSP/RTSP sessions, but any attempt to program an incorrect 16-bit value or use a row programming operation to program the values will be aborted without altering the existing data.

TABLE 6-4: ICSP™ WRITE INHIBIT ACTIVATION ADDRESSES AND DATA

	Configuration Memory Address	ICSP Write Inhibit Activation Value
Write Lock 1	0x801024	0x006D63
Write Lock 2	0x801028	0x006870

6.6 JTAG Operation

The PIC24F family supports JTAG boundary scan. Boundary scan can improve the manufacturing process by verifying pin to PCB connectivity.

6.7 Enhanced In-Circuit Serial Programming

Enhanced In-Circuit Serial Programming uses an onboard bootloader, known as the Program Executive (PE), to manage the programming process. Using an SPI data frame format, the Program Executive can erase, program and verify program memory. For more information on Enhanced ICSP, refer to the "*PIC24FJ128GL306 Family Flash Programming Specification*" (www.microchip.com/ DS30010189).

7.0 RESETS

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "Reset" (www.microchip.com/ DS39712) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The Reset module combines all Reset sources and controls the device Master Reset Signal, SYSRST. The following is a list of device Reset sources:

- · POR: Power-on Reset
- MCLR: Master Clear Pin Reset
- SWR: RESET Instruction
- WDT: Watchdog Timer Reset
- · BOR: Brown-out Reset
- CM: Configuration Mismatch Reset
- TRAPR: Trap Conflict Reset
- · IOPUWR: Illegal Opcode Reset
- UWR: Uninitialized W Register Reset

A simplified block diagram of the Reset module is shown in Figure 7-1.

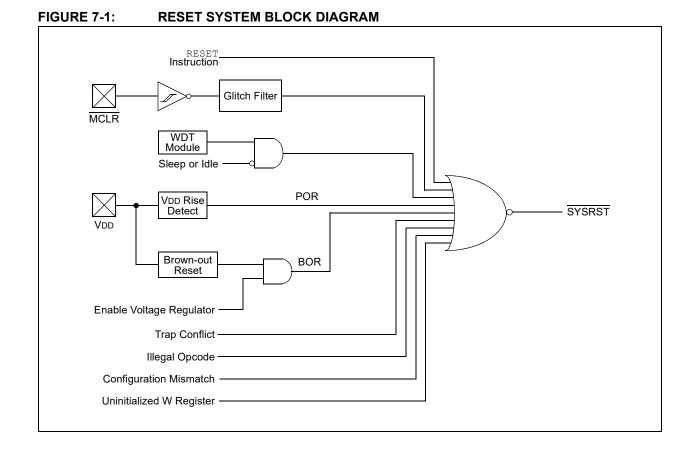
Any active source of Reset will make the SYSRST signal active. Many registers associated with the CPU and peripherals are forced to a known Reset state. Most registers are unaffected by a Reset; their status is unknown on POR and unchanged by all other Resets.

Note: Refer to the specific peripheral or CPU section of this data sheet for register Reset states.

All types of device Reset will set a corresponding status bit in the RCON register to indicate the type of Reset (see Register 7-1). A POR will clear all bits, except for the BOR and POR (RCON[1:0]) bits, which are set. The user may set or clear any bit at any time during code execution. The RCON bits only serve as status bits. Setting a particular Reset status bit in software will not cause a device Reset to occur.

The RCON register also has other bits associated with the Watchdog Timer and device Power-Saving states. The function of these bits is discussed in other sections of this data sheet.

Note: The status bits in the RCON register should be cleared after they are read so that the next RCON register values after a device Reset will be meaningful.



R/W-0	R/W-0	R/W-1	R/W-0	U-0	U-0	R/W-0	R/W-0
TRAPR ⁽¹⁾	IOPUWR ⁽¹⁾	SBOREN ⁽⁵⁾	RETEN ⁽²⁾	—	—	CM ⁽¹⁾	VREGS ⁽³⁾
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1	R/W-1
EXTR ⁽¹⁾	SWR ⁽¹⁾	SWDTEN ⁽⁴⁾	WDTO ⁽¹⁾	SLEEP ⁽¹⁾	IDLE ⁽¹⁾	BOR ⁽¹⁾	POR ⁽¹⁾
bit 7					I	I	bit 0
Legend:							
R = Readab	le bit	W = Writable b	bit	U = Unimplem	ented bit, read	as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
bit 15	1 = A Trap Co	Reset Flag bit ⁽ nflict Reset has	occurred				
	•	nflict Reset has				(1)	
bit 14	1 = An illegal Address I	l opcode detec Pointer and cau	tion, an illega ised a Reset	/ Register Acce I address mode gister Reset has	e or Uninitializ		is used as an
bit 13	SBOREN: So 1 = BOR is er 0 = BOR is dis		Over the BOR	Function bit ⁽⁵⁾			
bit 12	1 = Retention		ed while device	e is in Sleep mo tage levels are		ator supplies t	o the core)
bit 11-10	Unimplemen	ted: Read as '0	,				
bit 9	CM: Configura	ation Word Misi	match Reset F	lag bit ⁽¹⁾			
	•	ration Word Mis ration Word Mis		has occurred has not occurre	d		
bit 8	VREGS: Fast	Wake-up from	Sleep bit ⁽³⁾				
				ast wake-up, us ow wake-up, us			
bit 7		al Reset (MCLI					
		Clear (pin) Rese Clear (pin) Rese					
bit 6		re reset (Instr					
		nstruction has h nstruction has r					
	ll of the Reset st ause a device R		e set or cleare	d in software. S	etting one of th	ese bits in sof	ware does not
2: If	the LPCFG Con it has no effect.		ʻ1' (unprogran	nmed), the rete	ntion regulator	is disabled an	d the RETEN
3 : R	e-enabling the re						
4: If	the FWDTEN[1: ne SWDTEN bit s	0] Configuration			-	-	-
	he BOREN[1:0](n wake-up from		-				ave an effect.
-	ı		•				

REGISTER 7-1: RCON: RESET CONTROL REGISTER⁽⁶⁾

REGISTER 7-1: RCON: RESET CONTROL REGISTER⁽⁶⁾ (CONTINUED)

bit 5	SWDTEN: Software Enable/Disable of WDT bit ⁽⁴⁾
	1 = WDT is enabled
	0 = WDT is disabled
bit 4	WDTO: Watchdog Timer Time-out Flag bit ⁽¹⁾
	1 = WDT time-out has occurred
	0 = WDT time-out has not occurred
bit 3	SLEEP: Wake from Sleep Flag bit ⁽¹⁾
	1 = Device has been in Sleep mode
	0 = Device has not been in Sleep mode
bit 2	IDLE: Wake-up from Idle Flag bit ⁽¹⁾
	1 = Device has been in Idle mode
	0 = Device has not been in Idle mode
bit 1	BOR: Brown-out Reset Flag bit ⁽¹⁾
	1 = A Brown-out Reset has occurred (also set after a Power-on Reset)
	0 = A Brown-out Reset has not occurred
bit 0	POR: Power-on Reset Flag bit ⁽¹⁾
	1 = A Power-on Reset has occurred
	0 = A Power-on Reset has not occurred
Note 1:	All of the Reset status bits may be set or cleared in software. Setting one of these bits in software does not

cause a device Reset.

- 2: If the LPCFG Configuration bit is '1' (unprogrammed), the retention regulator is disabled and the RETEN bit has no effect.
- **3:** Re-enabling the regulator after it enters Standby mode will add a delay, TVREG, when waking up from Sleep. Applications that do not use the voltage regulator should set this bit to prevent this delay from occurring.
- 4: If the FWDTEN[1:0] Configuration bits are '11' (unprogrammed), the WDT is always enabled, regardless of the SWDTEN bit setting.
- 5: The BOREN[1:0] (FPOR[1:0]) Configuration bits must be set to '01' in order for SBOREN to have an effect.
- 6: On wake-up from Retention Sleep, RCON will have same value as a POR event.

Flag Bit	Setting Event	Clearing Event
TRAPR (RCON[15])	Trap Conflict Event	POR
IOPUWR (RCON[14])	Illegal Opcode or Uninitialized W Register Access	POR
CM (RCON[9])	Configuration Mismatch Reset	POR
EXTR (RCON[7])	MCLR Reset	POR
SWR (RCON[6])	RESET Instruction	POR
WDTO (RCON[4])	WDT Time-out	CLRWDT, PWRSAV Instruction, POR
SLEEP (RCON[3])	PWRSAV #0 Instruction	POR
IDLE (RCON[2])	PWRSAV #1 Instruction	POR
BOR (RCON[1])	POR, BOR	_
POR (RCON[0])	POR	—

TABLE 7-1: RESET FLAG BIT OPERATION

Note: All Reset flag bits may be set or cleared by the user software.

7.1 Special Function Register Reset States

Most of the Special Function Registers (SFRs) associated with the PIC24F CPU and peripherals are reset to a particular value at a device Reset. The SFRs are grouped by their peripheral or CPU function and their Reset values are specified in each section of this data sheet.

The Reset value for each SFR does not depend on the type of Reset, with the exception of four registers. The Reset value for the Reset Control register, RCON, will depend on the type of device Reset. The Reset value for the Oscillator Control register, OSCCON, will depend on the type of Reset and the programmed values of the FNOSC[2:0] bits in the FOSCSEL Configuration register (see Table 7-2). The NVMCON register is only affected by a POR.

7.2 Device Reset Times

The Reset times for various types of device Reset are summarized in Table 7-3. Note that the Master Reset Signal, SYSRST, is released after the POR delay time expires.

The time at which the device actually begins to execute code will also depend on the system oscillator delays, which include the Oscillator Start-up Timer (OST) and the PLL lock time. The OST and PLL lock times occur in parallel with the applicable SYSRST delay times.

The Fail-Safe Clock Monitor (FSCM) delay determines the time at which the FSCM begins to monitor the system clock source after the SYSRST signal is released.

7.3 Brown-out Reset (BOR)

PIC24FJ128GL306 family devices implement a BOR circuit that provides the user with several configuration and power-saving options. The BOR is controlled by the BOREN[1:0] (FPOR[1:0]) Configuration bits.

When BOR is enabled, any drop of VDD below the BOR threshold results in a device BOR. Threshold levels are described in **Section 30.1 "DC Characteristics"**.

7.4 Low-Power BOR (LPBOR)

Low-Power BOR is implemented to provide downside protection when BOR is disabled.

- LPBOR re-arms the POR to ensure that the device will reset if VDD drops below the POR threshold. The LPBOR trip point is around 2.0V.
- LPBOR is selected in the configuration through the DNVPEN bit in the FPOR Configuration register.

Because it is designed for very low-current consumption, accuracy may vary slightly.

7.5 Clock Source Selection at Reset

If clock switching is enabled, the system clock source at device Reset is chosen, as shown in Table 7-2. If clock switching is disabled, the system clock source is always selected according to the Oscillator Configuration bits. For more information, refer to "Oscillator" (www.microchip.com/DS39700) in the "dsPIC33/PIC24 Family Reference Manual".

TABLE 7-2:	OSCILLATOR SELECTION vs.
	TYPE OF RESET (CLOCK
	SWITCHING ENABLED)

Reset Type	Clock Source Determinant			
POR	FNOSC[2:0] Configuration bits			
BOR	(FOSCSEL[2:0])			
MCLR				
WDTO	COSC[2:0] Control bits (OSCCON[14:12])			
SWR				

Reset Type	Clock Source	SYSRST Delay	System Clock Delay	Notes
POR	EC	TPOR + TSTARTUP + TRST	_	1, 2, 3
	ECPLL	TPOR + TSTARTUP + TRST	Тьоск	1, 2, 3, 5
	XT, HS, SOSC	TPOR + TSTARTUP + TRST	Тоѕт	1, 2, 3, 4
	XTPLL, HSPLL	TPOR + TSTARTUP + TRST	Tost + Tlock	1, 2, 3, 4, 5
	FRC, OSCFDIV	TPOR + TSTARTUP + TRST	TFRC	1, 2, 3, 6, 7
	FRCPLL	TPOR + TSTARTUP + TRST	TFRC + TLOCK	1, 2, 3, 5, 6
	LPRC	TPOR + TSTARTUP + TRST	Tlprc	1, 2, 3, 6
BOR	EC	TSTARTUP + TRST	—	2, 3
	ECPLL	TSTARTUP + TRST	Тьоск	2, 3, 5
	XT, HS, SOSC	TSTARTUP + TRST	Тоѕт	2, 3, 4
	XTPLL, HSPLL	TSTARTUP + TRST	Tost + Tlock	2, 3, 4, 5
	FRC, OSCFDIV	TSTARTUP + TRST	TFRC	2, 3, 6, 7
	FRCPLL	TSTARTUP + TRST	TFRC + TLOCK	2, 3, 5, 6
	LPRC	TSTARTUP + TRST	Tlprc	2, 3, 6
MCLR	Any Clock	Trst	_	3
WDT	Any Clock	Trst	—	3
Software	Any clock	Trst	—	3
Illegal Opcode	Any Clock	Trst	—	3
Uninitialized W	Any Clock	Trst	—	3
Trap Conflict	Any Clock	Trst	_	3

TABLE 7-3: RESET DELAY TIMES FOR VARIOUS DEVICE RESETS

Note 1: TPOR = Power-on Reset delay (10 µs nominal).

- **2:** TSTARTUP = TVREG.
- 3: TRST = Internal State Reset Time (2 µs nominal).
- **4:** TOST = Oscillator Start-up Timer (OST). A 10-bit counter counts 1024 oscillator periods before releasing the oscillator clock to the system.
- **5:** TLOCK = PLL Lock Time.
- 6: TFRC and TLPRC = RC Oscillator Start-up Times.
- 7: If Two-Speed Start-up is enabled, regardless of the Primary Oscillator selected, the device starts with FRC so the system clock delay is just TFRC, and in such cases, FRC start-up time is valid; it switches to the Primary Oscillator after its respective clock delay.

7.5.1 POR AND LONG OSCILLATOR START-UP TIMES

The oscillator start-up circuitry and its associated delay timers are not linked to the device Reset delays that occur at power-up. Some crystal circuits (especially low-frequency crystals) will have a relatively long start-up time. Therefore, <u>one or more of the following conditions</u> is possible after SYSRST is released:

- The oscillator circuit has not begun to oscillate.
- The Oscillator Start-up Timer has not expired (if a crystal oscillator is used).
- The PLL has not achieved a lock (if PLL is used).

The device will not begin to execute code until a valid clock source has been released to the system. Therefore, the oscillator and PLL start-up delays must be considered when the Reset delay time must be known.

7.5.2 FAIL-SAFE CLOCK MONITOR (FSCM) AND DEVICE RESETS

If the FSCM is enabled, it will begin to monitor the system clock source when SYSRST is released. If a valid clock source is not available at this time, the device will automatically switch to the FRC Oscillator and the user can switch to the desired crystal oscillator in the Trap Service Routine (TSR).

8.0 INTERRUPT CONTROLLER

- Note 1: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to "Interrupts" (www.microchip.com/DS70000600) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.
 - Some registers and associated bits described in this section may not be available on all devices. Refer to Section 4.0 "Memory Organization" in this data sheet for device-specific register and bit information.

The PIC24FJ128GL306 family interrupt controller reduces the numerous peripheral interrupt request signals to a single interrupt request signal to the PIC24FJ128GL306 family CPU.

The interrupt controller has the following features:

- Up to Eight Processor Exceptions and Software Traps
- Seven User-Selectable Priority Levels
- Interrupt Vector Table (IVT) with a Unique Vector for Each Interrupt or Exception Source
- Fixed Priority within a Specified User Priority Level
- Fixed Interrupt Entry and Return Latencies

8.1 Interrupt Vector Table

The PIC24FJ128GL306 family IVT, shown in Figure 8-1, resides in program memory starting at location, 000004h. The IVT contains six non-maskable trap vectors and up to 118 sources of interrupt. In general, each interrupt source has its own vector. Each interrupt vector contains a 24-bit wide address. The value programmed into each interrupt vector location is the starting address of the associated Interrupt Service Routine (ISR).

Interrupt vectors are prioritized in terms of their natural priority. This priority is linked to their position in the vector table. Lower addresses generally have a higher natural priority. For example, the interrupt associated with Vector 0 takes priority over interrupts at any other vector address.

8.1.1 ALTERNATE INTERRUPT VECTOR TABLE

The Alternate Interrupt Vector Table (AIVT) is located after the IVT, as shown in Figure 8-1. The AIVTEN (INTCON2[8]) control bit provides access to the AIVT. If the AIVTEN bit is set, all interrupt and exception processes will use the alternate vectors instead of the default vectors. The alternate vectors are organized in the same manner as the default vectors.

The AIVT is available only if the Boot Segment has been defined and the AIVT has been enabled. To enable the AIVT, both the Configuration bit, AIVTDIS (FSEC[15]), and the AIVTEN bit (INTCON2[8] in the SFR), have to be set. When the AIVT is enabled, all interrupts and exception processes use the alternate vectors instead of the default vectors. The AIVT begins at the start of the last page of the Boot Segment (BS) defined by the BSLIM[12:0] bits. The AIVT address is: (BSLIM[12:0] – 1) x 0x800.

8.2 Reset Sequence

A device Reset is not a true exception because the interrupt controller is not involved in the Reset process. The PIC24FJ128GL306 family devices clear their registers in response to a Reset, which forces the PC to zero. The device then begins program execution at location, 0x000000. A GOTO instruction at the Reset address can redirect program execution to the appropriate start-up routine.

Note: Any unimplemented or unused vector locations in the IVT should be programmed with the address of a default interrupt handler routine that contains a RESET instruction.

FIGURE 8-1: PIC24F INTERRUPT VECTOR TABLES

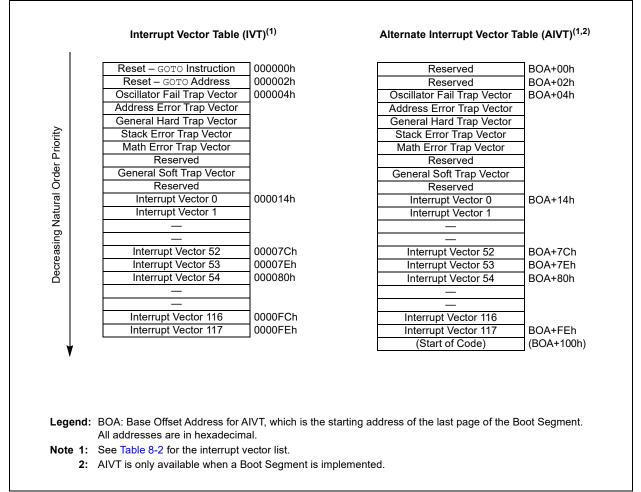


TABLE 8-1: TRAP VECTOR DETAILS

Vector Number	IVT Address	AIVT Address	Trap Source	MPLAB [®] XC16 ISR Name
0	000004h	BOA+04h	Oscillator Failure	_Oscillator Fail
1	000006h	BOA+06h	Address Error	_AddressError
2	000008h	BOA+08h	General Hardware Error	_NVMError
3	00000Ah	BOA+0Ah	Stack Error	_StackError
4	00000Ch	BOA+0Ch	Math Error	_MathError
5	00000Eh	BOA+0Eh	Reserved	Reserved
6	000010h	BOA+10h	General Software Error	_GeneralError
7	000012h	BOA+12h	Reserved	Reserved

Legend: BOA = Base Offset Address for AIVT segment, which is the starting address of the last page of the Boot Segment.

TABLE 8-2 :	INTERRUPT VECTOR DETAILS

Interrupt Description	MPLAB [®] XC16	Vector	IRQ	IVT Address	Inte	errupt Bit L	ocation
Interrupt Description	ISR Name	#	#	IVI Address	Flag	Enable	Priority
	F	lighest Na	tural Orde	r Priority			
External Interrupt 0	_INT0Interrupt	8	0	000014h	IFS0[0]	IEC0[0]	IPC0[2:0]
Capture/Compare/Timer1	_CCT1Interrupt	9	1	000016h	IFS0[1]	IEC0[1]	IPC0[6:4]
Capture/Compare/Timer2	_CCT2Interrupt	10	2	000018h	IFS0[2]	IEC0[2]	IPC0[10:8]
Timer1	_T1Interrupt	11	3	00001Ah	IFS0[3]	IEC0[3]	IPC0[14:12]
Direct Memory Access 0	_DMA0Interrupt	12	4	00001Ch	IFS0[4]	IEC0[4]	IPC1[2:0]
Reserved	Reserved	13-14	5-6	00001Eh-000020h	—	—	_
Timer2	_T2Interrupt	15	7	000022h	IFS0[7]	IEC0[7]	IPC1[14:12]
Timer3	_T3Interrupt	16	8	000024h	IFS0[8]	IEC0[8]	IPC2[2:0]
SPI1 General	_SPI1Interrupt	17	9	000026h	IFS0[9]	IEC0[9]	IPC2[6:4]
SPI1 Transfer Done	_SPI1TXInterrupt	18	10	000028h	IFS0[10]	IEC0[10]	IPC2[10:8]
UART1 Receiver	_U1RXInterrupt	19	11	00002Ah	IFS0[11]	IEC0[11]	IPC2[14:12]
UART1 Transmitter	U1TXInterrupt	20	12	00002Ch	IFS0[12]	IEC0[12]	IPC3[2:0]
A/D Converter 1	_ADC1Interrupt	21	13	00002Eh	IFS0[13]	IEC0[13]	IPC3[6:4]
Direct Memory Access 1	_DMA1Interrupt	22	14	000030h	IFS0[14]	IEC0[14]	IPC3[10:8]
NVM Program/Erase Complete	_NVMInterrupt	23	15	000032h	IFS0[15]	IEC0[15]	IPC3[14:12]
I2C1 Slave Events	_SI2C1Interrupt	24	16	000034h	IFS1[0]	IEC1[0]	IPC4[2:0]
I2C1 Master Events	_MI2C1Interrupt	25	17	000036h	IFS1[1]	IEC1[1]	IPC4[6:4]
Comparator	_CompInterrupt	26	18	000038h	IFS1[2]	IEC1[2]	IPC4[10:8]
Interrupt-on-Change Interrupt	_IOCInterrupt	27	19	00003Ah	IFS1[3]	IEC1[3]	IPC4[14:12]
External Interrupt 1	_INT1Interrupt	28	20	00003Ch	IFS1[4]	IEC1[4]	IPC5[2:0]
Reserved	Reserved	29	21	00003Eh	_	_	_
Capture/Compare 5	_CCP5Interrupt	30	22	000040h	IFS1[6]	IEC1[6]	IPC5[10:8]
Reserved	Reserved	31	23	000042h	—	—	_
Direct Memory Access 2	_DMA2Interrupt	32	24	000044h	IFS1[8]	IEC1[8]	IPC6[2:0]
Reserved	Reserved	33-34	25-26	000046h-000048h	_	_	_
Timer4	_T4Interrupt	35	27	00004Ah	IFS1[11]	IEC1[11]	IPC6[14:12]
Timer5	_T5Interrupt	36	28	00004Ch	IFS1[12]	IEC1[12]	IPC7[4:2]
External Interrupt 2	_INT2Interrupt	37	29	00004Eh	IFS1[13]	IEC1[13]	IPC7[6:4]
UART2 Receiver	_U2RXInterrupt	38	30	000050h	IFS1[14]	IEC1[14]	IPC7[10:8]
UART2 Transmitter	_U2TXInterrupt	39	31	000052h	IFS1[15]	IEC1[15]	IPC7[14:12]
SPI2 General	_SPI2Interrupt	40	32	000054h	IFS2[0]	IEC2[0]	IPC8[2:0]
SPI2 Transfer Done	_SPI2TXInterrupt	41	33	000056h	IFS2[1]	IEC2[1]	IPC8[6:4]
Reserved	Reserved	42-43	34-35	000058h-00005Ah	—	_	
Direct Memory Access 3	_DMA3Interrupt	44	36	00005Ch	IFS2[4]	IEC2[4]	IPC9[2:0]
Reserved	Reserved	45-50	37-42	00005Eh-000068h	—	—	_
Capture/Compare/Timer3	_CCT3Interrupt	51	43	00006Ah	IFS2[11]	IEC2[11]	IPC10[14:12]
Capture/Compare/Timer4	_CCT4Interrupt	52	44	00006Ch	IFS2[12]	IEC2[12]	IPC11[2:0]
Reserved	Reserved	53	45	00006Eh	—	—	_
Direct Memory Access 4	_DMA4Interrupt	54	46	000070h	IFS2[14]	IEC2[14]	IPC11[10:8]
Capture/Compare/Timer5	_CCT5Interrupt	55	47	000072h	IFS2[15]	IEC2[15]	IPC11[14:12]
Reserved	Reserved	56	48	000074h	_	_	_
I2C2 Slave Events	_SI2C2Interrupt	57	49	000076h	IFS3[1]	IEC3[1]	IPC12[6:4]
I2C2 Master Events	_MI2C2Interrupt	58	50	000078h	IFS3[2]	IEC3[2]	IPC12[10:8]
Reserved	Reserved	59-60	51-52	00007Ah-00007Ch		_	_

TABLE 8-2: INTERRUPT VECTOR DETAILS (CONTINUED)

Interrupt Description	MPLAB [®] XC16	Vector	IRQ	IVT Address	Inte	errupt Bit L	ocation
	ISR Name	#	#	IVI Address	Flag	Enable	Priority
External Interrupt 3	_INT3Interrupt	61	53	00007Eh	IFS3[5]	IEC3[5]	IPC13[6:4]
External Interrupt 4	_INT4Interrupt	62	54	000080h	IFS3[6]	IEC3[6]	IPC13[10:8]
Reserved	Reserved	63-65	55-57	000082h-000086h	_	_	_
SPI1 Receive Done	_SPI1RXInterrupt	66	58	000088h	IFS3[10]	IEC3[10]	IPC14[10:8]
SPI2 Receive Done	_SPI2RXInterrupt	67	59	00008Ah	IFS3[11]	IEC3[11]	IPC14[14:12]
Reserved	Reserved	68	60	00008Ch	_	—	
Direct Memory Access 5	_DMA5Interrupt	69	61	00008Eh	IFS3[13]	IEC3[13]	IPC15[6:4]
Real-Time Clock and Calendar	_RTCCInterrupt	70	62	000090h	IFS3[14]	IEC3[14]	IPC15[10:8]
Capture/Compare 1	_CCP1Interrupt	71	63	000092h	IFS3[15]	IEC3[15]	IPC15[14:12]
Capture/Compare 2	_CCP2Interrupt	72	64	000094h	IFS4[0]	IEC4[0]	IPC16[2:0]
UART1 Error	_U1EInterrupt	73	65	000096h	IFS4[1]	IEC4[1]	IPC16[6:4]
UART2 Error	_U2EInterrupt	74	66	000098h	IFS4[2]	IEC4[2]	IPC16[10:8]
Cyclic Redundancy Check	_CRCInterrupt	75	67	00009Ah	IFS4[3]	IEC4[3]	IPC16[14:12]
Reserved	Reserved	76-79	68-71	00009Ch-0000A2h	_	_	
High/Low-Voltage Detect	_HLVDInterrupt	80	72	0000A4h	IFS4[8]	IEC4[8]	IPC18[2:0]
Reserved	Reserved	81-88	73-80	0000A6h-0000B4h	_	_	—
UART3 Error	_U3EInterrupt	89	81	0000B6h	IFS5[1]	IEC5[1]	IPC20[6:4]
UART3 Receiver	_U3RXInterrupt	90	82	0000B8h	IFS5[2]	IEC5[2]	IPC20[10:8]
UART3 Transmitter	_U3TXInterrupt	91	83	0000BAh	IFS5[3]	IEC5[3]	IPC20[14:12]
I2C1 Bus Collision	_I2C1BCInterrupt	92	84	0000BCh	IFS5[4]	IEC5[4]	IPC21[2:0]
I2C2 Bus Collision	_I2C2BCInterrupt	93	85	0000BEh	IFS5[5]	IEC5[5]	IPC21[6:4]
Reserved	Reserved	94	86	0000C0h	_	—	—
UART4 Error	_U4EInterrupt	95	87	0000C2h	IFS5[7]	IEC5[7]	IPC21[14:12]
UART4 Receiver	_U4RXInterrupt	96	88	0000C4h	IFS5[8]	IEC5[8]	IPC22[2:0]
UART4 Transmitter	_U4TXInterrupt	97	89	0000C6h	IFS5[9]	IEC5[9]	IPC20[6:4]
Reserved	Reserved	98-101	90-93	0000C8h-0000CEh	_	—	_
Capture/Compare 3	_CCP3Interrupt	102	94	0000D0h	IFS5[14]	IEC5[14]	IPC23[10:8]
Capture/Compare 4	_CCP4Interrupt	103	95	0000D2h	IFS5[15]	IEC5[15]	IPC23[14:12]
Configurable Logic Cell 1	_CLC1Interrupt	104	96	0000D4h	IFS6[0]	IEC6[0]	IPC24[2:0]
Configurable Logic Cell 2	_CLC2Interrupt	105	97	0000D6h	IFS6[1]	IEC6[1]	IPC24[6:4]
Configurable Logic Cell 3	_CLC3Interrupt	106	98	0000D8h	IFS6[2]	IEC6[2]	IPC24[10:8]
Configurable Logic Cell 4	_CLC4Interrupt	107	99	0000DAh	IFS6[3]	IEC6[3]	IPC24[14:12]
LCD – Liquid Crystal Display	_LCDInterrupt	108	100	0000DCh	IFS6[4]	IEC6[4]	IPC25[2:0]
LCD Automation Timer	_LCDATInterrupt	109	101	0000DEh	IFS6[5]	IEC6[5]	IPC25[6:4]
Reserved	Reserved	110-113	102-105	0000E0h-0000E6h	_	_	_
FRC Self-Tuning Interrupt	_FSTInterrupt	114	106	0000E8h	IFS6[10]	IEC6[10]	IPC26[10:8]
Reserved	Reserved	115	107	0000EAh	_	_	_
ECC Single-Bit Error	_ECCSBEInterrupt	116	108	0000ECh	IFS6[12]	IEC6[12]	IPC27[2:0]
Reserved	Reserved	117	109	0000EEh	_	_	_
Real-Time Clock Timestamp	RTCCTSInterrupt	118	110	0000F0h	IFS6[14]	IEC6[14]	IPC27[10:8]
Reserved	Reserved	119-124	111-116	0000F2h-0000FCh	_	_	
JTAG	JTAGInterrupt	125	117	0000FEh	IFS7[5]	IEC7[5]	IPC29[6:4]

TABLE 8-3: INTERRUPT FLAG REGISTERS

Register	Address	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IFS0	0088h	NVMIF	DMA1IF	AD1IF	U1TXIF	U1RXIF	SPI1TXIF	SPI1IF	T3IF	T2IF	_	—	DMA0IF	T1IF	CCT2IF	CCT1IF	INT0IF
IFS1	008Ah	U2TXIF	U2RXIF	INT2IF	T5IF	T4IF	—	_	DMA2IF	_	CCP5IF	_	INT1IF	IOCIF	CMIF	MI2C1IF	SI2C1IF
IFS2	008Ch	CCT5IF	DMA4IF	_	CCT4IF	CCT3IF	_	_	_	_	_	_	DMA3IF	_	_	SPI2TXIF	SPI2IF
IFS3	008Eh	CCP1IF	RTCIF	DMA5IF	_	SPI2RXIF	SPI1RXIF	_	_	_	INT4IF	INT3IF	_	_	MI2C2IF	SI2C2IF	_
IFS4	0090h		_	_	_	_	_	_	HLVDIF	_	_	_	_	CRCIF	U2ERIF	U1ERIF	CCP2IF
IFS5	0092h	CCP4IF	CCP3IF	_	_	_	_	U4TXIF	U4RXIF	U4ERIF	_	I2C2BCIF	I2C1BCIF	U3TXIF	U3RXIF	U3ERIF	_
IFS6	0094h		RTCCTSIF	_	ECCSBEIF	_	FSTIF	_	_	_	_	LCDATIF	LCDIF	CLC4IF	CLC3IF	CLC2IF	CLC1IF
IFS7	0096h	_			_	_	_		—		_	JTAGIF	_	—		—	—

TABLE 8-4: INTERRUPT ENABLE REGISTERS

Register	Address	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IEC0	0098h	NVMIE	DMA1IE	AD1IE	U1TXIE	U1RXIE	SPI1TXIE	SPI1IE	T3IE	T2IE	—	—	DMA0IE	T1IE	CCT2IE	CCT1IE	INT0IE
IEC1	009Ah	U2TXIE	U2RXIE	INT2IE	T5IE	T4IE		—	DMA2IE	—	CCP5IE		INT1IE	IOCIE	CMIE	MI2C1IE	SI2C1IE
IEC2	009Ch	CCT5IE	DMA4IE	_	CCT4IE	CCT3IE		—	_	—	—		DMA3IE		_	SPI2TXIE	SPI2IE
IEC3	009Eh	CCP1IE	RTCIE	DMA5IE	_	SPI2RXIE	SPI1RXIE	—	_	—	INT4IE	INT3IE			MI2C2IE	SI2C2IE	—
IEC4	00A0h	_	_	_	_			—	HLVDIE	—	—			CRCIE	U2ERIE	U1ERIE	CCP2IE
IEC5	00A2h	CCP4IE	CCP3IE	_	—	_		U4TXIE	U4RXIE	U4ERIE	—	I2C2BCIE	I2C1BCIE	U3TXIE	U3RXIE	U3ERIE	—
IEC6	00A4h	_	RTCCTSIE	_	ECCSBEIE	_	FSTIE	—	_	_	—	LCDATIE	LCDIE	CLC4IE	CLC3IE	CLC2IE	CLC1IE
IEC7	00A6h	_	_	_	_	_	_	—	_	_	—	JTAGIE		_	_	_	—

Register	Address	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IPC0	00A8h	—		T1IP[2:0]		—	С	CT2IP[2:0]		—	С	CT1IP[2:0]		—	11	NT0IP[2:0]	
IPC1	00AAh	_		T2IP[2:0]		—	_	—	-	_	_	_		—	D	MA0IP[2:0]	
IPC2	00ACh	_	ι	J1RXIP[2:0]		—	SF	PI1TXIP[2:0]		_	S	SPI1IP[2:0]		—		T3IP[2:0]	
IPC3	00AEh	_		NVMIP[2:0]		—	D	MA1IP[2:0]		—		AD1IP[2:0]		—	U	1TXIP[2:0]	
IPC4	00B0h	—		IOCIP[2:0]		—		CMIP[2:0]		—	N	I2C1IP[2:0]		—	S	2C1IP[2:0]	
IPC5	00B2h	—	_	—	_	—	С	CP5IP[2:0]		—	—	—	—	—	1	NT1IP[2:0]	
IPC6	00B4h	—		T4IP[2:0]		—	—	—	_	—	—	—	—	—	D	MA2IP[2:0]	
IPC7	00B6h	—	ι	J2TXIP[2:0]		—	U	2RXIP[2:0]		_		NT2IP[2:0]		—		T5IP[2:0]	
IPC8	00B8h		_	_	_	—	_			_	SI	PI2TXIP[2:0]		—	S	PI2IP[2:0]	
IPC9	00BAh	_	_	—	_	—	_			_	_		_	—	D	MA3IP[2:0]	
IPC10	00BCh	—	(CCT3IP[2:0]		—	_	—	_	—	_		_	—		—	_
IPC11	00BEh	—	(CCT5IP[2:0]		—	D	MA4IP[2:0]		—	—	—	—	—	С	CT4IP[2:0]	
IPC12	00C0h	—	—	—	—	—	М	I2C2IP[2:0]		—	S	I2C2IP[2:0]		—	_	—	—
IPC13	00C2h	—	—	—	—	—	II	NT4IP[2:0]		—	1	NT3IP[2:0]		—	_	—	—
IPC14	00C4h	—		PI2RXIP[2:0	·	—		PI1RXIP[2:0]		—	—	—	—	—	_	—	_
IPC15	00C6h	—	(CCP1IP[2:0]		—	F	RTCIP[2:0]		—		MA5IP[2:0]		—	-	—	—
IPC16	00C8h	—		CRCIP[2:0]		—	U	2ERIP[2:0]		—	U	1ERIP[2:0]		—	С	CP2IP[2:0]	
IPC17	00CAh		_	—	—	—	—			—	_			—	—	—	—
IPC18	00CCh		_	_	_	—	_	_		_	_		_	—	Н	LVDIP[2:0]	
IPC19	00CEh	—	—	—	—	—	_	—	—	—	—	—	—	—	—	—	—
IPC20	00D0h	—		J3TXIP[2:0]		—	U	3RXIP[2:0]		—		3ERIP[2:0]		—	—	—	—
IPC21	00D2h	—		J4TXIP[2:0]		—	_	—	_	—		C2BCIP[2:0]		—		C1BCIP[2:0]	
IPC22	00D4h	—	—	—	_	—	_	—	—	—	L	I4TXIP[2:0]		—	U	4RXIP[2:0]	
IPC23	00D6h	—		CCP4IP[2:0]		—		CP3IP[2:0]		—	—	—	—	—	—	—	—
IPC24	00D8h			CLC4IP[2:0]				LC3IP[2:0]		_		LC2IP[2:0]		—		LC1IP[2:0]	
IPC25	00DAh		_	_	_	—		—	—	_	L	CDATIP[2:0]		_	L	.CDIP[2:0]	
IPC26	00DCh		_	—	_	—		STIP[2:0]		—	_	—	_	—	-		
IPC27	00DEh		_	—	_	—		CCTSIP[2:0		—	_	—	_	—	EC	CSBEIP[2:0]	<u> </u>
IPC28	00E0h		_	—	_	—	_	-		—	—		—	—	_	—	_
IPC29	00E2h	—	—	—	—	—	_	-	—	-	J	TAGIP[2:0]		—	_	—	—

8.3 Interrupt Resources

Many useful resources are provided on the main product page of the Microchip website for the devices listed in this data sheet.

8.3.1 KEY RESOURCES

- "Interrupts" (www.microchip.com/DS70000600) in the "dsPIC33/PIC24 Family Reference Manual"
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related "dsPIC33/PIC24 Family Reference Manual" Sections
- Development Tools

8.4 Interrupt Control and Status Registers

PIC24FJ128GL306 family devices implement the following registers for the interrupt controller:

- INTCON1
- INTCON2
- INTCON4
- IFS0 through IFS7
- IEC0 through IEC7
- IPC0 through ICP29
- INTTREG

8.4.1 INTCON1-INTCON4

Global interrupt control functions are controlled from INTCON1 and INTCON2. INTCON1 contains the Interrupt Nesting Disable (NSTDIS) bit, as well as the control and status flags for the processor trap sources.

The INTCON2 register controls global interrupt generation, the external interrupt request signal behavior and the use of the Alternate Interrupt Vector Table (AIVT).

The INTCON3 register contains the Deadman Timer (DMT) trap bit. The INTCON4 register contains the Software Generated Hard Trap (SGHT) bit and the ECC Double-Bit Error (ECCDBE) trap bit.

8.4.2 IFSx

The IFSx registers maintain all of the interrupt request flags. Each source of interrupt has a status bit, which is set by the respective peripherals or external signal, and is cleared via software.

8.4.3 IECx

The IECx registers maintain all of the interrupt enable bits. These control bits are used to individually enable interrupts from the peripherals or external signals.

8.4.4 IPCx

The IPCx registers are used to set the Interrupt Priority Level (IPL) for each source of interrupt. Each user interrupt source can be assigned to one of eight priority levels.

8.4.5 INTTREG

The INTTREG register contains the associated interrupt vector number and the new CPU Interrupt Priority Level, which are latched into the Vector Number bits (VECNUM[7:0]) and Interrupt Priority Level bits (ILR[3:0]) fields in the INTTREG register. The new Interrupt Priority Level is the priority of the pending interrupt.

The interrupt sources are assigned to the IFSx, IECx and IPCx registers in the same sequence as they are listed in Table 8-2. For example, the INT0 (External Interrupt 0) is shown as having Vector Number 8 and a natural order priority of 0. Thus, the INT0IF bit is found in IFS0[0], the INT0IE bit in IEC0[0] and the INT0IPx bits in the first position of IPC0 (IPC0[2:0]).

8.4.6 STATUS/CONTROL REGISTERS

Although these registers are not specifically part of the interrupt control hardware, two of the CPU Control registers contain bits that control interrupt functionality. For more information on these registers, refer to "CPU with Extended Data Space (EDS)" (www.microchip.com/DS39732) in the "dsPIC33/PIC24 Family Reference Manual".

- The CPU STATUS Register, SR, contains the IPL[2:0] bits (SR[7:5]). These bits indicate the current CPU Interrupt Priority Level. The user software can change the current CPU Interrupt Priority Level by writing to the IPLx bits.
- The CORCON register contains the IPL3 bit, which together with the IPL[2:0] bits, also indicates the current CPU Interrupt Priority Level. IPL3 is a read-only bit so that trap events cannot be masked by the user software.

All Interrupt registers are described in Register 8-3 through Register 8-7 in the following pages.

REGISTER 8-1: SR: ALU STATUS REGISTER⁽¹⁾

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	_	—	—	—	—	DC
bit 15			•	•	•		bit 8
R/W-0 ⁽³⁾	R/W-0 ⁽³⁾	R/W-0 ⁽³⁾	R-0	R/W-0	R/W-0	R/W-0	R/W-0
IPL2 ⁽²⁾	IPL1 ⁽²⁾	IPL0 ⁽²⁾	RA	N	OV	Z	С

bit	7
DIL	

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
-n = Value at POR	'1'= Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5	IPL[2:0]: CPU Interrupt Priority Level Status bits ^(2,3) 111 = CPU Interrupt Priority Level is 7 (15); user interrupts are disabled 110 = CPU Interrupt Priority Level is 6 (14) 101 = CPU Interrupt Priority Level is 5 (13) 100 = CPU Interrupt Priority Level is 4 (12) 011 = CPU Interrupt Priority Level is 3 (11) 010 = CPU Interrupt Priority Level is 2 (10) 001 = CPU Interrupt Priority Level is 1 (9)
	000 = CPU Interrupt Priority Level is 0 (8)

Note 1: For complete register details, see Register 3-1.

2: The IPL[2:0] Status bits are concatenated with the IPL3 Status bit (CORCON[3]) to form the CPU Interrupt Priority Level (IPL). The value in parentheses indicates the IPL when IPL3 = 1. User interrupts are disabled when IPL3 = 1.

3: The IPL[2:0] Status bits are read-only when the NSTDIS bit (INTCON1[15]) = 1.

bit 0

REGISTER 8-2:	CORCON: CPU CORE CONTROL REGISTER ⁽¹⁾

U-0 U-0 U-0 U-0 U-0 U-0 -								
U-0 U-0 U-0 R/C-0 R/W-1 U-0 — — — — IPL3 ⁽²⁾ PSV — bit 7	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
U-0 U-0 U-0 R/C-0 R/W-1 U-0 — — — — IPL3 ⁽²⁾ PSV — bit 7	—	—	—	_	—	—	—	—
— — — — IPL3 ⁽²⁾ PSV — bit 7	it 15		•					bit 8
IPL3 ⁽²⁾ PSV bit 7								
bit 7	U-0	U-0	U-0	U-0	R/C-0	R/W-1	U-0	U-0
	—	—	—	-	IPL3 ⁽²⁾	PSV	—	—
Lecend: C = Clearable bit	it 7							bit 0
Legend: $C = Clearable bit$								

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value at POR	'1'= Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-4	Unimplemented: Read as '0'
bit 3	IPL3: CPU Interrupt Priority Level Status bit ⁽²⁾
	 1 = CPU Interrupt Priority Level is greater than 7 0 = CPU Interrupt Priority Level is 7 or less
bit 2	PSV: Not used as part of the interrupt module

bit 1-0 Unimplemented: Read as '0'

Note 1: For complete register details, see Register 3-2.

2: The IPL[2:0] Status bits are concatenated with the IPL3 Status bit (CORCON[3]) to form the CPU Interrupt Priority Level (IPL). The value in parentheses indicates the IPL when IPL3 = 1. User interrupts are disabled when IPL3 = 1.

R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
NSTDIS	—	—	—	—	—	—	_
bit 15							bit 8
U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
_		_	MATHERR	ADDRERR	STKERR	OSCFAIL	_
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimplem	ented bit, read a	as '0'	
-n = Value at F	POR	'1' = Bit is set	:	'0' = Bit is clea	ired	x = Bit is unkr	nown
bit 15 bit 14-5	1 = Interrupt 0 = Interrupt Unimpleme	errupt Nesting nesting is disa nesting is ena nted: Read as	abled bled '0'				
bit 4	1 = Math err 0 = Math err	Math Error Sta or trap has occ or trap has not	curred occurred				
bit 3	ADDRERR: Address Error Trap Status bit 1 = Address error trap has occurred 0 = Address error trap has not occurred						
bit 2	STKERR: Stack Error Trap Status bit 1 = Stack error trap has occurred 0 = Stack error trap has not occurred						
bit 1	OSCFAIL: Oscillator Failure Trap Status bit 1 = Oscillator failure trap has occurred 0 = Oscillator failure trap has not occurred						
bit 0	Unimpleme	nted: Read as	'0'				

REGISTER 8-3: INTCON1: INTERRUPT CONTROL REGISTER 1

R/W-1	R-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0				
GIE	DISI	SWTRAP	_				AIVTEN				
bit 15							bit				
U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
			INT4EP	INT3EP	INT2EP	INT1EP	INTOEP				
bit 7							bit				
Legend:											
R = Readabl		W = Writable	bit		nented bit, read						
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unk	nown				
L:4 / C		l luste un unt Eurobie	. L:+								
bit 15		l Interrupt Enable ts and associate		able bite are on	ablad						
	•	its are disabled, l	•		labled						
bit 14	•	Instruction Statu									
		1 = DIST instruction is active									
	0 = DISI in	struction is not a	ctive								
bit 13	SWTRAP: S	Software Trap St	atus bit								
	1 = Software trap is enabled										
		e trap is disabled									
bit 12-9	-	ented: Read as '									
bit 8		ternate Interrupt									
		ternate Interrupt andard Interrupt			onfiguration bit	s)					
bit 7-5	Unimpleme	ented: Read as '	0'								
bit 4	INT4EP: Ex	ternal Interrupt 4	Edge Detect	Polarity Select	bit						
	1 = Interrupt on negative edge										
	0 = Interrupt on positive edge INT3EP: External Interrupt 3 Edge Detect Polarity Select bit										
bit 3			•	Polarity Select	bit						
	1 = Interrupt on negative edge 0 = Interrupt on positive edge										
bit 2	INT2EP: External Interrupt 2 Edge Detect Polarity Select bit										
	1 = Interrupt on negative edge										
		t on positive edg									
bit 1	INT1EP: Ex	ternal Interrupt 1	Edge Detect	Polarity Select	bit						
		t on negative ed									
	0 = Interrup	t on positive edg	е								
bit 0		ternal Interrupt (-	Polarity Select	bit						
		t on negative ed									
	0 – merrup	0 = Interrupt on positive edge									

REGISTER 8-4: INTCON2: INTERRUPT CONTROL REGISTER 2

REGISTER 8-	5: INTCO	INTCONS: INTERRUPT CONTROL REGISTER 3							
R/W-0	U-0	U-0	U-0	U-0	U-0	U-0			
DMT		_	—	—	—	—			
bit 15									
U-0	U-0	U-0	U-0	U-0	U-0	U-0			

INTCONS, INTERDURT CONTROL RECIETERS **REGISTER 8-5:**

bit 7			bit 0
Legend:			
D - Doodahla hit	M = Mritable bit	II = IInimplemented hit read as '0'	

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15	DMT: Deadman Timer (soft) Trap Status bit
	1 = Deadman Timer trap has occurred
	0 = Trap has not occurred

bit 14-0	Unimplemented: Read as '0'

REGISTER 8-6: INTCON4: INTERRUPT CONTROL REGISTER 4

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	_	—	—	_	_
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	R/C-0	R/C-0
—	_	—	—		—	ECCDBE	SGHT
bit 7							bit 0
Legend:		C = Clearable	e bit				
R = Readable bit W = Writable bit		bit	U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	

bit 15-2 Unimplemented: Read as '0'

- bit 1 ECCDBE: ECC Double-Bit Error Trap bit
 - 1 = ECC double-bit error trap has occurred
 - 0 = ECC double-bit error trap has not occurred
- bit 0 **SGHT:** Software Generated Hard Trap Status bit
 - 1 = Software generated hard trap has occurred
 - 0 = Software generated hard trap has not occurred

U-0 ___

U-0 ____

bit 8

R-0	U-0	R/W-0	U-0	R-0	R-0	R-0	R-0
CPUIRQ		VHOLD	_	ILR3	ILR2	ILR1	ILR0
bit 15					•		bit 8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			VECN	IUM[7:0]			
bit 7							bit (
Legend:							
R = Readable	e bit	W = Writable b	pit	U = Unimplei	mented bit, rea	d as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cle	eared	x = Bit is unkr	nown
bit 15	1 = An inter when th	terrupt Request fi rupt request has ne CPU priority is rrupt request is u	occurred bu higher than	t has not yet be the interrupt pr	een Acknowledg	ged by the CPU	; this happens
bit 14	Unimpleme	nted: Read as '0	,				
bit 13	1 = The VE 0 = The VE	ctor Number Cap CNUMx bits cont CNUMx bits con s occurred with hi	ain the value tain the valu	e of the highest le of the last A	cknowledged ir	nterrupt (i.e., the	
bit 12	Unimpleme	nted: Read as '0	,				
bit 11-8	1111 = CPL • • • • •	ew CPU Interrupt J Interrupt Priority J Interrupt Priority J Interrupt Priority	v Level is 15				
bit 7-0	VECNUM[7:	:0]: Vector Numb	er of Pendin	g Interrupt bits			
	• • 00001001 =	= 255, Reserved; = 9, CCT1, MCCF	91 timer	0			
	00000111 = 00000110 = 00000100 = 00000100 = 00000011 = 00000010 =	 8, INT0 – Extern 7, Reserved; do 6, Generic soft of 5, Reserved; do 4, Math error training 3, Stack error training 2, Generic hard 1, Address erroi 0, Oscillator fail 	o not use error trap o not use ap ap trap	U			

REGISTER 8-7: INTTREG: INTERRUPT CONTROL AND STATUS REGISTER

NOTES:

9.0 OSCILLATOR CONFIGURATION

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "Oscillator" (www.microchip.com/ DS39700) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The oscillator system for the PIC24FJ128GL306 family devices have the following features:

• An On-Chip PLL Block to Provide a Range of Frequency Options for the System Clock

- Software-Controllable Switching between Various Clock Sources
- Software-Controllable Postscaler for Selective Clocking of CPU for System Power Savings
- A Fail-Safe Clock Monitor (FSCM) that Detects Clock Failure and Permits Safe Application Recovery or Shutdown
- A Separate and Independently Configurable System Clock Output for Synchronizing External Hardware

A simplified diagram of the oscillator system is shown in Figure 9-1.

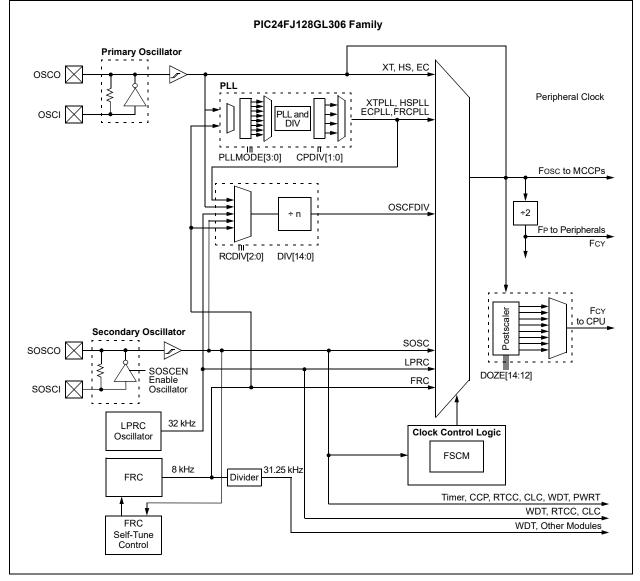


FIGURE 9-1: PIC24FJ128GL306 FAMILY CLOCK DIAGRAM

9.1 CPU Clocking Scheme

The system clock source can be provided by one of four sources:

- Primary Oscillator (POSC) on the OSCI and OSCO pins
- Secondary Oscillator (SOSC) on the SOSCI and SOSCO pins
- Fast Internal RC (FRC) Oscillator
- · Low-Power Internal RC (LPRC) Oscillator

The Primary Oscillator and FRC sources have the option of using the internal PLL block, which can generate a 4x, 6x or 8x PLL clock. If the PLL is used, the PLL clocks can then be postscaled, if necessary, and used as the system clock. Refer to **Section 9.7 "Oscillator Modes"** for additional information. The internal FRC provides an 8 MHz clock source.

Each clock source (XTPLL, ECPLL, FRCPLL, HS, XT, EC, FRC, LPRC and SOSC) can be used as an input to an additional divider, which can then be used to produce a divided clock source for use as a system clock (OSCFDIV).

The selected clock source generates the processor and peripheral clock sources. The processor clock source is divided by two to produce the internal instruction cycle clock, FCY. In this document, the instruction cycle clock is also denoted by FOSC/2. The internal instruction cycle clock, FOSC/2, can be provided on the OSCO I/O pin for some operating modes of the Primary Oscillator.

9.2 Initial Configuration on POR

The oscillator source (and operating mode) that is used at a device Power-on Reset event is selected using Configuration bit settings. The Oscillator Configuration bit settings are located in the Configuration registers in the program memory (refer to **Section 27.1 "Configuration Bits**" for further details). The Primary Oscillator Configuration bits, POSCMD[1:0] (FOSC[1:0]), and the Oscillator Select Configuration bits, FNOSC[2:0] (FOSCSEL[2:0]), select the oscillator source that is used at a Power-on Reset. The OSCFDIV clock source is the default (unprogrammed) selection; the default input source to the OSCFDIV divider is the FRC clock source. Other oscillators may be chosen by programming these bit locations.

The Configuration bits allow users to choose between the various Clock modes shown in Table 9-1.

9.2.1 CLOCK SWITCHING MODE CONFIGURATION BITS

The FCKSM[1:0] Configuration bits (FOSC[7:6]) are used to jointly configure device clock switching and the Fail-Safe Clock Monitor (FSCM). Clock switching is enabled only when FCKSM1 is programmed ('0'). The FSCM is enabled only when FCKSM[1:0] are both programmed ('00').

Oscillator Mode	Oscillator Source	POSCMD[1:0]	FNOSC[2:0]	Notes
Oscillator with Frequency Division (OSCFDIV)	Internal/External	11	111	1, 2, 3
Low-Power RC Oscillator (LPRC)	Internal	11	101	3
Secondary (Timer1) Oscillator (SOSC)	Secondary	11	100	3
Primary Oscillator (XT) with PLL Module (XTPLL)	Primary	01	011	
Primary Oscillator (EC) with PLL Module (ECPLL)	Primary	00	011	
Primary Oscillator (HS)	Primary	10	010	
Primary Oscillator (XT)	Primary	01	010	
Primary Oscillator (EC)	Primary	00	010	
Fast RC Oscillator with PLL Module (FRCPLL)	Internal	11	001	3
Fast RC Oscillator (FRC)	Internal	11	000	3

TABLE 9-1: CONFIGURATION BIT VALUES FOR CLOCK SELECTION

Note 1: The input oscillator to the OSCFDIV Clock mode is determined by the RCDIV[2:0] (CLKDIV[10:8) bits. At POR, the default value selects the FRC module.

2: This is the default Oscillator mode for an unprogrammed (erased) device.

3: OSCO pin function is determined by the OSCIOFNC Configuration bit.

9.3 Control Registers

The operation of the oscillator is controlled by five Special Function Registers:

- OSCCON
- CLKDIV
- OSCTUN
- OSCDIV
- OSCFDIV

The OSCCON register (Register 9-1) is the main control register for the oscillator. It controls clock source switching and allows the monitoring of clock sources. OSCCON is protected by a write lock to prevent inadvertent clock switches. See Section 9.4 "Clock Switching Operation" for more information.

The CLKDIV register (Register 9-2) controls the features associated with Doze mode, as well as the postscalers for the OSCFDIV Clock mode and the PLL module.

The OSCTUN register (Register 9-3) allows the user to fine-tune the FRC Oscillator over a range of approximately $\pm 1.5\%$.

The OSCDIV and OSCFDIV registers provide control for the system oscillator frequency divider.

U-0	R-x ⁽²⁾	R-x ⁽²⁾	R-x ⁽²⁾	U-0	R/W-x ⁽²⁾	R/W-x ⁽²⁾	R/W-x ⁽²⁾		
—	COSC2	COSC1	COSC0		NOSC2	NOSC1	NOSC0		
bit 15							bit		
		 (1)		-	D 444 0	D /14/0			
R/W-0	R/W-0	R-0 ⁽⁴⁾	U-0	R/CO-0	R/W-0	R/W-0	R/W-0		
CLKLOCK ⁽⁵) IOLOCK ⁽³⁾	LOCK	—	CF	POSCEN	SOSCEN	OSWEN		
bit 7							bit		
Legend:		CO = Clearat	ble Only bit						
R = Readabl	le bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'			
-n = Value at	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	own		
L:4 / C		tad. Daad as (o'						
bit 15 bit 14-12	•	ted: Read as '	o or Selection bi	+o(2)					
	110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary 001 = Fast R0	ed ower RC Oscill dary Oscillator y Oscillator wit y Oscillator (XT	(SOSC) h PLL module (ſ, HS, EC) th PLL module	(XTPLL, ECPLL	-)				
bit 11	Unimplemented: Read as '0'								
bit 10-8	111 = Oscillat 110 = Reserv 101 = Low-Po 100 = Second 011 = Primary 010 = Primary 001 = Fast R	tor with Freque red ower RC Oscill dary Oscillator y Oscillator wit y Oscillator (XT	(SOSC) h PLL module (ſ, HS, EC) th PLL module	OSCFDIV) (XTPLL, ECPLL	-)				
bit 7	If FSCM is En 1 = Clock and 0 = Clock and If FSCM is Dis Clock and PLI	abled (FCKSM d PLL selectior d PLL selectior sabled (FCKSM L selections ar	ns are locked ns are not locke <u>M[1:0] = 1x):</u> e never locked	bit ⁽⁵⁾ ed and may be and may be mo	-	-			
bit 6	IOLOCK: I/O 1 = I/O lock is 0 = I/O lock is		it ⁽³⁾						
S 2: R	OSCCON is protected by a write lock to prevent inadvertent clock switches. See Section 9.4 "Clock switching Operation" for more information. Reset values for these bits are determined by the FNOSCx Configuration bits. The state of the IOLOCK bit can only be changed once an unlocking sequence has been executed. In								
	ddition if the IOI	ition, if the IOLIVAY Configuration bit is '1', once the IOLOCK bit is set, it cannot be cleared.							
a	ddition, if the IOI his bit also reset	1WAY Config	uration bit is '1	, once the IOL	DCK bit is set, i	t cannot be cle	ared.		

REGISTER 9-1: OSCCON: OSCILLATOR CONTROL REGISTER⁽¹⁾

REGISTER 9-1: OSCCON: OSCILLATOR CONTROL REGISTER⁽¹⁾ (CONTINUED)

bit 5	LOCK: PLL Lock Status bit ⁽⁴⁾
	 1 = PLL module is in lock or PLL module start-up timer is satisfied 0 = PLL module is out of lock, PLL start-up timer is running or PLL is disabled
bit 4	Unimplemented: Read as '0'
bit 3	CF: Clock Fail Detect bit
	1 = FSCM has detected a clock failure0 = No clock failure has been detected
bit 2	POSCEN: Primary Oscillator Sleep Enable bit
	1 = Primary Oscillator continues to operate during Sleep mode0 = Primary Oscillator is disabled during Sleep mode
bit 1	SOSCEN: 32 kHz Secondary Oscillator (SOSC) Enable bit
	1 = Enables Secondary Oscillator0 = Disables Secondary Oscillator
bit 0	OSWEN: Oscillator Switch Enable bit 1 = Initiates an oscillator switch to a clock source specified by the NOSC[2:0] bits 0 = Oscillator switch is complete

- Note 1: OSCCON is protected by a write lock to prevent inadvertent clock switches. See Section 9.4 "Clock Switching Operation" for more information.
 - 2: Reset values for these bits are determined by the FNOSCx Configuration bits.
 - **3:** The state of the IOLOCK bit can only be changed once an unlocking sequence has been executed. In addition, if the IOL1WAY Configuration bit is '1', once the IOLOCK bit is set, it cannot be cleared.
 - 4: This bit also resets to '0' during any valid clock switch or whenever a non-PLL Clock mode is selected.
 - 5: When CLKLOCK is set, the NOSC[2:0], OSWEN, CPDIV[1:0] and PLLEN bits cannot be modified.

R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0		
ROI	DOZE2	DOZE1	DOZE0	DOZEN ⁽¹⁾	RCDIV2	RCDIV1	RCDIV0		
bit 15							bit 8		
	5444	D /// 0							
R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0	U-0		
CPDIV1	CPDIV0	PLLEN	—	—	_	—			
bit 7							bit		
Legend:									
R = Readable	e bit	W = Writable	bit	U = Unimplem	ented bit, read	l as '0'			
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	red	x = Bit is unkn	own		
bit 15	ROI: Recover	r on Interrupt b	it						
	1 = Interrupts	-	EN bit and res	et the CPU perip	oheral clock ra	tio to 1:1			
bit 14-12	•	CPU Peripheral							
	111 = 1:128	·							
	110 = 1:64								
	101 = 1:32 100 = 1:16								
	011 = 1:8 (de	efault)							
	010 = 1:4	,							
	001 = 1:2								
	000 = 1:1	- (1)							
bit 11		e Enable bit ⁽¹⁾							
	-	0] bits specify ipheral clock ra		neral clock ratio					
bit 10-8	•	-		ock Source Sele	ect bits				
		ved; do not use	-						
	110 = Reserv								
	101 = Low-Power RC Oscillator (LPRC) 100 = Secondary Oscillator (SOSC)								
				PLL module (X		FCP(1)			
		y Oscillator (X			IT LE, HOT LE,				
		•		nodule (FRCPLL	_)				
	000 = Fast R	C Oscillator (F	RC)						
bit 7-6	CPDIV[1:0]: System Clock Select bits (postscaler select from PLL, 32 MHz clock branch)								
	11 = 4 MHz (, ,							
	10 = 8 MHz (divide-by-4) 01 = 16 MHz (divide-by-2)								
	01 = 10 MHz 00 = 32 MHz								
bit 5	PLLEN: PLL								
	1 = PLL is alv	vays active							
		ly active when	a PLL Oscillato	or mode is selec	ted (USCCON	[14:12] = 0110	or 001)		
bit 4-0		ly active when ited: Read as '		or mode is selec	ted (USCCON	I[14:12] = 011 C	or 001)		

REGISTER 9-2: CLKDIV: CLOCK DIVIDER REGISTER

REGISTER	9-3: 0501	UN: FRC US	SCILLATOR I	UNE REGIS	IER		
R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STEN		STSIDL	STSRC ⁽¹⁾	STLOCK	STLPOL	STOR	STORPOL
bit 15							bit 8
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_				5:0] ⁽²⁾		
bit 7]		bit (
Legend:							
R = Readable	e bit	W = Writable	bit	-	nented bit, read	l as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unk	nown
=							
bit 15		Self-Tune Enab					
			led; TUNx bits bled; applicatior			INv hite	
bit 14		ted: Read as '	• •			JINA DILS	
	•						
bit 13		Self-Tune Sto	•				
		ng stops during	i iale moae uring Idle mode				
bit 12		•	ference Clock S				
DIT 12	1 = Reserved						
			match to the 32	2.768 kHz SOS	C tolerance		
bit 11		C Self-Tune L			• • • • • • • • • • • • • • • • • • • •		
2		-	tly within ±0.2%	6 of the STSRC	reference acc	uracy	
			be within ±0.2%				
bit 10	STLPOL: FR	C Self-Tune Lo	ock Interrupt Po	larity bit			
	1 = A self-tur	ne lock interrup	t is generated v	when STLOCK	is '0'		
	0 = A self-tur	ne lock interrup	t is generated v	when STLOCK	is '1'		
bit 9	STOR: FRC S	Self-Tune Out	of Range Status	s bit			
			error is beyon				ned
	0 = STSRC r	eference clock	is within the tu	nable range; tu	ning is perform	led	
bit 8	STORPOL: F	RC Self-Tune	Out of Range I	nterrupt Polarity	/ bit		
			interrupt is ger				
	0 = A self-tur	ne out of range	interrupt is ger	nerated when S	TOR is '1'		
bit 7-6	Unimplemen	ted: Read as '	0'				
Note 1: Us	se of either cloc	k tunina refere	nce source has	specific applic	ation requirem	ents. See <mark>Sec</mark>	tion 9.6 "FRC
	tive Clock Tu	•			adon roquioni		

Active Clock Tuning" for details.

2: These bits are read-only when STEN = 1.

REGISTER 9-3: OSCTUN: FRC OSCILLATOR TUNE REGISTER (CONTINUED)

- Note 1: Use of either clock tuning reference source has specific application requirements. See Section 9.6 "FRC Active Clock Tuning" for details.
 - 2: These bits are read-only when STEN = 1.

Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 15 Unimplemented: Read as '0'									
kit 15 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 DIV[7:0] DIV[7:0] bit 7 DIV[7:0] Legend: W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 15 Unimplemented: Read as '0' bit 15 DIV[14:0]: Reference Clock Divider bits Specifies the 1/2 period of the reference source * 2] * DIV[14:0]). 11111111111111 Oscillator frequency divided by 65,534 (32,767 * 2) 11111111111111 Oscillator frequency divided by 65,532 (32,766 * 2) • • • • 0000000000011 = Oscillator frequency divided by 6 (3 * 2) 0000000000011 = Oscillator frequency divided by 4 (2 * 2) 0000000000011 = Oscillator frequency divided by 4 (2 * 2) 0000000000011 = Oscillator frequency divided by 2 (1 * 2) (default)	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 DIV[7:0] DIV[7:0] bit 7 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 15 Unimplemented: Read as '0' bit 15 DIV[14:0]: Reference Clock Divider bits Specifies the 1/2 period of the reference clock in the source clocks (ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 11111111111111 Oscillator frequency divided by 65,534 (32,767 * 2) 111111111111110 Oscillator frequency divided by 65,532 (32,766 * 2) • • 0000000000011 = Oscillator frequency divided by 6 (3 * 2) 0000000000011 = Oscillator frequency divided by 4 (2 * 2) 0000000000010 = Oscillator frequency divided by 4 (2 * 2) 0000000000011 = Oscillator frequency divided by 2 (1 * 2) (default)	—				DIV[14:8]				
DIV[7:0] bit 7 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 15 Unimplemented: Read as '0' bit 14-0 DIV[14:0]: Reference Clock Divider bits Specifies the 1/2 period of the reference clock in the source clocks (ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 1111111111111 Oscillator frequency divided by 65,534 (32,767 * 2) 11111111111111 Oscillator frequency divided by 65,532 (32,766 * 2) • • • • 00000000000011 = Oscillator frequency divided by 6 (3 * 2) 00000000000010 = Oscillator frequency divided by 4 (2 * 2) 0000000000001 = Oscillator frequency divided by 2 (1 * 2) (default)	bit 15							bit	
DIV[7:0] bit 7 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 15 Unimplemented: Read as '0' bit 14-0 DIV[14:0]: Reference Clock Divider bits Specifies the 1/2 period of the reference clock in the source clocks (ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 1111111111111 Oscillator frequency divided by 65,534 (32,767 * 2) 11111111111111 Oscillator frequency divided by 65,532 (32,766 * 2) • • 00000000000011 Oscillator frequency divided by 6 (3 * 2) 00000000000011 Oscillator frequency divided by 4 (2 * 2) 0000000000001 Oscillator frequency divided by 2 (1 * 2) (default)	R/W-0	R/W-0	R/W-0	R/W/-0	R/W-0	R/W-0	R/\\\-0	R/W-1	
bit 7 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 15 Unimplemented: Read as '0' bit 14-0 DIV[14:0]: Reference Clock Divider bits Specifies the 1/2 period of the reference clock in the source clocks (ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 111111111111111 = Oscillator frequency divided by 65,534 (32,767 * 2) 111111111111110 = Oscillator frequency divided by 65,532 (32,766 * 2) • • • • 0000000000011 = Oscillator frequency divided by 6 (3 * 2) 0000000000011 = Oscillator frequency divided by 4 (2 * 2) 0000000000010 = Oscillator frequency divided by 2 (1 * 2) (default)	10,00-0	10,00-0	10,00-0			10,00-0	10,00-0	10/00-1	
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 15 Unimplemented: Read as '0' bit 14-0 DIV[14:0]: Reference Clock Divider bits Specifies the 1/2 period of the reference clock in the source clocks (ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 111111111111111111111111111111111111	bit 7			DI	11.0]			bit	
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 15 Unimplemented: Read as '0' bit 14-0 DIV[14:0]: Reference Clock Divider bits Specifies the 1/2 period of the reference clock in the source clocks (ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 111111111111111111111111111111111111									
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown bit 15 Unimplemented: Read as '0' bit 14-0 DIV[14:0]: Reference Clock Divider bits Specifies the 1/2 period of the reference clock in the source clocks (ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 11111111111111 = Oscillator frequency divided by 65,534 (32,767 * 2) 11111111111111 = Oscillator frequency divided by 65,532 (32,766 * 2) • • • • 0000000000011 = Oscillator frequency divided by 6 (3 * 2) 0000000000010 = Oscillator frequency divided by 4 (2 * 2) 0000000000011 = Oscillator frequency divided by 2 (1 * 2) (default)	Legend:								
bit 15 Unimplemented: Read as '0' bit 14-0 DIV[14:0]: Reference Clock Divider bits Specifies the 1/2 period of the reference clock in the source clocks (ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 111111111111111 = Oscillator frequency divided by 65,534 (32,767 * 2) 111111111111111 = Oscillator frequency divided by 65,532 (32,766 * 2) • • • • • • • • • • • • • • • • • • •	R = Reada	ble bit	W = Writable bit		U = Unimplem	nented bit, rea	d as '0'		
<pre>bit 14-0 DIV[14:0]: Reference Clock Divider bits Specifies the 1/2 period of the reference clock in the source clocks (ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 111111111111111 = Oscillator frequency divided by 65,534 (32,767 * 2) 111111111111111 = Oscillator frequency divided by 65,532 (32,766 * 2)</pre>	-n = Value	at POR	'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown		
<pre>bit 14-0 DIV[14:0]: Reference Clock Divider bits Specifies the 1/2 period of the reference clock in the source clocks (ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 1111111111111111 = Oscillator frequency divided by 65,534 (32,767 * 2) 111111111111111 = Oscillator frequency divided by 65,532 (32,766 * 2)</pre>									
Specifies the 1/2 period of the reference clock in the source clocks (ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 11111111111111 = Oscillator frequency divided by 65,534 (32,767 * 2) 11111111111111 = Oscillator frequency divided by 65,532 (32,766 * 2) • • • • • • • • • • • • • • • • • • •	bit 15	Unimpleme	nted: Read as '0'						
<pre>(ex: Period of ref_clk_output = [Reference Source * 2] * DIV[14:0]). 111111111111111 = Oscillator frequency divided by 65,534 (32,767 * 2) 1111111111111111 = Oscillator frequency divided by 65,532 (32,766 * 2)</pre>	bit 14-0	DIV[14:0]: F	Reference Clock Di	vider bits					
00000000000000000000000000000000000000		(ex: Period of 111111111	of ref_clk_output = 1111111 = Oscillato	[Reference or frequency	Source * 2] * DI y divided by 65,8	IV[14:0]). 534 (32,767 * :			
		000000000 000000000	000010 = Oscillato 000001 = Oscillato	or frequency or frequency	y divided by 4 (2 y divided by 2 (1	2 * 2) * 2) (default)			

REGISTER 9-5: OSCFDIV: OSCILLATOR FRACTIONAL DIVISOR REGISTER⁽¹⁾

_								
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
			TRI	V[0:7]				
bit 15							bit 8	
R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
TRIM8	_		_					
bit 7				•	•	•	bit 0	
Legend:								
R = Readable	e bit	W = Writable b	oit	U = Unimplem	nented bit, read	l as '0'		
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	= Bit is unknown	
bit 15-7	TRIM[0:8] Tri	m bits						
		tional additive to	the DIV[14:0] bits value for t	he 1/2 period c	of the oscillator	clock.	
		0 = 0/512 (0.0)						
		1 = 1/512 (0.00						
0000_0001_0 = 2/512 (0.00390625) divisor added to DIVx value								
	•							
	•							
	• 100000000 = 256/512 (0.5000) divisor added to DIVx value							
	•							
	•							
	1111 1111	0 = 510/512 (0.9	99609375) div	isor added to D	DIVx value			
		1 = 511/512 (0.9						
bit 6-0	Unimplemen	ted: Read as '0	,					
	•							

Note 1: TRIMx values greater than zero are ONLY valid when DIVx values are greater than zero.

9.4 Clock Switching Operation

With few limitations, applications are free to switch between any of the four clock sources (POSC, SOSC, FRC and LPRC) under software control and at any time. To limit the possible side effects that could result from this flexibility, PIC24F devices have a safeguard lock built into the switching process.

Note:	The Primary Oscillator mode has three
	different submodes (XT, HS and EC),
	which are determined by the POSCMDx
	Configuration bits. While an application
	can switch to and from Primary Oscillator
	mode in software, it cannot switch
	between the different primary submodes
	without reprogramming the device.

9.4.1 ENABLING CLOCK SWITCHING

To enable clock switching, the FCKSM1 Configuration bit in FOSC must be programmed to '0'. (Refer to **Section 27.1 "Configuration Bits**" for further details.) If the FCKSM1 Configuration bit is unprogrammed ('1'), the clock switching function and Fail-Safe Clock Monitor function are disabled; this is the default setting.

The NOSCx control bits (OSCCON[10:8]) do not control the clock selection when clock switching is disabled. However, the COSC[2:0] bits (OSCCON[14:12]) will reflect the clock source selected by the FNOSCx Configuration bits.

The OSWEN control bit (OSCCON[0]) has no effect when clock switching is disabled; it is held at '0' at all times.

9.4.2 OSCILLATOR SWITCHING SEQUENCE

At a minimum, performing a clock switch requires this basic sequence:

- 1. If desired, read the COSCx bits (OSCCON[14:12]) to determine the current oscillator source.
- 2. Perform the unlock sequence to allow a write to the OSCCON register high byte.
- 3. Write the appropriate value to the NOSCx bits (OSCCON[10:8]) for the new oscillator source.
- 4. Perform the unlock sequence to allow a write to the OSCCON register low byte.
- 5. Set the OSWEN bit to initiate the oscillator switch.

Once the basic sequence is completed, the system clock hardware responds automatically as follows:

- 1. The clock switching hardware compares the COSCx bits with the new value of the NOSCx bits. If they are the same, then the clock switch is a redundant operation. In this case, the OSWEN bit is cleared automatically and the clock switch is aborted.
- If a valid clock switch has been initiated, the LOCK (OSCCON[5]) and CF (OSCCON[3]) bits are cleared.
- The new oscillator is turned on by the hardware if it is not currently running. If a crystal oscillator must be turned on, the hardware will wait until the OST expires. If the new source is using the PLL, then the hardware waits until a PLL lock is detected (LOCK = 1).
- 4. The hardware waits for ten clock cycles from the new clock source and then performs the clock switch.
- 5. The hardware clears the OSWEN bit to indicate a successful clock transition. In addition, the NOSCx bits value is transferred to the COSCx bits.
- The old clock source is turned off at this time, with the exception of LPRC (if WDT or FSCM is enabled) or SOSC (if SOSCEN remains set).

Note 1: The processor will continue to execute code throughout the clock switching sequence. Timing-sensitive code should not be executed during this time.

2: Direct clock switches between any Primary Oscillator mode with PLL and FRCPLL mode are not permitted. This applies to clock switches in either direction. In these instances, the application must switch to FRC mode as a transitional clock source between the two PLL modes. A recommended code sequence for a clock switch includes the following:

- 1. Disable interrupts during the OSCCON register unlock and write sequence.
- Execute the unlock sequence for the OSCCON high byte by writing 78h and 9Ah to OSCCON[15:8] in two back-to-back instructions.
- 3. Write the new oscillator source to the NOSCx bits in the instruction immediately following the unlock sequence.
- 4. Execute the unlock sequence for the OSCCON low byte by writing 46h and 57h to OSCCON[7:0] in two back-to-back instructions.
- 5. Set the OSWEN bit in the instruction immediately following the unlock sequence.
- 6. Continue to execute code that is not clock-sensitive (optional).
- 7. Invoke an appropriate amount of software delay (cycle counting) to allow the selected oscillator and/or PLL to start and stabilize.
- Check to see if OSWEN is '0'. If it is, the switch was successful. If OSWEN is still set, then check the LOCK bit to determine the cause of the failure.

The core sequence for unlocking the OSCCON register and initiating a clock switch is shown in Example 9-1.

EXAMPLE 9-1: BASIC CODE SEQUENCE FOR CLOCK SWITCHING

;Place the new oscillator selection in WO ;OSCCONH (high byte) Unlock Sequence
MOV #OSCCONH, w1
MOV #0x78, w2
MOV #0x9A, w3
MOV.b w2, [w1]
MOV.b w3, [w1]
;Set new oscillator selection
MOV.b WREG, OSCCONH
;OSCCONL (low byte) unlock sequence
MOV #OSCCONL, w1
MOV #0x46, w2
MOV #0x57, w3
MOV.b w2, [w1]
MOV.b w3, [w1]
;Start oscillator switch operation
BSET OSCCON, #0
<pre>// or use XC16 built-in macro:</pre>
<pre>// Initiate Clock Switch to Primary</pre>
//Oscillator with PLL (NOSC=0b011)
builtin_write_OSCCONH(0x03);
builtin_write_OSCCONL(OSCCON 0x01);

9.5 Fail-Safe Clock Monitoring

The Fail-Safe Clock Monitor (FSCM) detects clock failures. In case of a clock problem, the Fail-Safe Clock Monitor switches the clock to the on-chip Low-Power RC (LPRC) Oscillator and generates the oscillator trap.

To enable clock switching, the FCKSM[1:0] Configuration bits in the FOSC register must be programmed to '00'.

9.6 FRC Active Clock Tuning

PIC24FJ128GL306 family devices include an automatic mechanism to calibrate the FRC during run time. This system uses active clock tuning from a source of known accuracy to maintain the FRC within a very narrow margin of its nominal 8 MHz frequency.

The self-tune system is controlled by the bits in the upper half of the OSCTUN register. Setting the STEN bit (OSCTUN[15]) enables the self-tuning feature, allowing the hardware to calibrate to a source selected by the STSRC bit (OSCTUN[12]).

When STSRC = 0, the system uses the crystalcontrolled SOSC for its calibration source. Regardless of the source, the system uses the TUN[5:0] bits (OSCTUN[5:0]) to change the FRC Oscillator's frequency. Frequency monitoring and adjustment are dynamic, occurring continuously during run time. While the system is active, the TUNx bits cannot be written to by software.

The self-tune system can generate a hardware interrupt, FSTIF. The interrupt can result from a drift of the FRC, from the reference, by greater than 0.2% in either direction, or whenever the frequency deviation is beyond the ability of the TUN[5:0] bits to correct (i.e., greater than 1.5%). The STLOCK and STOR status bits (OSCTUN[11,9]) are used to indicate these conditions.

The STLPOL and STORPOL bits (OSCTUN[10,8]) configure the FSTIF interrupt to occur in the presence or the absence of the conditions. It is the user's responsibility to monitor both the STLOCK and STOR bits to determine the exact cause of the interrupt.

Note:	The STLPOL and STORPOL bits should
	be ignored when the self-tune system is
	disabled (STEN = 0).

9.7 Oscillator Modes

÷8 (11)

The PLL block is shown in Figure 9-2. In this system, the input from the Primary Oscillator is divided down by a PLL prescaler to generate a 4 MHz output. This is used to drive an on-chip, 96 MHz PLL frequency multiplier to drive the fixed, divide-by-3 frequency divider and configurable PLL prescaler/divider to generate a range of system clock frequencies. The CPDIV[1:0] bits select the system clock speed. Available clock options are listed in Table 9-2.

The user must manually configure the PLL divider to generate the required 4 MHz output using the PLLMODE[3:0] Configuration bits. This limits the choices for Primary Oscillator frequency to a total of eight possibilities, as shown in Table 9-3.

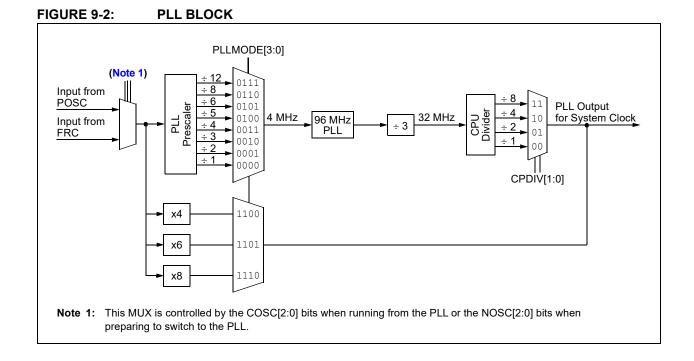
MCU Clock Division (CPDIV[1:0])	Microcontroller Clock Frequency
None (00)	32 MHz
÷2(01)	16 MHz
÷4(10)	8 MHz

4 MHz

TABLE 9-2: SYSTEM CLOCK OPTIONS

TABLE 9-3: VALID PRIMARY OSCILLATOR CONFIGURATIONS

Input Oscillator Frequency	Clock Mode	PLL Mode (PLLMODE[3:0])
48 MHz	ECPLL	÷ 12 (0111)
32 MHz	HSPLL, ECPLL	÷8(0110)
24 MHz	HSPLL, ECPLL	÷6(0101)
20 MHz	HSPLL, ECPLL	÷5 (0100)
16 MHz	HSPLL, ECPLL	÷4 (0011)
12 MHz	HSPLL, ECPLL	÷3(0010)
8 MHz	ECPLL, XTPLL, FRCPLL	÷2 (0001)
4 MHz	ECPLL, XTPLL, FRCPLL	÷1 (0000)



9.8 Primary Oscillator (PRI or POSC)

The PIC24FJ128GL306 family devices feature a Primary Oscillator (POSC), which is available on the OSCI and OSCO pins. This connection enables an external crystal (or ceramic resonator) to provide the clock to the device. The Primary Oscillator provides three modes of operation:

- Medium Speed Oscillator (XT Mode): The XT mode is a Medium Gain, Medium Frequency mode used to work with crystal frequencies of 3.5 MHz to 10 MHz.
- High-Speed Oscillator (HS Mode): The HS mode is a High-Gain, High-Frequency mode used to work with crystal frequencies of 10 MHz to 32 MHz.
- External Clock Source Operation (EC Mode): If the crystal driver is disabled, the EC mode allows the internal oscillator to be bypassed. The device clocks are generated from an external source (0 MHz to up to 64 MHz) and input on the CLKI pin.

9.9 Low-Power RC (LPRC) Oscillator

The PIC24FJ128GL306 family devices contain one instance of the Low-Power RC (LPRC) Oscillator, which provides a nominal clock frequency of 32 kHz. The LPRC Oscillator is the clock source for the Power-up Timer (PWRT), Watchdog Timer (WDT) and Fail-Safe Clock Monitor (FSCM) circuits in the clock subsystem. The LPRC Oscillator is enabled at power-on. The LPRC Oscillator remains enabled under these conditions:

- · The FSCM is enabled
- · The WDT is enabled
- The LPRC Oscillator is selected as the system clock

If none of these conditions is true, the LPRC Oscillator shuts off after the PWRT expires.

9.10 Secondary Oscillator (SOSC)

9.10.1 BASIC SOSC OPERATION

PIC24FJ128GL306 family devices do not have to set the SOSCEN bit to use the Secondary Oscillator. Any module requiring the SOSC (such as the RTCC or Timer1) will automatically turn on the SOSC when the

clock signal is needed. The SOSC, however, has a long start-up time (as long as one second). To avoid delays for peripheral start-up, the SOSC can be manually started using the SOSCEN bit.

To use the Secondary Oscillator, the SOSCSEL bit (FOSC[3]) must be set to '1'. Programming the SOSCSEL bit to '0' configures the SOSC pins for Digital mode, enabling digital I/O functionality on the pins.

9.10.2 CRYSTAL SELECTION

The 32.768 kHz crystal used for the SOSC must have the following specifications in order to properly start up and run at the correct frequency when the SOSC is in High-Power mode (default):

- 12.5 pF loading capacitance
- 1.0 pF shunt capacitance
- A typical ESR of 35k-50k; 70k maximum

In addition, the two external crystal loading capacitors should be in the range of 18 pF-22 pF, which will be based on the PC board layout. The capacitors should be C0G, 5% tolerance and rated 25V or greater.

The accuracy and duty cycle of the SOSC can be measured on the REFO pin, and is recommended to be in the range of 40-60% and accurate to ± 0.65 Hz.

9.10.3 LOW-POWER SOSC OPERATION

The Secondary Oscillator can operate in two distinct levels of power consumption based on device configuration. In Low-Power mode, the oscillator operates in a low drive strength, low-power state. By default, the oscillator uses a higher drive strength, and therefore, requires more power. Low-Power mode is selected by Configuration bit, SOSCHP (FDEVOPT1[3]). The lower drive strength of this mode makes the SOSC more sensitive to noise and requires a longer start-up time. This mode can be used with lower load capacitance crystals (6-9 pF) to reduce Sleep current in the RTCC. When Low-Power mode is used, care must be taken in the design and layout of the SOSC circuit to ensure that the oscillator starts up and oscillates properly. PC board layout issues, stray capacitance and other factors will need to be carefully controlled in order for the crystal to operate.

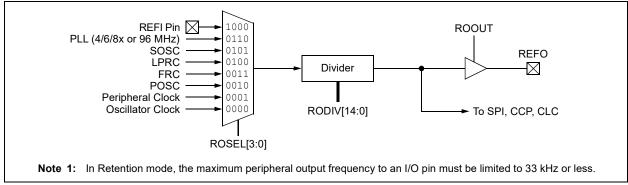


FIGURE 9-3: REFERENCE CLOCK GENERATOR

9.11 Reference Clock Output

In addition to the CLKO output (Fosc/2) available in certain Oscillator modes, the device clock in the PIC24FJ128GL306 family devices can also be configured to provide a reference clock output signal to a port pin. This feature is available in all oscillator configurations and allows the user to select a greater range of clock submultiples to drive external devices in the application. CLKO is enabled by Configuration bit, OSCIOFNC, and is independent of the REFO reference clock. REFO is mappable to any I/O pin that has mapped output capability. Refer to Table 11-10 for more information.

This reference clock output is controlled by the REFOCONL and REFOCONH registers. Setting the ROEN bit (REFOCONL[15]) makes the clock signal available on the REFO pin. The RODIV[14:0] bits (REFOCONH[14:0]) enable the selection of different clock divide options. The ROSWEN bit (REFOCONL[9]) indicates that the clock divider has successfully switched. In order to change the divider, the user should wait until this bit has been cleared. Write the updated values to RODIVx, set the ROSWEN bit and then wait until it is cleared before assuming that the REFO clock is valid.

The ROSEL[3:0] bits (REFOCONL[3:0]) determine which clock source is used for the reference clock output. The ROSLP bit (REFOCONL[11]) determines if the reference source is available on REFO when the device is in Sleep mode.

To use the reference clock output in Sleep mode, both the ROSLP bit must be set and the clock selected by the ROSELx bits must be enabled for operation, during Sleep mode, if possible. Clearing the ROSELx bits allows the reference output frequency to change as the system clock changes during any clock switches. The ROOUT bit enables/disables the reference clock output on the REFO pin.

The ROACTIVE bit (REFOCONL[8]) indicates that the module is active; it can be cleared by disabling the module (setting ROEN to '0'). The user must not change the reference clock source or adjust the divider when the ROACTIVE bit indicates that the module is active. To avoid glitches, the user should not disable the module until the ROACTIVE bit is '1'.

The PLLSS Configuration bit (FOSC[4]), when cleared, can be used to generate a REFO clock with the PLL that is independent of the system clock. The PLL cannot be used in the primary clock chain. For example, if the system clock is using FRC at 8 MHz, the PLL can use the FRC as the input and generate 32 MHz (PLL4x mode) out of REFO.

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R-0			
ROEN		ROSIDL	ROOUT	ROSLP		ROSWEN	ROACTIVE			
bit 15		•	•				bit 8			
U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0			
	—				ROS	EL[3:0]	L.:4			
bit 7							bit			
Legend:										
R = Readab	le bit	W = Writable	bit	U = Unimpler	nented bit, rea	d as '0'				
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown			
bit 15	ROEN: Refer	ence Oscillator		a hit						
DIT 10		e Oscillator mo	•							
		e Oscillator is c		_						
bit 14	Unimplement	ted: Read as '	D'							
bit 13	ROSIDL: REFO Stop in Idle Mode bit									
				levice enters Id	le mode					
		s module opera								
bit 12		erence Clock O	-							
		e clock is drive e clock is not d		•						
bit 11		erence Oscillato		•						
	1 = Reference	e Oscillator cor e Oscillator is c	itinues to run i	n Sleep						
bit 10		ted: Read as '								
bit 9	•	eference Clock		ch Enable bit						
				ching is current	y in progress					
	0 = Clock divi	der switch has	been complete	ed						
bit 8		Reference Cloc								
				not change the pdate the REF		s)				
bit 7-4	Unimplement	ted: Read as '	o'							
bit 3-0	ROSEL[3:0]:	Reference Clo	ck Source Sel	ect bits						
	1111-1001 =	Reserved								
	1000 = REFI	•								
	0111 = Reser 0110 = PLL	rved								
	0101 = SOSC	2								
	0100 = LPRC									
	0011 = FRC									
	0010 = POSC	C m clock (Fosc	(0)							

REGISTER 9-6: REFOCONL: REFERENCE OSCILLATOR CONTROL REGISTER LOW

REGISTER 9-7: REFOCONH: REFERENCE OSCILLATOR CONTROL REGISTER HIGH

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
_				RODIV[14:8]						
bit 15							bit 8			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
			ROD	0IV[7:0]						
bit 7							bit 0			
Legend:										
R = Readable bit W = Writa		W = Writable bit	bit U = Unimplemented bit, read as '0'							
-n = Value at POR		'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown			
bit 15 bit 14-0	RODIV[14:0 Specifies 1/2 (ex: Period c RODIV[14:0 111111111	nted: Read as '0']: Reference Clock 2 period of the refer of Output = [Refere] = 0). 111111 = REFO c 111110 = REFO c	rence clock nce Source lock is the t	in the source cl * 2] * RODIV[1/ base clock frequ	4:0]; this equat iency divided b	by 65,534 (32,70	67 * 2)			
	000000000 000000000	000011 = REFO c 000010 = REFO c 000001 = REFO c 000000 = REFO c	lock is the b lock is the b	base clock frequ base clock frequ	iency divided b iency divided b	by 4 (2 * 2) by 2 (1 * 2))			

NOTES:

10.0 POWER-SAVING FEATURES

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "Power-Saving Features with Deep Sleep" (www.microchip.com/DS39727) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The PIC24FJ128GL306 family of eXtreme low-power devices provides the ability to manage power consumption by selectively managing clocking to the CPU and the peripherals. In general, a lower clock frequency and a reduction in the number of circuits being clocked constitutes lower consumed power. All PIC24F devices manage power consumption in four different ways:

- Clock Frequency
- · Instruction-Based Sleep and Idle modes
- Software Controlled Doze mode
- · Selective Peripheral Control in Software

Combinations of these methods can be used to selectively tailor an application's power consumption, while still maintaining critical application features, such as timing-sensitive communications.

10.1 Clock Frequency and Clock Switching

PIC24F devices allow for a wide range of clock frequencies to be selected under application control. If the system clock configuration is not locked, users can choose low-power or high-precision oscillators by simply changing the NOSC[2:0] bits. The process of changing a system clock during operation, as well as limitations to the process, are discussed in more detail in **Section 9.0 "Oscillator Configuration"**.

10.2 Instruction-Based Power-Saving Modes

PIC24F devices have two special power-saving modes that are entered through the execution of a special PWRSAV instruction. Sleep mode stops clock operation and halts all code execution; Idle mode halts the CPU and code execution, but allows peripheral modules to continue operation. The assembly syntax of the PWRSAV instruction is shown in Example 10-1. The MPLAB[®] XC16 C compiler offers "built-in" functions for the power-saving modes as follows:

Idle(); // places part in Idle
Sleep(); // places part in Sleep

Sleep and Idle modes can be exited as a result of an enabled interrupt, WDT time-out or a device Reset. When the device exits these modes, it is said to "wake-up".

10.2.1 SLEEP MODE

Sleep mode has these features:

- The system clock source is shut down. If an on-chip oscillator is used, it is turned off.
- The device current consumption will be reduced to a minimum provided that no I/O pin is sourcing current.
- The Fail-Safe Clock Monitor does not operate during Sleep mode since the system clock source is disabled.
- The LPRC clock will continue to run in Sleep mode if the WDT is enabled.
- The WDT, if enabled, is automatically cleared prior to entering Sleep mode.
- Some device features or peripherals may continue to operate in Sleep mode. Refer to Table 10-2 for peripherals active in Sleep. This includes items, such as the Input Change Notification (ICN) on the I/O ports or peripherals that use an External Clock input. Any peripheral that requires the system clock source for its operation will be disabled in Sleep mode.

The device will wake-up from Sleep mode on any of the these events:

- On any interrupt source that is individually enabled.
- On any form of device Reset.
- On a WDT time-out.

On wake-up from Sleep, the processor will restart with the same clock source that was active when Sleep mode was entered.

EXAMPLE 10-1: PWRSAV INSTRUCTION SYNTAX

PWRSAV	#0	; Put	the	device	into	SLEEP mode
PWRSAV	#1	; Put	the	device	into	IDLE mode

10.2.2 IDLE MODE

Idle mode has these features:

- The CPU will stop executing instructions.
- The WDT is automatically cleared.
- The system clock source remains active. By default, all peripheral modules continue to operate normally from the system clock source, but can also be selectively disabled (see Section 10.4 "Selective Peripheral Module Control").
- If the WDT or FSCM is enabled, the LPRC will also remain active.

The device will wake from Idle mode on any of these events:

- Any interrupt that is individually enabled.
- · Any device Reset.
- A WDT time-out.

On wake-up from Idle, the clock is reapplied to the CPU and instruction execution begins immediately, starting with the instruction following the PWRSAV instruction or the first instruction in the ISR.

10.2.3 INTERRUPTS COINCIDENT WITH POWER SAVE INSTRUCTIONS

Any interrupt that coincides with the execution of a PWRSAV instruction will be held off until entry into Sleep or Idle mode has completed. The device will then wake-up from Sleep or Idle mode.

10.2.4 LOW-VOLTAGE RETENTION REGULATOR

PIC24FJ128GL306 family devices incorporate a second on-chip voltage regulator, designed to provide power to select microcontroller features at 1.2V nominal. This regulator allows features, such as data RAM and the WDT, to be maintained in power-saving modes where they would otherwise be inactive, or maintain them at a lower power than would otherwise be the case.

Retention Sleep uses less power than standard Sleep mode, but takes more time to recover and begin execution. An additional 10-15 μ s (typical) is required to charge VCAP from 1.2V to 1.8V and start to execute instructions when exiting Retention Sleep.

The VREGS bit allows control of speed to exit from the Sleep modes (regular and Retention) at the cost of more power. The regulator band gaps are enabled, which increases the current but reduces time to recover from Sleep by ~10 μ s.

The low-voltage retention regulator is only available when Sleep mode is invoked. It is controlled by the LPCFG Configuration bit (FPOR[2]) and in firmware by the RETEN bit (RCON[12]). LPCFG must be programmed (= 0) and the RETEN bit must be set (= 1) for the regulator to be enabled.

Note 1:	In Retention mode, the maximum periph-
	eral output frequency to an I/O pin must
	be limited to 33 kHz or less.

10.2.5 EXITING FROM LOW-VOLTAGE RETENTION SLEEP

All of the methods for exiting from standard Sleep also apply to Retention Sleep (MCLR, INT0, etc.). However, in order to allow the regulator to switch from 1.8V (operating) to Retention mode (1.2V), there is a hardware 'lockout timer' from the execution of Retention Sleep until Retention Sleep can be exited.

During the 'lockout time', the only method to exit Retention Sleep is a POR or MCLR. Interrupts that are asserted (such as INT0) during the 'lockout time' are masked. The lockout timer then sets a minimum interval from when the part enters Retention Sleep until it can exit from Retention Sleep. Interrupts are not 'held pending' during lockout; they are masked, and in order to exit after the lockout expires, the exiting source must assert after the lockout time.

The lockout timer is derived from the LPRC clock, which has a wide (untrimmed) frequency tolerance.

The lockout time will be one of the following two cases:

- If the LPRC was not running at the time of Retention Sleep, the lockout time is two LPRC periods + LPRC wake-up time
- If the LPRC was running at the time of Retention Sleep, the lockout time is one LPRC period

Refer to Table 30-20 and Table 30-21 in the AC Electrical Specifications for the LPRC timing.

10.2.6 SUMMARY OF LOW-POWER SLEEP MODES

The RETEN bit and the VREGS bit (RCON[12,8]) allow for four different Sleep modes, which will vary by wakeup time and power consumption. Refer to Table 10-1 for a summary of these modes. Specific information about the current consumption and wake times can be found in Section 30.0 "Electrical Characteristics".

TABLE 10-1: LOW-POWER SLEEP MODES

RETEN	VREGS	MODE	Relative Power
0	0	Standby Sleep	A Few µA Range
0	1	Sleep	100 µA Range
1	0	Low-Voltage Standby Sleep	Less than 1 µA
1	1	Low-Voltage Sleep	A Few μA Range

10.3 Doze Mode

Generally, changing clock speed and invoking one of the power-saving modes are the preferred strategies for reducing power consumption. There may be circumstances, however, where this is not practical. For example, it may be necessary for an application to maintain uninterrupted synchronous communication, even while it is doing nothing else. Reducing system clock speed may introduce communication errors, while using a power-saving mode may stop communications completely.

Doze mode is a simple and effective alternative method to reduce power consumption while the device is still executing code. In this mode, the system clock continues to operate from the same source and at the same speed. Peripheral modules continue to be clocked at the same speed while the CPU clock speed is reduced. Synchronization between the two clock domains is maintained, allowing the peripherals to access the SFRs while the CPU executes code at a slower rate.

Doze mode is enabled by setting the DOZEN bit (CLKDIV[11]). The ratio between peripheral and core clock speed is determined by the DOZE[2:0] bits (CLKDIV[14:12]). There are eight possible configurations, from 1:1 to 1:256, with 1:1 being the default.

It is also possible to use Doze mode to selectively reduce power consumption in event-driven applications. This allows clock-sensitive functions, such as synchronous communications, to continue without interruption while the CPU Idles, waiting for something to invoke an interrupt routine. Enabling the automatic return to full-speed CPU operation on interrupts is enabled by setting the ROI bit (CLKDIV[15]). By default, interrupt events have no effect on Doze mode operation.

Operating Mode	Active Clocks	Active Peripherals	Wake-up Sources
Low-Voltage/ Retention Sleep	Refer to the respective Peripheral for active clock source	Timer, REFO, MCCP, LCD, BOR, WDT, HLVD, RTCC, CMP, CVREF, CLC, UART, SPI, I ² C	 Interrupt source that is individually enabled Any form of device Reset WDT time-out
Sleep	Refer to the respective Peripheral for active clock source	Timer, REFO, MCCP, LCD, BOR, WDT, HLVD, ADC, RTCC, CMP, CVREF, CLC, UART, SPI, I ² C	 Interrupt source that is individually enabled Any form of device Reset WDT time-out
Idle	All clocks	All peripherals	 Interrupt source that is individually enabled Any form of device Reset WDT time-out
Doze	All clocks	All peripherals	 Interrupt source that is individually enabled (ROI bit (CLKDIV[15]) should be enabled) Any form of device Reset

TABLE 10-2: POWER-SAVING OPERATING MODES

10.4 Selective Peripheral Module Control

Idle and Doze modes allow users to substantially reduce power consumption by slowing or stopping the CPU clock. Even so, peripheral modules still remain clocked, and thus, consume power. There may be cases where the application needs what these modes do not provide: the allocation of power resources to CPU processing with minimal power consumption from the peripherals.

PIC24F devices address this requirement by allowing peripheral modules to be selectively disabled, reducing or eliminating their power consumption. This can be done with two control bits:

- The Peripheral Enable bit, generically named, "XXXEN", located in the module's main control SFR.
- The Peripheral Module Disable (PMD) bit, generically named, "XXXMD", located in one of the PMD Control registers.

Both bits have similar functions in enabling or disabling their associated module. Setting the PMD bit for a module disables all clock sources to that module, reducing its power consumption to an absolute minimum. In this state, the control and status registers associated with the peripheral will also be disabled, so writes to those registers will have no effect and read values will be invalid. Many peripheral modules have a corresponding PMD bit. In contrast, disabling a module by clearing its XXXEN bit disables its functionality, but leaves its registers available to be read and written to. This reduces power consumption, but not by as much as setting the PMD bit does. Most peripheral modules have an enable bit; exceptions include input capture, output compare and RTCC.

To achieve more selective power savings, peripheral modules can also be selectively disabled when the device enters Idle mode. This is done through the control bit of the generic name format, "XXXIDL". By default, all modules that can operate during Idle mode will do so. Using the disable on Idle feature allows further reduction of power consumption during Idle mode, enhancing power savings for extremely critical power applications.

TABLE 10-3: PERIPHERAL MODULE DISABLE REGISTER SUMMARY

Register	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1	T5MD	T4MD	T3MD	T2MD	T1MD	_	—	-	I2C1MD	U2MD	U1MD	SPI2MD	SPI1MD	_	_	ADCMD	0000
PMD2		_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	0000
PMD3		-	—	_	_	CMPMD	RTCCMD	_	CRCMD	_	_	_	U3MD	—	I2C2MD	_	0000
PMD4	_	_	_	_	_	_	_	_	—	_	U4MD	_	REFOMD	_	HLVDMD	_	0000
PMD5	_	_	_	_	_	_	—	_	—	_	—	CCP5MD	CCP4MD	CCP3MD	CCP2MD	CCP1MD	0000
PMD6	_	_	_	_	_	_	—	_	—	LCDMD	_	_	—	_	_	_	0000
PMD7	_	_	_	_	_	_	—	_	—	_	DMA1MD	DMA0MD	—	_	_	_	0000
PMD8	_	_		_	-	_	_	DMTMD	_	_	CLC4MD	CLC3MD	CLC2MD	CLC1MD	_	_	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

REGISTER 1	10-1: PMD [·]	1: PERIPHER		E DISABLE RE	GISTER 1		
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0
T5MD	T4MD	T3MD	T2MD	T1MD	_	_	
bit 15	•						bit
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0
I2C1MD	U2MD	U1MD	SPI2MD	SPI1MD			ADC1MD
bit 7	02MD	OIND	OFIZIND	GITTIND			bit
Legend:							
R = Readable	bit	W = Writable	hit	U = Unimplem	ontod hit roa	d ac '0'	
-n = Value at l		'1' = Bit is set		'0' = Bit is clea			
	PUR	I – DILIS SEL		0 – Bit is clea	reu	x = Bit is unk	CHOWIT
bit 15	T5MD: Timer	5 Module Disal	ole bit				
	1 = Module i						
bit 14	-	oower and clocl 4 Module Disal		enabled			
DIL 14	1 = Module is						
		ower and clock	sources are e	nabled			
bit 13	•	3 Module Disal					
	1 = Module i	s disabled					
	0 = Module p	power and cloc	k sources are e	enabled			
bit 12	T2MD: Timer	2 Module Disal	ole bit				
	1 = Module i						
	-	power and cloc		enabled			
bit 11		1 Module Disal	ole bit				
	1 = Module i	s disabled bower and clocl		nabled			
bit 10-8	-	nted: Read as '		enableu			
	-	1 Module Disal					
bit 7	1 = Module i						
		s disabled	sources are e	enabled			
bit 6		T2 Module Disa					
	1 = Module i						
		power and cloc	k sources are e	enabled			
bit 5	U1MD: UART	T1 Module Disa	ble bit				
	1 = Module i	s disabled					
	0 = Module p	power and cloc	k sources are e	enabled			
bit 4	SPI2MD: SP	I2 Module Disa	ble bit				
	1 = Module i						
		power and cloc		enabled			
bit 3	-	I1 Module Disa	ble bit				
	1 = Module i	s disabled		nabled			
bit 2-1				enableu			
	-	nted: Read as '		hit			
bit 0	ADC1MD: A/ 1 = Module i	D Converter M	Duule Disable I	DIL			
		s disabled	(sources are e	enabled			
	, modulo j						

REGISTER 10-1: PMD1: PERIPHERAL MODULE DISABLE REGISTER 1

REGISTER 10-2: PMD3: PERIPHERAL MODULE DISABLE REGISTER 3

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0	
_			_		CMPMD	RTCCMD	_	
bit 15	·	·	•	·			bit 8	
R/W-0	U-0	U-0	U-0	R/W-0	U-0	R/W-0	U-0	
CRCMD				U3MD		I2C2MD		
bit 7							bit (
Legend:								
R = Readab	ole bit	W = Writable	bit	U = Unimpler	mented bit, rea	d as '0'		
-n = Value a	t POR	1' = Bit is set		'0' = Bit is cle		x = Bit is unknown		
bit 15-11	Unimpleme	nted: Read as '	0'					
oit 10	CMPMD: Tri	ple Comparator	Module Disab	le bit				
	1 = Module							
	0 = Module	power and cloc	k sources are	enabled				
bit 9	RTCCMD: F	RTCC Module Di	sable bit					
	1 = Module							
		power and cloc		enabled				
bit 8	•	nted: Read as '						
bit 7		RC Module Disa	ble bit					
	1 = Module	is disabled power and cloc		anablad				
bit 6-4		nted: Read as '		enableu				
bit 3	•	T3 Module Disa						
DIL 3	1 = Module							
		power and cloc	sources are	enabled				
bit 2		•	0'					
	Unimpleme	, nted: Read as ' C2 Module Disal						
	Unimpleme	n ted: Read as ' C2 Module Disal						
bit 2 bit 1	Unimpleme I2C2MD: I2C 1 = Module	n ted: Read as ' C2 Module Disal	ole bit	enabled				

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
		<u> </u>			_	<u> </u>	<u> </u>
bit 15							bit 8
U-0	U-0	R/W-0	U-0	R/W-0	U-0	R/W-0	U-0
	—	U4MD		REFOMD		HLVDMD	
bit 7							bit 0
Legend:							
R = Readab	R = Readable bit W = Writable bit			U = Unimplem	d as '0'		
-n = Value at POR '1' = Bit is set			'0' = Bit is clea	ared	x = Bit is unkno	own	
bit 15-6	Unimplemen	ted: Read as ')'				
bit 5	U4MD: UART	4 Module Disa	ble bit				
	1 = Module is						
	-	ower and clock		enabled			
bit 4	•	ted: Read as '					
bit 3		eference Clock	Output Disable	e bit			
	1 = Module is			nablad			
bit 2		ower and clock		enableu			
	•	ted: Read as '		D:			
bit 1		gh/Low-Voltage	Detect Modul	e Disable bit			
	1 = Module is	s disabled		anabled			
bit 0	-	ted: Read as '					
	Sumplemen		,				

REGISTER 10-3: PMD4: PERIPHERAL MODULE DISABLE REGISTER 4

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0				
_			—	<u> </u>	<u> </u>	<u> </u>	<u> </u>				
bit 15							bit 8				
			D /11/0	D444	D M M A	D 444 0	D /11/0				
U-0	<u>U-0</u>	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
			CCP5MD	CCP4MD	CCP3MD	CCP2MD	CCP1MD				
bit 7							bit C				
Legend:											
R = Readal	ble bit	W = Writable	bit	U = Unimplem	nented bit, read	d as '0'					
-n = Value a	at POR	'1' = Bit is set	:	'0' = Bit is clea	ared	x = Bit is unknown					
bit 15-5	Unimplemen	ted: Read as	0'								
L:+ 1	CCP5MD: MCCP5 Module Disable bit										
bit 4	CCP5IVID: MO										
DIL 4	1 = Module is	s disabled									
dil 4	1 = Module is 0 = Module p	s disabled bower and cloc	k sources are e	enabled							
bit 3	1 = Module is 0 = Module p	s disabled		enabled							
	1 = Module is 0 = Module p CCP4MD: Mo 1 = Module is	s disabled power and cloc CCP4 Module s disabled	Disable bit								
bit 3	1 = Module is 0 = Module p CCP4MD: Module is 0 = Module is 0 = Module p	s disabled power and cloc CCP4 Module s disabled power and cloc	Disable bit k sources are e								
	1 = Module is 0 = Module p CCP4MD: Module is 0 = Module is 0 = Module p	s disabled power and cloc CCP4 Module s disabled	Disable bit k sources are e								
bit 3	1 = Module is 0 = Module p CCP4MD: Mo 1 = Module is 0 = Module p CCP3MD: Mo 1 = Module is	s disabled power and cloc CCP4 Module s disabled power and cloc CCP3 Module s disabled	Disable bit k sources are e Disable bit	enabled							
bit 3 bit 2	1 = Module is 0 = Module p CCP4MD: Module is 0 = Module p CCP3MD: Module is 0 = Module is 0 = Module is	s disabled oower and cloc CCP4 Module s disabled oower and cloc CCP3 Module s disabled oower and cloc	Disable bit k sources are e Disable bit k sources are e	enabled							
bit 3 bit 2	1 = Module is 0 = Module p CCP4MD: Module is 0 = Module p CCP3MD: Module is 0 = Module is 0 = Module is	s disabled power and cloc CCP4 Module s disabled power and cloc CCP3 Module s disabled	Disable bit k sources are e Disable bit k sources are e	enabled							
bit 3	1 = Module is 0 = Module p CCP4MD: Mo 1 = Module is 0 = Module p CCP3MD: Mo 1 = Module is 0 = Module p CCP2MD: Mo 1 = Module is	s disabled power and cloc CCP4 Module s disabled power and cloc CCP3 Module s disabled power and cloc CCP2 Module s disabled	Disable bit k sources are e Disable bit k sources are e	enabled enabled							

- CCP1MD: MCCP1 Module Disable bit
- 1 = Module is disabled

bit 0

0 = Module power and clock sources are enabled

REGISTER 10-5: PMD6: PERIPHERAL MODULE DISABLE REGISTER 6

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	—		—	—	_	
bit 15	·						bit 8
U-0	R/W-0	U-0	U-0	U-0	U-0	U-0	U-0
_	LCDMD	—	_	—	—	_	—
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, read	d as '0'	
-n = Value at POR '1' = Bit is set			'0' = Bit is clea	ared	x = Bit is unknown		

bit 15-7	Unimplemented: Read as '0'
bit 6	LCDMD: LCD Module Disable bit
	1 = Module is disabled
	0 = Module power and clock sources are enabled
bit 5-0	Unimplemented: Read as '0'

REGISTER 10-6: PMD7: PERIPHERAL MODULE DISABLE REGISTER 7

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	_	—	—	—
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	—	DMA1MD	DMA0MD	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-6	Unimplemented: Read as '0'
bit 5	DMA1MD: DMA1 Controller (Channels 4 through 7) Disable bit
	1 = Controller is disabled
	0 = Controller power and clock sources are enabled
bit 4	DMA0MD: DMA0 Controller (Channels 0 through 3) Disable bit
	1 = Controller is disabled
	0 = Controller power and clock sources are enabled
bit 3-0	Unimplemented: Read as '0'

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0							
_		_	—			_	DMTMD							
bit 15							bit							
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0							
_		CLC4MD	CLC3MD	CLC2MD	CLC1MD	—	_							
bit 7							bit							
Legend:														
R = Readab	ole bit	W = Writable	bit	U = Unimplem	nented bit, rea	d as '0'								
-n = Value a		'1' = Bit is set		'0' = Bit is clea		x = Bit is unk	nown							
bit 15-9	Unimplemer	nted: Read as ')'											
bit 8	-	DMTMD: DMT Module Disable bit												
	1 = Module i	s disabled												
	0 = Module	power and clock	sources are e	nabled										
bit 7-6	Unimplemer	nted: Read as ')'											
bit 5	CLC4MD: CL	_C4 Module Dis	able bit											
	1 = Module i	s disabled												
	0 = Module p	power and clock	sources are e	nabled										
bit 4	CLC3MD: CL	_C3 Module Dis	able bit											
	1 = Module i													
	-	power and clock		nabled										
bit 3	-	_C2 Module Dis	able bit											
	1 = Module i													
	•	power and clock		napled										
bit 2		CLC1MD: CLC1 Module Disable bit												
	1 = Module i	is disabled		nabled										
bit 1-0		nted: Read as '												
DIL 1-0	ommplemen	neu. Reau as)											

REGISTER 10-7: PMD8: PERIPHERAL MODULE DISABLE REGISTER 8

NOTES:

11.0 I/O PORTS

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "I/O Ports with Peripheral Pin Select (PPS)" (www.microchip.com/DS30009711) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

All of the device pins (except VDD, VSS, MCLR and OSCI/CLKI) are shared between the peripherals and the Parallel I/O (PIO) ports. All I/O input ports feature Schmitt Trigger (ST) inputs for improved noise immunity.

11.1 Parallel I/O (PIO) Ports

A Parallel I/O port that shares a pin with a peripheral is, in general, subservient to the peripheral. The peripheral's output buffer data and control signals are provided to a pair of multiplexers. The multiplexers select whether the peripheral or the associated port has ownership of the output data and control signals of the I/O pin. The logic also prevents "loop through", in which a port's digital output can drive the input of a peripheral that shares the same pin. Figure 11-1 shows how ports are shared with other peripherals and the associated I/O pin to which they are connected. When a peripheral is enabled and the peripheral is actively driving an associated pin, the use of the pin as a general purpose output pin is disabled. The I/O pin may be read, but the output driver for the parallel port bit will be disabled. If a peripheral is enabled, but the peripheral is not actively driving a pin, that pin may be driven by a port.

All port pins have three registers directly associated with their operation as digital I/Os and one register associated with their operation as analog inputs. The Data Direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is a '1', then the pin is an input. All port pins are defined as inputs after a Reset. Reads from the Output Latch register (LATx), read the latch; writes to the latch, write the latch. Reads from the PORTx register, read the port pins; writes to the port pins, write the latch.

Any bit and its associated data and control registers that are not valid for a particular device will be disabled. That means the corresponding LATx and TRISx registers, and the port pin, will read as zeros. Table 11-3 through Table 11-9 show ANSELx bits and port availability for device variants. When a pin is shared with another peripheral or function that is defined as an input only, it is regarded as a dedicated port because there is no other competing source of inputs.

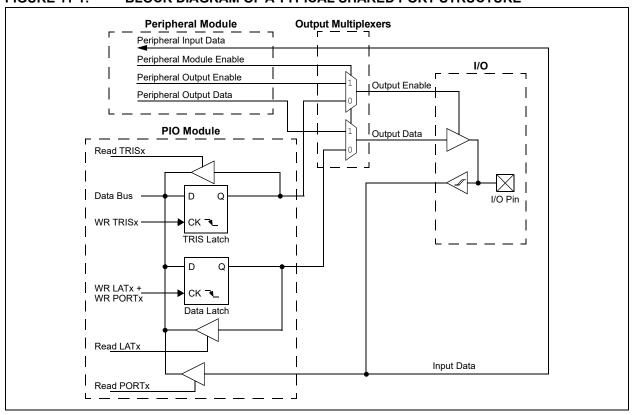


FIGURE 11-1: BLOCK DIAGRAM OF A TYPICAL SHARED PORT STRUCTURE

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11.1.1 I/O PORT WRITE/READ TIMING

One instruction cycle is required between a port direction change or port write operation and a read operation of the same port. Typically, this instruction would be a NOP.

11.1.2 OPEN-DRAIN CONFIGURATION

In addition to the PORTx, LATx and TRISx registers for data control, each port pin can also be individually configured for either a digital or open-drain output. This is controlled by the Open-Drain Control register, ODCx, associated with each port. Setting any of the bits configures the corresponding pin to act as an open-drain output.

The open-drain feature allows the generation of outputs higher than VDD (e.g., 5V) on any desired digital only pins by using external pull-up resistors. The maximum open-drain voltage allowed is the same as the maximum VIH specification.

11.2 Configuring Analog Port Pins (ANSELx)

The ANSELx and TRISx registers control the operation of the pins with analog function. Each port pin with analog function is associated with one of the ANSELx bits, which decide if the pin function should be analog or digital. Refer to Table 11-1 for detailed behavior of the pin for different ANSELx and TRISx bit settings.

When reading the PORTx register, all pins configured as analog input channels will read as cleared (a low level).

11.2.1 ANALOG INPUT PINS AND VOLTAGE CONSIDERATIONS

The voltage tolerance of pins used as device inputs is dependent on the pin's input function. Most input pins are able to handle DC voltages of up to 5.5V, a level typical for digital logic circuits. However, several pins can only tolerate voltages up to VDD. Voltage excursions beyond VDD on these pins should always be avoided.

Table 11-2 summarizes the different voltage tolerances. For more information, refer to **Section 30.0 "Electrical Characteristics"** for more details.

Pin Function	ANSELx Setting	TRISx Setting	Comments
Analog Input	1	1	It is recommended to keep ANSELx = 1.
Analog Output	1	1	It is recommended to keep ANSELx = 1.
Digital Input	0	1	Firmware must wait at least one instruction cycle after configuring a pin as a digital input before a valid input value can be read.
Digital Output	0	0	Make sure to disable the analog output function on the pin if any is present.

TABLE 11-1: CONFIGURING ANALOG/DIGITAL FUNCTION OF AN I/O PIN

TABLE 11-2: INPUT VOLTAGE LEVELS FOR PORT OR PIN TOLERATED DESCRIPTION INPUT

Port or Pin	Tolerated Input	Description
PORTB[15:7,5:2]		
PORTD[11:0]		
PORTE[4:0]	5.5V	Tolerates input levels above VDD; useful for most standard logic.
PORTF[6:0]		ior most standard logic.
PORTG[9,6,3:2]		
PORTA[0]		
PORTB[6,1:0]		
PORTC[15:12]	VDD	Only VDD input levels are tolerated.
PORTE[7:5]		
PORTG[8:7]		

Device	PORTA I/O Pins															
	RA15	RA14	RA13	RA12	RA11	RA10	RA9	RA8	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0
PIC24FJXXXGL306	—		_	—	_	—	_	—	_	—	—	_	_	—	—	х
PIC24FJXXXGL305	_		_	_	_	—	—	_	_	_	_	_	_	_	_	—
PIC24FJXXXGL303	_	_	_	_	_		_	—		_	_	Ι	_	—	—	-
PIC24FJXXXGL302	_		_	_		—	—	_	_	_	_	_	_	_	_	—
ANSELA Bit Present	_		_	_				_		_	_	_	_	_	_	х

TABLE 11-3: PORTA PIN AND ANSELA AVAILABILITY

TABLE 11-4:PORTB PIN AND ANSELB AVAILABILITY

Device	PORTB I/O Pins															
	RB15	RB14	RB13	RB12	RB11	RB10	RB9	RB8	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0
PIC24FJXXXGL306	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х
PIC24FJXXXGL305	х	х	_	_	х	х	х	х	х	х	х	х	—	—	х	х
PIC24FJXXXGL303	х	х	_	_	_	х	х	х	х	х	х	х	_	_	х	х
PIC24FJXXXGL302	х	х	_	_	_	х	_	_	х	х	х	х	_	_	х	х
ANSELB Bit Present	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х

TABLE 11-5: PORTC PIN AND ANSELC AVAILABILITY

Device	PORTC I/O Pins															
Device	RC15	RC14	RC13	RC12	RC11	RC10	RC9	RC8	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0
PIC24FJXXXGL306	х	х	х	х	—	—	—	—	—	—	—	—	—	—	—	—
PIC24FJXXXGL305	х	х	х	х	_		—	_		—	—	_	_	—	—	
PIC24FJXXXGL303	х	х	х	х	_		—	_		—	—	_	_	—	—	
PIC24FJXXXGL302	х	х	х	х		-										
ANSELC Bit Present				_	_							_	_			_

TABLE 11-6: PORTD PIN AND ANSELD AVAILABILITY

Device		PORTD I/O Pins														
Device	RD15	RD14	RD13	RD12	RD11	RD10	RD9	RD8	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0
PIC24FJXXXGL306	—	—	—	_	х	х	х	х	х	х	х	х	х	х	х	х
PIC24FJXXXGL305	_	—	_	_	х	х	_	—	х	х	х	х	х	_	—	х
PIC24FJXXXGL303	_	—	_	_	_		_	—	х	х	—	_	_	_	—	
PIC24FJXXXGL302				_	_	-								_		
ANSELD Bit Present	_	_	_		х	х	_	_	х	х	_				_	

Device	PORTE I/O Pins															
Device	RE15	RE14	RE13	RE12	RE11	RE10	RE9	RE8	RE7	RE6	RE5	RE4	RE3	RE2	RE1	RE0
PIC24FJXXXGL306	—	—				—	—		х	х	х	х	х	х	х	х
PIC24FJXXXGL305	_	_	_	_	_	_	_	_	х	х	х	_	х	х	х	х
PIC24FJXXXGL303	_	_	_	_	_	_	_	_	х	х	х	_	х	х	х	х
PIC24FJXXXGL302	—		_	_	_		_	_		_	-	_	х	х	х	х
ANSELE Bit Present	—		_	_	_		_	_		_	-	х	х	х	х	-

TABLE 11-7: PORTE PIN AND ANSELE AVAILABILITY

TABLE 11-8: PORTF PIN AND ANSELF AVAILABILITY

Davias							POR	TF I/O	Pins							
Device	RF15	RF14	RF13	RF12	RF11	RF10	RF9	RF8	RF7	RF6	RF5	RF4	RF3	RF2	RF1	RF0
PIC24FJXXXGL306					_		—	—		х	х	х	х	х	х	х
PIC24FJXXXGL305	—		—	—	—		_	_	_	_	х	х	х	_	х	_
PIC24FJXXXGL303		_					_	_	_	_	_	_	_	_	х	_
PIC24FJXXXGL302							_	_	_	_		_	_	_	х	_
ANSELF Bit Present	_	_	_	_	_	_										—

TABLE 11-9: PORTG PIN AND ANSELG AVAILABILITY

Device	PORTG I/O Pins															
Device	RG15	RG14	RG13	RG12	RG11	RG10	RG9	RG8	RG7	RG6	RG5	RG4	RG3	RG2	RG1	RG0
PIC24FJXXXGL306			—	—			х	х	х	х		_	х	х	—	—
PIC24FJXXXGL305	_		_	_			—	х	х	_	_	_	х	х	_	—
PIC24FJXXXGL303		_	_	_				х	х	_	_	_	х	х	_	—
PIC24FJXXXGL302								х	х	_	_	_	х	_	_	
ANSELG Bit Present		_	_	_			х	х	х	х	_	_	_	_	_	—

11.3 Interrupt-on-Change (IOC)

The interrupt-on-change function of the I/O ports allows the PIC24FJ128GL306 family of devices to generate interrupt requests to the processor in response to a Change-of-State (COS) on selected input pins. This feature is capable of detecting input Change-of-States, even in Sleep mode, when the clocks are disabled.

Interrupt-on-change functionality is enabled on a pin by setting the IOCPx and/or IOCNx register bit for that pin. For example, PORTC has register names, IOCPC and IOCNC, for these functions. Setting a value of '1' in the IOCPx register enables interrupts for low-to-high transitions, while setting a value of '1' in the IOCNx register enables interrupts for high-to-low transitions. Setting a value of '1' in both register bits will enable interrupts for either case (e.g., a pulse on the pin will generate two interrupts). In order for any IOC to be detected, the global IOC Interrupt Enable bit (IEC1[3]) must be set, the IOCON (PADCON[15]) bit set and the associated ISFx flag cleared.

When an interrupt request is generated for a pin, the corresponding status flag (IOCFx register bit) will be set, indicating that a Change-of-State occurred on that pin. The IOCFx register bit will remain set until cleared by writing a zero to it. When any IOCFx flag bit in a given port is set, the corresponding IOCPxF bit in the IOCSTAT register will be set. This flag indicates that a change was detected on one of the bits on the given port. The IOCPxF flag will be cleared when all IOCFx[15:0] bits are cleared.

Multiple individual status flags can be cleared by writing a zero to one or more bits using a Read-Modify-Write (RMW) operation. If another edge is detected on a pin whose status bit is being cleared during the Read-Modify-Write sequence, the associated change flag will still be set at the end of the Read-Modify-Write sequence. The user should use the instruction sequence (or equivalent) shown in Example 11-1 to clear the Interrupt-on-Change Status registers.

At the end of this sequence, the W0 register will contain a zero for each bit for which the port pin had a change detected. In this way, any indication of a pin changing will not be lost.

Due to the asynchronous and real-time nature of the interrupt-on-change, the value read on the port pins may not indicate the state of the port when the change was detected, as a second change can occur during the interval between clearing the flag and reading the port. It is up to the user code to handle this case if it is a possibility in their application. To keep this interval to a minimum, it is recommended that any code modifying the IOCFx registers be run either in the interrupt handler or with interrupts disabled.

Each Interrupt-on-Change (IOC) pin has both a weak pull-up and a weak pull-down connected to it. The pullups act as a current source connected to the pin, while the pull-downs act as a current sink connected to the pin. These eliminate the need for external resistors when push button or keypad devices are connected.

The pull-ups and pull-downs are separately enabled using the IOCPUx registers (for pull-ups) and the IOCPDx registers (for pull-downs). Each IOC pin has individual control bits for its pull-up and pull-down. Setting a control bit enables the weak pull-up or pull-down for the corresponding pin.

Note: Pull-ups and pull-downs on pins should always be disabled whenever the pin is configured as a digital output.

EXAMPLE 11-1: IOC STATUS READ/CLEAR IN ASSEMBLY

MOV	OxFFFF, WO	;	Initial mask value 0xFFFF -> W0
XOR	IOCFx, WO	;	W0 has '1' for each bit set in IOCFx
AND	IOCFx	;	IOCFx & WO ->IOCFx

EXAMPLE 11-2: PORT READ/WRITE IN ASSEMBLY

MOV	0xFF00, W0	; Configure PORTB[15:8] as inputs
MOV	W0, TRISB	; and PORTB[7:0] as outputs
NOP		; Delay 1 cycle
BTSS	PORTB, #13	; Next Instruction

EXAMPLE 11-3: PORT READ/WRITE IN 'C'

TRISB = 0xFF00;	<pre>// Configure PORTB[15:8] as inputs and PORTB[7:0] as outputs</pre>
Nop();	// Delay 1 cycle
<pre>If (PORTBbits.RB13) { };</pre>	// Next Instruction

11.4 I/O Port Control Registers

REGISTER 11-1: PADCON: PORT CONFIGURATION REGISTER

R/W-0	U-0						
IOCON	—	—	—	—	—	—	—
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	—	—	—	—	—	—	—
bit 7					•		bit 0
Legend:							

R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 IOCON: Interrupt-on-Change Enable bit

1 = Interrupt-on-change functionality is enabled

0 = Interrupt-on-change functionality is disabled

bit 14-0 Unimplemented: Read as '0'

REGISTER 11-2: IOCSTAT: INTERRUPT-ON-CHANGE STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	R/HS/HC-0						
_	IOCPGF	IOCPFF	IOCPEF	IOCPDF	IOCPCF	IOCPBF	IOCPAF
bit 7							bit 0

Legend:	HS = Hardware Settable bit	HC = Hardware Clearable b	it
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

Unimplemented: Read as '0'
IOCPGF: Interrupt-on-Change PORTG Flag bit 1 = A change was detected on an IOC-enabled pin on PORTG 0 = No change was detected or the user has cleared all detected changes
IOCPFF: Interrupt-on-Change PORTF Flag bit 1 = A change was detected on an IOC-enabled pin on PORTF
0 = No change was detected or the user has cleared all detected changes
IOCPEF: Interrupt-on-Change PORTE Flag bit
 1 = A change was detected on an IOC-enabled pin on PORTE 0 = No change was detected or the user has cleared all detected changes
IOCPDF: Interrupt-on-Change PORTD Flag bit
1 = A change was detected on an IOC-enabled pin on PORTD
0 = No change was detected or the user has cleared all detected changes
IOCPCF: Interrupt-on-Change PORTC Flag bit
 1 = A change was detected on an IOC-enabled pin on PORTC 0 = No change was detected or the user has cleared all detected changes
IOCPBF: Interrupt-on-Change PORTB Flag bit
 1 = A change was detected on an IOC-enabled pin on PORTB 0 = No change was detected or the user has cleared all detected changes
IOCPAF: Interrupt-on-Change PORTA Flag bit 1 = A change was detected on an IOC-enabled pin on PORTA 0 = No change was detected, or the user has cleared all detected change

REGISTER 11-3: TRISX: OUTPUT ENABLE FOR PORTX REGISTER⁽¹⁾

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			TRIS	x[15:8]			
bit 15							bit 8
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			TRIS	Sx[7:0]			
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimplemented bit, read as '0'			
-n = Value at P	OR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown

bit 15-0 **TRISx[15:0]:** Output Enable for PORTx bits 1 = LATx[n] is not driven on the PORTx[n] pin 0 = LATx[n] is driven on the PORTx[n] pin

Note 1: See Table 11-3 through Table 11-9 for individual bit availability in this register.

REGISTER 11-4: PORTX: INPUT DATA FOR PORTX REGISTER⁽¹⁾

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			PORT	Fx[15:8]			
bit 15							bit 8
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			POR	Tx[7:0]			
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit		t	U = Unimplemented bit, read as '0'				
-n = Value at POR '1' = Bit is set '0' = Bit is cleared		x = Bit is unknown					

bit 15-0 **PORTx[15:0]:** PORTx Data Input Value bits

Note 1: See Table 11-3 through Table 11-9 for individual bit availability in this register.

REGISTER 11-5: LATX: OUTPUT DATA FOR PORTX REGISTER⁽¹⁾

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
			LAT	x[15:8]				
bit 15							bit 8	
R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
			LAT	x[7:0]				
bit 7							bit 0	
Legend:								
R = Readable I	bit	W = Writable bit U = Unimplemented bit, read as '0'						
-n = Value at P	OR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unknown		

bit 15-0 LATx[15:0]: PORTx Data Output Value bits

Note 1: See Table 11-3 through Table 11-9 for individual bit availability in this register.

REGISTER 11-6: ODCx: OPEN-DRAIN ENABLE FOR PORTx REGISTER⁽¹⁾

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
			ODC>	(15:8]						
bit 15							bit 8			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
	ODCx[7:0]									
bit 7							bit 0			

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **ODCx[15:0]:** PORTx Open-Drain Enable bits 1 = Open-drain is enabled on the PORTx pin 0 = Open-drain is disabled on the PORTx pin

Note 1: See Table 11-3 through Table 11-9 for individual bit availability in this register.

REGISTER 11-7:	ANSELX: ANALOG SELECT FOR PORTX REGISTER ⁽¹⁾
----------------	---

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			ANSE	ELx[15:8]			
bit 15							bit 8
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			ANS	ELx[7:0]			
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable b	oit	U = Unimpler	mented bit, rea	ad as '0'	
-n = Value at F	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unknown	

bit 15-0 ANSELx[15:0]: Analog Select for PORTx bits

1 = Analog input is enabled and digital input is disabled on the PORTx[n] pin

0 = Analog input is disabled and digital input is enabled on the PORTx[n] pin

Note 1: See Table 11-3 through Table 11-9 for individual bit availability in this register.

IOCPx: INTERRUPT-ON-CHANGE POSITIVE EDGE x REGISTER^(1,2,3) **REGISTER 11-8:**

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
			IOCF	Px[15:8]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			IOCI	Px[7:0]			
bit 7							bit 0
Legend:							
R = Readable bitW = Writable bitU = Unimplemented bit, read as '0'							

bit 15-0 IOCPx[15:0]: Interrupt-on-Change Positive Edge x Enable bits

'1' = Bit is set

1 = Interrupt-on-change is enabled on the IOCx pin for a positive going edge; the associated status bit and interrupt flag will be set upon detecting an edge

'0' = Bit is cleared

- 0 = Interrupt-on-change is disabled on the IOCx pin for a positive going edge
- Note 1: Setting both IOCPx and IOCNx will enable the IOCx pin for both edges, while clearing both registers will disable the functionality.
 - 2: Changing the value of this register while the module is enabled (IOCON = 1) may cause a spurious IOC event. The corresponding interrupt must be ignored, cleared (using IOCFx) or masked (within the interrupt controller), or this module must be enabled (IOCON = 0) when changing this register.
 - 3: See Table 11-3 through Table 11-9 for individual bit availability in this register.

-n = Value at POR

x = Bit is unknown

REGISTER 11-9: IOCNX: INTERRUPT-ON-CHANGE NEGATIVE EDGE x REGISTER^(1,2,3)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
			IOC	Nx[15:8]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			IOC	Nx[7:0]			
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable bit	t	U = Unimplem	nented bit, rea	ad as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unknown	

bit 15-0 **IOCNx[15:0]:** Interrupt-on-Change Negative Edge x Enable bits

- 1 = Interrupt-on-change is enabled on the IOCx pin for a negative going edge; the associated status bit and interrupt flag will be set upon detecting an edge
- 0 = Interrupt-on-change is disabled on the IOCx pin for a negative going edge
- **Note 1:** Setting both IOCPx and IOCNx will enable the IOCx pin for both edges, while clearing both registers will disable the functionality.
 - 2: Changing the value of this register while the module is enabled (IOCON = 1) may cause a spurious IOC event. The corresponding interrupt must be ignored, cleared (using IOCFx) or masked (within the interrupt controller), or this module must be enabled (IOCON = 0) when changing this register.
 - **3:** See Table 11-3 through Table 11-9 for individual bit availability in this register.

REGISTER 11-10: IOCFx: INTERRUPT-ON-CHANGE FLAG x REGISTER^(1,2)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
			IOC	Fx[15:8]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			100	CFx[7:0]			
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable bit	t	U = Unimplemented bit, read as '0'			
-n = Value at	POR	'1' = Bit is set	set '0' = Bit is cleared x = Bit is unkn		nown		

bit 15-0 **IOCFx[15:0]:** Interrupt-on-Change Flag x bits

- 1 = An enabled change was detected on the associated pin; set when IOCPx = 1 and a positive edge was detected on the IOCx pin, or when IOCNx = 1 and a negative edge was detected on the IOCx pin
 0 = No change was detected or the user cleared the detected change
- **Note 1:** It is not possible to set the IOCFx register bits with software writes (as this would require the addition of significant logic). To test IOC interrupts, it is recommended to enable the IOC functionality on one or more GPIO pins and then use the corresponding LATx register bit(s) to trigger an IOC interrupt.

2: See Table 11-3 through Table 11-9 for individual bit availability in this register.

REGISTER 11-11: IOCPUX: INTERRUPT-ON-CHANGE PULL-UP ENABLE x REGISTER⁽¹⁾

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
			IOCF	PUx[15:8]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
N/ W-0	N/W-0	17/00-0		PUx[7:0]	N/ VV-0	N/W-0	11/00-0
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit			U = Unimplemented bit, read as '0'				
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unkno		nown		

bit 15-0 **IOCPUx[15:0]**: Interrupt-on-Change Pull-up Enable x bits

1 = Pull-up is enabled

0 =Pull-up is disabled

Note 1: See Table 11-3 through Table 11-9 for individual bit availability in this register.

REGISTER 11-12: IOCPDx: INTERRUPT-ON-CHANGE PULL-DOWN ENABLE x REGISTER⁽¹⁾

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	
			IOCF	PDx[15:8]				
bit 15							bit 8	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
			IOCI	PDx[7:0]				
bit 7							bit 0	
r								
Legend:								
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'								
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	ed x = Bit is unknown		

bit 15-0 **IOCPDx[15:0]:** Interrupt-on-Change Pull-Down Enable x bits

1 = Pull-down is enabled

0 = Pull-down is disabled

Note 1: See Table 11-3 through Table 11-9 for individual bit availability in this register.

11.5 Peripheral Pin Select (PPS)

A major challenge in general purpose devices is providing the largest possible set of peripheral features while minimizing the conflict of features on I/O pins. In an application that needs to use more than one peripheral multiplexed on a single pin, inconvenient work arounds in application code, or a complete redesign, may be the only option.

The Peripheral Pin Select (PPS) feature provides an alternative to these choices by enabling the user's peripheral set selection and its placement on a wide range of I/O pins. By increasing the pinout options available on a particular device, users can better tailor the microcontroller to their entire application, rather than trimming the application to fit the device.

The Peripheral Pin Select feature operates over a fixed subset of digital I/O pins. Users may independently map the input and/or output of any one of many digital peripherals to any one of these I/O pins. PPS is performed in software and generally does not require the device to be reprogrammed. Hardware safeguards are included that prevent accidental or spurious changes to the peripheral mapping once it has been established.

11.5.1 AVAILABLE PINS

The number of available pins is dependent on the particular device and its pin count. Pins that support the Peripheral Pin Select feature include the designation, "RPn" or "RPIn", in their full pin designation, where "n" is the remappable pin number. "RP" is used to designate pins that support both remappable input and output functions, while "RPI" indicates pins that support remappable input functions only.

PIC24FJ128GL306 family devices support a larger number of remappable input/output pins than remappable input only pins. In this device family, there are up to 33 remappable input/output pins, depending on the pin count of the particular device selected. These pins are numbered, RP0 through RP31 and RPI37.

See Table 1-1 for a summary of pinout options in each package offering.

11.5.2 AVAILABLE PERIPHERALS

The peripherals managed by the PPS are all digital only peripherals. These include general serial communications (UART and SPI), general purpose timer clock inputs, timer related peripherals (input capture and output compare) and external interrupt inputs. Also included are the outputs of the comparator module, since these are discrete digital signals. PPS is not available for these peripherals:

- I²C (input and output)
- Input Change Notifications
- Analog (inputs and outputs)
- INT0

A key difference between pin select and non-pin select peripherals is that pin select peripherals are not associated with a default I/O pin. The peripheral must always be assigned to a specific I/O pin before it can be used. In contrast, non-pin select peripherals are always available on a default pin, assuming that the peripheral is active and not conflicting with another peripheral.

11.5.2.1 Peripheral Pin Select Function Priority

Pin-selectable peripheral outputs (e.g., output compare, UART transmit) will take priority over general purpose digital functions on a pin, such as port I/O. Specialized digital outputs will take priority over PPS outputs on the same pin. The pin diagrams list peripheral outputs in the order of priority. Refer to them for priority concerns on a particular pin.

Unlike PIC24F devices with fixed peripherals, pinselectable peripheral inputs will never take ownership of a pin. The pin's output buffer will be controlled by the TRISx setting or by a fixed peripheral on the pin. If the pin is configured in Digital mode, then the PPS input will operate correctly. If an analog function is enabled on the pin, the PPS input will be disabled.

11.5.3 CONTROLLING PERIPHERAL PIN SELECT

PPS features are controlled through two sets of Special Function Registers (SFRs): one to map peripheral inputs and one to map outputs. Because they are separately controlled, a particular peripheral's input and output (if the peripheral has both) can be placed on any selectable function pin without constraint.

The association of a peripheral to a peripheral-selectable pin is handled in two different ways, depending on if an input or an output is being mapped.

11.5.3.1 Input Mapping

The inputs of the Peripheral Pin Select options are mapped on the basis of the peripheral; that is, a control register associated with a peripheral dictates the pin it will be mapped to. The RPINRx registers are used to configure peripheral input mapping (see Register 11-13 through Register 11-33).

Each register contains one or two sets of 6-bit fields, with each set associated with one of the pin-selectable peripherals. Programming a given peripheral's bit field with an appropriate 6-bit value maps the RPn/RPIn pin with that value to that peripheral. For any given device, the valid range of values for any of the bit fields corresponds to the maximum number of Peripheral Pin Selections supported by the device.

TABLE 11-10: SELECTABLE INPUT SOURCES (MAPS INPUT TO FUNCTION)⁽¹⁾

Input Name	Function Name	Register	Function Mapping Bits	
External Interrupt 1	INT1	RPINR0[13:8]	INT1R[5:0]	
External Interrupt 2	INT2	RPINR1[5:0]	INT2R[5:0]	
External Interrupt 3	INT3	RPINR1[13:8]	INT3R[5:0]	
External Interrupt 4	INT4	RPINR2[5:0]	INT4R[5:0]	
Timer2 External Clock	T2CK	RPINR3[5:0]	T2CKR[5:0]	
Timer3 External Clock	T3CK	RPINR3[13:8]	T3CKR[5:0]	
Timer4 External Clock	T4CK	RPINR4[5:0]	T4CKR[5:0]	
Timer5 External Clock	T5CK	RPINR4[13:8]	T5CKR[5:0]	
CCP Capture 1	ICM1	RPINR5[5:0]	ICM1R[5:0]	
CCP Capture 2	ICM2	RPINR5[13:8]	ICM2R[5:0]	
CCP Capture 3	ICM3	RPINR6[5:0]	ICM3R[5:0]	
CCP Capture 4	ICM4	RPINR6[13:8]	ICM4R[5:0]	
Output Compare Fault A	OCFA	RPINR11[5:0]	OCFAR[5:0]	
Output Compare Fault B	OCFB	RPINR11[13:8]	OCFBR[5:0]	
CCP Clock Input A	TCKIA	RPINR12[5:0]	TCKIAR[5:0]	
CCP Clock Input B	TCKIB	RPINR12[13:8]	TCKIBR[5:0]	
Reference Clock Input	REFI	RPINR13[5:0]	REFIR[5:0]	
Tamper Detect	TMPRN	RPINR13[13:8]	TMPRNR[5:0]	
CCP Capture 5	ICM5	RPINR14[5:0]	ICM5R[5:0]	
UART3 Receive	U3RX	RPINR17[13:8]	U3RXR[5:0]	
UART1 Receive	U1RX	RPINR18[5:0]	U1RXR[5:0]	
UART1 Clear-to-Send	U1CTS	RPINR18[13:8]	U1CTSR[5:0]	
UART2 Receive	U2RX	RPINR19[5:0]	U2RXR[5:0]	
UART2 Clear-to-Send	U2CTS	RPINR19[13:8]	U2CTSR[5:0]	
SPI1 Data Input	SDI1	RPINR20[5:0]	SDI1R[5:0]	
SPI1 Clock Input	SCK1IN	RPINR20[13:8]	SCK1R[5:0]	
SPI1 Slave Select Input	SS1IN	RPINR21[5:0]	SS1R[5:0]	
UART3 Clear-to-Send	U3CTS	RPINR21[13:8]	U3CTSR[5:0]	
SPI2 Data Input	SDI2	RPINR22[5:0]	SDI2R[5:0]	
SPI2 Clock Input	SCK2IN	RPINR22[13:8]	SCK2R[5:0]	
SPI2 Slave Select Input	SS2IN	RPINR23[5:0]	SS2R[5:0]	
Generic Timer External Clock	TxCK	RPINR23[13:8]	TXCKR[5:0]	
CLC Input A	CLCINA	RPINR25[5:0]	CLCINAR[5:0]	
CLC Input B	CLCINB	RPINR25[13:8]	CLCINBR[5:0]	
CLC Input C	CLCINC	RPINR26[5:0]	CLCINCR[5:0]	
CLC Input D	CLCIND	RPINR26[13:8]	CLCINDR[5:0]	
UART4 Receive	U4RX	RPINR27[5:0]	U4RXR[5:0]	
UART4 Clear-to-Send	U4CTS	RPINR27[13:8]	U4CTSR[5:0]	

Note 1: Unless otherwise noted, all inputs use the Schmitt Trigger (ST) input buffers.

11.5.3.2 Output Mapping

In contrast to inputs, the outputs of the Peripheral Pin Select options are mapped on the basis of the pin. In this case, a control register associated with a particular pin dictates the peripheral output to be mapped. The RPORx registers are used to control output mapping. Each register contains two 6-bit fields, with each field being associated with either one RPa pin or one RPb pin (see Register 11-34, Table 11-13 and Table 11-14). The value of the bit field corresponds to one of the peripherals and that peripheral's output is mapped to the pin (see Table 11-11).

Because of the mapping technique, the list of peripherals for output mapping also includes a null value of '000000'. This permits any given pin to remain disconnected from the output of any of the pin-selectable peripherals.

TABI F 11-11	SELECTABLE OUTPUT SOURCES	(MAPS FUNCTION TO OUTPUT)

Output Function Number	Function	Output Name
0	None (Pin Disabled)	_
1	C1OUT	Comparator 1 Output
2	C2OUT	Comparator 2 Output
3	U1TX	UART1 Transmit
4	U1RTS	UART1 Request-to-Send
5	U2TX	UART2 Transmit
6	U2RTS	UART2 Request-to-Send
7	SDO1	SPI1 Data Output
8	SCK1OUT	SPI1 Clock Output
9	SS1OUT	SPI1 Slave Select Output
10	SDO2	SPI2 Data Output
11	SCK2OUT	SPI2 Clock Output
12	SS2OUT	SPI2 Slave Select Output
16	OCM2A	CCP2A Output Compare
17	OCM2B	CCP2B Output Compare
18	OCM3A	CCP3A Output Compare
19	OCM3B	CCP3B Output Compare
20	OCM4A	CCP4A Output Compare
21	OCM4B	CCP4B Output Compare
22	U3TX	UART3 Transmit
23	U3RTS	UART3 Request-to-Send
24	U4TX	UART4 Transmit
25	U4RTS	UART4 Request-to-Send
26	C3OUT	Comparator 3 Output
27	PWRGT	RTCC Power Control
28	REFO	Reference Clock Output
29	CLC10UT	CLC1 Output
30	CLC2OUT	CLC2 Output
31	CLC3OUT	CLC3 Output
32	CLC4OUT	CLC4 Output
33	RTCC	RTCC Clock Output
34	OCM5B	CCP5B Output Compare
35	OCM5A	CCP5A Output Compare

11.5.3.3 Mapping Limitations

The control schema of the Peripheral Pin Select is extremely flexible. Other than systematic blocks that prevent signal contention, caused by two physical pins being configured as the same functional input or two functional outputs configured as the same pin, there are no hardware enforced lockouts. The flexibility extends to the point of allowing a single input to drive multiple peripherals or a single functional output to drive multiple output pins.

11.5.3.4 Mapping Exceptions for Family Devices

The differences in available remappable pins are summarized in Table 11-12.

When developing applications that use remappable pins, users should also keep these things in mind:

- For the RPINRx registers, bit combinations corresponding to an unimplemented pin for a particular device are treated as invalid; the corresponding module will not have an input mapped to it.
- For RPORx registers, the bit fields corresponding to an unimplemented pin will also be unimplemented; writing to these fields will have no effect.

11.5.4 CONTROLLING CONFIGURATION CHANGES

Because peripheral remapping can be changed during run time, some restrictions on peripheral remapping are needed to prevent accidental configuration changes. PIC24F devices include three features to prevent alterations to the peripheral map:

- Control register lock sequence
- Continuous state monitoring
- Configuration bit remapping lock

11.5.4.1 Control Register Lock

Under normal operation, writes to the RPINRx and RPORx registers are not allowed. Attempted writes will appear to execute normally, but the contents of the registers will remain unchanged. To change these registers, they must be unlocked in hardware. The register lock is controlled by the IOLOCK bit (OSCCON[6]). Setting IOLOCK prevents writes to the control registers; clearing IOLOCK allows writes.

To set or clear IOLOCK, a specific command sequence must be executed:

- 1. Write 46h to OSCCON[7:0].
- 2. Write 57h to OSCCON[7:0].
- 3. Clear (or set) IOLOCK as a single operation.

Unlike the similar sequence with the oscillator's LOCK bit, IOLOCK remains in one state until changed. This allows all of the Peripheral Pin Selects to be configured with a single unlock sequence, followed by an update to all control registers, then locked with a second lock sequence.

11.5.4.2 Continuous State Monitoring

In addition to being protected from direct writes, the contents of the RPINRx and RPORx registers are constantly monitored in hardware by shadow registers. If an unexpected change in any of the registers occurs (such as cell disturbances caused by ESD or other external events), a Configuration Mismatch Reset will be triggered.

11.5.4.3 Configuration Bit Pin Select Lock

As an additional level of safety, the device can be configured to prevent more than one write session to the RPINRx and RPORx registers. The IOL1WAY (FOSC[5]) Configuration bit blocks the IOLOCK bit from being cleared after it has been set once. If IOLOCK remains set, the register unlock procedure will not execute and the Peripheral Pin Select Control registers cannot be written to. The only way to clear the bit and re-enable peripheral remapping is to perform a device Reset.

In the default (unprogrammed) state, IOL1WAY is set, restricting users to one write session. Programming IOL1WAY allows users unlimited access (with the proper use of the unlock sequence) to the Peripheral Pin Select registers.

TABLE 11-12: REMAPPABLE PIN EXCEPTIONS FOR PIC24FJ128GL306 FAMILY DEVICES

Device	RPn Pins (I/O)		RPIn Pins		
Device	Total	Unimplemented	Total	Unimplemented	
PIC24FJXXXGL306	32	_	1		
PIC24FJXXXGL305	24	_	1	—	
PIC24FJXXXGL303	15		1	—	
PIC24FJXXXGL302	13	_	1	—	

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11.5.5 CONSIDERATIONS FOR PERIPHERAL PIN SELECTION

The ability to control Peripheral Pin Selection introduces several considerations into application design that could be overlooked. This is particularly true for several common peripherals that are available only as remappable peripherals.

The main consideration is that the Peripheral Pin Selects are not available on default pins in the device's default (Reset) state. Since all RPINRx registers reset to '111111' and all RPORx registers reset to '000000', all Peripheral Pin Select inputs are tied to Vss, and all Peripheral Pin Select outputs are disconnected.

This situation requires the user to initialize the device with the proper peripheral configuration before any other application code is executed. Since the IOLOCK bit resets in the unlocked state, it is not necessary to execute the unlock sequence after the device has come out of Reset. For application safety, however, it is best to set IOLOCK and lock the configuration after writing to the control registers.

Because the unlock sequence is timing-critical, it must be executed as an assembly language routine in the same manner as changes to the oscillator configuration. If the bulk of the application is written in 'C', or another high-level language, the unlock sequence should be performed by writing in-line assembly.

Choosing the configuration requires the review of all Peripheral Pin Selects and their pin assignments, especially those that will not be used in the application. In all cases, unused pin-selectable peripherals should be disabled completely. Unused peripherals should have their inputs assigned to an unused RPn/RPIn pin function. I/O pins with unused RPn functions should be configured with the null peripheral output.

The assignment of a peripheral to a particular pin does not automatically perform any other configuration of the pin's I/O circuitry. In theory, this means adding a pinselectable output to a pin may mean inadvertently driving an existing peripheral input when the output is driven. Users must be familiar with the behavior of other fixed peripherals that share a remappable pin and know when to enable or disable them. To be safe, fixed digital peripherals that share the same pin should be disabled when not in use.

Along these lines, configuring a remappable pin for a specific peripheral does not automatically turn that feature on. The peripheral must be specifically configured for operation and enabled as if it were tied to a fixed pin. Where this happens in the application code (immediately following a device Reset and peripheral configuration or inside the main application routine) depends on the peripheral and its use in the application.

A final consideration is that Peripheral Pin Select functions neither override analog inputs nor reconfigure pins with analog functions for digital I/Os. If a pin is configured as an analog input on a device Reset, it must be explicitly reconfigured as a digital I/O when used with a Peripheral Pin Select.

Example 11-4 shows a configuration for bidirectional communication with flow control using UART1. The following input and output functions are used:

- Input Functions: U1RX, U1CTS
- Output Functions: U1TX, U1RTS

EXAMPLE 11-4:	CONFIGURING UART1
	INPUT AND OUTPUT
	FUNCTIONS

	Unlock Regi	sters		
asm	volatile	("MOV	#OSCCON, w1	\n"
		"MOV	#0x46, w2	\n"
		"MOV	#0x57, w3	\n"
		"MOV.b	w2, [w1]	\n"
		"MOV.b	w3, [w1]	\n"
		"BCLR	OSCCON, #6")	;
//	or use XC16			
//	builtin_w	rite_OS	CCONL (OSCCON &	0xbf)
//	Configure I	nput Fu	nctions (Table 1	11-10)
	// Assign U	1RX To 1	Pin RPO	
	RPINR18bits	.Ulrxr =	= 0;	
	// Assign U	1CTS To	Pin RP1	
	RPINR18bits	.U1CTSR	= 1;	
//	Configure O	utput Fi	unctions (Table	11-11)
	// Assign U	1TX To 1	Pin RP2	
	RPOR1bits.R	P2R = 3	;	
	// Assign U	1RTS TO	Din DD2	
		TI(TO TO	PIN RPS	
	RPOR1bits.R			
//	-	P3R = 4;		
	RPOR1bits.R Lock Regist	P3R = 4; ers		\n "
	RPOR1bits.R Lock Regist	P3R = 4, ers ("MOV	#OSCCON, w1	\n" \n"
	RPOR1bits.R Lock Regist	P3R = 4, ers ("MOV "MOV	#OSCCON, w1	\n"
	RPOR1bits.R Lock Regist	P3R = 4, ers ("MOV "MOV "MOV	#OSCCON, w1 #0x46, w2	\n"
	RPOR1bits.R Lock Regist	P3R = 4, ers ("MOV "MOV "MOV "MOV.b	#OSCCON, w1 #0x46, w2 #0x57, w3	\n" \n"
	RPOR1bits.R Lock Regist	P3R = 4, ers ("MOV "MOV "MOV.b "MOV.b	#OSCCON, w1 #0x46, w2 #0x57, w3 w2, [w1]	\n" \n" \n" \n"
asm	RPOR1bits.R Lock Regist	P3R = 4, ers ("MOV "MOV "MOV.b "MOV.b "BSET	#OSCCON, w1 #0x46, w2 #0x57, w3 w2, [w1] w3, [w1] OSCCON, #6")	\n" \n" \n" \n"

11.5.6 PERIPHERAL PIN SELECT REGISTERS

The PIC24FJ128GL306 family of devices implements a total of 36 registers for remappable peripheral configuration:

- Input Remappable Peripheral Registers (21)
- Output Remappable Peripheral Registers (15)

Note: Input and Output register values can only be changed if IOLOCK (OSCCON[6]) = 0. See Section 11.5.4.1 "Control Register Lock" for a specific command sequence.

REGISTER 11-13: RPINR0: PERIPHERAL PIN SELECT INPUT REGISTER 0

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	INT1R5	INT1R4	INT1R3	INT1R2	INT1R1	INT1R0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	—	—	—	—	_	_	—
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit				U = Unimplemented bit, read as '0'			
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	

bit 15-14	Unimplemented: Read as '0'
bit 13-8	INT1R[5:0]: Assign External Interrupt 1 (INT1) to the Corresponding RPn or RPIn Pin bits
bit 7-0	Unimplemented: Read as '0'

REGISTER 11-14: RPINR1: PERIPHERAL PIN SELECT INPUT REGISTER 1

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	
		INT3R5	INT3R4	INT3R3	INT3R2	INT3R1	INT3R0	
bit 15							bit 8	
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	
—	_	INT2R5	INT2R4	INT2R3	INT2R2	INT2R1	INT2R0	
bit 7							bit 0	
Legend:								
R = Readable	bit	W = Writable I	oit	U = Unimplem	nented bit, read	d as '0'		
-n = Value at POR		'1' = Bit is set	'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	
-n – value at i	-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown							
bit 15-14 Unimplemented: Read as '0'								

bit 15-14	Unimplemented: Read as '0'
bit 13-8	INT3R[5:0]: Assign External Interrupt 3 (INT3) to the Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	INT2R[5:0]: Assign External Interrupt 2 (INT2) to the Corresponding RPn or RPIn Pin bits

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	—	—	—	—	—	—	—
bit 15		•	•				bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	—	INT4R5	INT4R4	INT4R3	INT4R2	INT4R1	INT4R0
bit 7		•		•	•		bit 0
Legend:							

R = Readable bit	Readable bit W = Writable bit		1 as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15-6 Unimplemented: Read as '0'

bit 5-0 INT4R[5:0]: Assign External Interrupt 4 (INT4) to the Corresponding RPn or RPIn Pin bits

REGISTER 11-16: RPINR3: PERIPHERAL PIN SELECT INPUT REGISTER 3

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	T3CKR5	T3CKR4	T3CKR3	T3CKR2	T3CKR1	T3CKR0
bit 15 bit 8							

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	T2CKR5	T2CKR4	T2CKR3	T2CKR2	T2CKR1	T2CKR0
bit 7 bit 0							

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-14 Unimplemented: Read as '0'

bit 13-8 T3CKR[5:0]: Assign Timer3 Clock (T3CK) to the Corresponding RPn or RPIn Pin bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 T2CKR[5:0]: Assign Timer2 Clock to (T2CK) the Corresponding RPn or RPIn Pin bits

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
	—	T5CKR5	T5CKR4	T5CKR3	T5CKR2	T5CKR1	T5CKR0
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
		TAOKDE	TIOKDA	TIOKDA	TIOKDO	TIOKEL	TIOKDO

0-0	0-0	1 1/ 1/ 1	1 1/ 1/ 1	1 1/ 1/ 1	1 1/ 1/ 1	1 1/ 1/ 1	1 \/ V V - 1
—	—	T4CKR5	T4CKR4	T4CKR3	T4CKR2	T4CKR1	T4CKR0
bit 7							bit 0

Legend:				
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-14	Unimplemented: Read as '0'
bit 13-8	T5CKR[5:0]: Assign Timer5 Clock (T5CK) to the Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	T4CKR[5:0]: Assign Timer4 Clock (T4CK) to the Corresponding RPn or RPIn Pin bits

REGISTER 11-18: RPINR5: PERIPHERAL PIN SELECT INPUT REGISTER 5

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	ICM2R5	ICM2R4	ICM2R3	ICM2R2	ICM2R1	ICM2R0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	ICM1R5	ICM1R4	ICM1R3	ICM1R2	ICM1R1	ICM1R0
bit 7							bit 0

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-14 Unimplemented: Read as '0'

bit 13-8 ICM2R[5:0]: Assign CCP2 Capture Mode (ICM2) to the Corresponding RPn or RPIn Pin bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 ICM1R[5:0]: Assign CCP1 Capture Mode (ICM1) to the Corresponding RPn or RPIn Pin bits

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	ICM4R5	ICM4R4	ICM4R3	ICM4R2	ICM4R1	ICM4R0
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	—	ICM3R5	ICM3R4	ICM3R3	ICM3R2	ICM3R1	ICM3R0
bit 7							bit 0
Logond							

REGISTER 11-19: RPINR6: PERIPHERAL PIN SELECT INPUT REGISTER 6

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-8	ICM4R[5:0]: Assign CCP4 Capture Mode (ICM4) to the Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	ICM3R[5:0]: Assign CCP3 Capture Mode (ICM3) to the Corresponding RPn or RPIn Pin bits

REGISTER 11-20: RPINR11: PERIPHERAL PIN SELECT INPUT REGISTER 11

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	OCFBR5	OCFBR4	OCFBR3	OCFBR2	OCFBR1	OCFBR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	OCFAR5	OCFAR4	OCFAR3	OCFAR2	OCFAR1	OCFAR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **OCFBR[5:0]:** Assign Output Compare Fault B (OCFB) to the Corresponding RPn or RPIn Pin bits bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 OCFAR[5:0]: Assign Output Compare Fault A (OCFA) to the Corresponding RPn or RPIn Pin bits

REGISTER 11-21: RPINR12: PERIPHERAL PIN SELECT INPUT REGISTER 12

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	TCKIBR5	TCKIBR4	TCKIBR3	TCKIBR2	TCKIBR1	TCKIBR0
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
	_	TCKIAR5	TCKIAR4	TCKIAR3	TCKIAR2	TCKIAR1	TCKIAR0
							bit 0

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **TCKIBR[5:0]:** Assign MCCP Clock Input B (TCKIB) to the Corresponding RPn or RPIn Pin bits bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 TCKIAR[5:0]: Assign MCCP Clock Input A (TCKIA) to the Corresponding RPn or RPIn Pin bits

REGISTER 11-22: RPINR13: PERIPHERAL PIN SELECT INPUT REGISTER 13

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	TMPRNR5	TMPRNR4	TMPRNR3	TMPRNR2	TMPRNR1	TMPRNR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	REFIR5	REFIR4	REFIR3	REFIR2	REFIR1	REFIR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **TMPRNR[5:0]:** Assign Tamper Detect (TMPRN) to the Corresponding RPn or RPIn Pin bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 **REFIR[5:0]:** Assign Reference Clock Input (REFI) to the Corresponding RPn or RPIn Pin bits

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	—	—	—	—	—	—
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	ICM5R5	ICM5R4	ICM5R3	ICM5R2	ICM5R1	ICM5R0
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'	
-n = Value at POR '1' = Bit is set			'0' = Bit is clea	ared	x = Bit is unkr	nown	

REGISTER 11-23: RPINR14: PERIPHERAL PIN SELECT INPUT REGISTER 14

bit 15-6 Unimplemented: Read as '0'

bit 5-0 ICM5R[5:0]: Assign CCP5 Capture Mode (ICM5) to the Corresponding RPn or RPIn Pin bits

REGISTER 11-24: RPINR17: PERIPHERAL PIN SELECT INPUT REGISTER 17

'1' = Bit is set

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U3RXR5	U3RXR4	U3RXR3	U3RXR2	U3RXR1	U3RXR0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7	•		•	•	•		bit 0
Legend:							
R = Readable bit W = Writable bit		bit	U = Unimplem	nented bit, read	as '0'		

'0' = Bit is cleared x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

-n = Value at POR

bit 13-8 U3RXR[5:0]: Assign UART3 Receive (U3RX) to the Corresponding RPn or RPIn Pin bits

bit 7-0 Unimplemented: Read as '0'

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U1CTSR5	U1CTSR4	U1CTSR3	U1CTSR2	U1CTSR1	U1CTSR0
bit 15							bit 8
					-		
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
U-0 —		R/W-1 U1RXR5	R/W-1 U1RXR4	R/W-1 U1RXR3	R/W-1 U1RXR2	R/W-1 U1RXR1	R/W-1 U1RXR0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-8	U1CTSR[5:0]: Assign UART1 Clear-to-Send (U1CTS) to the Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	U1RXR[5:0]: Assign UART1 Receive (U1RX) to the Corresponding RPn or RPIn Pin bits

REGISTER 11-26: RPINR19: PERIPHERAL PIN SELECT INPUT REGISTER 19

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U2CTSR5	U2CTSR4	U2CTSR3	U2CTSR2	U2CTSR1	U2CTSR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U2RXR5	U2RXR4	U2RXR3	U2RXR2	U2RXR1	U2RXR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 U2CTSR[5:0]: Assign UART2 Clear-to-Send (U2CTS) to the Corresponding RPn or RPIn Pin bits bit 7-6 Unimplemented: Read as '0'

bit 5-0 U2RXR[5:0]: Assign UART2 Receive (U2RX) to the Corresponding RPn or RPIn Pin bits

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
	_	SCK1R5	SCK1R4	SCK1R3	SCK1R2	SCK1R1	SCK1R0
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	SDI1R5	SDI1R4	SDI1R3	SDI1R2	SDI1R1	SDI1R0
bit 7							bit 0
l edenq.							

REGISTER 11-27: RPINR20: PERIPHERAL PIN SELECT INPUT REGISTER 20

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-14	Unimplemented: Read as '0'
bit 13-8	SCK1R[5:0]: Assign SPI1 Clock Input (SCK1IN) to the Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	SDI1R[5:0]: Assign SPI1 Data Input (SDI1) to the Corresponding RPn or RPIn Pin bits

REGISTER 11-28: RPINR21: PERIPHERAL PIN SELECT INPUT REGISTER 21

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	U3CTSR5	U3CTSR4	U3CTSR3	U3CTSR2	U3CTSR1	U3CTSR0
bit 15					•		bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	—	SS1R5	SS1R4	SS1R3	SS1R2	SS1R1	SS1R0
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit		bit	U = Unimplemented bit, read as '0'				
-n = Value at POR '1':		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	

bit 15-4 Unimplemented: Read as '0'

bit U3CTSR[5:0]: Assign UART3 Receive (U3CTS) to the Corresponding RPn or RPIn Pin bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 SS1R[5:0]: Assign SPI1 Slave Select Input (SS1IN) to the Corresponding RPn or RPIn Pin bits

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	—	SCK2R5	SCK2R4	SCK2R3	SCK2R2	SCK2R1	SCK2R0
bit 15					•	•	bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_		SDI2R5	SDI2R4	SDI2R3	SDI2R2	SDI2R1	SDI2R0
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit		bit	U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	

bit 15-14	Unimplemented: Read as '0'
bit 13-8	SCK2R[5:0]: Assign SPI2 Clock Input (SCK2IN) to the Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	SDI2R[5:0]: Assign SPI2 Data Input (SDI2) to the Corresponding RPn or RPIn Pin bits

REGISTER 11-30: RPINR23: PERIPHERAL PIN SELECT INPUT REGISTER 23

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	TXCKR5	TXCKR4	TXCKR3	TXCKR2	TXCKR1	TXCKR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	SS2R5	SS2R4	SS2R3	SS2R2	SS2R1	SS2R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **TXCKR[5:0]:** Assign Generic Timer External Clock (TxCK) to the Corresponding RPn or RPIn Pin bits bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 SS2R[5:0]: Assign SPI2 Slave Select Input (SS2IN) to the Corresponding RPn or RPIn Pin bits

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	CLCINBR5	CLCINBR4	CLCINBR3	CLCINBR2	CLCINBR1	CLCINBR0
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1

REGISTER 11-31: RPINR25: PERIPHERAL PIN SELECT INPUT REGISTER 25

bit 7	1	1	I	bit 0
Logond:				
Legend:				

CLCINAR5 CLCINAR4 CLCINAR3 CLCINAR2 CLCINAR1

=ogona.					
R = Readable bit	W = Writable bit	U = Unimplemented bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15-14	Unimplemented: Read as '0'
bit 13-8	CLCINBR[5:0]: Assign CLC Input B (CLCINB) to the Corresponding RPn or RPIn Pin bits
bit 7-6	Unimplemented: Read as '0'
bit 5-0	CLCINAR[5:0]: Assign CLC Input A (CLCINA) to the Corresponding RPn or RPIn Pin bits

REGISTER 11-32: RPINR26: PERIPHERAL PIN SELECT INPUT REGISTER 26

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	CLCINDR5	CLCINDR4	CLCINDR3	CLCINDR2	CLCINDR1	CLCINDR0
bit 15							bit 8

U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	CLCINCR5	CLCINCR4	CLCINCR3	CLCINCR2	CLCINCR1	CLCINCR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 CLCINDR[5:0]: Assign CLC Input D (CLCIND) to the Corresponding RPn or RPIn Pin bits

bit 7-6 Unimplemented: Read as '0'

bit 5-0 CLCINCR[5:0]: Assign CLC Input C (CLCINC) to the Corresponding RPn or RPIn Pin bits

CLCINAR0

			-	-			
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	—	U4CTSR5	U4CTSR4	U4CTSR3	U4CTSR2	U4CTSR1	U4CTSR0
bit 15							bit 8
U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	U4RXR5	U4RXR4	U4RXR3	U4RXR2	U4RXR1	U4RXR0
bit 7							bit 0
Legend:							

REGISTER 11-33: RPINR27: PERIPHERAL PIN SELECT INPUT REGISTER 27

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **U4CTSR[5:0]:** Assign UART4 Clear-to-Send (U4CTS) to the Corresponding RPn or RPIn Pin bits bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **U4RXR[5:0]:** Assign UART4 Receive (U4RX) to the Corresponding RPn or RPIn Pin bits

REGISTER 11-34: RPORx: PERIPHERAL PIN SELECT OUTPUT REGISTER x

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RPaR5	RPaR4	RPaR3	RPaR2	RPaR1	RPaR0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RPbR5	RPbR4	RPbR3	RPbR2	RPbR1	RPbR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **RPaR[5:0]:** RPa Output Pin Mapping bits

Peripheral Output Number y is assigned to pin, RPa (see Table 11-11 for peripheral function numbers).

bit 7-6 Unimplemented: Read as '0'

bit 5-0**RPbR[5:0]:** RPb Output Pin Mapping bitsPeripheral Output Number y is assigned to pin, RPb (see Table 11-11 for peripheral function numbers).

TABLE 11-13: PPS INPUT CONTROL FOR RPINR REGISTERS

Register	Address	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
RPINR0	790h	_	_			INT1	R[5:0]			_	_	_	_	_		_	_
RPINR1	792h		—		INT3R[5:0]				_	_	INT2R[5:0]				•		
RPINR2	794h		—	—	—	—	_	—	_	_	_	INT4R[5:0]					
RPINR3	796h		_		•	T3CK	[5:0]	•		_				T2CF	(R[5:0]		
RPINR4	798h	_	_			T5CK	[5:0]			—	_			T4Ck	KR[5:0]		
RPINR5	79Ah	_	_			ICM2	R[5:0]			_	_			ICM1	IR[5:0]		
RPINR6	79Ch	_	_			ICM4	R[5:0]			_	_			ICM3	3R[5:0]		
RPINR7	79Eh	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_
RPINR8	7A0h	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_
RPINR9	7A2h		—	—	_		_	—	—	—	_	—	_	—	_	—	_
RPINR10	7A4h	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_
RPINR11	7A6h		—		OCFBR[5:0]				—	_	OCFAR[5:0]						
RPINR12	7A8h		—		TCKIBR[5:0]				—	_			TCKI	AR[5:0]			
RPINR13	7AAh		—			TMPR	NR[5:0]			—	_			REFI	1R[5:0]		
RPINR14	7ACh		—	—	—		_	—	_	_	—	ICM5R[5:0]					
RPINR15	7AEh		—	—	—		_	—	_	_	—	—	_	—		—	—
RPINR16	7B0h		—	—	—		_	—	_	_	—	—	_	—		—	—
RPINR17	7B2h	-	—			U3RX	(R[5:0]			—	—	—	—	—	—	—	—
RPINR18	7B4h	-	—			U1CT	SR[5:0]			—	—			U1R)	KR[5:0]		
RPINR19	7B6h	_	—			U2CT	SR[5:0]			—	—			U2R>	KR[5:0]		
RPINR20	7B8h	_	—			SCK1	R[5:0]			—	—			SDI1	R[5:0]		
RPINR21	7BAh	_	—			U3CT	SR[5:0]			—	—			SS1	R[5:0]		
RPINR22	7BCh	_	—		SCK2R[5:0]				—	—			SDI2	2R[5:0]			
RPINR23	7BEh	_	—		TXCKR[5:0]				—	—		_	SS2	R[5:0]	-	-	
RPINR24	7C0h	_	—	—					—	—	—	—	—	—	—	—	
RPINR25	7C2h	_	—				BR[5:0]			—	—			CLCIN	IAR[5:0]		
RPINR26	7C4h	—	—			CLCIN	DR[5:0]			—	—			CLCIN	ICR[5:0]		
RPINR27	7C6h	_	—			U4CT	SR[5:0]			—	—			U4R>	KR[5:0]		

	1-14. 11	0.0011	01.00			01111		0									
Register	Address	Bit 15	Bit 14	Bit 13	Bit 13 Bit 12 Bit 11 Bit 10 Bit 9 Bit 8				Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
RPOR0	7D4h	—	—		RP1R[5:0]				—	—	RP0R[5:0]						
RPOR1	7D6h	_	_			RP3F	R[5:0]			_	_			RP2	R[5:0]		
RPOR2	7D8h	_	_			RP5F	R[5:0]			_	_			RP4	R[5:0]		
RPOR3	7DAh	_	_			RP7F	R[5:0]			_	_			RP6	R[5:0]		
RPOR4	7DCh	_	_		RP9R[5:0]			_	_			RP8	R[5:0]				
RPOR5	7DEh	_	_		RP11R[5:0]			_	_	RP10R[5:0]							
RPOR6	7E0h	_	_		RP13R[5:0]			_	_			RP12	2R[5:0]				
RPOR7	7E2h	_	_			RP15	R[5:0]			_	_			RP14	IR[5:0]		
RPOR8	7E4h	_	_			RP17	R[5:0]			_	_			RP16	6R[5:0]		
RPOR9	7E6h	_	_			RP19	R[5:0]			_	_			RP18	3R[5:0]		
RPOR10	7E8h	_	_			RP21	R[5:0]			_	_			RP20)R[5:0]		
RPOR11	7EAh	_	_			RP23	R[5:0]			_	_	RP22R[5:0]					
RPOR12	7ECh	_	_		RP25R[5:0]				_	_	RP24R[5:0]						
RPOR13	7EEh	_	_		RP27R[5:0]				_	_			RP26	6R[5:0]			
RPOR14	7F0h	_	_			RP29	R[5:0]			_	_	RP28R[5:0]					
RPOR15	7F2h	_	_			RP31	R[5:0]			_	_			RP30)R[5:0]		

TABLE 11-14: PPS OUTPUT CONTROL FOR RPOR REGISTERS

NOTES:

12.0 TIMER1

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "Timers" (www.microchip.com/ DS39704) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The Timer1 module is a 16-bit timer, which can serve as the time counter for the Real-Time Clock (RTC) or operate as a free-running, interval timer/counter. Timer1 can operate in three modes:

- 16-Bit Timer
- 16-Bit Synchronous Counter
- 16-Bit Asynchronous Counter

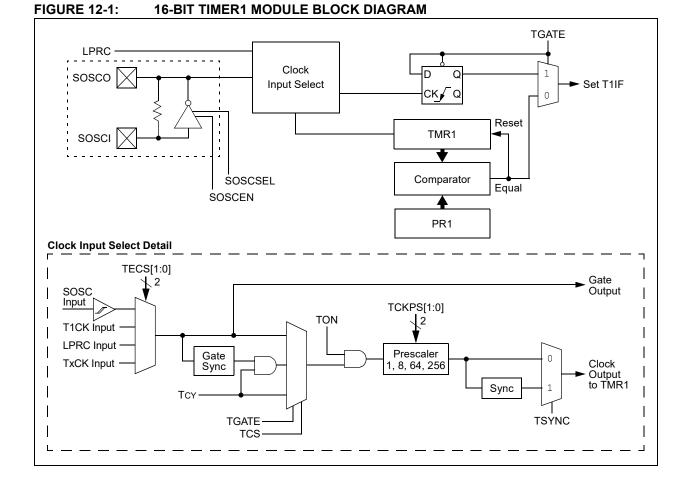
Timer1 also supports these features:

- Timer Gate Operation
- Selectable Prescaler Settings
- Timer Operation during CPU Idle and Sleep modes
- Interrupt on 16-Bit Period Register Match or Falling Edge of External Gate Signal

Figure 12-1 presents a block diagram of the 16-bit timer module.

To configure Timer1 for operation:

- 1. Set the TON bit (= 1).
- 2. Select the timer prescaler ratio using the TCKPS[1:0] bits.
- 3. Set the Clock and Gating modes using the TCS, TECS[1:0] and TGATE bits.
- 4. Set or clear the TSYNC bit to configure synchronous or asynchronous operation.
- 5. Load the timer period value into the PR1 register.
- 6. If interrupts are required, set the interrupt enable bit, T1IE. Use the priority bits, T1IP[2:0], to set the interrupt priority.



R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0
TON		TSIDL	_	_	_	TECS1	TECS0
bit 15							bit
U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0
_	TGATE	TCKPS1	TCKPS0	_	TSYNC	TCS	_
bit 7							bit
Legend:							
R = Readabl	le bit	W = Writable	bit	U = Unimpler	mented bit, read	as '0'	
-n = Value at	t POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 15	TON: Timer1	On bit					
	1 = Starts 16 0 = Stops 16						
bit 14	-	ted: Read as '	0'				
bit 13	TSIDL: Timer	r1 Stop in Idle I	Mode bit				
			peration when de ation in Idle mod		dle mode		
bit 12-10	Unimplemen	ited: Read as '	0'				
bit 9-8	TECS[1:0]: ⊺	imer1 Extende	d Clock Source	Select bits (se	elected when T	CS = 1)	
		timer (TxCK) e	external input				
	10 = LPRC C	oscillator External Clock ir	nout				
	00 = SOSC		iput				
bit 7	Unimplemen	nted: Read as '	0'				
bit 6	TGATE: Time	er1 Gated Time	Accumulation E	Enable bit			
	When TCS =						
	This bit is ign When TCS =						
		<u>o.</u> ne accumulatio	n is enabled				
		ne accumulatio					
bit 5-4		Timer1 Input C	Clock Prescale S	Select bits			
	11 = 1:256 10 = 1:64						
	01 = 1:8						
	00 = 1:1						
bit 3	-	ted: Read as '					
bit 2	When TCS =		ock Input Synch	ronization Sel	Iect Dit		
		<u>.</u> nizes the Exter	nal Clock input				
		•	ne External Cloc	k input			
	<u>When TCS =</u> This bit is ign						
bit 1	TCS: Timer1	Clock Source	Select bit				
	1 = Extended	l ala altia a ala at	ad by the timer				
		lock (Fosc/2)	ed by the timer				

REGISTER 12-1: T1CON: TIMER1 CONTROL REGISTER⁽¹⁾

reset and is not recommended.

13.0 TIMER2/3 AND TIMER4/5

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "Timers" (www.microchip.com/DS39704) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The Timer2/3 and Timer4/5 modules are 32-bit timers, which can also be configured as independent, 16-bit timers with selectable operating modes.

As a 32-bit timer, Timer2/3 or Timer4/5 can operate in three modes:

- Two Independent 16-Bit Timers with All 16-Bit Operating modes (except Asynchronous Counter mode)
- Single 32-Bit Timer
- Single 32-Bit Synchronous Counter

They also support these features:

- Timer Gate Operation
- Selectable Prescaler Settings
- Timer Operation during Idle and Sleep modes
- Interrupt on a 32-Bit Period Register Match
- A/D Event Trigger (on Timer4/5 in 32-bit mode and Timer5 in 16-bit mode)

Individually, all of the 16-bit timers can function as synchronous timers or counters. They also offer the features listed above, except for the A/D event trigger. This trigger is implemented only on Timer4/5 in 32-bit mode and Timer5 in 16-bit mode. The operating modes and enabled features are determined by setting the appropriate bit(s) in the T2CON, T3CON, T4CON and T5CON registers. T2CON and T4CON are shown in generic form in Register 13-1; T3CON and T5CON are shown in Register 13-2.

For 32-bit timer/counter operation, Timer2 and Timer4 are the least significant word; Timer3 and Timer5 are the most significant word of the 32-bit timer.

Note: For 32-bit operation, T3CON and T5CON control bits are ignored. Only T2CON and T4CON control bits are used for setup and control. Timer2 and Timer4 clocks, and gate inputs are utilized for the 32-bit timer modules, but an interrupt is generated with the Timer3 and Timer5 interrupt flags. To configure Timer2/3 or Timer4/5 for 32-bit operation:

- Set the T32 bit (T2CON[3] = 1 or T4CON[3] = 1).
- 2. Select the prescaler ratio for Timer2 or Timer4 using the TCKPS[1:0] bits.
- Set the Clock and Gating modes using the TCS and TGATE bits. If TCS is set to an External Clock, RPINRx (TyCK) must be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".
- Load the timer period value. PR3 or PR5 will contain the most significant word (msw) of the value, while PR2 or PR4 contains the least significant word (lsw).
- If interrupts are required, set the interrupt enable bit, T3IE or T5IE. Use the priority bits, T3IP[2:0] or T5IP[2:0], to set the interrupt priority. Note that while Timer2 or Timer4 controls the timer, the interrupt appears as a Timer3 or Timer5 interrupt.
- 6. Set the TON bit (= 1).

The timer value, at any point, is stored in the register pair, TMR[3:2] (or TMR[5:4]). TMR3 (or TMR5) always contains the most significant word of the count, while TMR2 (or TMR4) contains the least significant word.

To configure any of the timers for individual 16-bit operation:

- 1. Clear the T32 bit (T2CON[3] for Timer2 and Timer3 or T4CON[3] for Timer4 and Timer5).
- Select the timer prescaler ratio using the TCKPS[1:0] bits.
- Set the Clock and Gating modes using the TCS and TGATE bits. See Section 11.5 "Peripheral Pin Select (PPS)" for more information.
- 4. Load the timer period value into the PRx register.
- 5. If interrupts are required, set the interrupt enable bit, TxIE. Use the priority bits, TxIP[2:0], to set the interrupt priority.
- 6. Set the TON bit (TxCON[15] = 1).

PIC24FJ128GL306 FAMILY

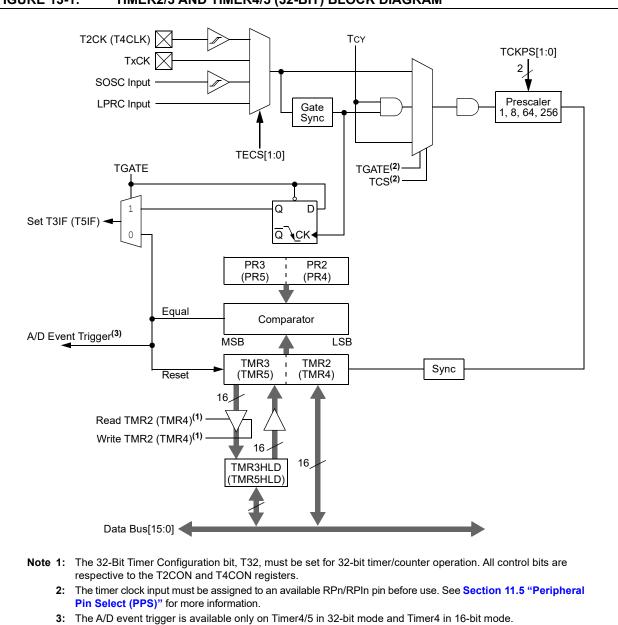
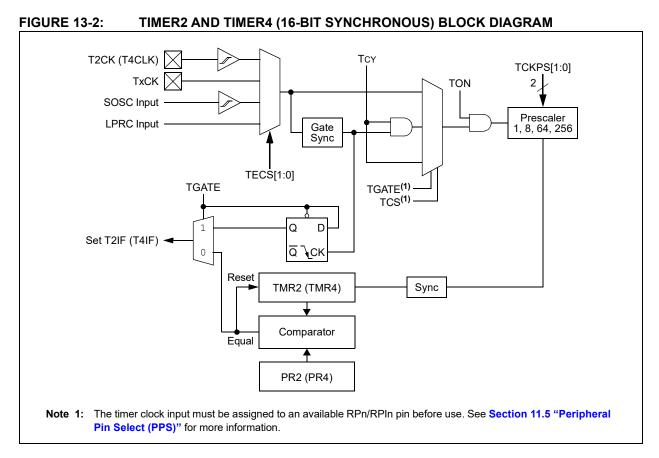
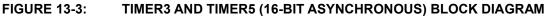
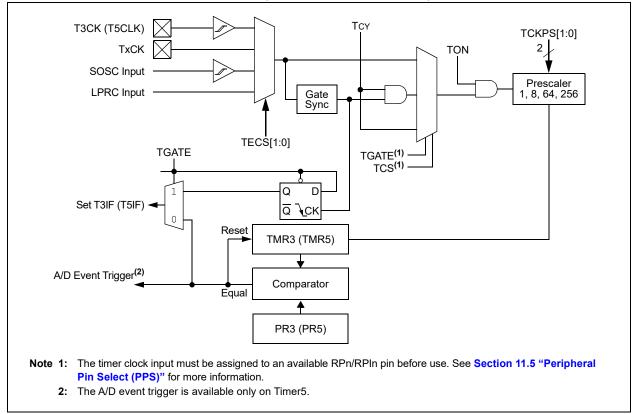


FIGURE 13-1: TIMER2/3 AND TIMER4/5 (32-BIT) BLOCK DIAGRAM







R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0
TON		TSIDL				TECS1 ⁽²⁾	TECS0 ⁽²⁾
bit 15							bit 8
U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0
	TGATE	TCKPS1	TCKPS0	T32 ⁽³⁾		TCS ⁽²⁾	
bit 7							bit (
Legend:							
R = Readat		W = Writable		•	nented bit, rea		
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkn	nown
L:1 4 F		O., h it					
bit 15	TON: Timerx	-					
	$\frac{\text{When TxCON}}{1 = \text{Starts } 32-$						
	0 = Stops 32-						
	When TxCON	-					
	1 = Starts 16-						
	0 = Stops 16-						
bit 14	•	ted: Read as '					
bit 13		x Stop in Idle N					
			eration when de tion in Idle moo		lle mode		
bit 12-10	Unimplemen	ted: Read as ')'				
bit 9-8	TECS[1:0]: T	imerx Extended	d Clock Source	Select bits (se	elected when T	CS = 1) ⁽²⁾	
	When TCS =						
	11 = Generic 10 = LPRC O	timer (TxCK) e	xternal input				
		ternal Clock in	put				
	00 = SOSC	_	<u>.</u>				
	When TCS =						
		-	imer is clocked	from the inter	nal system clo	ck (Fosc/2).	
bit 7	-	ted: Read as '					
bit 6			Accumulation E	Enable bit			
	When TCS = This bit is igno						
	When TCS =						
		e accumulation	n is enabled				
		e accumulatior					
bit 5-4	TCKPS[1:0]:	Timerx Input C	lock Prescale S	Select bits			
	11 = 1:256						
	10 = 1:64						
	01 = 1:8 00 = 1:1						
		(7.00)					
	Changing the valu reset and is not re		nile the timer is	s running (TON	n = 1) causes t	he timer presca	le counter to
-	f TCS = 1 and TE		he selected ext	ernal timer inn	out (TxCK or Tv	CK) must be co	nfigured to ar
	available RPn/RP						
- ·							

REGISTER 13-1: TxCON: TIMER2 AND TIMER4 CONTROL REGISTER⁽¹⁾

3: In 32-bit mode, the T3CON and T5CON control bits do not affect 32-bit timer operation.

REGISTER 13-1: TxCON: TIMER2 AND TIMER4 CONTROL REGISTER⁽¹⁾ (CONTINUED)

- bit 3 T32: 32-Bit Timer Mode Select bit⁽³⁾
 - 1 = Timerx and Timery form a single 32-bit timer
 - 0 = Timerx and Timery act as two 16-bit timers
- bit 2 Unimplemented: Read as '0'
- bit 1 **TCS:** Timerx Clock Source Select bit⁽²⁾ 1 = Timer source is selected by TECS[1:0] 0 = Internal clock (FOSC/2)
- bit 0 Unimplemented: Read as '0'
- **Note 1:** Changing the value of TxCON while the timer is running (TON = 1) causes the timer prescale counter to reset and is not recommended.
 - 2: If TCS = 1 and TECS[1:0] = x1, the selected external timer input (TxCK or TyCK) must be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".
 - **3:** In 32-bit mode, the T3CON and T5CON control bits do not affect 32-bit timer operation.

R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0
TON ⁽²⁾	_	TSIDL ⁽²⁾	_		_	TECS1 ^(2,3)	TECS0 ^(2,3)
bit 15					ł		bit
		R/W-0	D/M/ O	11.0		R/W-0	
U-0	R/W-0		R/W-0	U-0	U-0	TCS ^(2,3)	U-0
 bit 7	TGATE ⁽²⁾	TCKPS1 ⁽²⁾	TCKPS0 ⁽²⁾		_	108(2,0)	bit
							bit
Legend:							
R = Reada	able bit	W = Writable	bit	U = Unimple	mented bit, rea	ad as '0'	
-n = Value	at POR	'1' = Bit is set		'0' = Bit is cle	eared	x = Bit is unkn	nown
hit 1 <i>5</i>	TON: Timery	On hit(2)					
bit 15	1 = Starts 16-						
	0 = Stops 16-						
bit 14	•	ted: Read as ')'				
bit 13	-	y Stop in Idle M					
	1 = Discontin	ues module ope	eration when d	evice enters l	dle mode		
	0 = Continues	s module opera	tion in Idle mo	de			
bit 12-10	•	ted: Read as '					
bit 9-8		imery Extended		Select bits (s	elected when	TCS = 1) ^(2,3)	
	11 = Generic 10 = LPRC O	timer (TxCK) e	xternal input				
		xternal Clock in	put				
	00 = SOSC		put				
bit 7	Unimplemen	ted: Read as ')'				
bit 6	TGATE: Time	ery Gated Time	Accumulation	Enable bit ⁽²⁾			
	When TCS =						
	This bit is ign						
	<u>When TCS =</u> 1 = Gated tin	<u>0:</u> ne accumulatio	n is enabled				
		ne accumulatio					
bit 5-4	TCKPS[1:0]:	Timery Input C	lock Prescale	Select bits ⁽²⁾			
	11 = 1:256						
	10 = 1:64						
	01 = 1:8 00 = 1:1						
bit 3-2		ted: Read as '	ז'				
bit 1	-	Clock Source S					
	•	clock from pin,		sina edae)			
	0 = Internal c						
bit 0	Unimplemen	ted: Read as ')'				
Note 1:	Changing the value reset and is not re	•	nile the timer is	running (TON	= 1) causes th	e timer prescale	counter to
	When 32-bit oper operation; all time	er functions are	set through T2	2CON and T4	CON.		-
3:	If TCS = 1 and TE available RPn/RF						

REGISTER 13-2: TyCON: TIMER3 AND TIMER5 CONTROL REGISTER⁽¹⁾

14.0 CAPTURE/COMPARE/PWM/ TIMER MODULES (MCCP)

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "Capture/Compare/PWM/Timer (MCCP and SCCP)" (www.microchip.com/ DS30003035) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

PIC24FJ128GL306 family devices include several Capture/Compare/PWM/Timer base modules, which provide the functionality of three different peripherals of earlier PIC24F devices. The module can operate in one of three major modes:

- · General Purpose Timer
- Input Capture
- Output Compare/PWM

This family of devices features five instances of the MCCP module. MCCP1 provides up to six outputs and an extended range of power control features, whereas MCCP2-MCCP5 support two outputs.

The MCCPx modules can be operated only in one of the three major modes at any time. The other modes are not available unless the module is reconfigured for the new mode. A conceptual block diagram for the module is shown in Figure 14-1. All three modules share a time base generator and a common Timer register pair (CCPxTMRH/L); other shared hardware components are added as a particular mode requires.

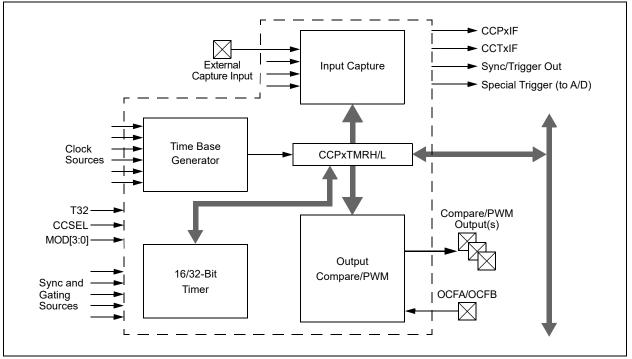
Each module has a total of eight control and status registers:

- CCPxCON1L (Register 14-1)
- CCPxCON1H (Register 14-2)
- CCPxCON2L (Register 14-3)
- CCPxCON2H (Register 14-4)
- CCPxCON3L (Register 14-5)
- CCPxCON3H (Register 14-6)
- CCPxSTATL (Register 14-7)

Each module also includes eight buffer/counter registers that serve as Timer Value registers or data holding buffers:

- CCPxTMRH/CCPxTMRL (CCPx Timer High/Low Counters)
- CCPxPRH/CCPxPRL (CCPx Timer Period High/ Low)
- CCPxRAH/CCPxRAL (CCPx Primary Output Compare Data High/Low Buffers)
- CCPxRBH/CCPxRBL (CCPx Secondary Output Compare Data High/Low Buffers)
- CCPxBUFH/CCPxBUFL (CCPx Input Capture High/Low Buffers)

FIGURE 14-1: MCCPx CONCEPTUAL BLOCK DIAGRAM



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14.1 Time Base Generator

The Timer Clock Generator (TCG) generates a clock for the module's internal time base using one of the clock signals already available on the microcontroller. This is used as the time reference for the module in its three major modes. The internal time base is shown in Figure 14-2. There are eight inputs available to the clock generator, which are selected using the CLKSEL[2:0] bits (CCPxCON1L[10:8]). Available sources include the FRC and LPRC, the Secondary Oscillator and the TCLKI External Clock inputs. The system clock is the default source (CLKSEL[2:0] = 000). On PIC24FJ128GL306 family devices, clock sources to the MCCPx modules must be synchronized with the system clock. As a result, when clock sources are selected, clock input timing restrictions or module operating restrictions may exist.

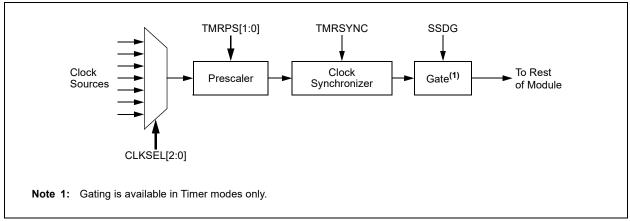


FIGURE 14-2: TIMER CLOCK GENERATOR

14.2 General Purpose Timer

Timer mode is selected when CCSEL = 0 and MOD[3:0] = 0000. The timer can function as a 32-bit timer or a dual 16-bit timer, depending on the setting of the T32 bit (Table 14-1).

T32 (CCPxCON1L[5])	Operating Mode
0	Dual Timer Mode (16-bit)
1	Timer Mode (32-bit)

TABLE 14-1: TIMER OPERATION MODE

Dual 16-Bit Timer mode provides a simple timer function with two independent 16-bit timer/counters. The primary timer uses the CCPxTMRL and CCPxPRL registers. Only the primary timer can interact with other modules on the device. It generates the MCCPx Sync out signals for use by other MCCPx modules. It can also use the SYNC[4:0] bits' signal generated by other modules.

The secondary timer uses the CCPxTMRH and CCPxPRH registers. It is intended to be used only as a periodic interrupt source for scheduling CPU events. It does not generate an output Sync/trigger signal like the primary time base. In Dual Timer mode, the CCPx Timer Period High register, CCPxPRH, generates the MCCPx compare event (CCPxIF) used by many other modules on the device.

The 32-Bit Timer mode uses the CCPxTMRL and CCPxTMRH registers, together, as a single 32-bit timer. When CCPxTMRL overflows, CCPxTMRH increments

FIGURE 14-3: DUAL 16-BIT TIMER MODE

by one. This mode provides a simple timer function when it is important to track long time periods. Note that the T32 bit (CCPxCON1L[5]) should be set before the CCPxTMRL or CCPxPRH registers are written to initialize the 32-bit timer.

14.2.1 SYNC AND TRIGGER OPERATION

In both 16-bit and 32-bit modes, the timer can also function in either Synchronization ("Sync") or Trigger mode operation. Both use the SYNC[4:0] bits (CCPxCON1H[4:0]) to determine the input signal source. The difference is how that signal affects the timer.

In Sync operation, the Timer Reset or clear occurs when the input selected by SYNC[4:0] is asserted. The timer immediately begins to count again from zero unless it is held for some other reason. Sync operation is used whenever the TRIGEN bit (CCPxCON1H[7]) is cleared. The SYNC[4:0] bits can have any value except '11111'.

In Trigger mode operation, the timer is held in Reset until the input selected by SYNC[4:0] is asserted; when it occurs, the timer starts counting. Trigger operation is used whenever the TRIGEN bit is set. In Trigger mode, the timer will continue running after a trigger event as long as the CCPTRIG bit (CCPxSTATL[7]) is set. To clear CCPTRIG, the TRCLR bit (CCPxSTATL[5]) must be set to clear the trigger event, reset the timer and hold it at zero until another trigger event occurs. On PIC24FJ128GL306 family devices, Trigger mode operation can only be used when the system clock is the time base source (CLKSEL[2:0] = 000).

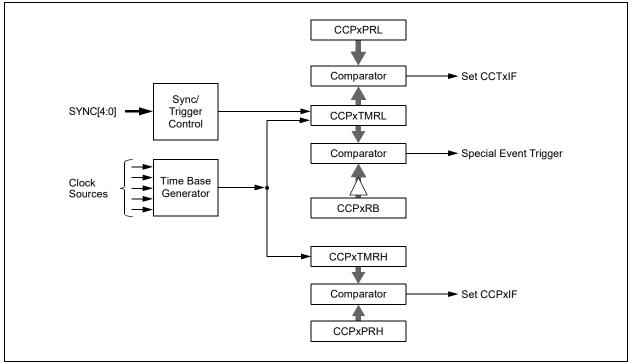
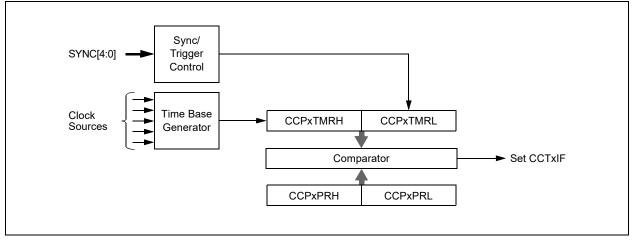


FIGURE 14-4: 32-BIT TIMER MODE



14.3 Output Compare Mode

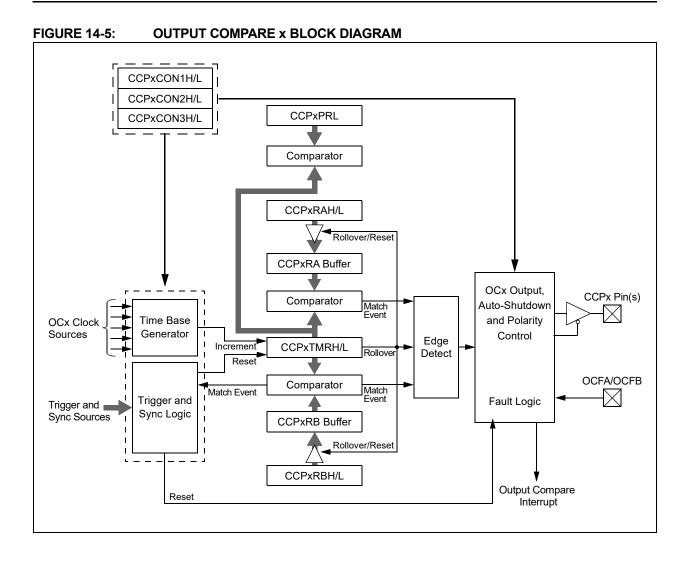
Output Compare mode compares the Timer register value with the value of one or two Compare registers, depending on its mode of operation. The Output Compare x module, on compare match events, has the ability to generate a single output transition or a train of output pulses. Like most PIC[®] MCU peripherals, the Output Compare x module can also generate interrupts on a compare match event.

Table 14-2shows the various modes available inOutput Compare modes.

MOD[3:0] (CCPxCON1L[3:0])	T32 (CCPxCON1L[5])	Operating Mode			
0001	0	Output High on Compare (16-bit)			
0001	1	Output High on Compare (32-bit)			
0010	0	Output Low on Compare (16-bit)	Single Edge Mede		
0010	1	Output Low on Compare (32-bit)	Single Edge Mode		
0011	0	Output Toggle on Compare (16-bit)			
0011	1	Output Toggle on Compare (32-bit)			
0100	0	Dual Edge Compare (16-bit)	Dual Edge Mode		
0101	0	Dual Edge Compare (16-bit buffered)	PWM Mode		
0110	0	Center-Aligned Pulse (16-bit buffered) ⁽¹⁾	Center PWM Mode		
0111	0	Variable Frequency Pulse (16-bit) ⁽¹⁾			
1111	0	External Input Source Mode (16-bit)			

TABLE 14-2: OUTPUT COMPARE/PWM MODES

Note 1: Available only on the MCCP1 module.



14.4 Input Capture Mode

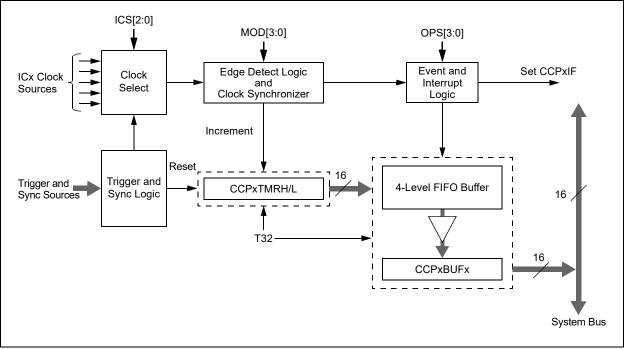
Input Capture mode is used to capture a timer value from an independent timer base upon an event on an input pin or other internal Trigger source. The input capture features are useful in applications requiring frequency (time period) and pulse measurement. Figure 14-6 depicts a simplified block diagram of the Input Capture mode. Input Capture mode uses a dedicated 16/32-bit, synchronous, up counting timer for the capture function. The timer value is written to the FIFO when a capture event occurs. The internal value may be read (with a synchronization delay) using the CCPxTMRH/L registers.

To use Input Capture mode, the CCSEL bit (CCPxCON1L[4]) must be set. The T32 and MOD[3:0] bits are used to select the proper Capture mode, as shown in Table 14-3.

MOD[3:0] (CCPxCON1L[3:0])	T32 (CCPxCON1L[5])	Operating Mode			
0000	0	Edge Detect (16-bit capture)			
0000	1	Edge Detect (32-bit capture)			
0001	0	Every Rising (16-bit capture)			
0001	1	Every Rising (32-bit capture)			
0010	0	Every Falling (16-bit capture)			
0010	1	Every Falling (32-bit capture)			
0011	0	Every Rise/Fall (16-bit capture)			
0011	1	Every Rise/Fall (32-bit capture)			
0100	0	Every 4th Rising (16-bit capture)			
0100	1	Every 4th Rising (32-bit capture)			
0101	0	Every 16th Rising (16-bit capture)			
0101	1	Every 16th Rising (32-bit capture)			

TABLE 14-3: INPUT CAPTURE MODES





The type of output signal is selected using the AUXOUT[1:0] control bits (CCPxCON2H[4:3]). The

type of output signal is also dependent on the module

operating mode.

14.5 Auxiliary Output

The MCCPx modules have an auxiliary (secondary) output that provides other peripherals access to internal module signals. The auxiliary output is intended to connect to other MCCPx modules, or other digital peripherals, to provide these types of functions:

- Time Base Synchronization
- Peripheral Trigger and Clock Inputs
- Signal Gating

AUXOUT[1:0]	CCSEL	MOD[3:0]	Comments	Signal Description
00	х	XXXX	Auxiliary Output Disabled	No Output
01	0	0000	Time Base Modes	Time Base Period Reset or Rollover
10				Special Event Trigger Output
11				No Output
01	0	0001	Output Compare Modes	Time Base Period Reset or Rollover
10		through		Output Compare Event Signal
11		1111		Output Compare Signal
01	1	XXXX	Input Capture Modes	Time Base Period Reset or Rollover
10				Reflects the Value of the ICDIS bit
11				Input Capture Event Signal

TABLE 14-4: AUXILIARY OUTPUT

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CCPON		CCPSIDL	CCPSLP	TMRSYNC	CLKSEL2	CLKSEL1	CLKSEL0
bit 15		•				•	bit
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
TMRPS1	TMRPS0	T32	CCSEL	MOD3	MOD2	MOD1	MOD0
bit 7							bit
Legend:							
R = Readabl		W = Writable	bit	-	nented bit, read		
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	IOWN
bit 15		Px Module Enal	ole hit				
				ode specified b	ov the MOD[3:0)] control bits	
	0 = Module is		an operating n				
bit 14	Unimplemen	ted: Read as ')'				
bit 13	CCPSIDL: CO	CPx Stop in Idle	e Mode Bit				
				device enters Id	le mode		
		s module opera		ode			
bit 12		Px Sleep Mode					
		ontinues to ope					
bit 11		pes not operate ïme Base Cloc	-				
			-	d to the interna	l system clock	s: timing restric	tions apply
				nized to the inte			aons apply
bit 10-8	CLKSEL[2:0]	: CCPx Time B	ase Clock Sel	ect bits			
	111 = TCKIA						
	110 = TCKIB						
	101 = PLL clo 100 = 2x syst						
	010 = SOSC						
		nce clock outpu	ıt				
	000 = System						
	For MCCP1 a 011 = CLC1 c						
	For MCCP2:	Julpul					
	011 = CLC2 c	output					
	For MCCP3:	•					
	011 = CLC3 c	output					
	For MCCP4:						
h:+ 7 C	011 = CLC4 o	•	anala Calant h	:4-			
bit 7-6		Time Base Pre	scale Select b	Its			
	11 = 1:64 Pre 10 = 1:16 Pre						
	±0 1.10110						
	01 = 1:4 Pres	caler					

REGISTER 14-1: CCPxCON1L: CCPx CONTROL 1 LOW REGISTERS

Note 1: Available only on the MCCP1 module.

REGISTER 14-1: CCPxCON1L: CCPx CONTROL 1 LOW REGISTERS (CONTINUED)

bit 5	T32: 32-Bit Time Base Select bit
	1 = Uses 32-bit time base for timer, single edge output compare or input capture function
	0 = Uses 16-bit time base for timer, single edge output compare or input capture function
bit 4	CCSEL: Capture/Compare Mode Select bit
	1 = Input capture peripheral
	0 = Output compare/PWM/timer peripheral (exact function is selected by the MOD[3:0] bits)
bit 3-0	MOD[3:0]: CCPx Mode Select bits
	For CCSEL = 1 (Input Capture modes):
	1xxx = Reserved
	011x = Reserved
	0101 = Capture every 16th rising edge
	0100 = Capture every 4th rising edge
	0011 = Capture every rising and falling edge
	0010 = Capture every falling edge
	0001 = Capture every rising edge
	0000 = Capture every rising and falling edge (Edge Detect mode)
	For CCSEL = 0 (Output Compare/Timer modes):
	1111 = External Input mode: Pulse generator is disabled, source is selected by ICS[2:0]
	1110 = Reserved
	110x = Reserved
	10xx = Reserved
	0111 = Variable Frequency Pulse mode ⁽¹⁾
	0110 = Center-Aligned Pulse Compare mode, buffered ⁽¹⁾
	0101 = Dual Edge Compare mode, buffered
	0100 = Dual Edge Compare mode
	0011 = 16-Bit/32-Bit Single Edge mode, toggles output on compare match
	0010 = 16-Bit/32-Bit Single Edge mode, drives output low on compare match
	0001 = 16-Bit/32-Bit Single Edge mode, drives output high on compare match
	0000 = 16-Bit/32-Bit Timer mode, output functions are disabled

Note 1: Available only on the MCCP1 module.

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0		
OPSSRC ⁽¹⁾	RTRGEN ⁽²⁾	_	_	OPS3 ⁽³⁾	OPS2 ⁽³⁾	OPS1 ⁽³⁾	OPS0 ⁽³⁾		
bit 15							bit 8		
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
TRIGEN	ONESHOT	ALTSYNC	SYNC4	SYNC3	SYNC2	SYNC1	SYNC0		
bit 7							bit C		
Legend:									
R = Readable	bit	W = Writable I	oit	II = Unimplem	nented bit, read	as '0'			
-n = Value at I		'1' = Bit is set		'0' = Bit is clea		x = Bit is unkn	own		
				0 2000 0000					
bit 15	OPSSRC: Ou	tput Postscaler	Source Selec	ct bit ⁽¹⁾					
		•		er output events	6				
		ostscaler scales		errupt events					
bit 14		trigger Enable l							
		 Time base can be retriggered when the TRIGEN bit = 1 Time base may not be retriggered when the TRIGEN bit = 1 							
bit 13-12		ted: Read as '0							
bit 11-8	•			ale Select bits ⁽³⁾)				
	1111 = Interru	upt every 16th t upt every 15th t	ime base peri	od match					
	0011 = Intern 0010 = Intern 0001 = Intern	upt every 3rd tir upt every 2nd ti	ne base perio ne base perio me base perio	d match d match or 4th i d match or 3rd od match or 2nd od match or inpu	input capture e input capture	vent event			
bit 7	TRIGEN: CCF	Px Trigger Enat	ole bit						
		eration of time eration of time							
bit 6		ne-Shot Mode							
		t Trigger mode t Trigger mode		igger mode dura	ation is set by t	he OSCNT[2:0] bits		
bit 5		CPx Clock Sele							
				lule synchroniza					
bit 4-0		CPx Synchroniza		gnal is the Time	base Resel/10	liover eveni			
bit 4 -0		5 for the definit							
Note 1: Th	is control bit ha			e modes					
	is control bit ha								
	tput postscale s								

REGISTER 14-2: CCPxCON1H: CCPx CONTROL 1 HIGH REGISTERS

SYNC[4:0]	Synchronization Source
11111	None; Timer with Rollover on CCPxPR Match or FFFFh
11110	Reserved
11101	Reserved
11100	Reserved
11011	A/D Start Conversion
11010	CMP3 Trigger
11001	CMP2 Trigger
11000	CMP1 Trigger
10111	Reserved
10110	Reserved
10101	Reserved
10100	Reserved
10011	CLC4 Out
10010	CLC3 Out
10001	CLC2 Out
10000	CLC1 Out
01111	Reserved
01110	Reserved
01101	Reserved
01100	Reserved
01011	INT2 Pad
01010	INT1 Pad
01001	INT0 Pad
01000	Reserved
00111	Reserved
00110	MCCP5 Sync Out
00101	MCCP4 Sync Out
00100	MCCP3 Sync Out
00011	MCCP2 Sync Out
00010	MCCP1 Sync Out
00001	MCCPx Sync Out ⁽¹⁾
00000	MCCPx Timer Sync Out ⁽¹⁾

TABLE 14-5: SYNCHRONIZATION SOURCES

Note 1: CCP1 when connected to CCP1, CCP2 when connected to CCP2, etc.

R/W-0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0
PWMRSEN	ASDGM		SSDG	—	—	—	
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ASDG7	ASDG6	ASDG5	ASDG4	ASDG3	ASDG2	ASDG1	ASDG0
bit 7							bit 0
Legend:							
R = Readable		W = Writable		•	nented bit, read		
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
bit 15 bit 14	 PWMRSEN: CCPx PWM Restart Enable bit 1 = ASEVT bit clears automatically at the beginning of the next PWM period, after the shutdown input has ended 0 = ASEVT bit must be cleared in software to resume PWM activity on output pins ASDGM: CCPx Auto-Shutdown Gate Mode Enable bit 1 = Waits until the next Time Base Reset or rollover for shutdown to occur 						
	0 = Shutdow	n event occurs	immediately				
bit 13	Unimplemen	ted: Read as ')'				
bit 12	SSDG: CCPx	Software Shut	down/Gate Co	ontrol bit			
	 1 = Manually forces auto-shutdown, timer clock gate or input capture signal gate event (setting of ASDGM bit still applies) 0 = Normal module operation 						
bit 11-8	Unimplemen	ted: Read as ')'				
bit 7-0	ASDG[7:0]: (CCPx Auto-Shu	tdown/Gating	Source Enable	bits		
		Source n is ena Source n is disa		e 14-6 for auto-	shutdown/gati	ng sources)	

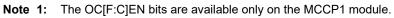
REGISTER 14-3: CCPxCON2L: CCPx CONTROL 2 LOW REGISTERS

TABLE 14-6: AUTO-SHUTDOWN SOURCES

ACDC17:01	Auto-Shutdown Source								
ASDG[7:0]	MCCP1	MCCP2	MCCP3	MCCP4	MCCP5				
1xxx xxxx			OCFB						
x1xx xxxx		OCFA							
xx1x xxxx	CLC1	CLC2	CLC3	CLC4	CLC1				
xxx1 xxxx	MCCP2 OCM Out	MCCP1 OCM Out	MCCP1 OCM Out	MCCP1 OCM Out	MCCP1 OCM Out				
xxxx 1xxx	MCCP3 OCM Out	MCCP3 OCM Out	MCCP4 OCM Out	MCCP5 OCM Out	MCCP2 OCM Out				
xxxx x1xx			CMP3 Out						
xxxx xx1x		CMP2 Out							
xxxx xxx1			CMP1 Out						

R/W-0	U-0	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R/W-0	R/W-1		
OENSYNC		OCFEN	OCEEN	OCDEN	OCCEN	OCBEN	OCAEN		
bit 15							bit 8		
R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
ICGSM1	ICGSM0	_	AUXOUT1	AUXOUT0	ICS2	ICS1	ICS0		
bit 7							bit		
Legend:									
R = Readable	e bit	W = Writable	bit	U = Unimplem	ented bit, read	d as '0'			
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea		x = Bit is unkr	iown		
bit 15	1 = Update b	Dutput Enable S y output enable y output enable	e bits occurs or	n the next Time	Base Reset of	r rollover			
bit 14	Unimplemen	ted: Read as '	o'						
bit 13-8	1 = OCMnx p 0 = OCMnx p		by the CCPx i blied by the CC	ol bits(') module and pro Px module; the			0		
bit 7-6	ICGSM[1:0]: Input Capture Gating Source Mode Control bits								
	01 = One-Sho 00 = Level-Se	ot mode: Fallin ot mode: Rising	g edge from ga A high level fr	ating source disa ting source ena om gating sour s	bles future cap	oture events (IC	DIS = 0)		
bit 5	Unimplemen	ted: Read as '	o '						
bit 4-3	AUXOUT[1:0]: Auxiliary Output Signal on Event Selection bits								
	10 = Signal o	utput is defined se rollover eve	d by module op	it; no signal in T perating mode (s)			
bit 2-0	ICS[2:0]: Input Capture Source Select bits								
	010 = Compa	output output output arator 3 output arator 2 output arator 1 output							

REGISTER 14-4: CCPxCON2H: CCPx CONTROL 2 HIGH REGISTERS



REGISTER 14-5: CCPxCON3L: CCPx CONTROL 3 LOW REGISTERS

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
—	—	—	—	-	—	—	—		
bit 15							bit 8		
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
	_		DT[5:0]						
bit 7	•	•					bit 0		

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	1 as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-6 Unimplemented: Read as '0'

bit 5-0 DT[5:0]: CCPx Dead-Time Select bits 111111 = Inserts 63 dead-time delay periods between complementary output signals

111110 = Inserts 62 dead-time delay periods between complementary output signals

... 000010 = Inserts 2 dead-time delay periods between complementary output signals 000001 = Inserts 1 dead-time delay period between complementary output signals

000001 - Inserts T dead-time delay period between complement

000000 = Dead-time logic is disabled

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0			
OETRIG	OSCNT2	OSCNT1	OSCNT0	_	OUTM2	OUTM1	OUTM0			
bit 15							bit			
U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
0-0	0-0			1	1					
 bit 7	—	POLACE	POLBDF	PSSACE1	PSSACE0	PSSBDF1	PSSBDF0 bit			
Legend:										
R = Readabl	e bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown			
bit 15	OETRIG: CC	Px Dead-Time	Select bit							
-		ered mode (TF output pin opera		odule does not	drive enabled c	output pins until	l triggered			
bit 14-12		One-Shot Eve								
		ls one-shot eve		ase periods (8 t	me base perio	ds total)				
	 110 = Extends one-shot event by 6 time base periods (7 time base periods total) 101 = Extends one-shot event by 5 time base periods (6 time base periods total) 									
	100 = Extends one-shot event by 4 time base periods (5 time base periods total)									
	011 = Extends one-shot event by 3 time base periods (4 time base periods total)									
	010 = Extends one-shot event by 2 time base periods (3 time base periods total)									
	001 = Extends one-shot event by 1 time base period (2 time base periods total) 000 = Does not extend one-shot trigger event									
bit 11		ted: Read as '		ont						
bit 10-8	-	PWMx Output N		its						
	111 = Reserv	-		10						
	110 = Output									
		DC Output mod	le, forward							
		DC Output mod DC Output mod								
	100 = Brush 011 = Reserv	DC Output mod	le, reverse							
	100 = Brush 011 = Reserv 010 = Half-B r	DC Output moo ved ridge Output mo	le, reverse ode							
	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F	DC Output moo ved ridge Output mo Pull Output moo	le, reverse ode le							
	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera	DC Output moo ved ridge Output mo Pull Output moo ble Single Outp	le, reverse ode le out mode							
bit 7-6	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplemen	DC Output mod red Pull Output mod ble Single Outp ted: Read as for	le, reverse ode le out mode o'							
bit 7-6 bit 5	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplemen POLACE: CC	DC Output mod ved Pull Output mod ble Single Outp ted: Read as ' CPx Output Pin	le, reverse ode le out mode o' s, OCMxA, OC	MxC and OCM	xE, Polarity Co	ntrol bit				
	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplemen POLACE: CO 1 = Output pi	DC Output mod ved Pull Output mod ble Single Outp ted: Read as 'o CPx Output Pins in polarity is ac	le, reverse ode le out mode o' s, OCMxA, OC tive-low	MxC and OCM	xE, Polarity Co	ntrol bit				
bit 5	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplemen POLACE: CC 1 = Output pi 0 = Output pi	DC Output mod red Pull Output mod ble Single Outp ted: Read as ' CPx Output Pins in polarity is ac in polarity is ac	le, reverse ode le out mode o' s, OCMxA, OC iive-low iive-high		•					
	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplemen POLACE: CO 1 = Output pi 0 = Output pi POLBDF: CO	DC Output mod red Pull Output mod ble Single Output ted: Read as '(CPx Output Pine in polarity is ac CPx Output Pine control and the second	le, reverse ode le out mode o' s, OCMxA, OC tive-low tive-high s, OCMxB, OC		•					
bit 5	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplemen POLACE: CO 1 = Output pi 0 = Output pi POLBDF: CO 1 = Output pi	DC Output mod red Pull Output mod ble Single Outp ted: Read as ' CPx Output Pins in polarity is ac CPx Output Pins in polarity is ac CPx Output Pins in polarity is ac	le, reverse ode le out mode o' s, OCMxA, OC tive-low tive-high s, OCMxB, OC tive-low		•					
bit 5 bit 4	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplemen POLACE: CO 1 = Output pi 0 = Output pi 0 = Output pi 0 = Output pi 0 = Output pi	DC Output mod ved Pull Output mod ble Single Output ted: Read as ' CPx Output Pins in polarity is ac CPx Output Pins in polarity is ac in polarity is ac in polarity is ac	le, reverse ode le out mode o' s, OCMxA, OC tive-low tive-high s, OCMxB, OC tive-low tive-low	MxD and OCM	xF, Polarity Co	ntrol bit	ntrol bits			
bit 5	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplemen POLACE: CO 1 = Output pi 0 = Output pi 0 = Output pi 0 = Output pi 0 = Output pi	DC Output mod red Pull Output mod ble Single Output ted: Read as ' CPx Output Pins in polarity is ac CPx Output Pins in polarity is ac in polarity is ac in polarity is ac in polarity is ac] PWMx Output	le, reverse ode le out mode o' s, OCMxA, OC ive-low ive-high s, OCMxB, OC ive-low ive-high it Pins, OCMxA	MxD and OCM A, OCMxC and	xF, Polarity Cor OCMxE, Shute	ntrol bit	ntrol bits			
bit 5 bit 4	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplemen POLACE: CC 1 = Output pi 0 = Output pi 1 = Output pi 0 = Output pi 1 = Pins are	DC Output mod ved Pull Output mod ble Single Output ted: Read as ' CPx Output Pins in polarity is ac CPx Output Pins in polarity is ac in polarity is ac in polarity is ac	le, reverse ode le out mode o' s, OCMxA, OC tive-low tive-high s, OCMxB, OC tive-low tive-high ti Pins, OCMxA when a shutdow	MxD and OCM A, OCMxC and vn event occurs	xF, Polarity Co OCMxE, Shutc	ntrol bit	ntrol bits			
bit 5 bit 4	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplemen POLACE: CC 1 = Output pi 0 = Output pi	DC Output mod red Pull Output mod ble Single Output ted: Read as ' CPx Output Pins in polarity is ac CPx Output Pins in polarity is ac in polarity is ac action polarity is ac driven active v	le, reverse ode le out mode o' s, OCMxA, OC tive-low tive-high s, OCMxB, OC tive-low tive-high ti Pins, OCMxA when a shutdow when a shutdow	MxD and OCM A, OCMxC and vn event occurs own event occu	xF, Polarity Co OCMxE, Shutc	ntrol bit	ntrol bits			
bit 5 bit 4	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplement POLACE: CO 1 = Output pi 0 = Output pi	DC Output mod red output mod ble Single Output ted: Read as ' CPx Output Pins in polarity is ac in polarity is ac	le, reverse ode le but mode o' s, OCMxA, OC tive-low tive-high s, OCMxB, OC tive-low tive-low tive-high ut Pins, OCMxA when a shutdow when a shutdow on a shutdown e	MxD and OCM A, OCMxC and wn event occurs own event occurs	xF, Polarity Col OCMxE, Shutc s irs	ntrol bit Iown State Cor				
bit 5 bit 4 bit 3-2	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplement POLACE: CO 1 = Output pi 0 = Pins area 0 x = Pins area	DC Output mod red Pull Output mod ble Single Output red: Read as '0 CPx Output Pins in polarity is ac CPx Output Pins in polarity is ac in polarity is ac di polarity is ac in polarity is ac di polarity is ac di polarity is ac	le, reverse ode le out mode o' s, OCMxA, OC tive-low tive-high s, OCMxB, OC tive-low tive-high t Pins, OCMxA when a shutdow when a shutdow a shutdown e t Pins, OCMxE	MxD and OCM A, OCMxC and wn event occurs own event occurs a, OCMxD, and	xF, Polarity Con OCMxE, Shuto Irs OCMxF, Shuto	ntrol bit Iown State Cor				
bit 5 bit 4 bit 3-2	100 = Brush 011 = Reserv 010 = Half-Br 001 = Push-F 000 = Steera Unimplemen POLACE: CO 1 = Output pi 0 = Output pi 11 = Pins are 0x = Pins are 0x = Pins are	DC Output mod yed ridge Output mod ble Single Output ted: Read as ' CPx Output Pins in polarity is ac in polarity is ac in polarity is ac in polarity is ac in polarity is ac]: PWMx Output driven active v driven inactive tri-stated when]: PWMx Output	le, reverse ode le but mode o' s, OCMxA, OC ive-low ive-high s, OCMxB, OC ive-low ive-high t Pins, OCMxA when a shutdow when a shutdow of a shutdown e tt Pins, OCMxE when a shutdow	MxD and OCM A, OCMxC and wn event occurs own event occurs avent occurs 3, OCMxD, and wn event occurs	xF, Polarity Con OCMxE, Shuto Irs OCMxF, Shuto	ntrol bit Iown State Cor				

REGISTER 14-6: CCPxCON3H: CCPx CONTROL 3 HIGH REGISTERS

U-0	U-0	U-0	U-0	U-0	W-0	U-0	U-0
			_	_	ICGARM	_	
bit 15							bit 8
R-0	W1-0	W1-0	R/C-0	R/C-0	R/C-0	R/C-0	R/C-0
CCPTRIG	TRSET	TRCLR	ASEVT	SCEVT	ICDIS	ICOV	ICBNE
bit 7							bit 0
Longrady			L.14	\A/ \A/######	L :4		
Legend: R = Readable	- hit	C = Clearable W1 = Write '1		W = Writable	nented bit, read	oo 'O'	
-n = Value at		'1' = Bit is set	•	0 – Onimpien 0' = Bit is clea	-	x = Bit is unkn	
	TOR	1 - Dit 13 3et			areu		
bit 15-11	Unimplemen	ted: Read as '	D '				
bit 10	-	ut Capture Gat					
				Input Capture :	k module for a	one-shot gatin	g event when
		01 or 10; read					
bit 9-8	-	ted: Read as '					
bit 7		CPx Trigger Sta					
		s been triggere s not been trigg		0			
bit 6		x Trigger Set R					
			-	r when TRIGE	N = 1 (location a	lways reads a	s '0').
bit 5		x Trigger Clear			,		,
	Writes '1' to th	nis location to c	ancel the time	r trigger when ⁻	TRIGEN = 1 (loo	cation always r	eads as '0').
bit 4	ASEVT: CCP	x Auto-Shutdov	vn Event Statu	s/Control bit			
				x outputs are in	the Shutdown	state	
L:1 0		tputs operate n	•				
bit 3	•	e Edge Compa edge compare					
	Ū.	edge compare					
bit 2	-	Capture x Disal					
				oes not genera	te a capture eve	ent	
				rate a capture e	event		
bit 1		Capture x Buffe					
		t Capture x FIF t Capture x FIF					
bit 0	•	Capture x Buff					
		ture x buffer ha		le			
		ture x buffer is					

REGISTER 14-7: CCPxSTATL: CCPx STATUS REGISTER LOW

15.0 SERIAL PERIPHERAL INTERFACE (SPI)

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to "Serial Peripheral Interface (SPI) with Audio Codec Support" (www.microchip.com/ DS70005136) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The Serial Peripheral Interface (SPI) module is a synchronous serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D Converters, etc. The SPI module is compatible with the Motorola[®] SPI and SIOP interfaces. All devices in the PIC24FJ128GL306 family include two SPI modules.

The module supports operation in two buffer modes. In Standard Buffer mode, datum is shifted through a single serial buffer. In Enhanced Buffer mode, data are shifted through a FIFO buffer. The FIFO level depends on the configured mode.

Note:	FIFO depth for this device is 32 (in 8-Bit
	Data mode).

Variable length data can be transmitted and received from 2 to 32 bits.

Note:	Do not perform Read-Modify-Write opera-
	tions (such as bit-oriented instructions) on
	the SPIxBUF register in either Standard or
	Enhanced Buffer mode.

The module also supports a basic framed SPI protocol while operating in either Master or Slave mode. A total of four framed SPI configurations are supported.

The module also supports Audio modes. Four different Audio modes are available.

- I²S mode
- Left Justified mode
- Right Justified mode
- PCM/DSP mode

In each of these modes, the serial clock is free-running and audio data are always transferred.

If an audio protocol data transfer takes place between two devices, then usually one device is the Master and the other is the Slave. However, audio data can be transferred between two Slaves. Because the audio protocols require free-running clocks, the Master can be a third party controller. In either case, the Master generates two free-running clocks: SCKx and LRC (Left, Right Channel Clock/SSx/FSYNC). The SPI serial interface consists of four pins:

- · SDIx: Serial Data Input
- SDOx: Serial Data Output
- SCKx: Shift Clock Input or Output
- SSx: Active-Low Slave Select or Frame Synchronization I/O Pulse

The SPI module can be configured to operate using two, three or four pins. In the 3-pin mode, \overline{SSx} is not used. In the 2-pin mode, both SDOx and \overline{SSx} are not used.

The SPI module has the ability to generate three interrupts reflecting the events that occur during the data communication. The following types of interrupts can be generated:

- 1. Receive interrupts are signalled by SPIxRXIF.
 - This event occurs when:
 - RX watermark interrupt
 - SPIROV = 1
 - SPIRBF = 1
 - SPIRBE = 1

provided the respective mask bits are enabled in SPIxIMSKL/H.

- 2. Transmit interrupts are signalled by SPIxTXIF. This event occurs when:
 - TX watermark interrupt
 - SPITUR = 1
 - SPITBF = 1
 - SPITBE = 1

provided the respective mask bits are enabled in SPIxIMSKL/H.

- 3. General interrupts are signalled by SPIxIF. This event occurs when
 - FRMERR = 1
 - SPIBUSY = 1
 - SRMT = 1

provided the respective mask bits are enabled in SPIxIMSKL/H.

A block diagram of the module in Enhanced Buffer mode is shown in Figure 15-1.

Note: In this section, the SPI modules are referred to together as SPIx, or separately as SPI1 or SPI2. Special Function Registers will follow a similar notation. For example, SPIxCON1 and SPIxCON2 refer to the control registers for either of the two SPI modules.

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15.1 Master Mode Operation

Perform the following steps to set up the SPIx module for Master mode operation:

- 1. Disable the SPIx interrupts in the respective IECx register.
- 2. Stop and reset the SPIx module by clearing the SPIEN bit.
- 3. Clear the receive buffer.
- Clear the ENHBUF bit (SPIxCON1L[0]) if using Standard Buffer mode or set the bit if using Enhanced Buffer mode.
- 5. If SPIx interrupts are not going to be used, skip this step. Otherwise, the following additional steps are performed:
 - a) Clear the SPIx interrupt flags/events in the respective IFSx register.
 - b) Write the SPIx interrupt priority and sub-priority bits in the respective IPCx register.
 - c) Set the SPIx interrupt enable bits in the respective IECx register.
- 6. Write the Baud Rate register, SPIxBRGL.
- 7. Clear the SPIROV bit (SPIxSTATL[6]).
- 8. Write the desired settings to the SPIxCON1L register with MSTEN (SPIxCON1L[5]) = 1.
- 9. Enable SPI operation by setting the SPIEN bit (SPIxCON1L[15]).
- 10. Write the data to be transmitted to the SPIxBUFL and SPIxBUFH registers. Transmission (and reception) will start as soon as data are written to the SPIxBUFL/H registers.

15.2 Slave Mode Operation

The following steps are used to set up the SPIx module for the Slave mode of operation:

- 1. If using interrupts, disable the SPIx interrupts in the respective IECx register.
- 2. Stop and reset the SPIx module by clearing the SPIEN bit.
- 3. Clear the receive buffer.
- Clear the ENHBUF bit (SPIxCON1L[0]) if using Standard Buffer mode or set the bit if using Enhanced Buffer mode.
- 5. If using interrupts, the following additional steps are performed:
 - a) Clear the SPIx interrupt flags/events in the respective IFSx register.
 - b) Write the SPIx interrupt priority and sub-priority bits in the respective IPCx register.
 - c) Set the SPIx interrupt enable bits in the respective IECx register.

- 6. Clear the SPIROV bit (SPIxSTATL[6]).
- 7. Write the desired settings to the SPIxCON1L register with MSTEN (SPIxCON1L[5]) = 0.
- Enable SPI operation by setting the SPIEN bit (SPIxCON1L[15]).
- 9. Transmission (and reception) will start as soon as the Master provides the serial clock.

The following additional features are provided in Slave mode:

- Slave Select Synchronization:
- The SSx pin allows a Synchronous Slave mode. If the SSEN bit (SPIxCON1L[7]) is set, transmission and reception are enabled in Slave mode only if the SSx pin is driven to a low state. The port output or other peripheral outputs must not be driven in order to allow the SSx pin to function as an input. If the SSEN bit is set and the SSx pin is driven high, the SDOx pin is no longer driven and will tri-state, even if the module is in the middle of a transmission. An aborted transmission will be tried again the next time the SSx pin is driven low using the data held in the SPIxTXB register. If the SSEN bit is not set, the SSx pin does not affect the module operation in Slave mode.
- SPITBE Status Flag Operation: The SPITBE bit (SPIxSTATL[3]) has a different function in the Slave mode of operation. The following describes the function of SPITBE for various settings of the Slave mode of operation:
 - If SSEN (SPIxCON1L[7]) is cleared, the SPITBE bit is cleared when SPIxBUF is loaded by the user code. It is set when the module transfers SPIxTXB to SPIxTXSR. This is similar to the SPITBE bit function in Master mode.
 - If SSEN is set, SPITBE is cleared when SPIxBUF is loaded by the user code. However, it is set only when the SPIx module completes data transmission. A transmission will be aborted when the SSx pin goes high and may be retried at a later time. So, each data word is held in SPIxTXB until all bits are transmitted to the receiver.

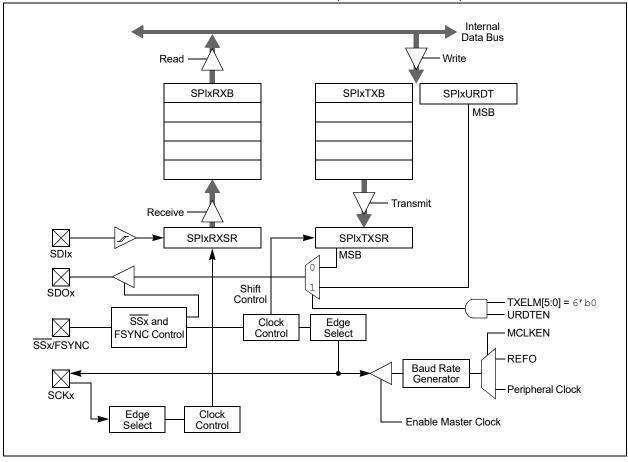


FIGURE 15-1: SPIX MODULE BLOCK DIAGRAM (ENHANCED MODE)

15.3 Audio Mode Operation

To initialize the SPIx module for Audio mode, follow the steps to initialize it for Master/Slave mode, but also set the AUDEN bit (SPIxCON1H[15]). In Master+Audio mode:

- This mode enables the device to generate SCKx and LRC pulses as long as the SPIEN bit (SPIxCON1L[15]) = 1.
- The SPIx module generates LRC and SCKx continuously, in all cases, regardless of the transmit data while in Master mode.
- The SPIx module drives the leading edge of LRC and SCKx within one SCKx period, and the serial data shift in and out continuously, even when the TX FIFO is empty.

In Slave+Audio mode:

- This mode enables the device to receive SCKx and LRC pulses as long as the SPIEN bit (SPIxCON1L[15]) = 1.
- The SPIx module drives zeros out of SDOx, but does not shift data out or in (SDIx) until the module receives the LRC (i.e., the edge that precedes the left channel).
- Once the module receives the leading edge of LRC, it starts receiving data if DISSDI (SPIxCON1L[4]) = 0 and the serial data shift out continuously, even when the TX FIFO is empty.

15.4 SPI Control Registers

REGISTER 15-1: SPIxCON1L: SPIx CONTROL REGISTER 1 LOW

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
SPIEN		SPISIDL	DISSDO	MODE32((1,4) MODE16	SMP	CKE ⁽¹⁾		
bit 15							bit 8		
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
SSEN ⁽²⁾	CKP	MSTEN	DISSDI	DISSCK	MCLKEN ⁽³⁾	SPIFE	ENHBUF		
bit 7				÷			bit 0		
Legend:									
R = Readab	le bit	W = Writable I	bit	-	lemented bit, read	as '0'			
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is	cleared	x = Bit is unk	nown		
bit 15	SPIEN: SPIX C	n hit							
DIC 10	1 = Enables m								
	0 = Turns off a	and resets me	odule, disable	es clocks, di	sables interrupt ev	vent generatio	on, allows SFF		
	modificatio								
bit 14	Unimplemente								
bit 13 SPISIDL: SPIx Stop in Idle Mode bit									
	1 = Halts in CPU Idle mode								
bit 12	 0 = Continues to operate in CPU Idle mode DISSDO: Disable SDOx Output Port bit 								
	1 = SDOx pin is not used by the module; pin is controlled by the port function								
	 SDOx pin is not used by the module, pin is controlled by the port function SDOx pin is controlled by the module 								
bit 11-10	MODE[32,16]:	Serial Word L	ength bits ^{(1,4})					
	AUDEN = 0:								
	MODE32		COMMUN		FIFO DEPTH				
	1 0	x 1	32-Bit 16-Bit		8 6				
	0	1 0	8-Bit		32				
	AUDEN = 1:	Ũ	0 2.1		-				
	MODE32	MODE16	COMMUN	ICATION					
	1	1), 32-Bit Channel/6				
	1	0), 32-Bit Channel/6				
	0	1), 32-Bit Channel/6), 16-Bit Channel/3				
L:1 0		U			, To-bit Channel/3	DZ-DIL FIAME			
bit 9	SMP: SPIx Dat	ta input Samp	le Phase bit						
	<u>Master Mode:</u> 1 = Input datun	n is sampled a	at the end of d	lata output tii	ne				
	0 = Input datum	•							
	Slave Mode:	·							
		always sampl	ed at the mido	dle of data ou	itput time, regardle	ess of the SMI	P setting.		
Note 1: V	Vhen AUDEN = 1.	this module f	unctions as if	CKE = 0, red	gardless of its actu	al value.			
	Vhen FRMEN = 1			- , ;	,				
	ICLKEN can only			l bit = 0.					
	-				follows the ERMS	VDM/ hit			

4: This channel is not meaningful for DSP/PCM mode as LRC follows the FRMSYPW bit.

REGISTER 15-1: SPIx CONTROL REGISTER 1 LOW (CONTINUED)

bit 8		CKE: SPIx Clock Edge Select bit ⁽¹⁾
		1 = Transmit happens on transition from active clock state to Idle clock state
		0 = Transmit happens on transition from Idle clock state to active clock state
bit 7		SSEN: Slave Select Enable bit (Slave mode) ⁽²⁾
		1 = \overline{SSx} pin is used by the macro in Slave mode; \overline{SSx} pin is used as the Slave select input 0 = \overline{SSx} pin is not used by the macro (\overline{SSx} pin will be controlled by the port I/O)
bit 6		CKP: SPIx Clock Polarity Select bit
		 1 = Idle state for clock is a high level; active state is a low level 0 = Idle state for clock is a low level; active state is a high level
bit 5		MSTEN: Master Mode Enable bit
		1 = Master mode 0 = Slave mode
bit 4		DISSDI: Disable SDIx Input Port bit
		 1 = SDIx pin is not used by the module; pin is controlled by the port function 0 = SDIx pin is controlled by the module
bit 3		DISSCK: Disable SCKx Output Port bit
		 1 = SCKx pin is not used by the module; pin is controlled by the port function 0 = SCKx pin is controlled by the module
bit 2		MCLKEN: Master Clock Enable bit ⁽³⁾
		1 = REFO is used by the BRG 0 = Peripheral clock is used by the BRG
bit 1		SPIFE: Frame Sync Pulse Edge Select bit
		 1 = Frame Sync pulse (Idle-to-active edge) coincides with the first bit clock 0 = Frame Sync pulse (Idle-to-active edge) precedes the first bit clock
bit 0		ENHBUF: Enhanced Buffer Mode Enable bit
		 1 = Enhanced Buffer mode is enabled 0 = Enhanced Buffer mode is disabled
Note	1:	When AUDEN = 1, this module functions as if CKE = 0, regardless of its actual value.
	2:	When FRMEN = 1, SSEN is not used.

- **3:** MCLKEN can only be written when the SPIEN bit = 0.
- 4: This channel is not meaningful for DSP/PCM mode as LRC follows the FRMSYPW bit.

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
AUDEN ⁽¹⁾	SPISGNEXT	IGNROV	IGNTUR	AUDMONO ⁽²⁾	URDTEN ⁽³⁾	AUDMOD1 ⁽⁴⁾	AUDMOD0 ⁽⁴			
bit 15							bit 8			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	FRMCNT2	FRMCNT1	FRMCNT0			
bit 7							bit (
Legend:										
R = Readat	ole hit	W = Writable b	hit	U = Unimpleme	ented bit read	as '0'				
-n = Value a		'1' = Bit is set		'0' = Bit is clear		x = Bit is unkr	own			
				0 - Dit is olda	cu		IOWIT			
bit 15	AUDEN: Audi	o Codec Suppo	ort Enable bit ⁽	1)						
	1 = Audio pro	tocol is enable	d; MSTEN co	ntrols the directio	n of both the S	SCKx and frame	e (a.k.a. LRC)			
				IEN = 1, FRMS	/NC = MSTE	N, FRMCNT[2:	0] = 001 and			
		SMP = 0, regardless of their actual values 0 = Audio protocol is disabled								
L:1 1 1	•			Deed Data Enabl	- h:t					
bit 14	SPISGNEXT: SPIx Sign-Extend RX FIFO Read Data Enable bit									
	 1 = Data from RX FIFO are sign-extended 0 = Data from RX FIFO are not sign-extended 									
bit 13	IGNROV: Ignore Receive Overflow bit									
	1 = A Receive Overflow (ROV) is NOT a critical error; during ROV, data in the FIFO are not overwritten									
	by the receive data									
	0 = A ROV is a critical error that stops SPI operation									
bit 12	IGNTUR: Ignore Transmit Underrun bit									
		1 = A Transmit Underrun (TUR) is NOT a critical error and data indicated by URDTEN are transmitted								
		until the SPIxTXB is not empty								
bit 11	 0 = A TUR is a critical error that stops SPI operation AUDMONO: Audio Data Format Transmit bit⁽²⁾ 									
	 1 = Audio data are mono (i.e., each data word is transmitted on both left and right channels) 0 = Audio data are stereo 									
bit 10	URDTEN: Tra	nsmit Underrur	n Data Enable	e bit ⁽³⁾						
				H registers during	g Transmit Un	derrun conditio	ns			
				Transmit Under	-					
bit 9-8	AUDMOD[1:0	AUDMOD[1:0]: Audio Protocol Mode Selection bits ⁽⁴⁾								
		11 = PCM/DSP mode								
		10 = Right Justified mode: This module functions as if SPIFE = 1, regardless of its actual value								
		01 = Left Justified mode: This module functions as if SPIFE = 1, regardless of its actual value 00 = I ² S mode: This module functions as if SPIFE = 0, regardless of its actual value								
bit 7										
DIL I		FRMEN: Framed SPIx Support bit 1 = Framed SPIx support is enabled (SSx pin is used as the FSYNC input/output)								
		Plx support is o	•							
Note 1: A	AUDEN can only	be written whe	n the SPIEN	bit = 0.						
	-			EN bit = 0 and is	only valid for	AUDEN = 1.				
	JRDTEN is only	•			-					
4: /		s can only be w		ne SPIEN bit = 0 a						

REGISTER 15-2: SPIxCON1H: SPIx CONTROL REGISTER 1 HIGH

REGISTER 15-2: SPIxCON1H: SPIx CONTROL REGISTER 1 HIGH (CONTINUED)

bit 6	FRMSYNC: Frame Sync Pulse Direction Control bit
	1 = Frame Sync pulse input (Slave)
	0 = Frame Sync pulse output (Master)
bit 5	FRMPOL: Frame Sync/Slave Select Polarity bit
	1 = Frame Sync pulse/Slave select is active-high 0 = Frame Sync pulse/Slave select is active-low
bit 4	MSSEN: Master Mode Slave Select Enable bit
	 1 = SPIx Slave select support is enabled with polarity determined by FRMPOL (SSx pin is automatically driven during transmission in Master mode) 0 = SPIx Slave select support is disabled (SSx pin will be controlled by port I/O)
L:1 0	
bit 3	FRMSYPW: Frame Sync Pulse-Width bit
	 1 = Frame Sync pulse is one serial word length wide (as defined by MODE[32,16]/WLENGTH[4:0]) 0 = Frame Sync pulse is one clock (SCKx) wide
bit 2-0	FRMCNT[2:0]: Frame Sync Pulse Counter bits
	Controls the number of serial words transmitted per Sync pulse.
	111 = Reserved
	110 = Reserved
	101 = Generates a Frame Sync pulse on every 32 serial words
	100 = Generates a Frame Sync pulse on every 16 serial words
	011 = Generates a Frame Sync pulse on every 8 serial words
	010 = Generates a Frame Sync pulse on every 4 serial words
	001 = Generates a Frame Sync pulse on every 2 serial words (value used by audio protocols)
	000 = Generates a Frame Sync pulse on each serial word

- **Note 1:** AUDEN can only be written when the SPIEN bit = 0.
 - **2:** AUDMONO can only be written when the SPIEN bit = 0 and is only valid for AUDEN = 1.
 - **3:** URDTEN is only valid when IGNTUR = 1.
 - **4:** AUDMOD[1:0] bits can only be written when the SPIEN bit = 0 and are only valid when AUDEN = 1. When NOT in PCM/DSP mode, this module functions as if FRMSYPW = 1, regardless of its actual value.

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
0-0	0-0	0-0	0-0	0-0	0-0	0-0	0-0
	_	—	_	—	_	—	—
bit 15							bit 8
U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	_	—		W	/LENGTH[4:0] ⁽¹	1,2)	
bit 7							bit 0
Legend:							
R = Readal	ole bit	W = Writable	bit	U = Unimplen	nented bit, read	l as '0'	
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	nown
bit 15-5	Unimplemen	ted: Read as '	0'				
bit 4-0	=	:0]: Variable W		_S (1,2)			
	11111 = 32- k	-	lora zongar bit	0			
	11110 = 31- k						
	11101 = 30- k	oit data					
	11100 = 29-k						
	11011 = 28-k						
	11010 = 27 - k						
	11001 = 26-k 11000 = 25-k						
	10111 = 24-k						
	10110 = 23- k						
	10101 = 22-k						
	10100 = 21- k						
	10011 = 20-k						
	10010 = 19- k 10001 = 18- k						
	100001 = 10-10						
	01111 = 16-k						
	01110 = 15- k						
	01101 = 14- k						
	01100 = 13 -k						
	01011 = 12- k 01010 = 11- k						
	01001 = 10- k						
	01000 = 9-bi						
	00111 = 8-bi	t data					
	00110 = 7-b i						
	00101 = 6-bi						
	00100 = 5-bi 00011 = 4-b i						
	00011 – 4-bi 00010 = 3-bi						
	00001 = 2-b i						
		MODE[32,16]	bits in SPIxCC	DN1L[11:10]			

REGISTER 15-3: SPIxCON2L: SPIx CONTROL REGISTER 2 LOW

- **Note 1:** These bits are effective when AUDEN = 0 only.
 - 2: Varying the length by changing these bits does not affect the depth of the TX/RX FIFO.

REGISTER 15-4: SPIxSTATL: SPIx STATUS REGISTER LOW

U-0	U-0	U-0	HS/R/C-0	HSC/R-0	U-0	U-0	HSC/R-0
—	—	_	FRMERR	SPIBUSY	—	—	SPITUR ⁽¹⁾
bit 15							bit 8

HSC/R-0	HS/R/C-0	HSC/R-1	U-0	HSC/R-1	U-0	HSC/R-0	HSC/R-0	
SRMT	SPIROV	SPIRBE	_	SPITBE	—	SPITBF	SPIRBF	
bit 7 bit								

Legend:	C = Clearable bit	HS = Hardware Settable bit	x = Bit is unknown		
R = Readable bit	W = Writable bit	'0' = Bit is cleared	HSC = Hardware Settable/Clearable bit		
-n = Value at POR	'1' = Bit is set	U = Unimplemented bit, read as '0'			

bit 15-13	Unimplemented: Read as '0'
bit 12	FRMERR: SPIx Frame Error Status bit
	1 = Frame error is detected
	0 = No frame error is detected
bit 11	SPIBUSY: SPIx Activity Status bit
	1 = Module is currently busy with some transactions0 = No ongoing transactions (at time of read)
bit 10-9	Unimplemented: Read as '0'
bit 8	SPITUR: SPIx Transmit Underrun Status bit ⁽¹⁾
	 1 = Transmit buffer has encountered a Transmit Underrun (TUR) condition 0 = Transmit buffer does not have a Transmit Underrun condition
bit 7	SRMT: Shift Register Empty Status bit
	 1 = No current or pending transactions (i.e., neither SPIxTXB or SPIxTXSR contains data to transmit) 0 = Current or pending transactions
bit 6	SPIROV: SPIx Receive Overflow Status bit
	 1 = A new byte/half-word/word has been completely received when the SPIxRXB is full 0 = No overflow
bit 5	SPIRBE: SPIx RX Buffer Empty Status bit
	1 = RX buffer is empty 0 = RX buffer is not empty
	<u>Standard Buffer Mode:</u> Automatically set in hardware when SPIxBUF is read from, reading SPIxRXB. Automatically cleared in hardware when SPIx transfers data from SPIxRXSR to SPIxRXB.
	Enhanced Buffer Mode: Indicates RXELM[5:0] = 6'b000000.
bit 4	Unimplemented: Read as '0'
bit 3	SPITBE: SPIx Transmit Buffer Empty Status bit
	1 = SPIxTXB is empty 0 = SPIxTXB is not empty
	Standard Buffer Mode:
	Automatically set in hardware when SPIx transfers data from SPIxTXB to SPIxTXSR. Automatically cleared in hardware when SPIxBUF is written, loading SPIxTXB.
	Enhanced Buffer Mode: Indicates TXELM[5:0] = 6'b000000.

Note 1: SPITUR is cleared when SPIEN = 0. When IGNTUR = 1, SPITUR provides dynamic status of the Transmit Underrun condition, but does not stop RX/TX operation and does not need to be cleared by software.

REGISTER 15-4: SPIxSTATL: SPIx STATUS REGISTER LOW (CONTINUED)

- bit 2 Unimplemented: Read as '0' bit 1 SPITBF: SPIx Transmit Buffer Full Status bit 1 = SPIxTXB is full 0 = SPIxTXB not full Standard Buffer Mode: Automatically set in hardware when SPIxBUF is written, loading SPIxTXB. Automatically cleared in hardware when SPIx transfers data from SPIxTXB to SPIxTXSR. Enhanced Buffer Mode: Indicates TXELM[5:0] = 6' b111111. bit 0 SPIRBF: SPIx Receive Buffer Full Status bit 1 = SPIxRXB is full 0 = SPIxRXB is not full Standard Buffer Mode: Automatically set in hardware when SPIx transfers data from SPIxRXSR to SPIxRXB. Automatically cleared in hardware when SPIxBUF is read from, reading SPIxRXB. Enhanced Buffer Mode: Indicates RXELM[5:0] = 6' b111111.
- **Note 1:** SPITUR is cleared when SPIEN = 0. When IGNTUR = 1, SPITUR provides dynamic status of the Transmit Underrun condition, but does not stop RX/TX operation and does not need to be cleared by software.

U-0	U-0	HSC/R-0	HSC/R-0	HSC/R-0	HSC/R-0	HSC/R-0	HSC/R-0
_	—	RXELM5 ⁽³⁾	RXELM4 ⁽²⁾	RXELM3 ⁽¹⁾	RXELM2	RXELM1	RXELM0
bit 15					•		bit 8
U-0	U-0	HSC/R-0	HSC/R-0	HSC/R-0	HSC/R-0	HSC/R-0	HSC/R-0
_	—	TXELM5 ⁽³⁾	TXELM4 ⁽²⁾	TXELM3 ⁽¹⁾	TXELM2	TXELM1	TXELM0
bit 7							bit 0

REGISTER 15-5: SPIxSTATH: SPIx STATUS REGISTER HIGH⁽⁴⁾

Legend:	HSC = Hardware Settable/Clearable bit				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown			

bit 15-14 Unimplemented: Read as '0'

bit 13-8 **RXELM[5:0]:** Receive Buffer Element Count bits (valid in Enhanced Buffer mode)^(1,2,3)

bit 7-6 Unimplemented: Read as '0'

bit 5-0 **TXELM[5:0]:** Transmit Buffer Element Count bits (valid in Enhanced Buffer mode)^(1,2,3)

Note 1: RXELM3 and TXELM3 bits are only present when FIFODEPTH = 8 or higher.

2: RXELM4 and TXELM4 bits are only present when FIFODEPTH = 16 or higher.

3: RXELM5 and TXELM5 bits are only present when FIFODEPTH = 32.

4: See the MODE32/16 bits in the SPIxCON1L register.

REGISTER 15-6: SPIxBUFL: SPIx BUFFER REGISTER LOW

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			DA	TA[15:8]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			DA	TA[7:0]			
bit 7							bit 0
Legend:							
R = Readab	le bit	W = Writable bit		U = Unimpleme	ented bit, read	l as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clear	red	x = Bit is unkr	nown

bit 15-0 DATA[15:0]: SPIx FIFO Data bits

When the MODE[32,16] or WLENGTH[4:0] bits select 16 to 9-bit data, the SPIx only uses DATA[15:0]. When the MODE[32,16] or WLENGTH[4:0] bits select 8 to 2-bit data, the SPIx only uses DATA[7:0].

REGISTER 15-7: SPIxBUFH: SPIx BUFFER REGISTER HIGH

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			DA	TA[31:24]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			DA	TA[23:16]			
bit 7							bit 0
Legend:							
R = Readab	le bit	W = Writable bit		U = Unimpleme	ented bit, read	as '0'	
-n = Value at POR '1' = Bit is set '0			'0' = Bit is clear	ed	x = Bit is unkr	nown	

bit 15-0 DATA[31:16]: SPIx FIFO Data bits

When the MODE[32,16] or WLENGTH[4:0] bits select 32 to 25-bit data, the SPIx uses DATA[31:16]. When the MODE[32,16] or WLENGTH[4:0] bits select 24 to 17-bit data, the SPIx only uses DATA[23:16].

x = Bit is unknown

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	_			BRG[12:8] ⁽¹⁾		
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			BRO	G[7:0] ⁽¹⁾			
bit 7							bit 0
Legend:							
R = Readab	le bit	W = Writable bit		U = Unimpleme	ented bit, read a	as 'O'	

'0' = Bit is cleared

REGISTER 15-8: SPIxBRGL: SPIx BAUD RATE GENERATOR REGISTER LOW

bit 15-13 Unimplemented: Read as '0'

-n = Value at POR

bit 15-13 Unimplemented: Read as '0' bit 12-0 BRG[12:0]: SPIx Baud Rate Generator Divisor bits⁽¹⁾

'1' = Bit is set

Note 1: Changing the BRG value when SPIEN = 1 causes undefined behavior.

U-0	U-0	U-0	R/W-0	R/W-0	U-0	U-0	R/W-0
_	—	—	FRMERREN	BUSYEN	—	—	SPITUREN
bit 15							bit 8
R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	R/W-0
SRMTEN	SPIROVEN	SPIRBEN	_	SPITBEN	—	SPITBFEN	SPIRBFEN
bit 7							bit C
Legend:							
R = Readabl	e bit	W = Writable	bit	U = Unimpleme	ented bit, read	as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clear	ed	x = Bit is unkr	nown
bit 15-13	Unimplemen	ted: Read as '	0'				
bit 12			pt Events via FF				
			in interrupt even				
hit 11		•	nerate an interru	•			
bit 11			Events via SPIBI interrupt event				
		U	erate an interrup	t event			
bit 10-9		ted: Read as '					
bit 8	-		t Events via SPI	TUR bit			
		•	R) generates an i				
	0 = Transmit I	Underrun does	not generate ar	n interrupt event			
bit 7	SRMTEN: En	able Interrupt I	Events via SRM ⁻	T bit			
			RMT) generates es not generate				
bit 6	SPIROVEN:	Enable Interrup	t Events via SPI	IROV bit			
			(ROV) generates				
			does not genera		vent		
bit 5			Events via SPIR				
			ty generates an ty does not gene		t overt		
bit 4		ted: Read as '		erate an interrup	it evenit		
bit 3	-		○ Events via SPIT	RE hit			
DIL 3		•	bty generates an				
			oty does not gen	•	pt event		
bit 2	Unimplemen	ted: Read as '	0'				
bit 1	SPITBFEN: E	nable Interrup	t Events via SPľ	TBF bit			
			generates an int does not genera		event		
bit 0			t Events via SPI	•			
		-	enerates an inte				
	0 = SPIx rece						

REGISTER 15-9: SPIXIMSKL: SPIX INTERRUPT MASK REGISTER LOW

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
RXWIEN	I —	RXMSK5 ⁽¹⁾	RXMSK4 ^(1,4)	RXMSK3 ^(1,3)	RXMSK2 ^(1,2)	RXMSK1 ⁽¹⁾	RXMSK0 ⁽¹
bit 15		•	•		•		bit
R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
TXWIEN	—	TXMSK5 ⁽¹⁾	TXMSK4 ^(1,4)	TXMSK3 ^(1,3)	TXMSK2 ^(1,2)	TXMSK1 ⁽¹⁾	TXMSK0 ⁽¹⁾
bit 7							bit
Legend:							
R = Reada	able bit	W = Writable	bit	U = Unimpleme	ented bit, read as	ʻ0'	
-n = Value	at POR	'1' = Bit is set		'0' = Bit is clear	ed	x = Bit is unkr	nown
bit 14 bit 13-8	RXMSK[5:	ented: Read as 0]: RX Buffer M	ask bits ^(1,2,3,4)				
	RX mask b	its; used in conj	unction with the	RXWIEN bit.			
bit 7		ransmit Watern					
	00	s transmit buffe s transmit buffe			hen TXMSK[5:0]	= TXELM[5:0]	
bit 6	-	ented: Read as					
bit 5-0	TXMSK[5:0	0]: TX Buffer Ma	ask bits ^(1,2,3,4)				
	TX mask bi	its; used in conj	unction with the	TXWIEN bit.			
Note 1:	Mask values this case.	higher than FIF	ODEPTH are r	not valid. The mo	odule will not trig	ger a match fo	r any value ir
2:	RXMSK2 and	d TXMSK2 bits a	are only present	t when FIFODEF	PTH = 8 or highe	r.	
3:	RXMSK3 and	d TXMSK3 bits a	are only present	t when FIFODEF	PTH = 16 or high	er.	
-							

REGISTER 15-10: SPIxIMSKH: SPIx INTERRUPT MASK REGISTER HIGH

4: RXMSK4 and TXMSK4 bits are only present when FIFODEPTH = 32.

'1' = Bit is set

REGISTER 15-11: SPIxURDTL: SPIx UNDERRUN DATA REGISTER LOW

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
10,00-0	10,00-0	1.1.4.4			10,00-0	1000-0	1.7.00-0
			URD	ATA[15:8]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			URD	ATA[7:0]			
bit 7							bit 0
Legend:							
R = Readab	le bit	W = Writable bit		U = Unimplem	ented bit, read	as '0'	

bit 15-0 URDATA[15:0]: SPIx Underrun Data bits These bits are only used when URDTEN = 1. This register holds the data to transmit when a Transmit Underrun condition occurs. When the MODE[32,16] or WLENGTH[4:0] bits select 16 to 9-bit data, the SPIx only uses URDATA[15:0]. When the MODE[32,16] or WLENGTH[4:0] bits select 8 to 2-bit data, the SPIx only uses URDATA[7:0].

'0' = Bit is cleared

REGISTER 15-12: SPIxURDTH: SPIx UNDERRUN DATA REGISTER HIGH

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
10,00-0	10,00-0	1////-0			10,00-0	17/00-0	11/00-0
			URDA	TA[31:24]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			URDA	TA[23:16]			
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable bit		U = Unimplem	ented bit, read	as '0'	

bit 15-0 URDATA[31:16]: SPIx Underrun Data bits

'1' = Bit is set

These bits are only used when URDTEN = 1. This register holds the data to transmit when a Transmit Underrun condition occurs.

'0' = Bit is cleared

When the MODE[32,16] or WLENGTH[4:0] bits select 32 to 25-bit data, the SPIx only uses URDATA[31:16]. When the MODE[32,16] or WLENGTH[4:0] bits select 24 to 17-bit data, the SPIx only uses URDATA[23:16].

-n = Value at POR

-n = Value at POR

x = Bit is unknown

x = Bit is unknown

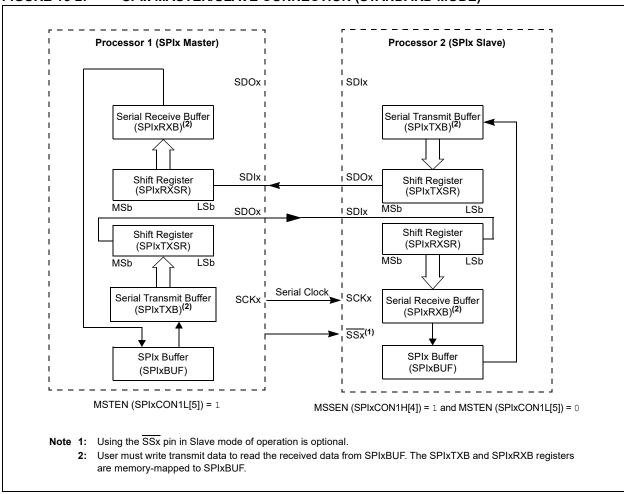
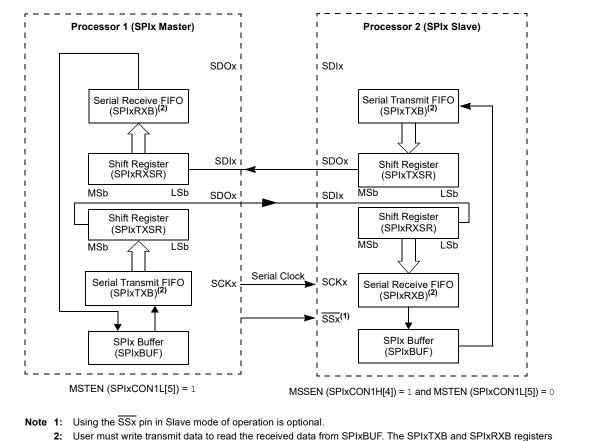


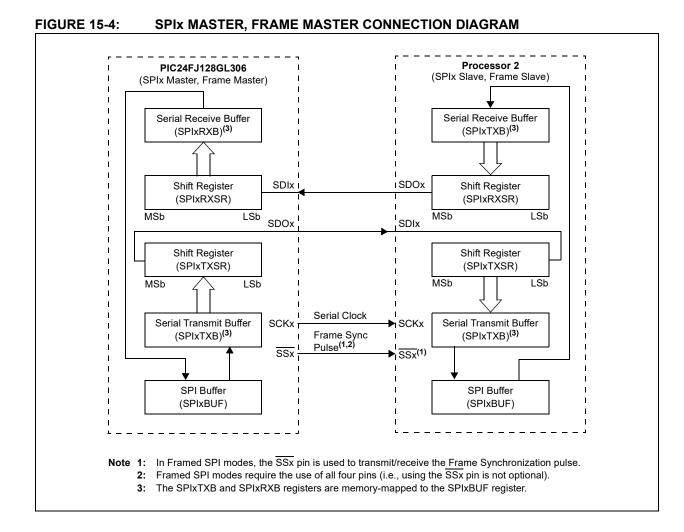
FIGURE 15-2: SPIx MASTER/SLAVE CONNECTION (STANDARD MODE)

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are memory-mapped to SPIxBUF.



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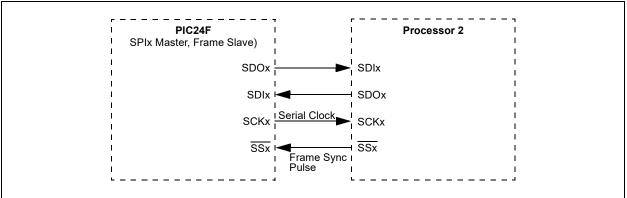


FIGURE 15-5: SPIX MASTER, FRAME SLAVE CONNECTION DIAGRAM



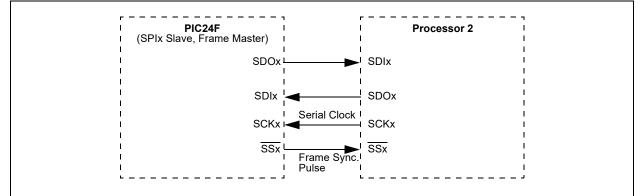
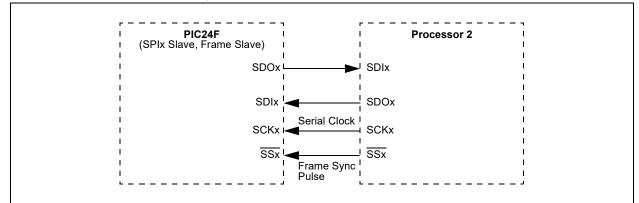


FIGURE 15-7: SPIx SLAVE, FRAME SLAVE CONNECTION DIAGRAM



EQUATION 15-1: RELATIONSHIP BETWEEN DEVICE AND SPIX CLOCK SPEED

 $Baud Rate = \frac{FPB}{(2 * (SPIxBRG + 1))}$ Where: FPB is the Peripheral Bus Clock Frequency.

16.0 INTER-INTEGRATED CIRCUIT (I²C)

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "Inter-Integrated Circuit (I²C)" (www.microchip.com/DS70000195) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The Inter-Integrated Circuit (I²C) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, display drivers, A/D Converters, etc.

The I²C module supports these features:

- · Independent Master and Slave Logic
- · 7-Bit and 10-Bit Device Addresses
- General Call Address as Defined in the I²C Protocol
- Clock Stretching to Provide Delays for the Processor to Respond to a Slave Data Request
- Both 100 kHz, 400 kHz and 1 MHz Bus Specifications
- Configurable Address Masking
- Multi-Master modes to Prevent Loss of Messages in Arbitration
- Bus Repeater mode, Allowing the Acceptance of All Messages as a Slave, regardless of the Address
- · Automatic SCL
- PMBus[™] Support

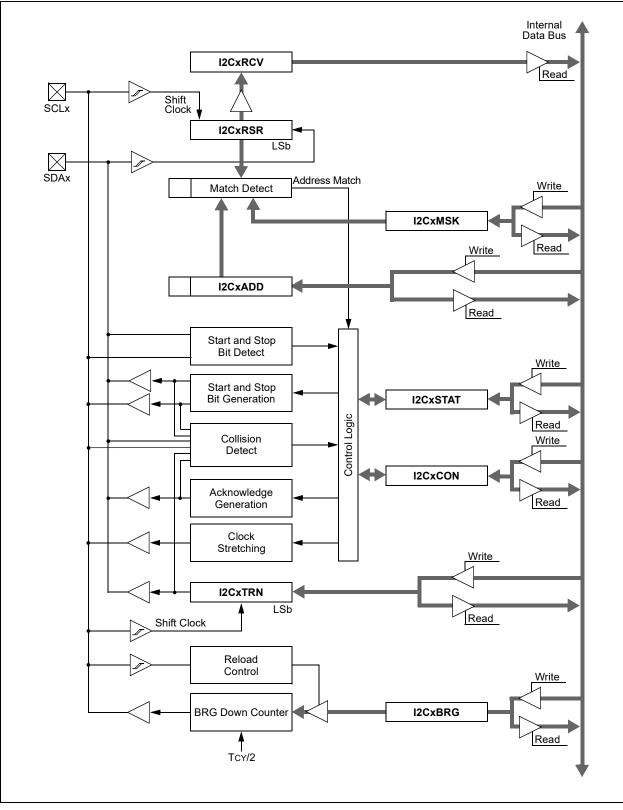
A block diagram of the module is shown in Figure 16-1.

16.1 Communicating as a Master in a Single Master Environment

The details of sending a message in Master mode depends on the communications protocol for the device being communicated with. Typically, the sequence of events is as follows:

- 1. Assert a Start condition on SDAx and SCLx.
- 2. Send the I²C device address byte to the Slave with a write indication.
- 3. Wait for and verify an Acknowledge from the Slave.
- 4. Send the first data byte (sometimes known as the command) to the Slave.
- 5. Wait for and verify an Acknowledge from the Slave.
- 6. Send the serial memory address low byte to the Slave.
- 7. Repeat Steps 4 and 5 until all data bytes are sent.
- 8. Assert a Repeated Start condition on SDAx and SCLx.
- 9. Send the device address byte to the Slave with a read indication.
- 10. Wait for and verify an Acknowledge from the Slave.
- 11. Enable Master reception to receive serial memory data.
- 12. Generate an ACK or NACK condition at the end of a received byte of data.
- 13. Generate a Stop condition on SDAx and SCLx.

FIGURE 16-1: I2Cx BLOCK DIAGRAM



16.2 Setting Baud Rate When Operating as a Bus Master

To compute the Baud Rate Generator reload value, use Equation 16-1.

EQUATION 16-1: COMPUTING BAUD RATE RELOAD VALUE^(1,2,3)

FSCL = $\frac{FCY}{(I2CxBRG + 2) * 2}$ or: $I2CxBRG = \left[\frac{FCY}{(FSCL * 2)} - 2\right]$

Note 1: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

2: These clock rate values are for guidance only. The actual clock rate can be affected by various system-level parameters. The actual clock rate should be measured in its intended application.

3: I2CxBRG values of 0 to 3 are forbidden.

16.3 Slave Address Masking

The I2CxMSK register (Register 16-4) designates address bit positions as "don't care" for both 7-Bit and 10-Bit Addressing modes. Setting a particular bit location (= 1) in the I2CxMSK register causes the Slave module to respond, whether the corresponding address bit value is a '0' or a '1'. For example, when I2CxMSK is set to '0010000000', the Slave module will detect both addresses, '000000000' and '001000000'.

To enable address masking, the Intelligent Peripheral Management Interface (IPMI) must be disabled by clearing the STRICT bit (I2CxCONL[11]).

Note: As a result of changes in the I²C protocol, the addresses in Table 16-2 are reserved and will not be Acknowledged in Slave mode. This includes any address mask settings that include any of these addresses.

Benuired System Fool	Fcy	I2CxBI	RG Value	Actual FSCL
Required System Fsc∟	FCY	(Decimal)	(Hexadecimal)	
100 kHz	16 MHz	78	4E	100 kHz
100 kHz	8 MHz	38	26	100 kHz
100 kHz	4 MHz	18	12	100 kHz
400 kHz	16 MHz	18	12	400 kHz
400 kHz	8 MHz	8	8	400 kHz
400 kHz	4 MHz	3	3	400 kHz
1 MHz	16 MHz	6	6	1 MHz

TABLE 16-1: I2Cx CLOCK RATES^(1,2)

Note 1: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

2: These clock rate values are for guidance only. The actual clock rate can be affected by various system-level parameters. The actual clock rate should be measured in its intended application.

TABLE 16-2: I2Cx RESERVED ADDRESSES⁽¹⁾

Slave Address	R/W Bit	Description
000 000	0	General Call Address ⁽²⁾
0000 000	1	Start Byte
0000 001	х	C-Bus Address
0000 01x	Х	Reserved
0000 1xx	х	HS Mode Master Code
1111 0xx	Х	10-Bit Slave Upper Byte ⁽³⁾
1111 1xx	х	Reserved

Note 1: The address bits listed here will never cause an address match independent of address mask settings.

2: This address will be Acknowledged only if GCEN = 1.

3: A match on this address can only occur on the upper byte in 10-Bit Addressing mode.

R/W-0	U-0	HC/R/W-0	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0
I2CEN	I —	I2CSIDL	SCLREL ⁽¹⁾	STRICT	A10M	DISSLW	SMEN
bit 15							bit 8
R/W-0	R/W-0	R/W-0	HC/R/W-0	HC/R/W-0	HC/R/W-0	HC/R/W-0	HC/R/W-0
GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN
bit 7							bit (
Legend:		HC = Hardwa	re Clearable bi				
R = Read	able bit	W = Writable	bit	U = Unimplem	nented bit, read	l as '0'	
-n = Value	e at POR	'1' = Bit is set		'0' = Bit is clea		x = Bit is unkn	iown
bit 15	1 = Enables t 0 = Disables	Enable bit (writ the I2Cx module the I2Cx modul	e and configure e; all l ² C pins a	s the SDAx an			s
bit 14	-	nted: Read as '					
bit 13		x Stop in Idle N					
		ues module op s module opera			e mode		
bit 12		Lx Release Co)(1)		
	If STREN = 1 1 = Releases	clock ock low (clock s .:		y program this	bit to '0', clock	stretch at next	t SCLx low
bit 11	STRICT: 12C	x Strict Reserve	ed Address Rule	e Enable bit			
	In Slave that cate In Maste 0 = Reserve In Slave there is a	erved addressi Mode: The dev gory are NACK r Mode: The de d addressing w Mode: The dev a match with an r Mode: Reserv	ice does not re ed. vice is allowed ould be Acknov ce will respond y of the reserve	spond to reser to generate ad vledged to an address	ved address s dresses with r falling in the re	bace and addreseserved addreserved addreseserved addreses	esses falling i ss space. s space. Whe
bit 10	A10M: 10-Bit	Slave Address	Flag bit				
) is a 10-bit Slav) is a 7-bit Slave					
bit 9	DISSLW: Sle	w Rate Control	Disable bit				
		control is disat control is enab				o disabled for 1	MHz mode)
Note 1:	Automatically cle of Slave receptio ting the SCLREL specified in Secti	n. The user soft bit. This delay i	ware must pro must be greate	vide a delay be r than the minir	tween writing t	the transmit l	ouffer and set
	Automatically cle						

REGISTER 16-1: I2CxCONL: I2Cx CONTROL REGISTER LOW

- **2:** Automatically cleared to '0' at the beginning of Slave transmission.
- 3: SMBus 3.0 specification input level can be selected by the SMB3EN Configuration bit (FDEVOPT1[10]).

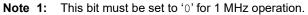
REGISTER 16-1: I2CxCONL: I2Cx CONTROL REGISTER LOW (CONTINUED)

bit 8	SMEN: SMBus Input Levels Enable bit ⁽³⁾
	 1 = Enables input logic so thresholds are compliant with the SMBus specification 0 = Disables SMBus-specific inputs
bit 7	GCEN: General Call Enable bit (I ² C Slave mode only)
	 1 = Enables interrupt when a general call address is received in I2CxRSR; module is enabled for reception 0 = General call address is disabled
bit 6	STREN: SCLx Clock Stretch Enable bit
	In I ² C Slave mode only; used in conjunction with the SCLREL bit. 1 = Enables clock stretching 0 = Disables clock stretching
bit 5	ACKDT: Acknowledge Data bit
	In I ² C Master mode during Master Receive mode. The value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.
	In I ² C Slave mode when AHEN = 1 or DHEN = 1. The value that the Slave will transmit when it initiates an Acknowledge sequence at the end of an address or data reception. 1 = NACK is sent 0 = ACK is sent
bit 4	ACKEN: Acknowledge Sequence Enable bit
	In I ² C Master mode only; applicable during Master Receive mode. 1 = Initiates Acknowledge sequence on SDAx and SCLx pins, and transmits the ACKDT data bit 0 = Acknowledge sequence is Idle
bit 3	RCEN: Receive Enable bit (I ² C Master mode only)
	1 = Enables Receive mode for I ² C; automatically cleared by hardware at the end of the 8-bit receive data byte
hit 0	 0 = Receive sequence is not in progress PEN: Stop Condition Enable bit (I²C Master mode only)
bit 2	1 = Initiates Stop condition on the SDAx and SCLx pins
	0 = Stop condition is Idle
bit 1	RSEN: Restart Condition Enable bit (I ² C Master mode only)
	 1 = Initiates Restart condition on the SDAx and SCLx pins 0 = Restart condition is Idle
bit 0	SEN: Start Condition Enable bit (I ² C Master mode only)
	 1 = Initiates Start condition on the SDAx and SCLx pins 0 = Start condition is Idle
Note 1:	Automatically cleared to '0' at the beginning of Slave transmission; automatically cleared to '0' at the end of Slave reception. The user software must provide a delay between writing to the transmit buffer and setting the SCLREL bit. This delay must be greater than the minimum setup time for Slave transmissions, as specified in Section 30.0 "Electrical Characteristics".

- 2: Automatically cleared to '0' at the beginning of Slave transmission.
- 3: SMBus 3.0 specification input level can be selected by the SMB3EN Configuration bit (FDEVOPT1[10]).

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
—	—		—	—	—	—	—		
bit 15		·					bit		
U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
—	PCIE	SCIE	BOEN	SDAHT ⁽¹⁾	SBCDE	AHEN	DHEN		
bit 7			·				bit		
Legend:									
R = Readabl	le bit	W = Writable	bit	U = Unimplem	ented bit, read	as '0'			
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	own		
bit 15-7	Unimplemen	ted: Read as '	0'						
bit 6	PCIE: Stop Condition Interrupt Enable bit (I ² C Slave mode only)								
	 1 = Enables interrupt on detection of Stop condition 0 = Stop detection interrupts are disabled 								
	-	-		(1 ² 0.0)					
bit 5	SCIE: Start Condition Interrupt Enable bit (I ² C Slave mode only) 1 = Enables interrupt on detection of Start or Restart conditions								
	 1 = Enables interrupt on detection of Start or Restart conditions 0 = Start detection interrupts are disabled 								
bit 4	BOEN: Buffer Overwrite Enable bit (I ² C Slave mode only)								
	1 = 12CxRCV is updated and an ACK is generated for a received address/data byte, ignoring the stat								
	of the I2COV bit only if the RBF bit = 0								
	0 = I2CxRCV is only updated when I2COV is clear								
bit 3	SDAHT: SDAx Hold Time Selection bit ⁽¹⁾								
	 = Minimum of 300 ns hold time on SDAx after the falling edge of SCLx = Minimum of 100 ns hold time on SDAx after the falling edge of SCLx 								
bit 2	SBCDE : Slave Mode Bus Collision Detect Enable bit (I^2C Slave mode only)								
	If, on the rising edge of SCLx, SDAx is sampled low when the module is outputting a high state, th								
	BCL bit is set and the bus goes Idle. This Detection mode is only valid during data and ACK transn								
	sequences.								
	 Enables Slave bus collision interrupts Slave bus collision interrupts are disabled 								
bit 1	AHEN: Address Hold Enable bit (I^2C Slave mode only)								
	1 = Following the 8th falling edge of SCLx for a matching received address byte; the SCLREL b								
	 (I2CxCONL[12]) will be cleared and SCLx will be held low 0 = Address holding is disabled 								
bit 0	DHEN: Data I	Hold Enable bi	t (I ² C Slave m	ode only)					
	1 = Following	g the 8th falling	edge of SCLx	for a received da	ata byte; Slave	hardware clears	s the SCLRE		
		CONL[12]) and		low					
	0 = Data holo	aind is disabled	1						

REGISTER 16-2: I2CxCONH: I2Cx CONTROL REGISTER HIGH



HSC/R-0	HSC/R-0	HSC/R-0	U-0	U-0	HSC/R/C-0	HSC/R-0	HSC/R-0		
ACKSTAT	TRSTAT	ACKTIM	_	—	BCL	GCSTAT	ADD10		
bit 15	•	·		•		·	bit 8		
HS/R/C-0	HS/R/C-0	HSC/R-0	HSC/R-0	HSC/R-0	HSC/R-0	HSC/R-0	HSC/R-0		
IWCOL	I2COV	D/A	P	S	R/W	RBF	TBF		
bit 7	12001	Birt	·	U	1000	T(D)	bit		
Legend:		C = Clearab	le bit	HS = Hardware	e Settable bit	'0' = Bit is clea	red		
R = Readable	e bit	W = Writable	e bit	U = Unimplem	ented bit, read as	s 'O'			
-n = Value at	POR	'1' = Bit is se	t	HSC = Hardwa	re Settable/Cleara	able bit			
bit 15	ACKSTAT: A	cknowledge S	tatus bit (upda	ated in all Maste	er and Slave mod	es)			
		edge was not r edge was recei							
bit 14	TRSTAT: Trai	nsmit Status b	it (when oper	ating as I ² C Ma	ster; applicable to	Master transm	it operation)		
	TRSTAT: Transmit Status bit (when operating as I ² C Master; applicable to Master transmit operation) 1 = Master transmit is in progress (8 bits + ACK)								
bit 13	 0 = Master transmit is not in progress ACKTIM: Acknowledge Time Status bit (valid in I²C Slave mode only) 								
DIL 15	1 = Indicates I ² C bus is in an Acknowledge sequence, set on 8th falling edge of SCLx clock								
	0 = Not an Acknowledge sequence, cleared on 9th rising edge of SCLx clock								
bit 12-11	Unimplemented: Read as '0'								
bit 10	BCL: Bus Collision Detect bit (Master/Slave mode; cleared when I^2C module is disabled, I2CEN = 0)								
	1 = A bus collision has been detected during a Master or Slave transmit operation								
	0 = No bus collision has been detected								
bit 9	GCSTAT: General Call Status bit (cleared after Stop detection)								
	 1 = General call address was received 0 = General call address was not received 								
bit 8	ADD10: 10-Bit Address Status bit (cleared after Stop detection)								
	1 = 10-bit address was matched								
	0 = 10-bit address was not matched								
bit 7	IWCOL: I2Cx Write Collision Detect bit								
	1 = An attempt to write to the I2CxTRN register failed because the I ² C module is busy; must be cleared								
	in software 0 = No collision								
bit 6	I2COV: I2Cx Receive Overflow Flag bit								
Sit 0	1 = A byte was received while the I2CxRCV register is still holding the previous byte; I2COV is a "don't								
	care" in Transmit mode, must be cleared in software								
	0 = No overflow								
bit 5		ldress bit (whe		,					
		that the last b							
L:1 /			yte received of	or transmitted w	as an address				
bit 4	P: I2Cx Stop		or Stor in -!-	to stadu al serie d	where the 120	طبيام أمطام والم			
	Updated when Start, Reset or Stop is detected; cleared when the I^2C module is disabled, I2CEN = 0. 1 = Indicates that a Stop bit has been detected last								
					when the I-C mo	ulle is disabled,	12CEN = 0.		

REGISTER 16-3: I2CxSTAT: I2Cx STATUS REGISTER

REGISTER 16-3: I2CxSTAT: I2Cx STATUS REGISTER (CONTINUED)

bit 3	 S: I2Cx Start bit Updated when Start, Reset or Stop is detected; cleared when the I²C module is disabled, I2CEN = 0. 1 = Indicates that a Start (or Repeated Start) bit has been detected last 0 = Start (or Repeated Start) bit was not detected last
bit 2	R/W : Read/Write Information bit (when operating as I ² C Slave)
	 1 = Read: Indicates the data transfer is output from the Slave 0 = Write: Indicates the data transfer is input to the Slave
bit 1	RBF: Receive Buffer Full Status bit
	1 = Receive is complete, I2CxRCV is full 0 = Receive is not complete, I2CxRCV is empty
bit 0	TBF: Transmit Buffer Full Status bit
	1 = Transmit is in progress, I2CxTRN is full (8 bits of data)
	0 = Transmit is complete, I2CxTRN is empty

REGISTER 16-4: I2CxMSK: I2Cx SLAVE MODE ADDRESS MASK REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
_	_	—	_	—		MSK	([9:8]
bit 15						-	bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			MS	K[7:0]			
bit 7						bit 0	
Legend:							
R = Readable bit		W = Writable I	bit	U = Unimplemented bit, read as '0'			
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared		x = Bit is unknown		

bit 15-10 Unimplemented: Read as '0'

bit 9-0 MSK[9:0]: I2Cx Mask for Address Bit x Select bits

1 = Enables masking for bit x of the incoming message address; bit match is not required in this position 0 = Disables masking for bit x; bit match is required in this position

17.0 UNIVERSAL ASYNCHRONOUS RECEIVER TRANSMITTER (UART)

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "Universal Asynchronous Receiver Transmitter (UART)" (www.microchip.com/DS70000582) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The Universal Asynchronous Receiver Transmitter (UART) module is one of the serial I/O modules available in the PIC24F device family. The UART is a full-duplex, asynchronous system that can communicate with peripheral devices, such as personal computers, LIN/J2602, RS-232 and RS-485 interfaces. The module also supports a hardware flow control option with the UxCTS and UxRTS pins. The UART module includes an IrDA[®] encoder/decoder unit.

The PIC24FJ128GL306 family devices are equipped with four UART modules, referred to as UART1, UART2, UART3 and UART4.

The primary features of the UARTx modules are:

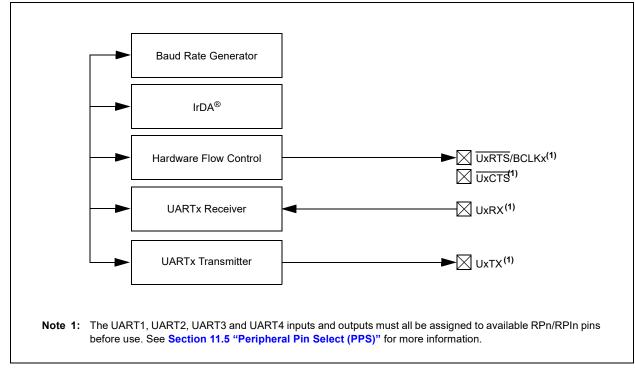
- Full-Duplex, 8 or 9-Bit Data Transmission through the UxTX and UxRX Pins
- · Even, Odd or No Parity Options (for 8-bit data)
- One or Two Stop bits
- Hardware Flow Control Option with the UxCTS and UxRTS Pins
- Fully Integrated Baud Rate Generator with 16-Bit Prescaler
- Baud Rates Range from Up to 1 Mbps and Down to 15 Hz at 16 MIPS in 16x mode
- Baud Rates Range from Up to 4 Mbps and Down to 61 Hz at 16 MIPS in 4x mode
- 4-Deep, First-In-First-Out (FIFO) Transmit Data Buffer
- 4-Deep FIFO Receive Data Buffer
- · Parity, Framing and Buffer Overrun Error Detection
- Support for 9-Bit mode with Address Detect $(9^{th} bit = 1)$
- · Separate Transmit and Receive Interrupts
- · Loopback mode for Diagnostic Support
- Polarity Control for Transmit and Receive Lines
- Support for Sync and Break Characters
- · Supports Automatic Baud Rate Detection
- IrDA[®] Encoder and Decoder Logic
- Includes DMA Support
- 16x Baud Clock Output for IrDA Support

A simplified block diagram of the UARTx module is shown in Figure 17-1. The UARTx module consists of these key important hardware elements:

- Baud Rate Generator
- Asynchronous Transmitter
- Asynchronous Receiver
- **Note:** Throughout this section, references to register and bit names that may be associated with a specific UART module are referred to generically by the use of 'x' in place of the specific module number. Thus, "UxSTA" might refer to the Status register for either UART1, UART2, UART3 or UART4.

PIC24FJ128GL306 FAMILY

FIGURE 17-1: UARTX SIMPLIFIED BLOCK DIAGRAM



17.1 UARTx Baud Rate Generator (BRG)

The UARTx module includes a dedicated, 16-bit Baud Rate Generator. The UxBRG register controls the period of a free-running, 16-bit timer. Equation 17-1 shows the formula for computation of the baud rate when BRGH = 0.

EQUATION 17-1: UARTX BAUD RATE WITH BRGH = $0^{(1,2)}$

Baud Rate =
$$\frac{FCY}{16 \cdot (UxBRG + 1)}$$

 $UxBRG = \frac{FCY}{16 \cdot Baud Rate} - 1$
Note 1: FCY denotes the instruction cycle clock frequency (FOSC/2).
2: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

Example 17-1 shows the calculation of the baud rate error for the following conditions:

- Fcy = 4 MHz
- Desired Baud Rate = 9600

The maximum baud rate (BRGH = 0) possible is Fcy/16 (for UxBRG = 0) and the minimum baud rate possible is Fcy/(16 * 65536).

Equation 17-2 shows the formula for computation of the baud rate when BRGH = 1.

EQUATION 17-2: UARTX BAUD RATE WITH BRGH = $1^{(1,2)}$

Baud Rate =
$$\frac{FCY}{4 \cdot (UxBRG + 1)}$$

UxBRG = $\frac{FCY}{4 \cdot Baud Rate} - 1$

- **Note 1:** FCY denotes the instruction cycle clock frequency.
 - **2:** Based on FCY = FOSC/2; Doze mode and PLL are disabled.

The maximum baud rate (BRGH = 1) possible is FCY/4 (for UxBRG = 0) and the minimum baud rate possible is FCY/(4 * 65536).

Writing a new value to the UxBRG register causes the BRG timer to be reset (cleared). This ensures the BRG does not wait for a timer overflow before generating the new baud rate.

EXAMPLE 17-1: BAUD RATE ERROR CALCULATION (BRGH = 0)⁽¹⁾

Desired Baud Rate	= FCY/(16 (UxBRG + 1))
Solving for UxBRG	Value:
UxBRG	= $((FCY/Desired Baud Rate)/16) - 1$
UxBRG	= ((4000000/9600)/16) - 1
UxBRG	= 25
Calculated Baud Rate	a = 4000000/(16(25+1))
	= 9615
Error	= (Calculated Baud Rate - Desired Baud Rate)/Desired Baud Rate
	= (9615 - 9600)/9600
	= 0.16%

17.2 Transmitting in 8-Bit Data Mode

- 1. Set up the UARTx:
 - a) Write appropriate values for data, parity and Stop bits.
 - b) Write appropriate baud rate value to the UxBRG register.
 - c) Set up transmit and receive interrupt enable and priority bits.
- 2. Enable the UARTx.
- 3. Set the UTXEN bit (causes a transmit interrupt, two cycles after being set).
- 4. Write a data byte to the lower byte of the UxTXREG word. The value will be immediately transferred to the Transmit Shift Register (TSR) and the serial bit stream will start shifting out with the next rising edge of the baud clock.
- Alternatively, the data byte may be transferred while UTXEN = 0 and then the user may set UTXEN. This will cause the serial bit stream to begin immediately because the baud clock will start from a cleared state.
- 6. A transmit interrupt will be generated as per interrupt control bits, UTXISEL[1:0].

17.3 Transmitting in 9-Bit Data Mode

- 1. Set up the UARTx (as described in Section 17.2 "Transmitting in 8-Bit Data Mode").
- 2. Enable the UARTx.
- 3. Set the UTXEN bit (causes a transmit interrupt).
- 4. Write UxTXREG as a 16-bit value only.
- 5. A word write to UxTXREG triggers the transfer of the 9-bit data to the TSR. The serial bit stream will start shifting out with the first rising edge of the baud clock.
- 6. A transmit interrupt will be generated as per the setting of control bits, UTXISELx.

17.4 Break and Sync Transmit Sequence

The following sequence will send a message frame header, made up of a Break, followed by an auto-baud Sync byte.

- 1. Configure the UARTx for the desired mode.
- 2. Set UTXEN and UTXBRK to set up the Break character.
- 3. Load the UxTXREG with a dummy character to initiate transmission (value is ignored).
- 4. Write '55h' to UxTXREG; this loads the Sync character into the transmit FIFO.
- 5. After the Break has been sent, the UTXBRK bit is reset by hardware. The Sync character now transmits.

17.5 Receiving in 8-Bit or 9-Bit Data Mode

- 1. Set up the UARTx (as described in Section 17.2 "Transmitting in 8-Bit Data Mode").
- 2. Enable the UARTx by setting the URXEN bit (UxSTA[12]).
- 3. A receive interrupt will be generated when one or more data characters have been received as per interrupt control bits, URXISEL[1:0].
- 4. Read the OERR bit to determine if an overrun error has occurred. The OERR bit must be reset in software.
- 5. Read UxRXREG.

The act of reading the UxRXREG character will move the next character to the top of the receive FIFO, including a new set of PERR and FERR values.

17.6 Operation of UxCTS and UxRTS Control Pins

UARTx Clear-to-Send (UxCTS) and Request-to-Send (UxRTS) are the two hardware controlled pins that are associated with the UARTx modules. These two pins allow the UARTx to operate in Simplex and Flow Control mode. They are implemented to control the transmission and reception between the Data Terminal Equipment (DTE). The UEN[1:0] bits in the UxMODE register configure these pins.

17.7 Infrared Support

The UARTx module provides two types of infrared UART support: one is the IrDA clock output to support an external IrDA encoder and decoder device (legacy module support), and the other is the full implementation of the IrDA encoder and decoder. Note that because the IrDA modes require a 16x baud clock, they will only work when the BRGH bit (UxMODE[3]) is '0'.

17.7.1 IrDA CLOCK OUTPUT FOR EXTERNAL IrDA SUPPORT

To support external IrDA encoder and decoder devices, the BCLKx pin (same as the UxRTS pin) can be configured to generate the 16x baud clock. When UEN[1:0] = 11, the BCLKx pin will output the 16x baud clock if the UARTx module is enabled; it can be used to support the IrDA codec chip.

17.7.2 BUILT-IN IrDA ENCODER AND DECODER

The UARTx has full implementation of the IrDA encoder and decoder as part of the UARTx module. The built-in IrDA encoder and decoder functionality is enabled using the IREN bit (UxMODE[12]). When enabled (IREN = 1), the receive pin (UxRX) acts as the input from the infrared receiver. The transmit pin (UxTX) acts as the output to the infrared transmitter.

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0		
UARTEN ⁽¹⁾		USIDL	IREN ⁽²⁾	RTSMD		UEN1	UEN0		
bit 15							bit 8		
HC/R/W-0	R/W-0	HC/R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
WAKE	LPBACK	ABAUD	URXINV	BRGH	PDSEL1	PDSEL0	STSEL		
bit 7							bit		
Legend:		HC = Hardwar	e Clearable bit	t					
R = Readabl	le bit	W = Writable b	pit	U = Unimplem	nented bit, read	as '0'			
n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkno	own		
bit 15	UARTEN: UA	RTx Enable bit ⁽	1)						
	1 = UARTx is	enabled; all UA	RTx pins are o	ontrolled by UA	ARTx as define	d by UEN[1:0]			
		disabled; all UAF	-	ntrolled by port l	atches, UARTx	power consump	tion is minima		
bit 14	-	ted: Read as '0							
bit 13	USIDL: UARTx Stop in Idle Mode bit								
	 1 = Discontinues module operation when device enters Idle mode 0 = Continues module operation in Idle mode 								
bit 12	IREN: IrDA [®] Encoder and Decoder Enable bit ⁽²⁾								
	1 = IrDA encoder and decoder are enabled								
	0 = IrDA encoder and decoder are disabled								
bit 11	RTSMD: Mode Selection for UxRTS Pin bit								
		n is in Simplex r n is in Flow Cor							
bit 10	Unimplemen	ted: Read as '0	,						
bit 9-8	UEN[1:0]: UARTx Enable bits								
	11 = UxTX, UxRX and BCLKx pins are enabled and used; UxCTS pin is controlled by port latches 10 = UxTX, UxRX, UxCTS and UxRTS pins are enabled and used								
						controlled by pa	t latchas		
	01 = UxTX, UxRX and UxRTS pins are enabled and used; UxCTS pin is controlled by port latches 00 = UxTX and UxRX pins are enabled and used; UxCTS and UxRTS/BCLKx pins are controlled b								
	port latches								
bit 7	WAKE: Wake-up on Start Bit Detect During Sleep Mode Enable bit								
	1 = UARTx continues to sample the UxRX pin; interrupt is generated on the falling edge, bit is cleared								
	in hardware on the following rising edge 0 = No wake-up is enabled								
bit 6	LPBACK: UARTx Loopback Mode Select bit								
	1 = Enables Loopback mode								
	0 = Loopback mode is disabled								
bit 5	ABAUD: Auto-Baud Enable bit								
		baud rate meas n hardware upor		e next characte	er – requires re	ception of a Sy	nc field (55h		
		e measurement		-					
bit 4		RTx Receive Po	larity Inversion	bit					
	1 = UxRX Idle 0 = UxRX Idle								
		5 SIAIC 15 1							
		the peripheral ir				vailable RPn/RI	PIn pin. For		
m	ore information	n, see Section 1	1.5 "Peripher	al Pin Select (PPS)".				

REGISTER 17-1: UxMODE: UARTx MODE REGISTER

2: This feature is only available for the 16x BRG mode (BRGH = 0).

REGISTER 17-1: UxMODE: UARTx MODE REGISTER (CONTINUED)

- bit 3 BRGH: High Baud Rate Enable bit 1 = High-Speed mode (4 BRG clock cycles per bit) 0 = Standard Speed mode (16 BRG clock cycles per bit)
- bit 2-1 **PDSEL[1:0]:** Parity and Data Selection bits
 - 11 = 9-bit data, no parity
 - 10 = 8-bit data, odd parity
 - 01 = 8-bit data, even parity
 - 00 = 8-bit data, no parity
- bit 0 STSEL: Stop Bit Selection bit 1 = Two Stop bits
 - 0 = One Stop bit
- Note 1: If UARTEN = 1, the peripheral inputs and outputs must be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".
 - **2:** This feature is only available for the 16x BRG mode (BRGH = 0).

R/W-0	R/W-0	R/W-0	U-0	HC/R/W-0	R/W-0	HSC/R-0	HSC/R-1		
UTXISEL1	UTXINV ⁽¹⁾	UTXISEL0	—	UTXBRK	UTXEN ⁽²⁾	UTXBF	TRMT		
bit 15							bit 8		
R/W-0	R/W-0	R/W-0	HSC/R-1	HSC/R-0	HSC/R-0	HS/R/C-0	HSC/R-0		
URXISEL1	URXISEL0	ADDEN	RIDLE	PERR	FERR	OERR	URXDA		
bit 7							bit 0		
Lonondi			L :4		ana Cattabla/C	la anabia bit			
Legend:			C = Clearable bit HSC = Hardware Settable/Cle						
R = Readable	e bit	W = Writable bit		U = Unimplemented bit, read as '0'					
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown			
HS = Hardwa	re Settable bit	HC = Hardware Clearable bit							
bit 15,13	UTXISEL[1:0]: UARTx Transmission Interrupt Mode Selection bits								
	11 = Reserved; do not use								
	10 = Interrupt when a character is transferred to the Transmit Shift Register (TSR), and as a result, the transmit buffer becomes empty								
	01 = Interrupt when the last character is shifted out of the Transmit Shift Register; all transmit								
	operations are completed								
	00 = Interrupt when a character is transferred to the Transmit Shift Register (this implies there is at least								
		racter open in t		,					
bit 14	UTXINV: UAF	RTx IrDA [®] Enco	oder Transmit	Polarity Inversio	on bit ⁽¹⁾				
	IREN = 0:								
	1 = UxTX Idle state is '0'								

REGISTER 17-2: UxSTA: UARTx STATUS AND CONTROL REGISTER

	01 = Interrupt when the last character is shifted out of the Transmit Shift Register; all transmit operations are completed
	 00 = Interrupt when a character is transferred to the Transmit Shift Register (this implies there is at least one character open in the transmit buffer)
bit 14	UTXINV: UARTx IrDA [®] Encoder Transmit Polarity Inversion bit ⁽¹⁾
	IREN = 0:
	1 = UxTX Idle state is '0'
	0 = UxTX Idle state is '1'
	<u>IREN = 1:</u>
	1 = UxTX Idle state is '1'
	0 = UxTX Idle state is '0'
bit 12	Unimplemented: Read as '0'
bit 11	UTXBRK: UARTx Transmit Break bit
	 1 = Sends Sync Break on next transmission – Start bit, followed by twelve '0' bits, followed by Stop bit; cleared by hardware upon completion
	0 = Sync Break transmission is disabled or completed
bit 10	UTXEN: UARTx Transmit Enable bit ⁽²⁾
	1 = Transmit is enabled, UxTX pin is controlled by UARTx
	 Transmit is disabled, any pending transmission is aborted and the buffer is reset; UxTX pin is controlled by the port
bit 9	UTXBF: UARTx Transmit Buffer Full Status bit (read-only)
	1 = Transmit buffer is full
	0 = Transmit buffer is not full, at least one more character can be written
bit 8	TRMT: Transmit Shift Register Empty bit (read-only)
	 1 = Transmit Shift Register is empty and transmit buffer is empty (the last transmission has completed) 0 = Transmit Shift Register is not empty, a transmission is in progress or queued
Note 1:	The value of this bit only affects the transmit properties of the module when the IrDA [®] encoder is enabled (IREN = 1).
2:	If UARTEN = 1, the peripheral inputs and outputs must be configured to an available RPn/RPIn pin. For

2: If UARTEN = 1, the peripheral inputs and outputs must be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".

REGISTER 17-2: UxSTA: UARTx STATUS AND CONTROL REGISTER (CONTINUED)

bit 7-6	URXISEL[1:0]: UARTx Receive Interrupt Mode Selection bits
	 11 = Interrupt is set on an RSR transfer, making the receive buffer full (i.e., has four data characters) 10 = Interrupt is set on an RSR transfer, making the receive buffer 3/4 full (i.e., has three data characters) 0x = Interrupt is set when any character is received and transferred from the RSR to the receive buffer; receive buffer has one or more characters
bit 5	ADDEN: Address Character Detect bit (bit 8 of received data = 1)
	 1 = Address Detect mode is enabled (if 9-bit mode is not selected, this does not take effect) 0 = Address Detect mode is disabled
bit 4	RIDLE: Receiver Idle bit (read-only)
	1 = Receiver is Idle0 = Receiver is active
bit 3	PERR: Parity Error Status bit (read-only)
	 1 = Parity error has been detected for the current character (the character at the top of the receive FIFO) 0 = Parity error has not been detected
bit 2	FERR: Framing Error Status bit (read-only)
	 1 = Framing error has been detected for the current character (the character at the top of the receive FIFO) 0 = Framing error has not been detected
bit 1	OERR: Receive Buffer Overrun Error Status bit (clear/read-only)
	 1 = Receive buffer has overflowed 0 = Receive buffer has not overflowed (clearing a previously set OERR bit ('1' to '0' transition) will reset the receive buffer and the RSR to the empty state)
bit 0	URXDA: UARTx Receive Buffer Data Available bit (read-only)
	 1 = Receive buffer has data, at least one more character can be read 0 = Receive buffer is empty
Note 1:	The value of this bit only affects the transmit properties of the module when the $IrDA^{\mbox{\sc B}}$ encoder is enabled (IREN = 1).

2: If UARTEN = 1, the peripheral inputs and outputs must be configured to an available RPn/RPIn pin. For more information, see Section 11.5 "Peripheral Pin Select (PPS)".

REGISTER 17-3: UxRXREG: UARTx RECEIVE REGISTER (NORMALLY READ-ONLY)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R-0
_	—	—	_	_	_	—	UxRXREG8
bit 15		· ·		·			bit 8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			UxR〉	(REG[7:0]			
bit 7							bit 0
Legend:							
R = Readabl	e bit	W = Writable b	it	U = Unimpler	nented bit, re	ead as '0'	
-n = Value at POR '1' = Bit is set				'0' = Bit is cle	ared	x = Bit is unk	nown

bit 15-9 Unimplemented: Read as '0'

bit 8-0 UxRXREG[8:0]: Data of the Received Character bits

REGISTER 17-4: UxTXREG: UARTx TRANSMIT REGISTER (NORMALLY WRITE-ONLY)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	W-x
—	—	—	—	—	—	—	UxTXREG8
bit 15							bit 8

W-x	W-x	W-x	W-x	W-x	W-x	W-x	W-x					
UxTXREG[7:0]												
bit 7												

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-9 Unimplemented: Read as '0'

bit 8-0 UxTXREG[8:0]: Data of the Transmitted Character bits

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			BRO	G[15:8]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			BR	G[7:0]			
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable b	oit	U = Unimpleme	nted bit, rea	d as '0'	
-n = Value at I	POR	'1' = Bit is set		'0' = Bit is clear	ed	x = Bit is unkr	nown

REGISTER 17-5: UxBRG: UARTx BAUD RATE GENERATOR REGISTER

bit 15-0 BRG[15:0]: Baud Rate Divisor bits

REGISTER 17-6: UXADMD: UARTX ADDRESS DETECT AND MATCH REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
ADMMASK7	ADMMASK6	ADMMASK5	ADMMASK4	ADMMASK3	ADMMASK2	ADMMASK1	ADMMASKO			
bit 15							bit 8			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
ADMADDR7	ADMADDR6	ADMADDR5	ADMADDR4	ADMADDR3	ADMADDR2	ADMADDR1	ADMADDR0			
bit 7		•					bit C			
Legend:										
R = Readable	bit	W = Writable	bit	U = Unimplem	nented bit, read	as '0'				
n = Value at POR '1' = Bit is set				'0' = Bit is cleared x = Bit is unknown						

ADMMASK[7:0]: ADMADDR[7:0] (UXADMD[7:0]) Masking bits For ADMMASKx: 1 = ADMADDRx is used to detect the address match 0 = ADMADDRx is not used to detect the address match

bit 7-0 **ADMADDR[7:0]:** Address Detect Task Off-Load bits Used with the ADMMASK[7:0] bits (UxADMD[15:8]) to offload the task of detecting the address character from the processor during Address Detect mode.

18.0 LIQUID CRYSTAL DISPLAY (LCD) CONTROLLER

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to "Liquid Crystal Display (LCD)" (www.microchip.com/DS30009740) in the "dsPIC33/PIC24 Family Reference Manual".

The Liquid Crystal Display (LCD) controller generates the data and timing control required to directly drive a static or multiplexed LCD panel. The module can drive up to eight commons signals on all devices, and from 9 to 36 segments, depending on the specific device.

Note: To be driven by the LCD controller, pins must be set as analog inputs. For the port corresponding to the desired common or segment pin, set TRISx = 1 and ANSELx = 1.

The LCD controller includes these features:

- Direct Driving of LCD Panel
- Three LCD Clock Sources with Selectable
 Prescaler

- Up to Eight Commons:
 - Static (one common)
 - 1/2 multiplex (two commons)
 - 1/3 multiplex (three commons)
 - 1/4 multiplex (four commons)
 - 1/5 multiplex (five commons)
 - 1/6 multiplex (six commons)
 - 1/7 multiplex (seven commons)
 - 1/8 multiplex (eight commons)
- Ability to Drive Up to 9 (in 28-pin devices) or Up to 36 (in 64-pin devices) Segments, Depending on the Multiplexing Mode Selected; Table 18-1 shows the segment availability
- Static, 1/2 or 1/3 LCD Bias
- On-Chip Bias Generator with Dedicated Charge Pump to Support a Range of Fixed and Bias Options
- Internal Resistors for Bias Voltage Generation
- Software Contrast Control for LCD Using Internal Biasing
- Core-Independent Automatic Display Features:
 Dual display memory used to display two
 - different content displays
 - Blink mode of individual pixels or the complete pixels
 - Blanking of individual pixels or the complete pixels
 - Timing schedule can be changed without core intervention based on user configurations

A simplified block diagram of the module is shown in Figure 18-1.

	Segments																	
Device	SEG 17	SEG 16	SEG 15	SEG 14	SEG 13	SEG 12	SEG 11	SEG 10	SEG 9	SEG 8	SEG 7	SEG 6	SEG 5	SEG 4	SEG 3	SEG 2	SEG 1	SEG 0
PIC24FJXXXGL306	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х
PIC24FJXXXGL305	х	х	х	_		х	х	х	х	х	х	х			х	х	_	_
PIC24FJXXXGL303	_	_	_	_		_	_		х	х	х	х	_	—	х	х	_	_
PIC24FJXXXGL302		_	_	_	_	_	_		х	х	х	х			х	х	_	_

									Segn	nents								
Device	SEG 63	SEG 48	SEG 47	SEG 40	SEG 31	SEG 30	SEG 29	SEG 28	SEG 27	SEG 26	SEG 25	SEG 24	SEG 23	SEG 22	SEG 21	SEG 20	SEG 19	SEG 18
PIC24FJXXXGL306	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х	х
PIC24FJXXXGL305	_	х	х	—	х	х	х	х	_	х	х	х	х	х	_	_	_	_
PIC24FJXXXGL303	_	х	х		х	х	х	х		х	х	_	_	_		_	_	_
PIC24FJXXXGL302		х	х				х			Ι	Ι	Ι	Ι	Ι		Ι		Ι

TABLE 18-1: LCD SEGMENT AVAILABILITY

PIC24FJ128GL306 FAMILY

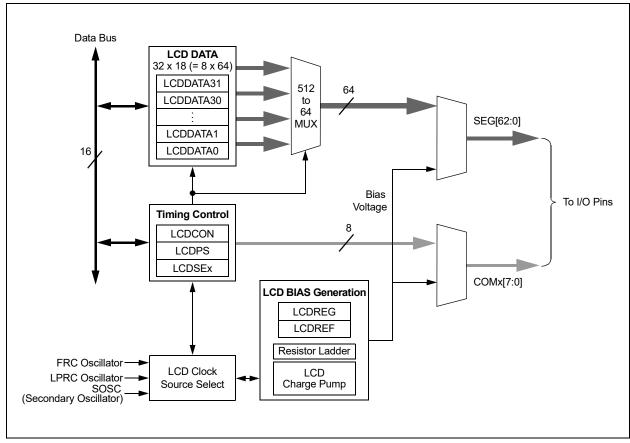


FIGURE 18-1: LCD CONTROLLER MODULE BLOCK DIAGRAM

18.1 LCD Control Registers

REGISTER 18-1: LCDCON: LCD CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
LCDEN		LCDSIDL	—	—	—	—	—
bit 15							bit 8
U-0	R/W-0	R/C-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	SLPEN	WERR	CS1	CS0	LMUX2	LMUX1	LMUX0
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	LCDEN: LCD Driver Enable bit 1 = LCD driver module is enabled 0 = LCD driver module is not enabled										
bit 14	Unimplemented: Read as '0)'									
bit 13	LCDSIDL: Stop LCD Drive in	n CPU Idle Mode Control bit									
	 1 = LCD driver halts in CPU Idle mode 0 = LCD driver continues to operate in CPU Idle mode 										
bit 12-7	Unimplemented: Read as '0'										
bit 6	SLPEN: LCD Driver Enable in Sleep Mode bit										
	1 = LCD driver module is disabled in Sleep mode0 = LCD driver module is enabled in Sleep mode										
bit 5	WERR: LCD Write Failed Error bit										
	 1 = LCDDATAx register is written while WA (LCDPS[4]) = 0 (must be cleared in software) 0 = No LCD write error 										
bit 4-3	CS[1:0]: Clock Source Select	ct bits									
	1x = SOSC										
	01 = LPRC										
h it 0 0	00 = FRC										
bit 2-0	LMUX[2:0]: LCD Commons										
	LMUX[2:0]	Multiplex	Bias								
	111	1/8 MUX (COM[7:0])	1/3								
	110	1/7 MUX (COM[6:0])	1/3								
	101	1/6 MUX (COM[5:0])	1/3								
	100	1/5 MUX (COM[4:0])	1/3								
	011	1/4 MUX (COM[3:0])	1/3								
	010	1/3 MUX (COM[2:0])	1/2 or 1/3								
	001	1/2 MUX (COM[1:0])	1/2 or 1/3								
	000	Static (COM0)	Static								

PIC24FJ128GL306 FAMILY

REGISTER 18-2: LCDREG: LCD CHARGE PUMP CONTROL REGISTER

RW-0	U-0						
CPEN	—	—	—	—	—	_	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	RW-0	RW-0
—	_	—	—	—	_	CKSEL1	CKSEL0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **CPEN:** 3.6V Charge Pump Enable bit

1 = The regulator generates the highest (3.6V) voltage

0 = Highest voltage in the system is supplied externally (AVDD)

bit 14-2 Unimplemented: Read as '0'

bit 1-0 CLKSEL[1:0]: Regulator Clock Select Control bits

11 = SOSC

10 = 8 MHz FRC

01 = 32 kHz LPRC

00 = Disables regulator and floats regulator voltage output

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0				
	—	—		—	—	—	—				
bit 15							bit				
R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0				
WFT	BIASMD	LCDA	WA	LP3	LP2	LP1	LP0				
bit 7							bit				
Legend:			1.1								
R = Readal		W = Writable		-	nented bit, read						
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	own				
bit 15-8	Unimplomor	tod: Dood oo '	o '								
bit 7	-	nted: Read as ' form Type Select									
				each frame bou	ndary)						
	 1 = Type-B waveform (phase changes on each frame boundary) 0 = Type-A waveform (phase changes within each common type) 										
bit 6	BIASMD: Bias Mode Select bit										
	When LMUX[2:0] = 000 or 011 through 111 :										
	0 = Static Bias mode (do not set this bit to '1')										
	<u>When LMUX[2:0] = 001 or 010:</u> 1 = 1/2 Bias mode										
	0 = 1/3 Bias mode										
bit 5	LCDA: LCD Active Status bit										
	1 = LCD driver module is active										
		er module is ina									
bit 4	-	WA: LCD Write Allow Status bit									
	 1 = Write into the LCDDATAx registers is allowed 0 = Write into the LCDDATAx registers is not allowed 										
bit 3-0		Prescaler Sele	ect bits								
	1111 = 1:16										
	1110 = 1:15 1101 = 1:14										
	1101 - 1.14 1100 = 1.13										
	1011 = 1:12	1011 = 1:12									
		1010 = 1:11									
	1001 = 1:10 1000 = 1:9	1001 = 1:10 1000 = 1:9									
	0111 = 1:8										
	0110 = 1:7										
	0101 = 1:6										
	0100 = 1:5 0011 = 1:4										
	0011 = 1.4 0010 = 1:3										
	0001 = 1:2										
	0000 = 1:1										

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SE(n+15)	SE(n+14)	SE(n+13)	SE(n+12)	SE(n+11)	SE(n+10)	SE(n+9)	SE(n+8)
bit 15	•				·		bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SE(n+7)	SE(n+6)	SE(n+5)	SE(n+4)	SE(n+3)	SE(n+2)	SE(n+1)	SE(n)
bit 7	•				•		bit 0
Logond.							

REGISTER 18-4: LCDSEx: LCD SEGMENT x ENABLE REGISTER

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 SE(n+15):SE(n): Segment Enable bits

 $\frac{For LCDSE0: n = 0}{For LCDSE1: n = 16}$ For LCDSE2: n = 32 For LCDSE3: n = 48

1 = Segment function of the pin is enabled, digital I/O is disabled

0 = Segment function of the pin is disabled, digital I/O is enabled

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
S(n+15)Cy	S(n+14)Cy	S(n+13)Cy	S(n+12)Cy	S(n+11)Cy	S(n+10)Cy	S(n+9)Cy	S(n+8)Cy
bit 15	, , ,	<u> </u>	, , ,	. , .	. , .	, , ,	bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
S(n+7)Cy	S(n+6)Cy	S(n+5)Cy	S(n+4)Cy	S(n+3)Cy	S(n+2)Cy	S(n+1)Cy	S(n)Cy
bit 7							bit 0
Legend:							

REGISTER 18-5: LCDDATAX: LCD DATA x REGISTER⁽¹⁾

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 S(n+15)Cy:S(n)Cy: Pixel On bits

<u>For Registers, LCDDATA0 through LCDDATA3: n = (16x), y = 0</u>
For Registers, LCDDATA4 through LCDDATA7: $n = (16(x - 4)), y = 1$
For Registers, LCDDATA8 through LCDDATA11: $n = (16(x - 8)), y = 2$
For Registers, LCDDATA12 through LCDDATA15: $n = (16(x - 12)), y = 3$
For Registers, LCDDATA16 through LCDDATA19: $n = (16(x - 16)), y = 4$
For Registers, LCDDATA20 through LCDDATA23: n = (16(x - 20)), y = 5
For Registers, LCDDATA24 through LCDDATA27: $n = (16(x - 24)), y = 6$
For Registers, LCDDATA28 through LCDDATA31: n = (16(x - 28)), y = 7
1 = Pixel is on
0 = Pixel is off

Note 1: Table 18-2 shows the correlation of each bit in the LCDDATAx registers to the respective common and segment signals.

COMLines	Segments								
COM Lines	0 to 15	16 to 31	32 to 47	48 to 64					
0	LCDDATA0	LCDDATA1	LCDDATA2	LCDDATA3					
0	S00C0:S15C0	S16C0:S31C0	S32C0:S47C0	S48C0:S63C0					
4	LCDDATA4	LCDDATA5	LCDDATA6	LCDDATA7					
1	S00C1:S15C1	S16C1:S31C1	S32C1:S47C1	S48C1:S63C1					
0	LCDDATA8	LCDDATA9	LCDDATA10	LCDDATA11					
2	S00C2:S15C2	S16C2:S31C2	S32C2:S47C2	S48C2:S63C2					
	LCDDATA12	LCDDATA13	LCDDATA14	LCDDATA15					
3	S00C3:S15C3	S16C3:S31C3	S32C3:S47C3	S48C3:S63C3					
4	LCDDATA16	LCDDATA17	LCDDATA18	LCDDATA19					
4	S00C4:S15C4	S16C4:S31C4	S32C4:S47C4	S48C4:S63C4					
5	LCDDATA20	LCDDATA21	LCDDATA22	LCDDATA23					
5	S00C5:S15C5	S16C5:S31C5	S32C5:S47C5	S48C5:S63C5					
C	LCDDATA24	LCDDATA25	LCDDATA26	LCDDATA27					
6	S00C6:S15C6	S16C6:S31C6	S32C6:S47C6	S48C6:S63C6					
7	LCDDATA28	LCDDATA29	LCDDATA30	LCDDATA31					
7	S00C7:S15C7	S16C7:S31C7	S32C7:S47C7	S48C7:S63C7					

TABLE 18-2: LCD DATA REGISTERS AND BITS FOR SEGMENT AND COM COMBINATIONS

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R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
LCDIRE		LCDCST2	LCDCST1	LCDCST0	VLCD3PE	VLCD2PE	VLCD1PE					
bit 15			I				bit 8					
R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0					
LRLAP1	LRLAP0	LRLBP1	LRLBP0		LRLAT2	LRLAT1	LRLAT0					
bit 7							bit (
Legend:												
R = Readabl	e hit	W = Writable	bit		nented bit, read	l as '0'						
-n = Value at		'1' = Bit is set	DIL	'0' = Bit is clea			0.11/2					
-n = value at	POR	I = Bil is sel		0 = Bit is clear	ared	x = Bit is unkr	IOWN					
bit 15	LCDIRE: C	D Internal Refe	ence Fnable b	it								
	_	CD reference is			ne internal cont	rast control circ	uit					
	0 = Internal L	CD reference is	s disabled									
bit 14	Unimplemer	nted: Read as ')'									
bit 13-11	LCDCST[2:0]: LCD Contras	t Control bits									
	Selects the Resistance of the LCD Contrast Control Resistor Ladder:											
	111 = Resistor ladder is at maximum resistance (minimum contrast)											
	110 = Resistor ladder is at 6/7th of maximum resistance											
	101 = Resistor ladder is at 5/7th of maximum resistance											
	100 = Resistor ladder is at 4/7th of maximum resistance											
	011 = Resistor ladder is at 3/7th of maximum resistance 010 = Resistor ladder is at 2/7th of maximum resistance											
	010 = Resistor ladder is at 2/7 th of maximum resistance 001 = Resistor ladder is at 1/7 th of maximum resistance											
		um resistance (adder is shorted	d						
bit 10		CD Bias 3 Pin B										
	1 = Bias 3 level is connected to the external pin, LCDBIAS3											
		vel is internal (ir										
bit 9		/LCD2PE: LCD Bias 2 Pin Enable bit										
	1 = Bias 2 level is connected to the external pin, LCDBIAS2											
L:4 0	 0 = Bias 2 level is internal (internal resistor ladder) VLCD1PE: LCD Bias 1 Pin Enable bit 											
bit 8					24							
	 1 = Bias 1 level is connected to the external pin, LCDBIAS1 0 = Bias 1 level is internal (internal resistor ladder) 											
bit 7-6					ol bits							
	LRLAP[1:0]: LCD Reference Ladder A Time Power Control bits <u>During Time Interval A:</u>											
	11 = Internal LCD reference ladder is powered in High-Power mode											
	10 = Internal LCD reference ladder is powered in Medium Power mode											
	01 = Internal LCD reference ladder is powered in Low-Power mode											
					00 = Internal LCD reference ladder is powered down and unconnected							
	00 = Internal	LCD reference	ladder is powe	ered down and								
bit 5-4	00 = Internal		ladder is powe	ered down and								
bit 5-4	00 = Internal LRLBP[1:0]: During Time	LCD reference LCD Reference Interval B:	ladder is powe e Ladder B Tim	ered down and ne Power Contr	ol bits							
bit 5-4	00 = Internal LRLBP[1:0]: During Time 11 = Internal	LCD reference LCD Reference Interval B: LCD reference	ladder is powe e Ladder B Tim ladder is powe	ered down and ne Power Contr ered in High-Po	ol bits wer mode							
bit 5-4	00 = Internal LRLBP[1:0]: During Time 11 = Internal 10 = Internal	LCD reference LCD Reference Interval B: LCD reference LCD reference	ladder is powe e Ladder B Tim ladder is powe ladder is powe	ered down and le Power Contr ered in High-Po ered in Medium	ol bits wer mode Power mode							
bit 5-4	00 = Internal LRLBP[1:0]: During Time 11 = Internal 10 = Internal 01 = Internal	LCD reference LCD Reference Interval B: LCD reference LCD reference LCD reference	ladder is powe e Ladder B Tim ladder is powe ladder is powe ladder is powe	ered down and he Power Contr ered in High-Po ered in Medium ered in Low-Pov	ol bits wer mode Power mode wer mode							
bit 5-4 bit 3	00 = Internal LRLBP[1:0]: <u>During Time</u> 11 = Internal 10 = Internal 00 = Internal	LCD reference LCD Reference Interval B: LCD reference LCD reference	ladder is powe e Ladder B Tim ladder is powe ladder is powe ladder is powe ladder is powe	ered down and he Power Contr ered in High-Po ered in Medium ered in Low-Pov	ol bits wer mode Power mode wer mode							

REGISTER 18-6: LCDREF: LCD REFERENCE LADDER CONTROL REGISTER

REGISTER 18-6: LCDREF: LCD REFERENCE LADDER CONTROL REGISTER (CONTINUED)

bit 2-0 LRLAT[2:0]: LCD Reference Ladder A Time Interval Control bits

Sets the number of 32 clock counts when the A Time Interval Power mode is active.

For Type-A Waveforms (WFT = 0):

111 = Internal LCD reference ladder is in A Power mode for 7 clocks and B Power mode for 9 clocks 110 = Internal LCD reference ladder is in A Power mode for 6 clocks and B Power mode for 10 clocks 101 = Internal LCD reference ladder is in A Power mode for 5 clocks and B Power mode for 11 clocks 100 = Internal LCD reference ladder is in A Power mode for 4 clocks and B Power mode for 12 clocks 111 = Internal LCD reference ladder is in A Power mode for 3 clocks and B Power mode for 13 clocks 112 = Internal LCD reference ladder is in A Power mode for 3 clocks and B Power mode for 13 clocks 113 = Internal LCD reference ladder is in A Power mode for 2 clocks and B Power mode for 14 clocks 114 = Internal LCD reference ladder is in A Power mode for 1 clocks and B Power mode for 14 clocks 115 = Internal LCD reference ladder is in A Power mode for 1 clock and B Power mode for 15 clocks 115 = Internal LCD reference ladder is always in B Power mode

For Type-B Waveforms (WFT = 1):

111 = Internal LCD reference ladder is in A Power mode for 7 clocks and B Power mode for 25 clocks 110 = Internal LCD reference ladder is in A Power mode for 6 clocks and B Power mode for 26 clocks 101 = Internal LCD reference ladder is in A Power mode for 5 clocks and B Power mode for 27 clocks 100 = Internal LCD reference ladder is in A Power mode for 4 clocks and B Power mode for 28 clocks 111 = Internal LCD reference ladder is in A Power mode for 3 clocks and B Power mode for 29 clocks 112 = Internal LCD reference ladder is in A Power mode for 3 clocks and B Power mode for 29 clocks 113 = Internal LCD reference ladder is in A Power mode for 2 clocks and B Power mode for 30 clocks 114 = Internal LCD reference ladder is in A Power mode for 2 clocks and B Power mode for 30 clocks 115 = Internal LCD reference ladder is in A Power mode for 1 clock and B Power mode for 31 clocks 116 = Internal LCD reference ladder is always in B Power mode

R/W-0		R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
SMFCS[2:0] ^(1,2,3,4,5)			BLINKFCS[2:0] ^(4,5,6,7)			BLINKMO	BLINKMODE[1:0] ^(8,9)		
bit 15							bit 8		
D /// 0	DAMA	DIMO	DAMO	DAMA	DAMO	DAVA	DAMO		
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0		
	ANKFCS[2:0] ^{(3,5,}	,0,7,10,11)	BLANKI	/ODE[1:0]	FCC	S[1:0]	ELCDEN		
bit 7							bit (
Legend:									
R = Reada	able bit	W = Writable b	bit	U = Unimplen	nented bit, rea	d as '0'			
-n = Value	at POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown		
bit 15-13	SMFCS[2:0]	: Frame Counter	Selection for	Data Memory	Selection bits ⁽¹	,2,3,4,5)			
		EL[1:0] = 10 (one					nemory):		
	000 = Rese		0 (500)						
	001 = Selects Frame Counter 0 (FC0)								
	When DMSEL[1:0] = 11 (continues to switch over from one memory to another memory): 000 = Reserved								
	000 = Reserved 001 = Selects Frame Counter 0 (FC0)								
		ts Frame Counte		en continues wi	ith Frame Cou	nter 1 (FC1) at	the frequency		
		by the time ever					the frequency		
	011 = Rese								
	When DMSE	EL[1:0] = 11 (cont	inues to switc	h over from one	memory to an	other with a rep	eated pattern)		
		nates between F							
	101 = Rese								
	110 = Rese	rved							
	111 = Rese	rved							
Note 1:		nory is selected for			nk when				
0.		0] = 01 BLANKI			the sivel to Di	ali an Diank			
2:	Secondary mem	•							
3:		en Blink mode is	•			,			
4:		en Blank mode is		•	DE[1:0] = 00	⊥⊥).			
5:		selection switchov			w aiven by the	a clasted from	aguntar		
6: 7.		te between ON a		•			e counter.		
7:	FC0 is used whe (i.e., DMSEL[1:0		mory is not se	elected with SWI		11			
8:	Blink mode ON		to the pixel wi	nen Blank mode	e is off.				
9:	Blink mode OFF		-	2.2.1.1000					
	One-time Blank			changes the B	lank mode to e	nable or disabl	e the		
		feature (clears El							
11:	In One-Time Bla		,		Blink (to alterr	nate between o	n and off) unti ⁱ		

REGISTER 18-7: LCDACTRL: LCD AUTOMATIC CONTROL REGISTER

11: In One-Time Blank Configuration mode, the pixel continues to Blink (to alternate between on and off) until the timer event happens.

REGISTER 18-7: LCDACTRL: LCD AUTOMATIC CONTROL REGISTER (CONTINUED)

bit 12	-10	BLINKFCS[2:0]: Frame Counter Selection for Blink Selection bits (BLINKMODE = 01 or 10) ^(4,5,6,7)
		000 = Reserved
		001 = Selects Frame Counter 1 (FC1)
		010 = Selects Frame Counter 0 (FC0), then continues with Frame Counter 1 (FC1) at the frequency given by the time event
		011 = Reserved
		100 = Alternates between FC0 and FC1 at the frequency given by the time event (repeated pattern)
		101 = Reserved 110 = Reserved
		110 - Reserved
bit 9-8	3	BLINKMODE[1:0]: Blink Mode bits ^(8,9)
		00 = Blink mode is disabled
		01 = Blink mode is enabled with selected pixels (when DMSEL[1:0] = 00)
		10 = Blink mode is enabled with all pixels
		11 = Reserved
bit 7-5	5	BLANKFCS[2:0]: Blank Operation Selection from Frame Counter Selection bits ^(3,5,6,7,10,11) (when BLANKMODE[1:0] = 01 or 10)
		000 = Reserved
		001 = Selects Frame Counter 2 (FC2)
		010 = Selects Frame Counter 0 (FC0), then continues with Frame Counter 1 (FC1) at the frequency given by the time event
		011 = Reserved
		100 = Alternates between FC0 and FC1 at the frequency given by the time event (repeated pattern)
		101 = Reserved 110 = One-time Blank selects Frame Counter 2 (FC2) by the time event ^(10,11)
		110 - One-time blank selects Frame Counter 2 (FG2) by the time events of the fille eve
bit 4-3	3	BLANKMODE[1:0]: Blank Mode bits
	,	00 = Blank mode is disabled
		01 = Blank mode is enabled with selected pixels (when DMSEL[1:0] = 00)
		10 = Blank mode is enabled with all pixels
		11 = Reserved
bit 2-1	l	FCCS[1:0]: Clock Source bits
		00 = LCD clock
		01 = RTCC
		10 = CLC1
		11 = CLC2
bit 0		ELCDEN: Enhancement LCD Enable bit
		1 = Enhancement function is enabled
		0 = Enhancement function is disabled
Note	1:	Secondary memory is selected for pixel enable to Blink or Blank when
		BLINKMODE[1:0] = 01 BLANKMODE[1:0] = 01.
	2:	Secondary memory is used to store data to display or selects the pixel to Blink or Blank.
	3:	FC1 is used when Blink mode is not selected (i.e., BLINKMODE[1:0] = 00 11).
	4:	FC2 is used when Blank mode is not selected (i.e., BLANKMODE[1:0] = 00 11).
	5:	Frame counter selection switchover based on time event.
	6:	Pixel will alternate between ON and OFF state at the frequency given by the selected frame counter.
	7:	FC0 is used when secondary memory is not selected with switchover function (i.e., DMSEL[1:0] = 00 or 01).
	8:	Blink mode ON state is effective to the pixel when Blank mode is off.
	9:	Blink mode OFF state drives '0' to the pixel.
	10:	One-time Blank continues to Blank until a user changes the Blank mode to enable or disable the enhanced LCD feature (clears ELCDEN) or SBLANK is clear.
	11.	In One-Time Blank Configuration mode, the pixel continues to Blink (to alternate between on and off) until
	•••	the timer event happens.

U-0	R/C-0	R-0	R-0	R/C-0	R/C-0	R/C-0	R/C-0	
	SBLANK ^(1,2,3,4)	SMEMACT	PMEMACT	TEVENTO	FC2O	FC1O	FC0O	
bit 15							bit 8	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
SMLOCK ⁽⁷⁾) SMCLEAR	PMLOCK ^(5,6)	PMCLEAR	SMEMEN	PMEMDIS	DMSEL1	DMSEL0	
bit 7							bit 0	
r								
Legend:		C = Clearable	bit					
R = Readab	le bit	W = Writable I	oit	U = Unimplem	nented bit, rea	d as '0'		
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unki	nown	
bit 15	Unimplemente							
bit 14	SBLANK: Blank	< Status bit ^{(1,2,3}	3,4)					
	1 = Pixels are in							
L:1 40	0 = Pixels are n							
bit 13	SMEMACT: Sec 1 = Data display							
	0 = Data display			ory				
bit 12	PMEMACT: Prin		•	5				
	1 = Data display							
	0 = Data display	/ is not from pri	mary memory					
bit 11	TEVENTO: Tim	e Event Overflo	ow bit					
	1 = This flag is s 0 = Timer event			lows				
bit 10	FC2O: Frame C	ounter 2 Overf	low bit					
	1 = This flag is s 0 = Frame Cour			rerflows				
bit 9	FC10: Frame C	ounter 1 Overf	low bit					
	1 = This flag is s 0 = Frame Cour			reflows				
bit 8	FC00: Frame C	ounter 0 Overf	low bit					
	1 = This flag is set when Frame Counter 0 overflows							
	0 = Frame Cour	nter 0 does not	overflow					
Note 1: R	eflects BLANKFC	S[2:0] = 110 sta	atus.					
2: It	t is the user's responsibility to clear the bit to make LCD active.							
3: ⊤	his bit is cleared b	is bit is cleared by hardware when the user changes Blank mode = 0 or clears the ELCDEN bit.						
4: T	his flag bit is used	to generate an	enhanced fea	ture interrupt.				
	his bit is effective v						LCDPS[4]).	
6: V	hen the PMLOCK bit is set, it does not allow the user to write to the primary memory.							

REGISTER 18-8: LCDASTAT: LCD AUTOMATIC STATUS REGISTER

7: When the SMLOCK bit is set, it does not allow the user to write to the secondary memory.

REGISTER 18-8: LCDASTAT: LCD AUTOMATIC STATUS REGISTER (CONTINUED)

bit 7	SMLOCK: Secondary Memory Lock Enable bit ⁽⁷⁾
	1 = Secondary memory is locked
	0 = Secondary memory is unlocked
bit 6	SMCLEAR: Secondary Memory Clear Enable bit
	1 = Secondary memory is cleared immediately
	0 = Secondary memory is not cleared
bit 5	PMLOCK: Primary Memory Lock Enable bit ^(5,6)
	1 = Primary memory is locked
	0 = Primary memory is unlocked
bit 4	PMCLEAR: Primary Memory Clear Enable bit
	1 = Primary memory is cleared immediately
	0 = Primary memory is not cleared
bit 3	SMEMEN: Secondary Memory Enable bit
	1 = Secondary memory is enabled
	0 = Secondary memory is disabled
bit 2	PMEMDIS: Primary Memory Disable bit
	1 = Primary memory is disabled
	0 = Primary memory is enabled
bit 1-0	DMSEL[1:0]: Data Memory Selection bits
	11 = Continues alternating selection between primary and secondary memories based on SMFCS[2:0]
	10 = Alternates selection between primary and secondary memories on SMFCS[2:0]
	01 = Selects secondary memory as display memory
	00 = Selects primary memory as display memory
Note 1:	Reflects BLANKFCS[2:0] = 110 status.
2:	It is the user's responsibility to clear the bit to make LCD active.
3:	This bit is cleared by hardware when the user changes Blank mode = 0 or clears the ELCDEN bit.
4:	This flag bit is used to generate an enhanced feature interrupt.

- 5: This bit is effective when SMEMEN = 1; otherwise, the write follows the Write Allow bit, WA (LCDPS[4]).
- 6: When the PMLOCK bit is set, it does not allow the user to write to the primary memory.
- 7: When the SMLOCK bit is set, it does not allow the user to write to the secondary memory.

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			FC0[1	5:8] ^(1,2,3)			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			FC0[7	7:0] ^(1,2,3)			
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable bi	t	U = Unimpleme	nted bit, rea	d as '0'	
-n = Value at I	POR	'1' = Bit is set		'0' = Bit is cleare	ed	x = Bit is unkr	nown

bit 15-0 **FC0[15:0]:** Time Base Value bits^(1,2,3) These bits define the overflow value.

Note 1: It is recommended to make the FC0x values to be multiples of the frame frequency.

- **2:** FC0x value must be greater than two.
- **3:** FC0x should not be written when ELCDEN = 1.

REGISTER 18-10: LCDFC1: LCD FRAME COUNTER 1 REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			FC1[1	5:8] ^(1,2,3)			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			FC1[7:0] ^(1,2,3)			
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable b	bit	U = Unimplem	nented bit, read	d as '0'	
-n = Value at l	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown

bit 15-0 **FC1[15:0]:** Time Base Value bits^(1,2,3) These bits define the overflow value.

Note 1: It is recommended to make the FC1x values to be multiples of the frame frequency.

- 2: FC1x value must be greater than two.
- **3:** FC1x should not be written when ELCDEN = 1.

REGISTER 18-11: LCDFC2: LCD FRAME COUNTER 2 REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			FC2[1	5:8] ^(1,2,3)			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			FC2[7	7:0] ^(1,2,3)			
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable b	oit	U = Unimpleme	ented bit, read	d as '0'	
-n = Value at I	POR	'1' = Bit is set		ʻ0' = Bit is clear	ed	x = Bit is unkr	nown

bit 15-0 **FC2[15:0]:** Time Base Value bits^(1,2,3) These bits define the overflow value.

Note 1: It is recommended to make the FC2x values to be multiples of the frame frequency.

- **2:** FC2x value must be greater than two.
- **3:** FC2x should not be written when ELCDEN = 1.

REGISTER 18-12: LCDEVENT: LCD TIME EVENT SELECTION REGISTER

Legend: R = Readable I	bit	W = Writable bit		U = Unimplen	nented bit, read	l as '0'	
bit 7							bit 0
hit 7							hit O
			TEVEN	Г[7:0] ^(1,2,3)			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
bit 15							bit 8
			TEVENT	[15:8] ^(1,2,3)			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0

bit 15:0 **TEVENT[15:0]:** Time Base Event Value bits^(1,2,3) These bits define the time event value.

Note 1: The TEVENTx value should be multiples of the frame frequency.

'1' = Bit is set

- 2: The TEVENTx value should be greater than the FCx value.
- **3:** The overflow is (TEVENTx * 16 ±1); the TEVENTx overflow gets ±1 based on the TEVENTx ratio with the FCx value.

'0' = Bit is cleared

-n = Value at POR

x = Bit is unknown

REGISTER 18-13: LCDSDATAX: LCD SDATA x REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
S(n+15)Cy	S(n+14)Cy	S(n+13)Cy	S(n+12)Cy	S(n+11)Cy	S(n+10)Cy	S(n+9)Cy	S(n+8)Cy
bit 15							bit 8

R/W-0	R/W-0						
S(n+7)Cy	S(n+6)Cy	S(n+5)Cy	S(n+4)Cy	S(n+3)Cy	S(n+2)Cy	S(n+1)Cy	S(n)Cy
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15:0

S(n+15)Cy:S(n)Cy: Pixel Blink/Blank Enable bits (Segment x and Common y)

If BLINKMODE[1:0] = 01 or BLANKMODE[1:0] = 01:

1 = Pixel is selected for Blink or Blank 0 = Pixel is not selected for Blink or Blank Else: SEGxCOMy: Pixel Data bits (Segment x and Common y) 1 = Pixel on (dark)

0 = Pixel off (clear)

TABLE 18-3: LCD SDATA REGISTERS AND BITS FOR SEGMENT AND COM COMBINATIONS

	Segments								
COM Lines	0 to 15	16 to 31	32 to 47	48 to 64					
0	LCDSDATA0	LCDSDATA1	LCDSDATA2	LCDSDATA3					
0	S00C0:S15C0	S16C0:S31C0	S32C0:S47C0	S48C0:S63C0					
1	LCDSDATA4	LCDSDATA5	LCDSDATA6	LCDSDATA7					
1	S00C1:S15C1	S16C1:S31C1	S32C1:S47C1	S48C1:S63C1					
2	LCDSDATA8	LCDSDATA9	LCDSDATA10	LCDSDATA11					
2	S00C2:S15C2	S16C2:S31C2	S32C2:S47C2	S48C2:S63C2					
3	LCDSDATA12	LCDSDATA13	LCDSDATA14	LCDSDATA15					
3	S00C3:S15C3	S16C3:S31C3	S32C3:S47C3	S48C3:S63C3					
4	LCDSDATA16	LCDSDATA17	LCDSDATA18	LCDSDATA19					
4	S00C4:S15C4	S16C4:S31C4	S32C4:S47C4	S48C4:S63C4					
5	LCDSDATA20	LCDSDATA21	LCDSDATA22	LCDSDATA23					
5	S00C5:S15C5	S16C5:S31C5	S32C5:S47C5	S48C5:S63C5					
6	LCDSDATA24	LCDSDATA25	LCDSDATA26	LCDSDATA27					
0	S00C6:S15C6	S16C6:S31C6	S32C6:S47C6	S48C6:S63C6					
7	LCDSDATA28	LCDSDATA29	LCDSDATA30	LCDSDATA31					
· · ·	S00C7:S15C7	S16C7:S31C7	S32C7:S47C7	S48C7:S63C7					

19.0 REAL-TIME CLOCK AND CALENDAR (RTCC) WITH TIMESTAMP

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "RTCC with Timestamp" (www.microchip.com/DS70005193) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The RTCC provides the user with a Real-Time Clock and Calendar (RTCC) function that can be calibrated.

Key features of the RTCC module are:

- Selectable Clock Source
- Provides Hours, Minutes and Seconds Using 24-Hour Format
- · Visibility of One Half Second Period
- Provides Calendar Weekday, Date, Month and Year
- Alarm-Configurable for Half a Second, 1 Second, 10 Seconds, 1 Minute, 10 Minutes, 1 Hour, 1 Day, 1 Week, 1 Month or 1 Year
- Alarm Repeat with Decrementing Counter
- Alarm with Indefinite Repeat Chime
- Year 2000 to 2099 Leap Year Correction
- BCD Format for Smaller Software Overhead
- Optimized for Long-Term Battery Operation
- User Calibration of the 32.768 kHz Clock Crystal/32 kHz INTRC Frequency with Periodic Auto-Adjust
- Fractional Second Synchronization
- Calibration to within ±2.64 Seconds Error per Month
- · Calibrates Up to 260 ppm of Crystal Error
- Ability to Periodically Wake-up External Devices without CPU Intervention (external power control)
- Power Control Output for External Circuit Control
- Calibration takes Effect Every 15 Seconds
- Timestamp Capture Register for Time and Date
- Programmable Prescaler and Clock Divider Circuit allows Operation with Any Clock Source Up to 32 MHz, Including 32.768 kHz Crystal, 50/60 Hz Powerline Clock, External Real-Time Clock (RTC) or 32 kHz LPRC Clock

19.1 RTCC Source Clock

The RTCC clock divider block converts the incoming oscillator source into accurate 1/2 and 1 second clocks for the RTCC. The clock divider is optimized to work with three different oscillator sources:

- 32.768 kHz Crystal Oscillator
- 32 kHz Low-Power RC Oscillator (LPRC)
- External 50 Hz or 60 Hz Powerline Frequency

An asynchronous prescaler, PS[1:0] (RTCCON2L[5:4]), is provided that allows the RTCC to work with higher speed clock sources, such as the system clock. Divide ratios of 1:16, 1:64 or 1:256 may be selected, allowing sources up to 32 MHz to clock the RTCC.

19.1.1 COARSE FREQUENCY DIVISION

The clock divider block has a 16-bit counter used to divide the input clock frequency. The divide ratio is set by the DIV[15:0] register bits (RTCCON2H[15:0]). The DIV[15:0] bits should be programmed with a value to produce a nominal 1/2 second clock divider count period.

19.1.2 FINE FREQUENCY DIVISION

The fine frequency division is set using the FDIV[4:0] (RTCCON2L[15:11]) bits. Increasing the FDIVx value will lengthen the overall clock divider period.

If FDIV[4:0] = 00000, the fine frequency division circuit is effectively disabled. Otherwise, it will optionally remove a clock pulse from the input of the clock divider every 1/2 second. This functionality will allow the user to remove up to 31 pulses over a fixed period of 16 seconds, depending on the value of FDIVx.

The value for DIV[15:0] is calculated as shown in Equation 19-1. The fractional remainder of the DIV[15:0] calculation result can be used to calculate the value for FDIV[4:0].

EQUATION 19-1: RTCC CLOCK DIVIDER OUTPUT FREQUENCY

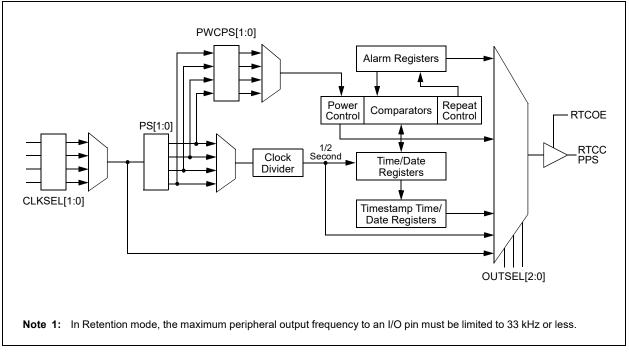
$$FOUT = \frac{FIN}{2 \cdot (PS[1:0] \ Prescaler) \cdot (DIV[15:0] + 1) + \left(\frac{FDIV[4:0]}{32}\right)}$$

The DIV[15:0] value is the integer part of this calculation:

$$DIV[15:0] = \frac{FIN}{2 \cdot (PS[1:0] \ Prescaler)} - 1$$

The FDIV[4:0] value is the fractional part of the DIV[15:0] calculation, multiplied by 32.

FIGURE 19-1: RTCC BLOCK DIAGRAM



19.2 RTCC Module Registers

The RTCC module registers are organized into four categories:

- RTCC Control Registers
- RTCC Value Registers
- Alarm Value Registers
- Timestamp Registers

19.2.1 REGISTER MAPPING

Previous RTCC implementations used a Register Pointer to access the RTCC Time and Date registers, as well as the Alarm Time and Date registers. These registers are now mapped to memory and are individually addressable.

19.2.2 WRITE LOCK

To prevent spurious changes to the Time Control or Time Value registers, the WRLOCK bit (RTCCON1L[11]) must be cleared ('0'). The POR default state is when the WRLOCK bit is '0' and is cleared on any device Reset (POR, BOR, MCLR). It is recommended that the WRLOCK bit be set to '1' after the Date and Time registers are properly initialized, and after the RTCEN bit (RTCCON1L[15]) has been set.

Any attempt to write to the RTCEN bit, the RTCCON2L/H registers, or the Date or Time registers, will be ignored as long as WRLOCK is '1'. The Alarm, Power Control and Timestamp registers can be changed when WRLOCK is '1'.

EXAMPLE 19-1: SETTING THE WRLOCK BIT

Clearing the WRLOCK bit requires an unlock sequence after it has been written to a '1', writing two bytes consecutively to the NVMKEY register. A sample assembly sequence is shown in Example 19-1. If WRLOCK is already cleared, it can be set to '1' without using the unlock sequence.

Note: To avoid accidental writes to the timer, it is recommended that the WRLOCK bit (RTCCON1L[11]) is kept clear at any other time. For the WRLOCK bit to be set, there is only one instruction cycle time window allowed between the 55h/AA sequence and the setting of WRLOCK; therefore, it is recommended that code follow the procedure in Example 19-1.

19.2.3 SELECTING RTCC CLOCK SOURCE

The clock source for the RTCC module can be selected using the CLKSEL[1:0] bits in the RTCCON2L register. When the bits are set to '00', the Secondary Oscillator (SOSC) is used as the reference clock and when the bits are '01', LPRC is used as the reference clock. When CLKSEL[1:0] = 10, the external powerline (50 Hz and 60 Hz) is used as the clock source. When CLKSEL[1:0] = 11, the system clock is used as the clock source.

DISI	#6	;disable interrupts for 6 instructions
MOV	#NVKEY, W1	
MOV	#0x55, W2	; first unlock code
MOV	W2, [W1]	; write first unlock code
MOV	#0xAA, W3	; second unlock sequence
MOV	W3, [W1]	; write second unlock sequence
BCLR	RTCCON1L, #WRLOCK	; clear the WRLOCK bit

19.3 RTCC Registers

19.3.1 RTCC CONTROL REGISTERS

REGISTER 19-1: RTCCON1L: RTCC CONTROL REGISTER 1 LOW

RTCEN — — WRLOCK PWCEN PWCPOL PWCPOE bit 15 bit 3 bit 3 bit 3	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
bit 15 bit a	RTCEN	—	—	—	WRLOCK	PWCEN	PWCPOL	PWCPOE
	bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	R/W-0
RTCOE	OUTSEL2	OUTSEL1	OUTSEL0	—	—	_	TSAEN
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	RTCEN: RTCC Enable bit 1 = RTCC is enabled and counts from selected clock source 0 = RTCC is not enabled
bit 14-12	Unimplemented: Read as '0'
bit 11	WRLOCK: RTCC Register Write Lock bit
	1 = RTCC registers are locked0 = RTCC registers may be written to by user
bit 10	PWCEN: Power Control Enable bit
	1 = Power control is enabled0 = Power control is disabled
bit 9	PWCPOL: Power Control Polarity bit
	1 = Power control output is active-high0 = Power control output is active-low
bit 8	PWCPOE: Power Control Output Enable bit
	1 = Power control output pin is enabled0 = Power control output pin is disabled
bit 7	RTCOE: RTCC Output Enable bit
	1 = RTCC output is enabled
	0 = RTCC output is disabled
bit 6-4	OUTSEL[2:0]: RTCC Output Signal Selection bits
	111 = Unused 110 = Unused
	101 = Unused
	100 = Timestamp A event
	011 = Power control
	010 = RTCC input clock 001 = Second clock
	000 = Alarm event
bit 3-1	Unimplemented: Read as '0'
bit 0	TSAEN: Timestamp A Enable bit
	1 = Timestamp event will occur when a low pulse is detected on the TMPRN pin 0 = Timestamp is disabled

REGISTER 19-2: RTCCON1H: RTCC CONTROL REGISTER 1 HIGH

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
ALRMEN	CHIME			AMASK3	AMASK2	AMASK1	AMASK0
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ALMRPT7	ALMRPT6	ALMRPT5	ALMRPT4	ALMRPT3	ALMRPT2	ALMRPT1	ALMRPT0
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable k	pit	U = Unimplem	nented bit, rea	d as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
bit 15	ALRMEN: Ala	arm Enable bit					
	1 = Alarm is CHIME = 0 = Alarm is	,	ed automatical	ly after an aları	m event when	ever ALMRPT[7	7:0] = 00h and
bit 14	CHIME: Chim						
DIL 14	-	enabled; ALMR	PT[7:0] bits ro	ll over from 00k	to FFh		
		disabled; ALMR					
bit 13-12		ted: Read as '0					
bit 11-8	AMASK[3:0]:	Alarm Mask Co	onfiguration bi	ts			
	0000 = Every		0				
	0001 = Every						
	0010 = Every						
	0011 = Every						
	0100 = Every						
	0101 = Every 0110 = Once						
	0111 = Once						
	1000 = Once						
	1001 = Once	a year (except	when configur	ed for February	/ 29th, once ev	/ery four years))
	101x = Rese	rved – do not us	se				
	11xx = Rese	rved – do not us	se				
bit 7-0	ALMRPT[7:0	: Alarm Repeat	t Counter Valu	e bits			
	11111111 =	Alarm will repea	at 255 more tin	nes			
	•						
	•						
	•	Alarm will repea	40 mag + 1	_			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0
FDIV4	FDIV3	FDIV2	FDIV1	FDIV0	_	—	—
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0
PWCPS1	PWCPS0	PS1	PS0	—	—	CLKSEL1	CLKSEL0
bit 7							bit (
Legend:							
R = Readabl	le bit	W = Writable	bit	U = Unimplem	ented bit, rea	d as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea		x = Bit is unkı	nown
bit 15-11	FDIV[4·01· Er	actional Clock	Divide hits				
511 15-11		fractional clock					
				t clock cycle ever	v 16 seconds		
				t clock cycles eve			
	•						
	•						
	• 11101 - Incr	ease period by	30 RTCC innu	ut clock cycles ev	ioni 16 socor	de	
				ut clock cycles ev			
bit 10-8		ted: Read as '	-	,	,		
bit 7-6	-	: Power Contro		ect bits			
	00 = 1:1						
	01 = 1:16						
	10 = 1:64						
	11 = 1:256						
bit 5-4		scale Select bits	6				
	00 = 1:1 01 = 1:16						
	10 = 1:64						
	11 = 1 : 256						
bit 3-2	Unimplemen	ted: Read as ')'				
bit 1-0	CLKSEL[1:0]	: Clock Select	bits				
	00 = SOSC						
	01 = LPRC	l K min					
	01 = LPRC 10 = PWRLC 11 = System						

REGISTER 19-3: RTCCON2L: RTCC CONTROL REGISTER 2 LOW

19.3.2 RTCVAL REGISTER MAPPINGS

REGISTER 19-4: RTCCON2H: RTCC CONTROL REGISTER 2 HIGH⁽¹⁾

R/W-0	R/W-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			DIV[15:8]			
bit 15							bit 8
R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
			DIV	[7:0]			
bit 7							bit 0
Legend:							

R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **DIV[15:0]:** Clock Divide bits

Sets the period of the clock divider counter; value should cause a nominal 1/2 second underflow.

Note 1: A write to this register is only allowed when WRLOCK = 1.

R/W-0							
	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			PWCSA	MP[7:0]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			PWCST	AB[7:0] ⁽¹⁾			
bit 7							bit (
Legend:							
R = Readable	e bit	W = Writable b	oit	U = Unimplem	ented bit, read	d as '0'	
-n = Value at	= Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unknown			nown
	11111111 =	Sample window is	s always enab				
	11111111 = 111111110 = •	-	s always enab s 254 TPWCCL	led, even when P < clock periods			
	11111111 = 11111110 = • • • • • • • • • • • • • • • • • • •	Sample window is Sample window is Sample window is No sample windo	s always enab s 254 TPWCCL s 1 TPWCCLK c w	led, even when P < clock periods lock period	WCEN = 0		
bit 7-0	11111111 = 11111110 = • • • • • • • • • • • • • • • • • • •	Sample window is Sample window is Sample window is No sample windo ':0]: Power Contr	s always enab s 254 TPWCCL s 1 TPWCCLK o w rol Stability W	led, even when P K clock periods dock period indow Timer bits	WCEN = 0 (1)		
bit 7-0	11111111 = 11111110 = • • • • • • • • • • • • • • • • • • •	Sample window is Sample window is Sample window is No sample windo	s always enab s 254 TPWCCL s 1 TPWCCLK c w rol Stability W is 255 TPWCC	led, even when P K clock periods clock period indow Timer bits CLK clock periods	WCEN = 0 (1)		
bit 7-0	11111111 = 11111110 = • • • • • • • • • • • • • • • • • • •	Sample window is Sample window is Sample window is No sample windo ':0]: Power Conti Stability window	s always enab s 254 TPWCCLK o w rol Stability W is 255 TPWC0 is 254 TPWC0	led, even when P K clock periods lock period indow Timer bits ⁶ CLK clock periods	WCEN = 0 (1)		

REGISTER 19-5: RTCCON3L: RTCC CONTROL REGISTER 3 LOW

Note 1: The sample window always starts when the stability window timer expires, except when its initial value is 00h.

-	-						
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	—	_	—	—	_	_	_
bit 15		- -		·			bit 8
U-0	U-0	R/C-0	U-0	R/C-0	R-0	R-0	R-0
	—	ALMEVT	—	TSAEVT ⁽¹⁾	SYNC	ALMSYNC	HALFSEC ⁽²⁾
bit 7							bit 0
Legend:		C = Clearable					
R = Readab		W = Writable	bit	U = Unimplem	-	l as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ired	x = Bit is unkr	nown
bit 15-6	-	ted: Read as ')'				
bit 5	ALMEVT: Alarm Event bit						
		event has occu					
	0 = An alarm event has not occurred						
bit 4	Unimplemented: Read as '0' TSAEVT: Timestamp A Event bit ⁽¹⁾						
bit 3		•					
		mp event has o mp event has n					
bit 2		•					
	SYNC: Synchronization Status bit 1 = TIMEL/H registers may change during software read						
		registers may b		Solution road			
bit 1	ALMSYNC: A	larm Synchron	ization Status	bit			
				ALMDATEL/H			
	· ·	[3:0]) snouid n luring software		d, and Alarm c	ontrol dits (A	LRIVIEN, ALIVIE	RPI[7:0]) may
				may be written/	modified safely	/	
bit 0		alf Second Sta			-		
	1 = Second h	alf period of a s	econd				
	0 = First half	period of a seco	ond				
	lser software ma		this location to	initiate a Times	tamp A event;	timestamp cap	oture is not
V	alid until TSAEV	T reads as '1'.					

REGISTER 19-6: RTCSTATL: RTCC STATUS REGISTER LOW

2: This bit is read-only; it is cleared to '0' on a write to the SECONE[3:0] bits.

19.3.3 RTCC VALUE REGISTERS

REGISTER 19-7: TIMEL: RTCC TIME REGISTER LOW

STEN2 SEC	CTEN1 SE	CTEN0	SECONE3	SECONE2	SECONE1	SECONE0 bit 8
						bit 8
J-0 I	J-0	U-0	U-0	U-0	U-0	U-0
—	—	_	_		_	—
						bit 0
	J-0 (J-0 U-0 — —	J-0 U-0 U-0 — — —	J-0 U-0 U-0 U-0 — — — —	J-0 U-0 U-0 U-0 — — — — —	J-0 U-0 U-0 U-0 U-0 — — — — — — —

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 Unimplemented: Read as '	0'
---------------------------------	----

bit 14-12	SECTEN[2:0]: Binary Coded Decimal Value of Seconds '10' Digit bits
	Contains a value from 0 to 5.
bit 11-8	SECONE[3:0]: Binary Coded Decimal Value of Seconds '1' Digit bits
	Contains a value from 0 to 9.

bit 7-0 Unimplemented: Read as '0'

REGISTER 19-8: TIMEH: RTCC TIME REGISTER HIGH

U-0	U-0	R/W-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 15							bit 8
U-0	R/W-0	R/W-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
_	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7							bit 0

Legend:R = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-12	HRTEN[1:0]: Binary Coded Decimal Value of Hours '10' Digit bits
	Contains a value from 0 to 2.
bit 11-8	HRONE[3:0]: Binary Coded Decimal Value of Hours '1' Digit bits
	Contains a value from 0 to 9.
bit 7	Unimplemented: Read as '0'
bit 6-4	MINTEN[2:0]: Binary Coded Decimal Value of Minutes '10' Digit bits
	Contains a value from 0 to 5.
bit 3-0	MINONE[3:0]: Binary Coded Decimal Value of Minutes '1' Digit bits
	Contains a value from 0 to 9.

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x
	—	—	—	—	WDAY2	WDAY1	WDAY0
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable I	bit	U = Unimplemented bit, read as '0'			
-n = Value at l	POR	'1' = Bit is set		'0' = Bit is cleared x = Bit is unknown		iown	

REGISTER 19-9: DATEL: RTCC DATE REGISTER LOW

bit 15-14	Unimplemented: Read as '0'
bit 13-12	DAYTEN[1:0]: Binary Coded Decimal Value of Days '10' Digit bits
	Contains a value from 0 to 3.
bit 11-8	DAYONE[3:0]: Binary Coded Decimal Value of Days '1' Digit bits
	Contains a value from 0 to 9.
bit 7-3	Unimplemented: Read as '0'
bit 2-0	WDAY[2:0]: Binary Coded Decimal Value of Weekdays '1' Digit bits
	Contains a value from 0 to 6.

REGISTER 19-10: DATEH: RTCC DATE REGISTER HIGH

R/W-0	R/W-0	R/W-0	R/W-0	R/W-x	R/W-x	R/W-x	R/W-x
YRTEN3	YRTEN2	YRTEN1	YRTEN0	YRONE3	YRONE2	YRONE1	YRONE0
bit 15							bit 8

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	—	MTHTEN	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7 bit 0							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-12	YRTEN[3:0]: Binary Coded Decimal Value of Years '10' Digit bits
bit 11-8	YRONE[3:0]: Binary Coded Decimal Value of Years '1' Digit bits
bit 7-5	Unimplemented: Read as '0'
bit 4	MTHTEN: Binary Coded Decimal Value of Months '10' Digit bit
	Contains a value either 0 or 1.
bit 3-0	MTHONE[3:0]: Binary Coded Decimal Value of Months '1' Digit bits
	Contains a value from 0 to 9.

19.3.4 ALARM VALUE REGISTERS

Γ.

REGISTER 19-11: ALMTIMEL: RTCC ALARM TIME REGISTER LOW

U-0	R/W-0						
—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—			_	_	_		_
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	Unimplemented: Read as '0'
bit 14-12	SECTEN[2:0]: Binary Coded Decimal Value of Seconds '10' Digit bits
	Contains a value from 0 to 5.
bit 11-8	SECONE[3:0]: Binary Coded Decimal Value of Seconds '1' Digit bits
	Contains a value from 0 to 9.
bit 7-0	Unimplemented: Read as '0'

REGISTER 19-12: ALMTIMEH: RTCC ALARM TIME REGISTER HIGH

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 15							bit 8
U-0	R/W-0						
_	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7		•		•			bit 0
Logondi							

Legena:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14	Unimplemented: Read as '0'
bit 13-12	HRTEN[1:0]: Binary Coded Decimal Value of Hours '10' Digit bits
	Contains a value from 0 to 2.
bit 11-8	HRONE[3:0]: Binary Coded Decimal Value of Hours '1' Digit bits
	Contains a value from 0 to 9.
bit 7	Unimplemented: Read as '0'
bit 6-4	MINTEN[2:0]: Binary Coded Decimal Value of Minutes '10' Digit bits
	Contains a value from 0 to 5.
bit 3-0	MINONE[3:0]: Binary Coded Decimal Value of Minutes '1' Digit bits
	Contains a value from 0 to 9.

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	WDAY2	WDAY1	WDAY0
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit		bit	U = Unimplemented bit, read as '0'				
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unknown			iown	
L							

REGISTER 19-13: ALMDATEL: RTCC ALARM DATE REGISTER LOW

bit 15-14	Unimplemented: Read as '0'
bit 13-12	DAYTEN[1:0]: Binary Coded Decimal Value of Days '10' Digit bits
	Contains a value from 0 to 3.
bit 11-8	DAYONE[3:0]: Binary Coded Decimal Value of Days '1' Digit bits
	Contains a value from 0 to 9.
bit 7-3	Unimplemented: Read as '0'
bit 2-0	WDAY[2:0]: Binary Coded Decimal Value of Weekdays '1' Digit bits
	Contains a value from 0 to 6.

REGISTER 19-14: ALMDATEH: RTCC ALARM DATE REGISTER HIGH

| R/W-0 |
|--------|--------|--------|--------|--------|--------|--------|--------|
| YRTEN3 | YRTEN2 | YRTEN1 | YRTEN0 | YRONE3 | YRONE2 | YRONE1 | YRONE0 |
| bit 15 | | | | | | | bit 8 |

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	MTHTEN	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7 bit 0							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-12	YRTEN[3:0]: Binary Coded Decimal Value of Years '10' Digit bits
-----------	---

bit 11-8YRONE[3:0]: Binary Coded Decimal Value of Years '1' Digit bitsbit 7-5Unimplemented: Read as '0'

bit 4 MTHTEN: Binary Coded Decimal Value of Months '10' Digit bit Contains a value either 0 or 1.

bit 3-0 MTHONE[3:0]: Binary Coded Decimal Value of Months '1' Digit bits Contains a value from 0 to 9.

19.3.5 TIMESTAMP REGISTERS

REGISTER 19-15: TSATIMEL: RTCC TIMESTAMP A TIME REGISTER LOW⁽¹⁾

U-0	R/W-0						
—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	_	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 Unimplemented: Read as '0'

bit 14-12 SECTEN[2:0]: Binary Coded Decimal Value of Seconds '10' Digit bits Contains a value from 0 to 5.

bit 11-8 **SECONE[3:0]:** Binary Coded Decimal Value of Seconds '1' Digit bits Contains a value from 0 to 9.

bit 7-0 Unimplemented: Read as '0'

Note 1: If TSAEN = 0, bits[15:0] can be used for persistent storage throughout a non-Power-on Reset (MCLR, WDT, etc.).

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
—	—	HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0	
bit 15							bit 8	
U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
_	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0	
bit 7							bit 0	
Legend:								
R = Readable bit		W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown		
bit 15-14	Unimplemented: Read as '0'							
bit 13-12	HRTEN[1:0]: Binary Coded Decimal Value of Hours '10' Digit bits							
	Contains a va	lue from 0 to 2						
bit 11-8	HRONE[3:0]: Binary Coded Decimal Value of Hours '1' Digit bits							
	Contains a va	lue from 0 to 9						
bit 7	Unimplemented: Read as '0'							
bit 6-4	MINTEN[2:0]	: Binary Coded	Decimal Value	e of Minutes '10)' Digit bits			
	Contains a va	lue from 0 to 5			-			

REGISTER 19-16: TSATIMEH: RTCC TIMESTAMP A TIME REGISTER HIGH⁽¹⁾

bit 3-0	MINONE[3:0]: Binary Coded Decimal Value of Minutes '1' Digit bits
	Contains a value from 0 to 9.

Note 1: If TSAEN = 0, bits[15:0] can be used for persistence storage throughout a non-Power-on Reset (MCLR, WDT, etc.).

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
—	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0	
bit 15							bit 8	
U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	
	—	—	_		WDAY2	WDAY1	WDAY0	
bit 7							bit 0	
Legend:								
R = Readable bit		W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown		
bit 15-14	Unimplemented: Read as '0'							
bit 13-12	DAYTEN[1:0]: Binary Coded Decimal Value of Days '10' Digit bits							
	Contains a va	lue from 0 to 3						
bit 11-8	DAYONE[3:0]: Binary Coded Decimal Value of Days '1' Digit bits							
	Contains a va	lue from 0 to 9						
bit 7-3	Unimplemented: Read as '0'							
bit 2-0	WDAY[2:0]: Binary Coded Decimal Value of Weekdays '1' Digit bits							
	Contains a va	lue from 0 to 6		-	-			

REGISTER 19-17: TSADATEL: RTCC TIMESTAMP A DATE REGISTER LOW⁽¹⁾

Note 1: If TSAEN = 0, bits[15:0] can be used for persistence storage throughout a non-Power-on Reset (MCLR, WDT, etc.).

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
YRTEN3	YRTEN2	YRTEN1	YRTEN0	YRONE3	YRONE2	YRONE1	YRONE0	
bit 15						•	bit 8	
U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
_		—	MTHTEN	MTHONE3	MTHONE2	MTHONE1	MTHONE0	
bit 7						•	bit 0	
Legend:								
R = Readable bit		W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown		
bit 15-12 YRTEN[3:0]: Binary Coded Decimal Value of Years '10' Digit bits								
bit 11-8 YRONE[3:0]: Binary Coded Decimal Value of Years '1' Digit bits								
bit 7-5	Unimplemented: Read as '0'							
bit 4	MTHTEN: Binary Coded Decimal Value of Months '10' Digit bit							
	Contains a value either 0 or 1.							
bit 3-0	MTHONE[2:0]: Binary Coded Decimal Value of Months '1' Digit bits							

REGISTER 19-18: TSADATEH: RTCC TIMESTAMP A DATE REGISTER HIGH⁽¹⁾

Contains a value from 0 to 9.

Note 1: If TSAEN = 0, bits[15:0] can be used for persistence storage throughout a non-Power-on Reset (MCLR, WDT, etc.).

19.4 Calibration

19.4.1 CLOCK SOURCE CALIBRATION

A crystal oscillator that is connected to the RTCC may be calibrated to provide an accurate 1-second clock in two ways. First, coarse frequency adjustment is performed by adjusting the value written to the DIV[15:0] bits. Secondly, a 5-bit value can be written to the FDIV[4:0] control bits to perform a fine clock division.

The DIVx and FDIVx values can be concatenated and considered as a 21-bit prescaler value. If the oscillator source is slightly faster than ideal, the FDIV[4:0] value can be increased to make a small decrease in the RTC frequency. The value of DIV[15:0] should be increased to make larger decreases in the RTC frequency. If the oscillator source is slower than ideal, FDIV[4:0] may be decreased for small calibration changes and DIV[15:0] may need to be decreased to make larger calibration changes.

Before calibration, the user must determine the error of the crystal. This should be done using another timer resource on the device or an external timing reference. It is up to the user to include in the error value, the initial error of the crystal, drift due to temperature and drift due to crystal aging.

19.5 Alarm

- · Configurable from half second to one year
- Enabled using the ALRMEN bit (RTCCON1H[15])
- One-time alarm and repeat alarm options are available

19.5.1 CONFIGURING THE ALARM

The alarm feature is enabled using the ALRMEN bit. This bit is cleared when an alarm is issued. Writes to the Alarm Value registers should only take place when ALRMEN = 0.

As shown in Figure 19-2, the interval selection of the alarm is configured through the AMASK[3:0] bits (RTCCON1H[11:8]). These bits determine which and how many digits of the alarm must match the clock value for the alarm to occur.

The alarm can also be configured to repeat based on a preconfigured interval. The amount of times this occurs, once the alarm is enabled, is stored in the ALMRPT[7:0] bits (RTCCON1H[7:0]). When the value of the ALMRPTx bits equals 00h and the CHIME bit (RTCCON1H[14]) is cleared, the repeat function is disabled and only a single alarm will occur. The alarm can be repeated, up to 255 times, by loading ALMRPT[7:0] with FFh.

After each alarm is issued, the value of the ALMRPTx bits is decremented by one. Once the value has reached 00h, the alarm will be issued one last time, after which, the ALRMEN bit will be cleared automatically and the alarm will turn off.

Indefinite repetition of the alarm can occur if the CHIME bit = 1. Instead of the alarm being disabled when the value of the ALMRPTx bits reaches 00h, it rolls over to FFh and continues counting indefinitely while CHIME is set.

19.5.2 ALARM INTERRUPT

At every alarm event, an interrupt is generated. This output is completely synchronous to the RTCC clock and can be used as a trigger clock to the other peripherals.

Note:	Changing any of the register bits, other
	than the RTCOE bit (RTCCON1L[7]), the
	ALMRPT[7:0] bits (RTCCON1H[7:0] and
	the CHIME bit, while the alarm is enabled
	(ALRMEN = 1), can result in a false alarm
	event leading to a false alarm interrupt. To
	avoid a false alarm event, the timer and
	alarm values should only be changed
	while the alarm is disabled (ALRMEN = 0).

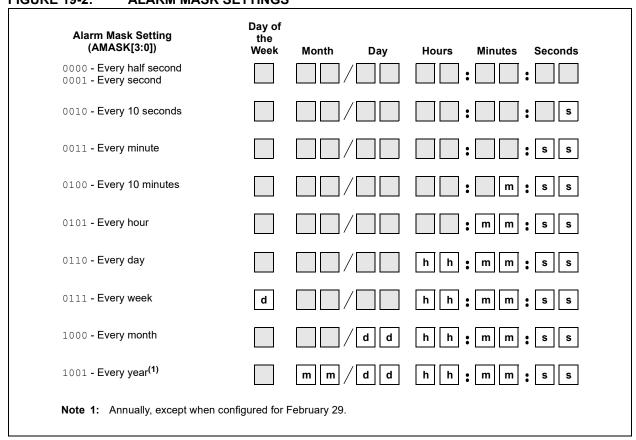


FIGURE 19-2: ALARM MASK SETTINGS

19.6 Power Control

The RTCC includes a power control feature that allows the device to periodically wake-up an external device, wait for the device to be stable before sampling wake-up events from that device and then shut down the external device. This can be done completely autonomously by the RTCC, without the need to wake-up from the current lower power mode.

To use this feature:

- 1. Enable the RTCC (RTCEN = 1).
- 2. Set the PWCEN bit (RTCCON1L[10]).
- Configure the RTCC pin to drive the PWC control signal (RTCOE = 1 and OUTSEL[2:0] = 011).

The polarity of the PWC control signal may be chosen using the PWCPOL bit (RTCCON1L[9]). An active-low or active-high signal may be used with the appropriate external switch to turn on or off the power to one or more external devices. The active-low setting may also be used in conjunction with an open-drain setting on the RTCC pin, in order to drive the ground pin(s) of the external device directly (with the appropriate external VDD pull-up device), without the need for external switches. Finally, the CHIME bit should be set to enable the PWC periodicity. Once the RTCC and PWC are enabled and running, the PWC logic will generate a control output and a sample gate output. The control output is driven out on the RTCC pin (when RTCOE = 1 and OUTSEL[2:0] = 011) and is used to power up or down the device, as described above.

Once the control output is asserted, the stability window begins, in which the external device is given enough time to power up and provide a stable output.

Once the output is stable, the RTCC provides a sample gate during the sample window. The use of this sample gate depends on the external device being used, but typically, it is used to mask out one or more wake-up signals from the external device.

Finally, both the stability and the sample windows close after the expiration of the sample window and the external device is powered down.

19.6.1 POWER CONTROL CLOCK SOURCE

The stability and sample windows are controlled by the PWCSAMPx and PWCSTABx bit fields in the RTCCON3L register (RTCCON3L[15:8] and [7:0], respectively). As both the stability and sample windows are defined in terms of the RTCC clock, their absolute values vary by the value of the PWC clock base period (TPWCCLK). For example, using a 32.768 kHz SOSC input clock would produce a TPWCCLK of 1/32768 = 30.518 µs. The 8-bit magnitude of PWCSTABx and PWCSAMPx allows for a window size of 0 to 255 TPWCCLK. The period of the PWC clock can also be adjusted with a 1:1, 1:16, 1:64 or 1:256 prescaler, determined by the PWCPS[1:0] bits (RTCCON2L[7:6]).

In addition, certain values for the PWCSTABx and PWCSAMPx fields have specific control meanings in determining power control operations. If either bit field is 00h, the corresponding window is inactive. In addition, if the PWCSTABx field is FFh, the stability window remains active continuously, even if power control is disabled.

19.7 Event Timestamping

The RTCC includes a set of Timestamp registers that may be used for the capture of Time and Date register values when an external input signal is received. The RTCC will trigger a timestamp event when a low pulse occurs on the TMPRN pin.

19.7.1 TIMESTAMP OPERATION

The event input is enabled for timestamping using the TSAEN bit (RTCCON1L[0]). When the timestamp event occurs, the present time and date values will be stored in the TSATIMEL/H and TSADATEL/H registers, the TSAEVT status bit (RTCSTATL[3]) will be set and an RTCC interrupt will occur. A new timestamp capture event cannot occur until the user clears the TSAEVT status bit.

Note 1:	The TSATIMEL/H and TSADATEL/H regis-
	ter pairs can be used for data storage when
	TSAEN = 0. The values of TSATIMEL/H
	and TSADATEL/H will be maintained
	throughout all types of non-Power-on
	Resets (MCLR, WDT, etc).

19.7.2 MANUAL TIMESTAMP OPERATION

The current time and date may be captured in the TSATIMEL/H and TSADATEL/H registers by writing a '1' to the TSAEVT bit location while the timestamp functionality is enabled (TSAEN = 1). This write will not set the TSAEVT bit, but it will initiate a timestamp capture. The TSAEVT bit will be set when the capture operation is complete. The user must poll the TSAEVT bit to determine when the capture operation is complete.

After the Timestamp registers have been read, the TSAEVT bit should be cleared to allow further hardware or software timestamp capture events.

20.0 32-BIT PROGRAMMABLE CYCLIC REDUNDANCY CHECK (CRC) GENERATOR

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "32-Bit Programmable Cyclic Redundancy Check (CRC)" (www.microchip.com/DS30009729) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

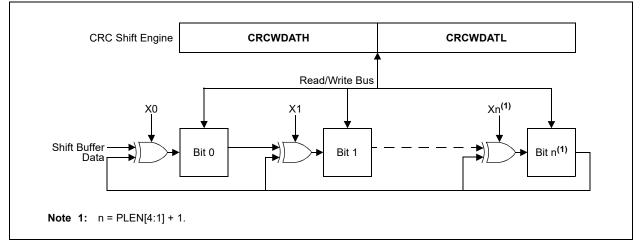
The 32-bit programmable CRC generator provides a hardware implemented method of quickly generating checksums for various networking and security applications. It offers the following features:

- User-Programmable CRC Polynomial Equation, Up to 32 Bits
- Programmable Shift Direction (little or big-endian)
- Independent Data and Polynomial Lengths
- Configurable Interrupt Output
- Data FIFO

Figure 20-1 displays a simplified block diagram of the CRC generator. A simple version of the CRC shift engine is displayed in Figure 20-2.

FIGURE 20-1: **CRC BLOCK DIAGRAM** CRCDATL CRCDATH **FIFO Empty** Variable FIFO (4x32, 8x16 or 16x8) Event CRCISEL CRCWDATH CRCWDATL 1 CRC Interrupt LENDIAN Shift Buffer **CRC Shift Engine** Shift Complete Event Shifter Clock 2 * FCY

FIGURE 20-2: CRC SHIFT ENGINE DETAIL



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20.1 User Interface

20.1.1 POLYNOMIAL INTERFACE

The CRC module can be programmed for CRC polynomials of up to the 32^{nd} order, using up to 32 bits.

Polynomial length, which reflects the highest exponent in the equation, is selected by the PLEN[4:0] bits (CRCCON2[4:0]).

The CRCXORL and CRCXORH registers control which exponent terms are included in the equation. Setting a particular bit includes that exponent term in the equation. Functionally, this includes an XOR operation on the corresponding bit in the CRC engine. Clearing the bit disables the XOR.

For example, consider two CRC polynomials, one a 16-bit and the other a 32-bit equation.

EQUATION 20-1: 16-BIT, 32-BIT CRC POLYNOMIALS

$$X16 + X12 + X5 + 1$$

and

 $\begin{array}{c} X32 + X26 + X23 + X22 + X16 + X12 + X11 + X10 + \\ X8 + X7 + X5 + X4 + X2 + X + 1 \end{array}$

To program these polynomials into the CRC generator, set the register bits, as shown in Table 20-1.

Note that the appropriate positions are set to '1' to indicate that they are used in the equation (for example, X26 and X23). The '0' bit required by the equation is always XORed; thus, X0 is a don't care. For a polynomial of length 32, it is assumed that the 32^{nd} bit will be used. Therefore, the X[31:1] bits do not have the 32^{nd} bit.

20.1.2 DATA INTERFACE

The module incorporates a FIFO that works with a variable datum width. Input datum width can be configured to any value, between 1 and 32 bits, using the DWIDTH[4:0] bits (CRCCON2[12:8]). When the datum width is greater than 15, the FIFO is 4 words deep. When the DWIDTHx bits are between 15 and 8, the FIFO is 8 words deep. When the DWIDTHx bits are less than 8, the FIFO is 16 words deep.

The data for which the CRC is to be calculated must first be written into the FIFO. Even if the datum width is less than 8, the smallest data element that can be written into the FIFO is 1 byte. For example, if the DWIDTHx bits are 5, then the size of the data is DWIDTH[4:0] + 1 or 6. The data are written as a whole byte; the two unused upper bits are ignored by the module.

Once datum is written into the MSb of the CRCDAT registers (that is, the MSb as defined by the datum width), the value of the VWORD[4:0] bits (CRCCON1[12:8]) increments by one. For example, if the DWIDTHx bits are 24, the VWORDx bits will increment when bit 7 of CRCDATH is written. Therefore, CRCDATL must always be written to before CRCDATH.

The CRC engine starts shifting data when the CRCGO bit (CRCCON1[4]) is set and the value of the VWORDx bits is greater than zero.

Each word is copied out of the FIFO into a buffer register, which decrements the VWORDx bits. The data are then shifted out of the buffer. The CRC engine continues shifting at a rate of two bits per instruction cycle, until the VWORDx bits reach zero. This means that for a given data width, it takes half that number of instructions for each word to complete the calculation. For example, it takes 16 cycles to calculate the CRC for a single word of 32-bit data.

When the VWORDx bits reach the maximum value for the configured value of the DWIDTHx bits (4, 8 or 16), the CRCFUL bit (CRCCON1[7]) becomes set. When the VWORDx bits reach zero, the CRCMPT bit (CRCCON1[6]) becomes set. The FIFO is emptied and the VWORD[4:0] bits are set to '00000' whenever CRCEN is '0'.

At least one instruction cycle must pass after a write to CRCWDAT before a read of the VWORDx bits is done.

TABLE 20-1: CRC SETUP EXAMPLES FOR 16 AND 32-BIT POLYNOMIALS

CRC Control Bits	Bit V	alues
	16-Bit Polynomial	32-Bit Polynomial
PLEN[4:0]	01111	11111
X[31:16]	0000 0000 0000 0001	0000 0100 1100 0001
X[15:1]	0001 0000 0010 000	0001 1101 1011 011

20.1.3 DATA SHIFT DIRECTION

The LENDIAN bit (CRCCON1[3]) is used to control the shift direction. By default, the CRC will shift data through the engine, MSb first. Setting LENDIAN (= 1) causes the CRC to shift data, LSb first. This setting allows better integration with various communication schemes and removes the overhead of reversing the bit order in software. Note that this only changes the direction that the data are shifted into the engine. The result of the CRC calculation will still be a normal CRC result, not a reverse CRC result.

20.1.4 INTERRUPT OPERATION

The module generates an interrupt that is configurable by the user for either of two conditions.

If CRCISEL is '0', an interrupt is generated when the VWORD[4:0] bits make a transition from a value of '1' to '0'. If CRCISEL is '1', an interrupt will be generated after the CRC operation finishes and the module sets the CRCGO bit to '0'. Manually setting CRCGO to '0' will not generate an interrupt. Note that when an interrupt occurs, the CRC calculation would not yet be complete. The module will still need (PLENx + 1)/2 clock cycles after the interrupt is generated until the CRC calculation is finished.

20.1.5 TYPICAL OPERATION

To use the module for a typical CRC calculation:

- 1. Set the CRCEN bit to enable the module.
- 2. Configure the module for desired operation:
 - a) Program the desired polynomial using the CRCXOR registers and PLEN[4:0] bits.
 - b) Configure the data width and shift direction using the DWIDTH[4:0] and LENDIAN bits.
- 3. Set the CRCGO bit to start the calculations.
- 4. Set the desired CRC non-direct initial value by writing to the CRCWDAT registers.
- Load all data into the FIFO by writing to the CRCDAT registers as space becomes available (the CRCFUL bit must be zero before the next data loading).
- 6. Wait until the data FIFO is empty (CRCMPT bit is set).
- Read the result: If the data width (DWIDTH[4:0] bits) is more than the polynomial length (PLEN[4:0] bits):
 - a) Wait (DWIDTH[4:0] + 1)/2 instruction cycles to make sure that shifts from the shift buffer are finished.
 - b) Change the data width to the polynomial length (DWIDTH[4:0] = PLEN[4:0]).
 - c) Write one dummy data word to the CRCDAT registers.
 - d) Wait two instruction cycles to move the data from the FIFO to the shift buffer and (PLEN[4:0] + 1)/2 instruction cycles to shift out the result.

Or, if the data width (DWIDTH[4:0] bits) is less than the polynomial length (PLEN[4:0] bits):

- Clear the CRC Interrupt Selection bit (CRCISEL = 0) to get the interrupt when all shifts are done. Clear the CRC interrupt flag. Write dummy data in the CRCDAT registers and wait until the CRC interrupt flag is set.
- 2. Read the final CRC result from the CRCWDAT registers.
- Restore the data width (DWIDTH[4:0] bits) for further calculations (optional). If the data width (DWIDTH[4:0] bits) is equal to, or less than, the polynomial length (PLEN[4:0] bits):
 - a) Clear the CRC Interrupt Selection bit (CRCISEL = 0) to get the interrupt when all shifts are done.
 - b) Suspend the calculation by setting CRCGO = 0.
 - c) Clear the CRC interrupt flag.
 - Write the dummy data with the total data length equal to the polynomial length in the CRCDAT registers.
 - e) Resume the calculation by setting CRCGO = 1.
 - f) Wait until the CRC interrupt flag is set.
 - g) Read the final CRC result from the CRCWDAT registers.

There are eight registers used to control programmable CRC operation:

- CRCCON1
- CRCCON2
- CRCXORL
- CRCXORH
- CRCDATL
- CRCDATH
- CRCWDATL
- CRCWDATH

The CRCCON1 and CRCCON2 registers (Register 20-1 and Register 20-2) control the operation of the module and configure the various settings.

The CRCXOR registers (Register 20-3 and Register 20-4) select the polynomial terms to be used in the CRC equation. The CRCDAT and CRCWDAT registers are each register pairs that serve as buffers for the double-word input data, and CRC processed output, respectively.

R/W-0	U-0	R/W-0	HSC/R-0	HSC/R-0	HSC/R-0	HSC/R-0	HSC/R-0
CRCEN	—	CSIDL	VWORD4	VWORD3	VWORD2	VWORD1	VWORD0
bit 15				·		•	bit 8
HSC/R-0	HSC/R-1	R/W-0	HC/R/W-0	R/W-0	U-0	U-0	U-0
CRCFUL	CRCMPT	CRCISEL	CRCGO	LENDIAN	—	—	
bit 7							bit 0
			0		0 11 11 10		
Legend:	1. 1.14	HC = Hardware	-	-	are Settable/C		
R = Readab		W = Writable b	it		nented bit, read		
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	iown
bit 15		RC Enable bit					
DIL 15	1 = Enables	-					
		s module; all sta	te machines, po	inters and CRC	WDAT/CRCDA	AT registers res	et; other SFRs
	are NO	T reset					
bit 14	Unimpleme	ented: Read as '	0'				
bit 13		C Stop in Idle Me					
		tinues module op			e mode		
hit 10 0		ies module oper		le			
bit 12-8	-	0]: CRC Pointer e number of vali		IFO Has a ma	vimum value of	f 8 when PI FN	[4.0] > 7 or 16
	when PLEN						1[4.0] 2 7 01 10
bit 7		RC FIFO Full bi	t				
	1 = FIFO is	full					
	0 = FIFO is	not full					
bit 6		CRC FIFO Empty	/ bit				
	1 = FIFO is						
bit 5	0 = FIFO is	CRC Interrupt Se	plantion hit				
DIL D		t on FIFO is emp		d of datum is st	ill shifting throu	igh the CRC	
		t on shift is com					
bit 4	CRCGO: St	-		-			
	1 = Starts C	CRC serial shifte	r				
	0 = CRC se	erial shifter is tur	ned off				
bit 3		Data Shift Direct					
		ord is shifted into		•	· ,		
hit 2.0		ord is shifted into		ing with the MS	n (nið eugiau)		
bit 2-0	ommpieme	ented: Read as '	U				

REGISTER 20-1: CRCCON1: CRC CONTROL 1 REGISTER

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
—	—	—	DWIDTH4	DWIDTH3	DWIDTH2	DWIDTH1	DWIDTH0	
bit 15							bit 8	
U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
—	—	—	PLEN4	PLEN3	PLEN2	PLEN1	PLEN0	
bit 7							bit 0	
Legend:								
R = Readable bit W = Writable bit			bit	U = Unimplemented bit, read as '0'				
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unknown					

REGISTER 20-2: CRCCON2: CRC CONTROL 2 REGISTER

bit 15-13 Unimplemented: Read as '0'

bit 12-8 **DWIDTH[4:0]:** CRC Data Word Width Configuration bits

Configures the width of the data word (Data Word Width – 1).

bit 7-5 Unimplemented: Read as '0'

bit 4-0 **PLEN[4:0]:** Polynomial Length Configuration bits Configures the length of the polynomial (Polynomial Length – 1).

REGISTER 20-3: CRCXORL: CRC XOR POLYNOMIAL REGISTER LOW

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
		Х	[15:8]			
						bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
		X[7:1]				—
						bit 0
oit	W = Writable bi	it	U = Unimpler	nented bit, rea	d as '0'	
OR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkn	iown
	R/W-0	R/W-0 R/W-0 it W = Writable b	X R/W-0 R/W-0 R/W-0 X[7:1] it W = Writable bit	X[15:8] R/W-0 R/W-0 X[7:1] it W = Writable bit U = Unimplem	X[15:8] R/W-0 R/W-0 X[7:1] it W = Writable bit U = Unimplemented bit, rea	X[15:8] R/W-0 R/W-0 R/W-0 R/W-0 X[7:1] it W = Writable bit U = Unimplemented bit, read as '0'

bit 15-1 X[15:1]: XOR of Polynomial Term Xⁿ Enable bits

bit 0 Unimplemented: Read as '0'

REGISTER 20-4: CRCXORH: CRC XOR POLYNOMIAL REGISTER HIGH

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			X[31:24]			
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
-			X[2	23:16]			
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimplem	nented bit, rea	ad as '0'	
-n = Value at F	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown

bit 15-0 X[31:16]: XOR of Polynomial Term Xⁿ Enable bits

21.0 CONFIGURABLE LOGIC CELL (CLC)

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "Configurable Logic Cell (CLC)" (www.microchip.com/DS70005298) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM. The Configurable Logic Cell (CLC) module allows the user to specify combinations of signals as inputs to a logic function and to use the logic output to control other peripherals or I/O pins. This provides greater flexibility and potential in embedded designs, since the CLC module can operate outside the limitations of software execution and supports a vast amount of output designs.

There are four input gates to the selected logic function. These four input gates select from a pool of up to 32 signals that are selected using four data source selection multiplexers. Figure 21-1 shows an overview of the module. Figure 21-3 shows the details of the data source multiplexers and logic input gate connections.

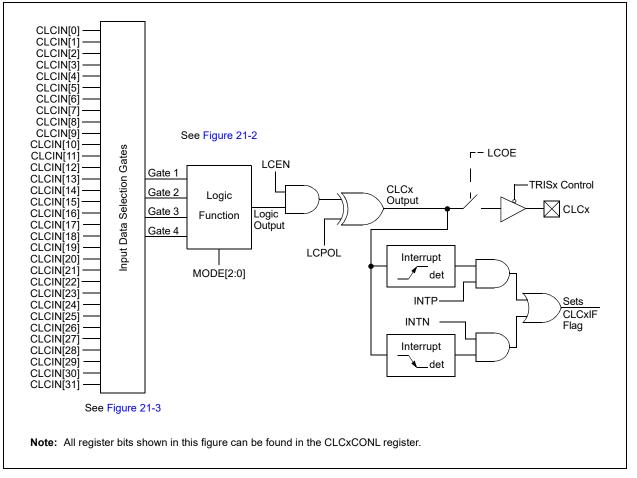
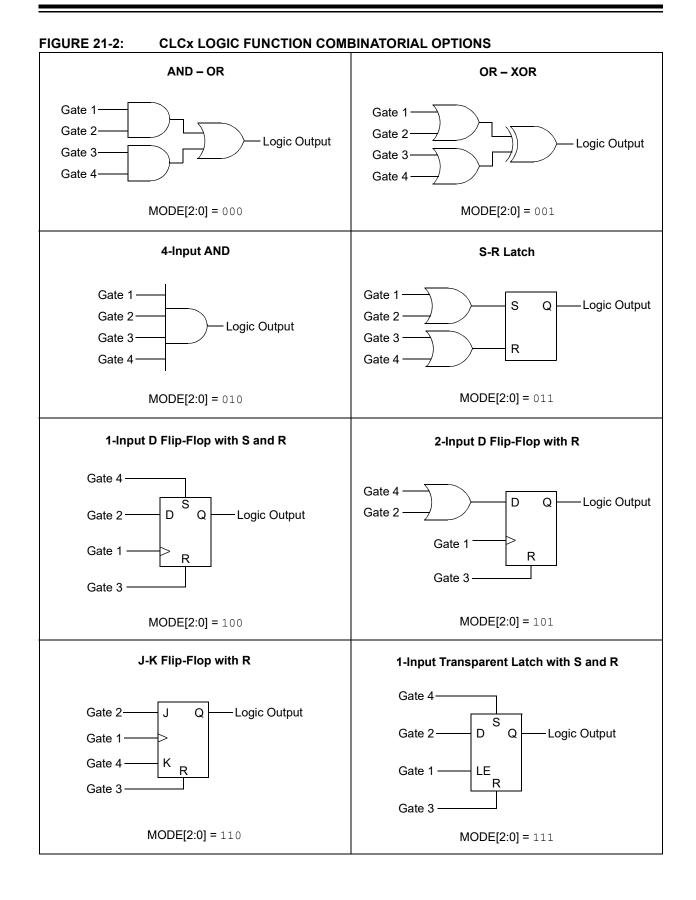
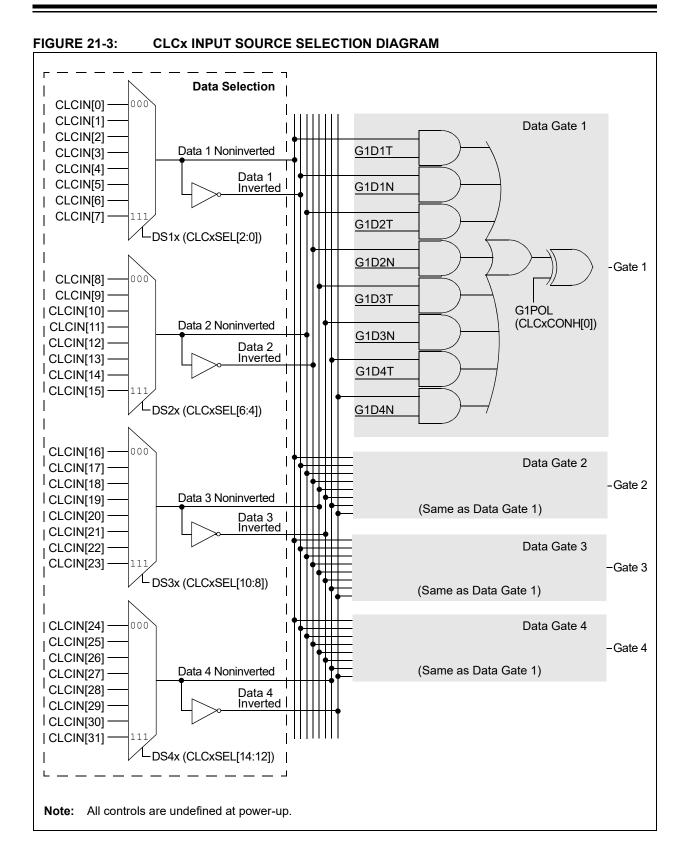


FIGURE 21-1: CLCx MODULE

PIC24FJ128GL306 FAMILY





21.1 Control Registers

The CLCx module is controlled by the following registers:

- CLCxCONL
- CLCxCONH
- CLCxSEL
- CLCxGLSL
- CLCxGLSH

The CLCx Control registers (CLCxCONL and CLCxCONH) are used to enable the module and interrupts, control the output enable bit, select output polarity and select the logic function. The CLCx Control registers also allow the user to control the logic polarity of not only the cell output, but also some intermediate variables. The CLCx Input MUX Select register (CLCxSEL) allows the user to select up to four data input sources using the four data input selection multiplexers. Each multiplexer has a list of eight data sources available.

The CLCx Gate Logic Input Select registers (CLCxGLSL and CLCxGLSH) allow the user to select which outputs from each of the selection MUXes are used as inputs to the input gates of the logic cell. Each data source MUX outputs both a true and a negated version of its output. All of these eight signals are enabled, ORed together by the logic cell input gates. If no gate inputs are selected, the output will be zero or one, depending on the GxPOL bits.

REGISTER 21-1: CLCxCONL: CLCx CONTROL REGISTER LOW

R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0	U-0
LCEN	—	—	—	INTP	INTN	_	—
bit 15							bit 8
R/W-0	R-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0
LCOE	LCOUT	LCPOL	—		MODE2	MODE1	MODE0
bit 7							bit 0
Legend:							
R = Readab	le bit	W = Writable	bit	U = Unimpler	nented bit, read	d as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is cle		x = Bit is unkr	nown
L:: 4 F		En abla bit					
bit 15	LCEN: CLCx						
		enabled and mi disabled and ha					
bit 14-12		ted: Read as '	•				
bit 11	INTP: CLCx F	Positive Edge Ir	nterrupt Enab	le bit			
				ing edge occurs	on LCOUT		
		will not be gene					
bit 10		Negative Edge	•				
		will be generate will not be gene		ling edge occurs	s on LCOUT		
bit 9-8	•	ted: Read as '					
bit 7	•	Port Enable bit					
bit i		t pin output is e	-				
		t pin output is d					
bit 6	LCOUT: CLC	x Data Output \$	Status bit				
	1 = CLCx out						
	0 = CLCx out	-					
bit 5		x Output Polari ut of the modul	•				
		ut of the modul		ted			
bit 4-3	•	ted: Read as '					
	-						

REGISTER 21-1: CLCxCONL: CLCx CONTROL REGISTER LOW (CONTINUED)

- bit 2-0 **MODE[2:0]:** CLCx Mode bits
 - 111 = Cell is a 1-input transparent latch with S and R
 - 110 = Cell is a JK flip-flop with R
 - 101 = Cell is a 2-input D flip-flop with R
 - 100 = Cell is a 1-input D flip-flop with S and R
 - 011 = Cell is an SR latch
 - 010 = Cell is a 4-input AND
 - 001 = Cell is an OR-XOR
 - 000 = Cell is an AND-OR

REGISTER 21-2: CLCxCONH: CLCx CONTROL REGISTER (HIGH)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—			—
bit 15							bit 8

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	—	G4POL	G3POL	G2POL	G1POL
bit 7							bit 0

Legend:

Legenu.				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-4	Unimplemented: Read as '0'
bit 3	G4POL: Gate 4 Polarity Control bit
	 1 = The output of Channel 4 logic is inverted when applied to the logic cell 0 = The output of Channel 4 logic is not inverted
bit 2	G3POL: Gate 3 Polarity Control bit
	 1 = The output of Channel 3 logic is inverted when applied to the logic cell 0 = The output of Channel 3 logic is not inverted
bit 1	G2POL: Gate 2 Polarity Control bit
	1 = The output of Channel 2 logic is inverted when applied to the logic cell0 = The output of Channel 2 logic is not inverted
bit 0	G1POL: Gate 1 Polarity Control bit
	 1 = The output of Channel 1 logic is inverted when applied to the logic cell 0 = The output of Channel 1 logic is not inverted

U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0				
_		DS4[2:0]				DS3[2:0]					
bit 15							bit				
U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0				
_		DS2[2:0]		_		DS1[2:0]					
bit 7							bit				
Legend:	la hit	VV - VV/ritable	ait		monted hit rea	d ee '0'					
R = Readab		W = Writable I	JIL	•	nented bit, rea		0.110				
-n = Value a	ILPUR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkn	own				
bit 15	Unimplem	ented: Read as 'o)'								
bit 14-12	DS4[2:0]: [Data Selection ML	JX 4 Signal S	election bits							
	111 = MCC	CP3 OC out									
		CP1 OC out									
		nplemented automation timer	intorrunt								
		Input (SDIx) corr		the CLCx modu	ule ⁽¹⁾						
	010 = Com	parator 3 output									
		ule-specific CLCx	output ⁽¹⁾								
		IND I/O pin									
bit 11	-	Unimplemented: Read as '0'									
bit 10-8	DS3[2:0]: Data Selection MUX 3 Signal Selection bits										
	111 = MCCP3 OC out 110 = MCCP2 OC out										
	10 = MCCP2 OC out 101 = DMA Channel 1 interrupt										
	100 = UAR	Tx RX output cor	responding to								
		(Output (SDOx) c	orresponding	to the CLCx m	odule ⁽¹⁾						
	010 = Com 001 = CLC	parator 2 output									
		INC I/O pin									
bit 7		ented: Read as '()'								
bit 6-4	DS2[2:0]: [Data Selection ML	JX 2 Signal S	election bits							
	111 = MCC	CP2 OC out									
		CP1 OC out									
		A Channel 0 interro conversion done i									
				he CLCx modul	e ⁽¹⁾						
	011 = UARTx TX input corresponding to the CLCx module ⁽¹⁾ 010 = Comparator 1 output										
	001 = CLC										
	000 = CLC	•									
bit 3	•	ented: Read as '									
bit 2-0		Data Selection ML	JX 1 Signal S	election bits							
		er3 match event er2 match event									
		nplemented									
	100 = REF	Ó output									
		RC/LPRC clock so	ource								
	010 - 909										
		SC clock source em clock (TCY)									

REGISTER 21-3: CLCxSEL: CLCx INPUT MUX SELECT REGISTER

Note 1: For more information, see Table 21-1.

Bit Field Value		Input Source							
		CLC1	CLC2	CLC3	CLC4				
011		SDI1	SDI2	SDI1	SDI2				
DS4[2:0]	001	CLC2 Output	CLC1 Output	CLC4 Output	CLC3 Output				
	100	U1RX	U2RX	U3RX	U4RX				
DS3[2:0]	011	SDO1	SDO2	SDO1	SDO2				
	001	CLC1 Output	CLC2 Output	CLC1 Output	CLC2 Output				
00010-01	011	U1TX	U2TX	U3TX	U4TX				
DS2[2:0]	001	CLC2 Output	CLC1 Output	CLC2 Output	CLC1 Output				

TABLE 21-1: MODULE-SPECIFIC INPUT DATA SOURCES

REGISTER 21-4: CLCxGLSL: CLCx GATE LOGIC INPUT SELECT LOW REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
G2D4T	G2D4N	G2D3T	G2D3N	G2D2T	G2D2N	G2D1T	G2D1N
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| G1D4T | G1D4N | G1D3T | G1D3N | G1D2T | G1D2N | G1D1T | G1D1N |
| bit 7 | | | | | | | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	G2D4T: Gate 2 Data Source 4 True Enable bit 1 = The Data Source 4 signal is enabled for Gate 2 0 = The Data Source 4 signal is disabled for Gate 2
bit 14	G2D4N: Gate 2 Data Source 4 Negated Enable bit 1 = The Data Source 4 inverted signal is enabled for Gate 2 0 = The Data Source 4 inverted signal is disabled for Gate 2
bit 13	G2D3T: Gate 2 Data Source 3 True Enable bit 1 = The Data Source 3 signal is enabled for Gate 2 0 = The Data Source 3 signal is disabled for Gate 2
bit 12	G2D3N: Gate 2 Data Source 3 Negated Enable bit 1 = The Data Source 3 inverted signal is enabled for Gate 2 0 = The Data Source 3 inverted signal is disabled for Gate 2
bit 11	G2D2T: Gate 2 Data Source 2 True Enable bit 1 = The Data Source 2 signal is enabled for Gate 2 0 = The Data Source 2 signal is disabled for Gate 2
bit 10	G2D2N: Gate 2 Data Source 2 Negated Enable bit 1 = The Data Source 2 inverted signal is enabled for Gate 2 0 = The Data Source 2 inverted signal is disabled for Gate 2
bit 9	G2D1T: Gate 2 Data Source 1 True Enable bit 1 = The Data Source 1 signal is enabled for Gate 2 0 = The Data Source 1 signal is disabled for Gate 2

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REGISTER 21-4: CLCxGLSL: CLCx GATE LOGIC INPUT SELECT LOW REGISTER (CONTINUED)

bit 8	G2D1N: Gate 2 Data Source 1 Negated Enable bit
	1 = The Data Source 1 inverted signal is enabled for Gate 20 = The Data Source 1 inverted signal is disabled for Gate 2
bit 7	G1D4T: Gate 1 Data Source 4 True Enable bit
	 1 = The Data Source 4 signal is enabled for Gate 1 0 = The Data Source 4 signal is disabled for Gate 1
bit 6	G1D4N: Gate 1 Data Source 4 Negated Enable bit
	 1 = The Data Source 4 inverted signal is enabled for Gate 1 0 = The Data Source 4 inverted signal is disabled for Gate 1
bit 5	G1D3T: Gate 1 Data Source 3 True Enable bit
	 1 = The Data Source 3 signal is enabled for Gate 1 0 = The Data Source 3 signal is disabled for Gate 1
bit 4	G1D3N: Gate 1 Data Source 3 Negated Enable bit
	 1 = The Data Source 3 inverted signal is enabled for Gate 1 0 = The Data Source 3 inverted signal is disabled for Gate 1
bit 3	G1D2T: Gate 1 Data Source 2 True Enable bit
	1 = The Data Source 2 signal is enabled for Gate 10 = The Data Source 2 signal is disabled for Gate 1
bit 2	G1D2N: Gate 1 Data Source 2 Negated Enable bit
	 1 = The Data Source 2 inverted signal is enabled for Gate 1 0 = The Data Source 2 inverted signal is disabled for Gate 1
bit 1	G1D1T: Gate 1 Data Source 1 True Enable bit
	 1 = The Data Source 1 signal is enabled for Gate 1 0 = The Data Source 1 signal is disabled for Gate 1
bit 0	G1D1N: Gate 1 Data Source 1 Negated Enable bit
	 1 = The Data Source 1 inverted signal is enabled for Gate 1 0 = The Data Source 1 inverted signal is disabled for Gate 1

	REGISTER 21-5:	CLCxGLSH: CLCx GATE LOGIC INPUT SELECT HIGH REGISTER
--	----------------	--

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
G4D4T	G4D4N	G4D3T	G4D3N	G4D2T	G4D2N	G4D1T	G4D1N			
bit 15							bit 8			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
G3D4T	G3D4N	G3D3T	G3D3N	G3D2T	G3D2N	G3D1T	G3D1N			
bit 7		00001	CODON	00021	CODEN	00011	bit (
Legend:										
R = Readable	e bit	W = Writable	bit	U = Unimpler	mented bit, rea	d as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown			
bit 15	G4D4T: Gate	4 Data Source	4 True Enable	e bit						
		Source 4 signa								
		Source 4 signa								
bit 14		e 4 Data Source	-							
		Source 4 inver Source 4 inver								
bit 13		4 Data Source	-							
		Source 3 signa Source 3 signa								
bit 12		-								
	1 = The Data	G4D3N: Gate 4 Data Source 3 Negated Enable bit 1 = The Data Source 3 inverted signal is enabled for Gate 4 0 = The Data Source 3 inverted signal is disabled for Gate 4								
bit 11	G4D2T: Gate 4 Data Source 2 True Enable bit									
		Source 2 signa Source 2 signa								
bit 10	G4D2N: Gate	e 4 Data Source	2 Negated E	nable bit						
		Source 2 inver Source 2 inver								
bit 9	G4D1T: Gate	4 Data Source	1 True Enable	e bit						
		Source 1 signa								
		Source 1 signa								
bit 8		4 Data Source	-							
	0 = The Data	Source 1 inver Source 1 inver	ted signal is di	sabled for Gate						
bit 7	G3D4T: Gate 3 Data Source 4 True Enable bit									
	 1 = The Data Source 4 signal is enabled for Gate 3 0 = The Data Source 4 signal is disabled for Gate 3 									
bit 6	G3D4N: Gate	e 3 Data Source	4 Negated E	nable bit						
		Source 4 inver Source 4 inver	0							
bit 5	G3D3T: Gate	3 Data Source	3 True Enable	e bit						
		Source 3 signa Source 3 signa								
bit 4	G3D3N: Gate	e 3 Data Source	3 Negated E	nable bit						
		Source 3 inver	-		e 3					

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REGISTER 21-5: CLCxGLSH: CLCx GATE LOGIC INPUT SELECT HIGH REGISTER (CONTINUED)

bit 3	G3D2T: Gate 3 Data Source 2 True Enable bit
	1 = The Data Source 2 signal is enabled for Gate 3
	0 = The Data Source 2 signal is disabled for Gate 3
bit 2	G3D2N: Gate 3 Data Source 2 Negated Enable bit
	1 = The Data Source 2 inverted signal is enabled for Gate 3
	$_{\rm 0}$ = The Data Source 2 inverted signal is disabled for Gate 3
bit 1	G3D1T: Gate 3 Data Source 1 True Enable bit
	1 = The Data Source 1 signal is enabled for Gate 3
	0 = The Data Source 1 signal is disabled for Gate 3
bit 0	G3D1N: Gate 3 Data Source 1 Negated Enable bit
	1 = The Data Source 1 inverted signal is enabled for Gate 3
	$\ensuremath{\scriptscriptstyle 0}$ = The Data Source 1 inverted signal is disabled for Gate 3

22.0 12-BIT A/D CONVERTER WITH THRESHOLD DETECT

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "12-Bit A/D Converter with Threshold Detect" (www.microchip.com/ DS39739) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The A/D Converter has the following key features:

- Successive Approximation Register (SAR)
 Conversion
- Selectable 10-Bit or 12-Bit (default) Conversion Resolution
- Conversion Speeds of Up to 350 ksps (12-bit) and 400 ksps (10-bit)
- Up to 20 Analog Input Channels (internal and external)
- Multiple Internal Reference Input Channels
- External Voltage Reference Input Pins
- Unipolar Differential Sample-and-Hold (S/H)
 Amplifier
- Automated Threshold Scan and Compare
 Operation to Pre-Evaluate Conversion Results
- Selectable Conversion Trigger Source
- Fixed Length (one word per channel), Configurable Conversion Result Buffer
- · Four Options for Results Alignment
- Configurable Interrupt Generation
- Enhanced DMA Operations with Indirect Address Generation
- Operation During CPU Sleep and Idle modes

The 12-bit A/D Converter module is an enhanced version of the 10-bit module offered in earlier PIC24 devices. It is a Successive Approximation Register (SAR) Converter, enhanced with 12-bit resolution, a wide range of automatic sampling options, tighter integration with other analog modules and a configurable results buffer.

It also includes a unique Threshold Detect feature that allows the module itself to make simple decisions based on the conversion results, and enhanced operation with the DMA Controller through Peripheral Indirect Addressing (PIA).

A simplified block diagram for the module is shown in Figure 22-1.

22.1 Basic Operation

To perform a standard A/D conversion:

- 1. Configure the module:
 - a) Configure port pins as analog inputs by setting the appropriate bits in the ANSELx registers (see Section 11.2 "Configuring Analog Port Pins (ANSELx)" for more information).
 - b) Select the voltage reference source to match the expected range on analog inputs (AD1CON2[15:13]).
 - c) Select the positive and negative multiplexer inputs for each channel (AD1CHS[15:0]).
 - Select the analog conversion clock to match the desired data rate with the processor clock (AD1CON3[7:0]).
 - e) Select the appropriate sample/conversion sequence (AD1CON1[7:4] and AD1CON3[12:8]).
 - f) For Channel A scanning operations, select the positive channels to be included (AD1CSSH and AD1CSSL registers).
 - g) Select how conversion results are presented in the buffer (AD1CON1[9:8] and AD1CON5 register).
 - h) Select the interrupt rate (AD1CON2[5:2]).
 - i) Turn on A/D module (AD1CON1[15]).
- 2. Configure the A/D interrupt (if required):
 - a) Clear the AD1IF bit (IFS0[13]).
 - b) Enable the AD1IE interrupt (IEC0[13]).
 - c) Select the A/D interrupt priority (IPC3[6:4]).
- If the module is configured for manual sampling, set the SAMP bit (AD1CON1[1]) to begin sampling.

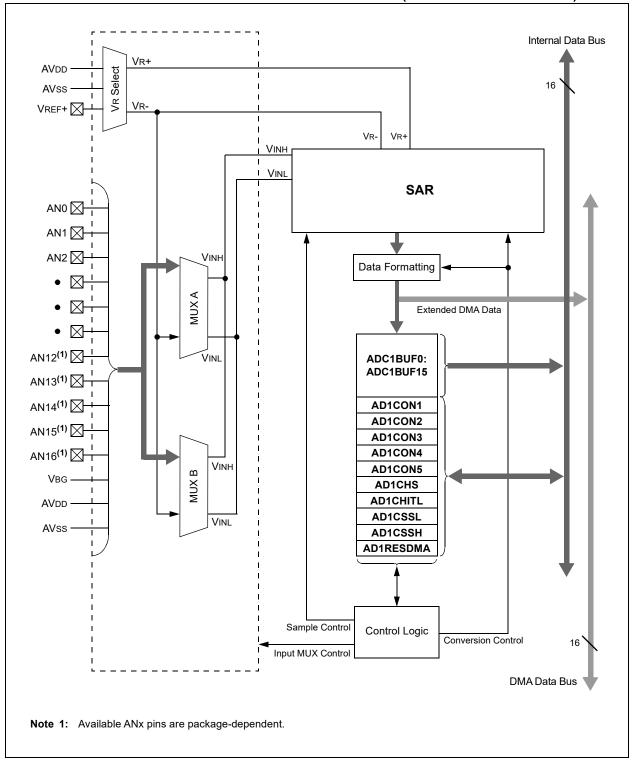


FIGURE 22-1: 12-BIT A/D CONVERTER BLOCK DIAGRAM (PIC24FJ128GL306 FAMILY)

22.2 Extended DMA Operations

In addition to the standard features available on all 12-bit A/D Converters, PIC24FJ128GL306 family devices implement a limited extension of DMA functionality. This extension adds features that work with the device's DMA Controller to expand the A/D module's data storage abilities beyond the module's built-in buffer.

The Extended DMA functionality is controlled by the DMAEN bit (AD1CON1[11]); setting this bit enables the functionality. The DMABM bit (AD1CON1[12]) configures how the DMA feature operates.

22.2.1 EXTENDED BUFFER MODE

Extended Buffer mode (DMABM = 1) maps the A/D Data Buffer registers and data from all channels above 13 into a user-specified area of data RAM. This allows users to read the conversion results of channels above 13, which do not have their own memory-mapped A/D buffer locations, from data memory.

To accomplish this, the DMA destination address must be configured in Peripheral Indirect Addressing mode, the DMA destination address must point to the beginning of the buffer, the DMA source address must be configured in "Remains Unchanged" mode and the source address should be pointing to the AD1RESDMA register. The DMA count must be set to generate an interrupt after the desired number of conversions.

In Extended Buffer mode, the A/D control bits will function similarly to non-DMA modes. The BUFREGEN bit will still select between FIFO mode and Channel-Aligned mode, but the number of words in the destination FIFO will be determined by the SMPI[4:0] bits in DMA mode. In FIFO mode, the BUFM bit will still split the output FIFO into two sets of 13 results (the SMPIx bits should be set accordingly) and the BUFS bit will still indicate which set of results is being written to and which can be read.

22.2.2 PIA MODE

When DMABM = 0, the A/D module is configured to function with the DMA Controller for Peripheral Indirect Addressing (PIA) mode operations. In this mode, the A/D module generates an 11-bit Indirect Address (IA). This is ORed with the destination address in the DMA Controller to define where the A/D conversion data will be stored.

In PIA mode, the buffer space is created as a series of contiguous smaller buffers, one per analog channel. The size of the channel buffer determines how many analog channels can be accommodated. The size of the buffer is selected by the DMABL[2:0] bits (AD1CON4[2:0]). The size options range from a single word per buffer to 128 words. Each channel is allocated a buffer of this size, regardless of whether or not the channel will actually have conversion data.

The IA is created by combining the base address within a channel buffer with three to five bits (depending on the buffer size) to identify the channel. The base address ranges from zero to seven bits wide, depending on the buffer size. The address is right-padded with a '0' in order to maintain address alignment in the Data Space. The concatenated channel and base address bits are then left-padded with zeros, as necessary, to complete the 11-bit IA.

The IA is configured to auto-increment which channel is written in each analog input's sub-buffer during write operations by using the SMPIx bits (AD1CON2[6:2]).

As with PIA operations for any DMA-enabled module, the base destination address in the DMADSTn register must be masked properly to accommodate the IA. Table 22-1 shows how complete addresses are formed. Note that the address masking varies for each buffer size option. Because of masking requirements, some address ranges may not be available for certain buffer sizes. Users should verify that the DMA base address is compatible with the buffer size selected.

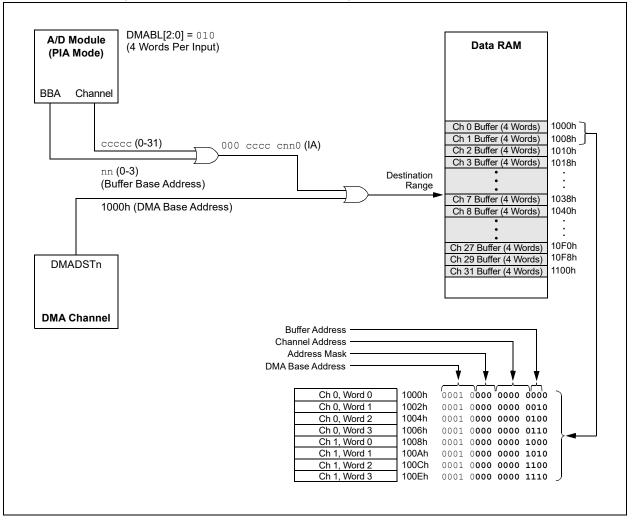
Figure 22-2 shows how the parts of the address define the buffer locations in data memory. In this case, the module "allocates" 256 bytes of data RAM (1000h to 1100h) for 32 buffers of four words each. However, this is not a hard allocation and nothing prevents these locations from being used for other purposes. For example, in the current case, if Analog Channels 1, 3 and 8 are being sampled and converted, conversion data will only be written to the channel buffers, starting at 1008h, 1018h and 1040h. The holes in the PIA buffer space can be used for any other purpose. It is the user's responsibility to keep track of buffer locations and prevent data overwrites.

DMABL[2:0]	Buffer Size per Channel (words)	Generated Offset Address (lower 11 bits)	Available Input Channels	Allowable DMADSTn Addresses
000	1	000 00cc ccc0	32	xxxx xxxx xx00 0000
001	2	000 0ccc ccn0	32	xxxx xxxx x000 0000
010	4	000 cccc cnn0	32	xxxx xxxx 0000 0000
011	8	00c cccc nnn0	32	xxxx xxx0 0000 0000
100	16	0cc cccn nnn0	32	xxxx xx00 0000 0000
101	32	ccc ccnn nnn0	32	xxxx x000 0000 0000
110	64	ccc cnnn nnn0	16	xxxx x000 0000 0000
111	128	ccc nnnn nnn0	8	xxxx x000 0000 0000

TABLE 22-1: INDIRECT ADDRESS GENERATION IN PIA MODE

Legend: ccc = Channel number (three to five bits), n = Base buffer address (zero to seven bits), x = User-definable range of DMADSTn for base address, 0 = Masked bits of DMADSTn for IA

FIGURE 22-2: EXAMPLE OF BUFFER ADDRESS GENERATION IN PIA MODE (4-WORD BUFFERS PER CHANNEL)



22.3 Registers

The 12-bit A/D Converter is controlled through a total of 12 registers:

- AD1CON1 through AD1CON5 (Register 22-1 through Register 22-5)
- AD1CHS (Register 22-6)

- ANCFG (Register 22-7)
- AD1CHITH and AD1CHITL (Register 22-8 and Register 22-9)
- AD1CSSH and AD1CSSL (Register 22-10 and Register 22-11)
- AD1RESDMA (not shown) The 16-bit conversion buffer for Extended Buffer mode

REGISTER 22-1: AD1CON1: A/D CONTROL REGISTER 1

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADON	—	ADSIDL	DMABM ⁽¹⁾	DMAEN	MODE12	FORM1	FORM0
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	HSC/R/W-0	HSC/R/C-0
SSRC3	SSRC2	SSRC1	SSRC0	—	ASAM	SAMP	DONE
bit 7							bit 0

Legend:	Legend: C = Clearable bit		, read as '0'
R = Readable bit	W = Writable bit	HSC = Hardware Setta	ble/Clearable bit
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	ADON: A/D Operating Mode bit
	1 = A/D Converter is operating
	0 = A/D Converter is off
bit 14	Unimplemented: Read as '0'
bit 13	ADSIDL: A/D Stop in Idle Mode bit
	1 = Discontinues module operation when device enters Idle mode0 = Continues module operation in Idle mode
bit 12	DMABM: Extended DMA Buffer Mode Select bit ⁽¹⁾
	 1 = Extended Buffer mode: Buffer address is defined by the DMADSTn register 0 = PIA mode: Buffer addresses are defined by the DMA Controller and AD1CON4[2:0]
bit 11	DMAEN: Extended DMA/Buffer Enable bit
	1 = Extended DMA and buffer features are enabled
	0 = Extended features are disabled
bit 10	MODE12: A/D 12-Bit Operation Mode bit
	1 = 12-bit A/D operation
	0 = 10-bit A/D operation
bit 9-8	FORM[1:0]: Data Output Format bits (see formats following)
	11 = Fractional result, signed, left justified
	10 = Absolute fractional result, unsigned, left justified
	01 = Decimal result, signed, right justified 00 = Absolute decimal result, unsigned, right justified
bit 7-4	SSRC[3:0]: Sample Clock Source Select bits
	0000 = SAMP is cleared by software
	0001 = INTO
	0010 = Timer3
	0011 = Timer5 0101 = Timer1 (will not trigger during Sleep mode)
	0110 = Timer1 (may trigger during Sleep mode)
	0111 = Auto-Convert mode

Note 1: This bit is only available when Extended DMA and buffer features are available (DMAEN = 1).

REGISTER 22-1: AD1CON1: A/D CONTROL REGISTER 1 (CONTINUED)

bit 3	Unimplemented: Read as '0'
bit 2	ASAM: A/D Sample Auto-Start bit
	1 = Sampling begins immediately after last conversion; SAMP bit is auto-set0 = Sampling begins when SAMP bit is manually set
bit 1	SAMP: A/D Sample Enable bit
	1 = A/D Sample-and-Hold amplifiers are sampling
	0 = A/D Sample-and-Hold amplifiers are holding
bit 0	DONE: A/D Conversion Status bit
	$1 - \Lambda/D$ conversion evels has completed

1 = A/D conversion cycle has completed

 $_{\rm 0}$ = A/D conversion cycle has not started or is in progress

Note 1: This bit is only available when Extended DMA and buffer features are available (DMAEN = 1).

R/W-0	R/W-0	R/W-0	r-0	R/W-0	R/W-0	U-0	U-0	
PVCFG1	PVCFG0	NVCFG0	_	BUFREGEN	CSCNA	—	_	
bit 15							bit 8	
D 0	D/M/O	DAMO	DAMA				DAMO	
R-0 BUFS	R/W-0 SMPI4	R/W-0 SMPI3	R/W-0 SMPI2	R/W-0 SMPI1	R/W-0 SMPI0	R/W-0 BUFM	R/W-0 ALTS	
bit 7	5101114	5101915	SIMPIZ	SIMPTI	SIVIPIU	DUFIM	bit	
Legend:		r = Reserved b	it					
R = Readable	e bit	W = Writable b	it	U = Unimpleme	ented bit, read	l as '0'		
-n = Value at	POR	'1' = Bit is set		ʻ0' = Bit is clea	red	x = Bit is unkn	iown	
bit 15-14		mented, do not		ge Reference Co	onfiguration bi	ts		
bit 13	NVCFG0: A/E 1 = AVss 0 = AVss) Converter Neg	ative Voltage	Reference Conf	iguration bit			
bit 12	Reserved: M	aintain as '0'						
bit 11	1 = Conversio		ed into the bu	oit Iffer location dete	rmined by the	converted cha	nnel	
bit 10	 0 = A/D result buffer is treated as a FIFO CSCNA: Scan Input Selections for CH0+ During Sample A bit 1 = Scans inputs 0 = Does not scan inputs 							
bit 9-8	Unimplemen	ted: Read as '0'	,					
bit 7	When DMAE! 1 = A/D is cu [buffer sta [buffer sta 0 = A/D is cu User show When DMAE! 1 = A/D is cu ADC1BU	art + (buffer size art + (buffer size rrently filling the uld access data I N = 0: rrently filling AD F0-ADC1BUF12 rrently filling AD	destination b - 1)]. User s /2) – 1]. destination l ocated from [C1BUF13-A[2	ouffer from [buffe should access da ouffer from [buffe buffer start + (buf DC1BUF25, user C1BUF12, user s	ta located fror r start] to [buf fer size/2)] to [should acces	n [buffer start] f fer start + (buffe buffer start + (bi s data in	er size/2) – 1	

REGISTER 22-2: AD1CON2: A/D CONTROL REGISTER 2

REGISTER 22-2: AD1CON2: A/D CONTROL REGISTER 2 (CONTINUED)

bit 6-2	SMPI[4:0]: Interrupt Sample/DMA Increment Rate Select bits When DMAEN = 1 and DMABM = 0:
	11111 = Increments the DMA address after completion of the 32nd sample/conversion operation 11110 = Increments the DMA address after completion of the 31st sample/conversion operation
	•
	•
	00001 = Increments the DMA address after completion of the 2nd sample/conversion operation 00000 = Increments the DMA address after completion of each sample/conversion operation
	When DMAEN = 1 and DMABM = 1:
	11111 = Resets the DMA offset after completion of the 32nd sample/conversion operation 11110 = Resets the DMA offset after completion of the 31nd sample/conversion operation
	•
	•
	• 00001 = Resets the DMA offset after completion of the 2nd sample/conversion operation 00000 = Resets the DMA offset after completion of every sample/conversion operation
	When DMAEN = 0:
	11111 = Interrupts at the completion of the conversion for each 32nd sample
	11110 = Interrupts at the completion of the conversion for each 31st sample
	•
	00001 = Interrupts at the completion of the conversion for every other sample 00000 = Interrupts at the completion of the conversion for each sample
bit 1	BUFM: Buffer Fill Mode Select bit
	 1 = Starts buffer filling at ADC1BUF0 on first interrupt and ADC1BUF13 on next interrupt 0 = Always starts filling buffer at ADC1BUF0
bit 0	ALTS: Alternate Input Sample Mode Select bit
	 1 = Uses channel input selects for Sample A on first sample and Sample B on next sample 0 = Always uses channel input selects for Sample A

R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADRC ⁽¹⁾	EXTSAM	PUMPEN ⁽²⁾	SAMC4	SAMC3	SAMC2	SAMC1	SAMC0
bit 15				·			bit
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADCS7	ADCS6	ADCS5	ADCS4	ADCS3	ADCS2	ADCS1	ADCS0
bit 7	1					I	bit
Legend:							
R = Readable	e bit	W = Writable b	oit	U = Unimplem	nented bit, read	l as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown
bit 14 bit 13 bit 12-8	EXTSAM: Ex 1 = A/D is stil 0 = A/D is fini PUMPEN: Ch 1 = Charge p 0 = Charge p	ived from syste tended Samplin I sampling after shed sampling narge Pump Ena ump for switche ump for switche Auto-Sample Tir	g Time bit SAMP = 0 able bit ⁽²⁾ s is enabled s is disabled				
bit 7-0	11111 = 31 T	ĀD .	Clock Select I				
	• • 00000001 = 00000000 =	2 • Tcy = Tad Tcy = Tad					

REGISTER 22-3: AD1CON3: A/D CONTROL REGISTER 3

- **Note 1:** Selecting the internal ADC RC clock requires that ADCSx be one or greater. Setting ADCSx = 0 when ADRC = 1 will violate the TAD (minimum) specification.
 - 2: The user should enable the charge pump if AVDD is < 2.7V. Longer sample times are required due to the increase of the internal resistance of the MUX if the charge pump is disabled.

REGISTER 22-4: AD1CON4: A/D CONTROL REGISTER 4

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	_	_		—			
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	DMABL[2:0] ⁽¹⁾		
bit 7	bit 7						bit 0
Legend:							
R = Readable	bit	W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at I	POR	'1' = Bit is set		'0' = Bit is cleared x = Bit is unknown			iown

bit 15-3 Unimplemented: Read as '0'

bit 2-0

- DMABL[2:0]: DMA Buffer Size Select bits⁽¹⁾
 - 111 = Allocates 128 words of buffer to each analog input
 - 110 = Allocates 64 words of buffer to each analog input
 - 101 = Allocates 32 words of buffer to each analog input
 - 100 = Allocates 16 words of buffer to each analog input
 - 011 = Allocates 8 words of buffer to each analog input
 - 010 = Allocates 4 words of buffer to each analog input
 - 001 = Allocates 2 words of buffer to each analog input

000 = Allocates 1 word of buffer to each analog input

Note 1: The DMABL[2:0] bits are only used when AD1CON1[11] = 1 and AD1CON1[12] = 0; otherwise, their value is ignored.

	REGISTER 22-5:	AD1CON5: A/D CONTROL REGISTER 5
--	----------------	---------------------------------

R/W-0	R/W-0	U-0	R/W-0	U-0	U-0	R/W-0	R/W-0			
ASEN	LPEN	—	BGREQ	—	_	ASINT1	ASINT0			
bit 15						•	bit 8			
U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0			
—	—	—	—	WM1	WM0	CM1	CM0			
bit 7							bit (
Legend:										
R = Readab		W = Writable		U = Unimplem						
-n = Value a	t POR	'1' = Bit is set	1	'0' = Bit is clea	red	x = Bit is unkr	nown			
bit 15		Scan Enable b	:+							
	1 = Auto-scar		it.							
	0 = Auto-scar									
bit 14	LPEN: Low-F	ower Enable b	oit							
		er is enabled a								
		r is enabled af								
bit 13	-	ted: Read as '								
bit 12		d Gap Reques								
	• •	is enabled wh	en the A/D is er by the A/D	habled and activ	ve					
bit 11-10		ted: Read as '	-							
bit 9-8	-		reshold Detect)	Interrupt Mode	bits					
			ld Detect seque	-		id compare has	s occurred			
			ompare has occ							
	01 = Interrup 00 = No inter		ld Detect seque	nce has comple	eted					
bit 7-4		ted: Read as '	0'							
bit 3-2	WM[1:0] : Wri		0							
	11 = Reserve									
	10 = Auto-compare only (conversion results are not saved, but interrupts are generated when a valid									
	match occurs, as defined by the CMx and ASINTx bits)									
	01 = Convert and save (conversion results are saved to locations as determined by the register bits when a match occurs, as defined by the CMx bits)									
			version data are		ation determir	ned by the buffe	er register bits			
bit 1-0	CM[1:0]: Con	npare Mode bi	ts							
	11 = Outside Window mode: Valid match occurs if the conversion result is outside of the window									
			onding buffer pa Valid match occ		rsion result is	inside the wind	low defined by			
		esponding buff								
	01 = Greater	Than mode: Va	alid match occur	rs if the result is	greater than t	he value in the	corresponding			
	buffer re		match occurs if	the result is les	e than the vel	in the correct	nonding buffs			
			match occurs ll	ILIC ICSULTS ICS	os unan une vali	ae in the corres	ponung pulle			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
CH0NB2	CH0NB1	CH0NB0	CH0SB4	CH0SB3	CH0SB2	CH0SB1	CH0SB0			
bit 15			I				bit			
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0			
CH0NA2	CH0NA1	CH0NA0	CH0SA4	CH0SA3	CH0SA2	CH0SA1	CH0SA0			
bit 7							bit			
Legend:										
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, rea	d as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown			
bit 15-13	CH0NB[2:0]: 1xx = Unimpl 011 = Unimpl 010 = AN1-	emented	nnel 0 Negativ	e Input Select k	bits					
		emented								
	001 = Unimplemented									
bit 7-5		00000 = AN0 CH0NA[2:0]: Sample A Channel 0 Negative Input Select bits Same definitions as for CHONB[2:0].								
	Same definitions as for CHONB[2:0]. CH0SA[4:0]: Sample A Channel 0 Positive Input Select bits Same definitions as for CHOSB[4:0].									

REGISTER 22-6: AD1CHS: A/D SAMPLE SELECT REGISTER

Note 1: These input channels do not have corresponding memory-mapped result buffers.

REGISTER 22-7: ANCFG: A/D BAND GAP REFERENCE CONFIGURATION REGISTER

							U-0		
U-0									
_		—			—	—			
bit 15									
U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0		
—	—	—	—	—	VBGEN3 ⁽¹⁾	VBGEN2 ⁽¹⁾	VBGEN1 ⁽¹⁾		
bit 7							bit 0		
Legend:									
R = Readab	ole bit	W = Writable b	bit	U = Unimplem	nented bit, read	l as '0'			
-n = Value a	at POR	'1' = Bit is set		'0' = Bit is cleared x = Bit is unknown					
bit 15-3	Unimplemen	ted: Read as '0	,						
bit 2	VBGEN3: A/I	D Band Gap Ref	ference Enable	e bit ⁽¹⁾					
	1 = Band gap	reference is en	abled						
	0 = Band gap	reference is dis	sabled						
bit 1	VBGEN2: Co	mparator Band	Gap Reference	e Enable bit ⁽¹⁾					
	1 = Band gap	reference is en	abled						
	0 = Band gap	reference is dis	sabled						
bit 0	VBGEN1: VF	REG, BOR, HLV	D, FRC, NVM	and A/D Boost	Band Gap Ref	erence Enable	bit ⁽¹⁾		
		reference is en							
	0 = Band gap	reference is dis	sabled						

Note 1: When a module requests a band gap reference voltage, that reference will be enabled automatically after a brief start-up time. The user can manually enable the band gap references using the ANCFG register, before enabling the module requesting the band gap reference, to avoid this start-up time (~1 ms).

U/0	U/0	U/0	U/0	U/0	U/0	U/0	U/0
_	—	—	_	—	—	—	—
bit 15		·					bit 8
U/0	U/0	U/0	U/0	U/0	U/0	U/0	R/W-0
_		—	_	—	—	_	CHH16
bit 7		·				•	bit 0
Legend:							
R = Readable	e bit	W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at	POR	'1' = Bit is set	et '0' = Bit is cleared x = Bit is unknown			nown	

REGISTER 22-8: AD1CHITH: A/D SCAN COMPARE HIT REGISTER HIGH

bit 15-1 Unimplemented: Read as '0'

bit 0

CHH16: A/D Compare Hit bit

If CM[1:0] = 11:

1 = A/D Result Buffer n has been written with data or a match has occurred

0 = A/D Result Buffer n has not been written with data

For All Other Values of CM[1:0]:

1 = A match has occurred on A/D Result Channel n

0 = No match has occurred on A/D Result Channel n

REGISTER 22-9: AD1CHITL: A/D SCAN COMPARE HIT REGISTER LOW

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
			CHH	4[15:8]				
bit 15							bit 8	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
			СН	H[7:0]				
bit 7							bit 0	
Legend:								
R = Readable bit W = Writable bit		oit	U = Unimplemented bit, read as '0'					
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unknow			nown		

bit 15-0 **CHH[15:0]:** A/D Compare Hit bits

If CM[1:0] = 11:

1 = A/D Result Buffer n has been written with data or a match has occurred

0 = A/D Result Buffer n has not been written with data

For All Other Values of CM[1:0]:

1 = A match has occurred on A/D Result Channel n

0 = No match has occurred on A/D Result Channel n

REGISTER 22-10: AD1CSSH: A/D INPUT SCAN SELECT REGISTER HIGH

U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0			
		CSS[30:28]		—	—	—	—			
bit 15							bit 8			
U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0			
	—	—	—	—	—	—	CSS16			
bit 7							bit 0			
Legend:										
R = Readab	le bit	W = Writable bit		U = Unimplemented bit, read as '0'						
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown				
bit 15	Unimplemented: Read as '0'									
bit 14-12	CSS[30:28]: A/D Input Scan Selection bits									
	1 = Includes corresponding channel for input scan									
	0 = Skips ch	0 = Skips channel for input scan								
bit 11-1	Unimplemented: Read as '0'									
bit 0	CSS16: A/D Input Scan Selection bit									
	1 = Includes	1 = Includes corresponding channel for input scan								
	0 = Skips ch	0 = Skips channel for input scan								

REGISTER 22-11: AD1CSSL: A/D INPUT SCAN SELECT REGISTER LOW

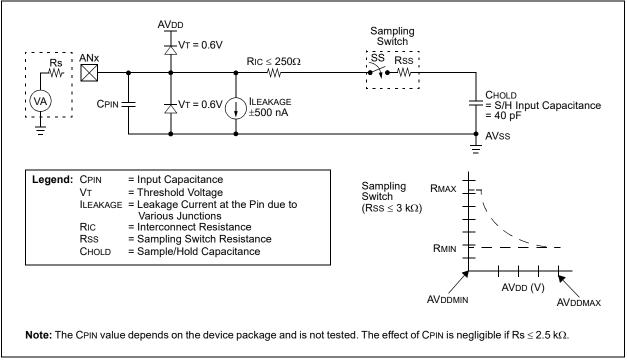
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
			CS	S[15:8]				
bit 15							bit 8	
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
			CS	S[7:0]				
bit 7							bit 0	
Legend:								
R = Readable bit W		W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown		

bit 15-0 CSS[15:0]: A/D Input Scan Selection bits

1 = Includes corresponding channel for input scan

0 = Skips channel for input scan



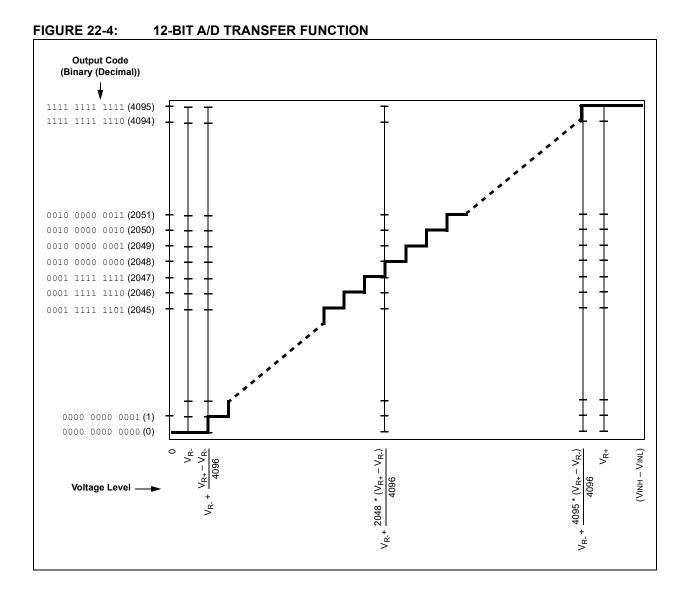


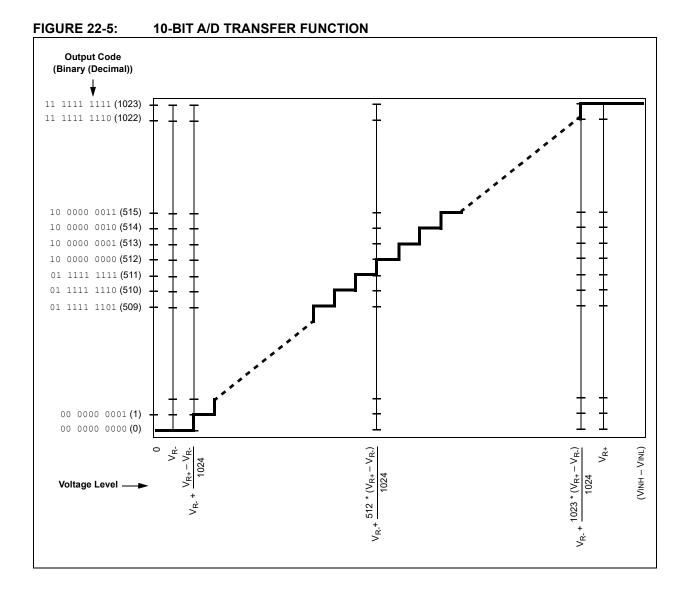
EQUATION 22-1: A/D CONVERSION CLOCK PERIOD

$$T_{AD} = T_{CY} \left(ADCS + 1 \right)$$

$$ADCS = \frac{TAD}{TCY} - 1$$

Note: Based on TCY = 2/FOSC; Doze mode and PLL are disabled.





23.0 TRIPLE COMPARATOR MODULE

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "Scalable Comparator Module" (www.microchip.com/DS39734) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The triple comparator module provides three dual input comparators. The inputs to the comparator can be configured to use any one of five external analog inputs (CxINA, CxINB, CxINC, CxIND and CVREF+) and a voltage reference input from one of the internal band gap references or the comparator voltage reference generator (VBG and CVREF).

The comparator outputs may be directly connected to the CxOUT pins. When the respective COE bit equals '1', the I/O pad logic makes the unsynchronized output of the comparator available on the pin.

A simplified block diagram of the module in shown in Figure 23-1. Diagrams of the possible individual comparator configurations are shown in Figure 23-2 through Figure 23-4.

Each comparator has its own control register, CMxCON (Register 23-1), for enabling and configuring its operation. The output and event status of all three comparators is provided in the CMSTAT register (Register 23-2).

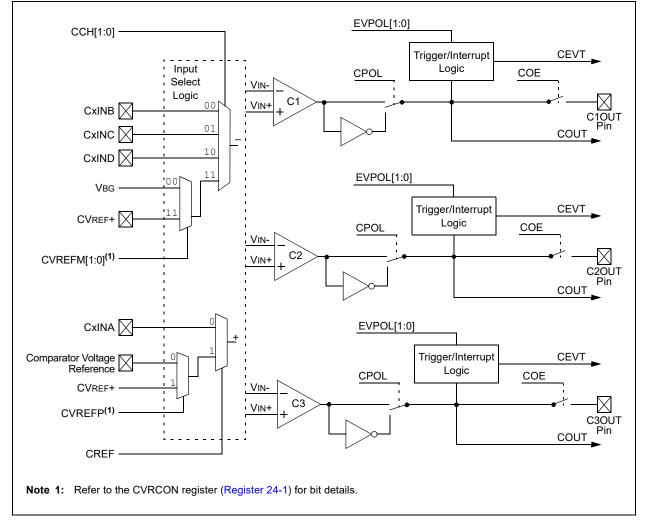


FIGURE 23-1: TRIPLE COMPARATOR MODULE BLOCK DIAGRAM



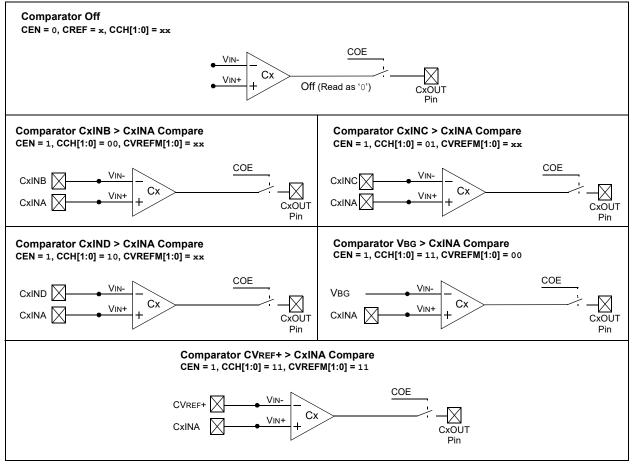
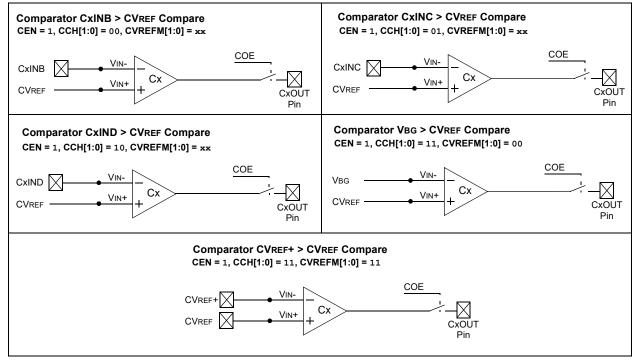
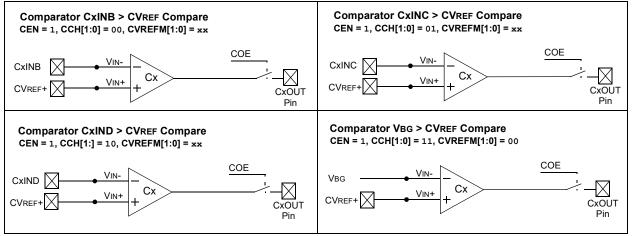


FIGURE 23-3: INDIVIDUAL COMPARATOR CONFIGURATIONS WHEN CREF = 1 AND CVREFP = 0







REGISTER 23-1: CMxCON: COMPARATOR x CONTROL REGISTERS (COMPARATORS 1 THROUGH 3)

R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	HS/R/W-0	HSC/R-0
CEN	COE	CPOL		—	_	CEVT	COUT
bit 15							bit 8
R/W-0	R/W-0	U-0	R/W-0	U-0	U-0	R/W-0	R/W-0
EVPOL1	EVPOL0		CREF	_	—	CCH1	CCH0
bit 7							bit 0
Legend:		HS = Hardware	Settable bit	HSC = Hardv	vare Settable/	Clearable bit	
R = Readab	le bit	W = Writable b	it	U = Unimpler	nented bit, re	ad as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown
bit 15 bit 14	1 = Compara 0 = Compara COE: Compa 1 = Compara	arator Enable bit ator is enabled ator is disabled arator Output En- ator output is pre ator output is inte	sent on the Cx	OUT pin			
bit 13	 CPOL: Comparator Output Polarity Select bit 1 = Comparator output is inverted 0 = Comparator output is not inverted 						
bit 12-10	Unimplemented: Read as '0'						
bit 9	CEVT: Comparator Event bit						
	 1 = Comparator event that is defined by EVPOL[1:0] has occurred; subsequent triggers and interrup are disabled until the bit is cleared 0 = Comparator event has not occurred 						and interrupts
bit 8	COUT: Comp	parator Output bi	t				
	$\frac{\text{When CPOL} = 0:}{1 = \text{VIN} + \text{VIN}}$ $0 = \text{VIN} + \text{VIN}$						
	When CPOL 1 = VIN+ < V	'IN-					
bit 7-6	11 = Trigger/ 10 = Trigger/ High-to- <u>If CPOL</u> Low-to- 01 = Trigger/ <u>If CPOL</u> Low-to- <u>If CPOL</u> High-to-	Trigger/Event/Ir event/interrupt is event/interrupt is $_{=} = 0$ (noninverte -low transition or $_{=} = 1$ (inverted po- high transition of event/interrupt is $_{=} = 0$ (noninverte high transition of $_{=} = 1$ (inverted po- -low transition or event/interrupt g	s generated on s generated on <u>d polarity):</u> hly. <u>plarity):</u> hly. s generated on <u>d polarity):</u> hly. <u>plarity):</u> hly.	any change of transition of the transition of cc	e comparator	output:	CEVT = 0)
hit 5				sadied			
bit 5	Unimplemen	nted: Read as '0					

REGISTER 23-1: CMxCON: COMPARATOR x CONTROL REGISTERS (COMPARATORS 1 THROUGH 3) (CONTINUED)

- bit 4 **CREF:** Comparator Reference Select bits (noninverting input)
 - 1 = Noninverting input connects to the internal CVREF voltage
 - 0 = Noninverting input connects to the CxINA pin
- bit 3-2 Unimplemented: Read as '0'
- bit 1-0 CCH[1:0]: Comparator Channel Select bits
 - 11 = Inverting input of the comparator connects to the internal selectable reference voltage specified by the CVREFM[1:0] bits in the CVRCON register
 - 10 = Inverting input of the comparator connects to the CxIND pin
 - 01 = Inverting input of the comparator connects to the CxINC pin
 - 00 = Inverting input of the comparator connects to the CxINB pin

REGISTER 23-2: CMSTAT: COMPARATOR MODULE STATUS REGISTER

R/W-0	U-0	U-0	U-0	U-0	HSC/R-0	HSC/R-0	HSC/R-0
CMIDL	—		—	_	C3EVT	C2EVT	C1EVT
bit 15 bit 8							bit 8

U-0	U-0	U-0	U-0	U-0	HSC/R-0	HSC/R-0	HSC/R-0
—	—		—	—	C3OUT	C2OUT	C1OUT
bit 7							bit 0

Legend:	HSC = Hardware Settable/Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15	CMIDL: Comparator Stop in Idle Mode bit
	 1 = Discontinues operation of all comparators when device enters Idle mode 0 = Continues operation of all enabled comparators in Idle mode
bit 14-11	Unimplemented: Read as '0'
bit 10	C3EVT: Comparator 3 Event Status bit (read-only)
	Shows the current event status of Comparator 3 (CM3CON[9]).
bit 9	C2EVT: Comparator 2 Event Status bit (read-only)
	Shows the current event status of Comparator 2 (CM2CON[9]).
bit 8	C1EVT: Comparator 1 Event Status bit (read-only)
	Shows the current event status of Comparator 1 (CM1CON[9]).
bit 7-3	Unimplemented: Read as '0'
bit 2	C3OUT: Comparator 3 Output Status bit (read-only)
	Shows the current output of Comparator 3 (CM3CON[8]).
bit 1	C2OUT: Comparator 2 Output Status bit (read-only)
	Shows the current output of Comparator 2 (CM2CON[8]).
bit 0	C1OUT: Comparator 1 Output Status bit (read-only)
	Shows the current output of Comparator 1 (CM1CON[8]).

NOTES:

24.0 COMPARATOR VOLTAGE REFERENCE

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "Dual Comparator Module" (www.microchip.com/DS39710) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

24.1 Configuring the Comparator Voltage Reference

The voltage reference module is controlled through the CVRCON register (Register 24-1). The comparator voltage reference provides two ranges of output voltage, each with 16 distinct levels. The primary difference between the ranges is the size of the steps selected by the CVREF Value Selection bits (CVR[4:0]), with one range offering finer resolution.

The comparator reference supply voltage can come from either VDD and VSS, or the external VREF+ and VREF-. The voltage source is selected by the CVRSS bit (CVRCON[5]).

The settling time of the comparator voltage reference must be considered when changing the CVREF output.

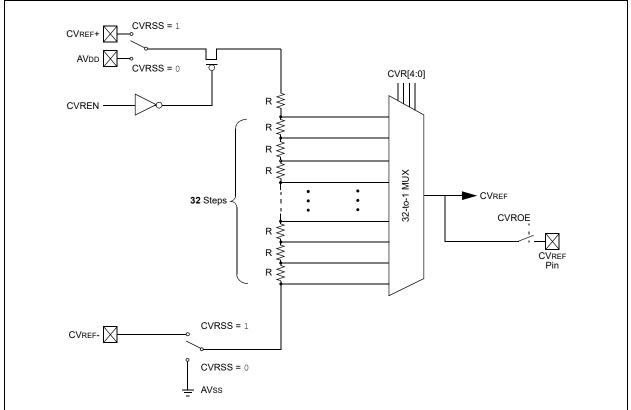


FIGURE 24-1: COMPARATOR VOLTAGE REFERENCE BLOCK DIAGRAM

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
_	—	—	_	—	CVREFP	CVREFM1	CVREFM0
bit 15	·						bit 8
D // / 0	D /// 0	D /11/0	D /// 0	DAAC	D 444 0	D 444 0	D 444 0
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0 CVR2	R/W-0	R/W-0
CVREN	N CVROE CVRSS CVR4 CVR3 (CVR1	CVR0
bit 7							bit 0
Legend:							
R = Readab	ole bit	W = Writable b	it	U = Unimplen	nented bit, read	d as '0'	
-n = Value a	t POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	iown
bit 15-11	Unimplemen	ited: Read as '0'	,				
bit 10	CVREFP: Co	mparator Voltag	e Reference	Select bit (valid	only when CR	EF is '1')	
		s used as a refe					
		[4:0] bits (5-bit D	,			•	•
bit 9-8	-]: Comparator B	•		•	only when CCI	H[1:0] = 11)
	00 = Band ga 01 = Reserve	ap voltage is prov	/ided as an ii	nput to the comp	parators		
	10 = Reserve						
		is provided as a	n input to the	e comparators			
bit 7	CVREN: Con	nparator Voltage	Reference E	nable bit			
		rcuit is powered					
	0 = CVREF ci	rcuit is powered	down				
bit 6	CVROE: Cor	nparator VREF O	utput Enable	bit			
1 = CVREF voltage level is output on the CVREF pin							
	0 = CVREF voltage level is disconnected from the CVREF pin						
		•		om the CVREF p	pin		
bit 5	CVRSS: Con	nparator VREF So	ource Selecti	om the CVREF p on bit			
bit 5	CVRSS: Con 1 = Compara	•	ource Selecti urce, CVRSR	om the CVREF p on bit c = CVREF+ – C	Vref-		
bit 5 bit 4-0	CVRSS: Con 1 = Compara 0 = Compara CVR[4:0]: Co	nparator VREF So tor reference so tor reference so omparator VREF	ource Selecti urce, CVRSR urce, CVRSR	om the CVREF p on bit c = CVREF+ – C c = AVDD – AVs	Vref- s		
-	CVRSS: Con 1 = Compara 0 = Compara CVR[4:0]: Co <u>When CVRS</u>	nparator VREF So tor reference so tor reference so omparator VREF $^{\circ}$ S = 1:	ource Selecti urce, CVRSR urce, CVRSR Value Selecti	om the CVREF p on bit $C = CVREF+ - CC = AVDD - AVSion bits (0 \leq CVF$	Vref- s		
-	CVRSS: Con 1 = Compara 0 = Compara CVR[4:0]: Co When CVRS CVREF = (CV	nparator VREF Sector reference so tor reference so pomparator VREF $\frac{1}{2}$ $\frac{5 = 1}{2}$ REF-) + (CVR[4:0	ource Selecti urce, CVRSR urce, CVRSR Value Selecti	om the CVREF p on bit $C = CVREF+ - CC = AVDD - AVSion bits (0 \leq CVF$	Vref- s		
-	CVRSS: Con 1 = Compara 0 = Compara CVR[4:0]: Co When CVRSS CVREF = (CV When CVRSS	nparator VREF Sector reference so tor reference so pomparator VREF $\frac{1}{2}$ $\frac{5 = 1}{2}$ REF-) + (CVR[4:0	burce Selecti urce, CVRSR(urce, CVRSR(Value Selecti 0]/32) • (CVR	om the CVREF p on bit C = CVREF + - C $C = AVDD - AVSon bits (0 \leq CVFEF + - CVREF-)$	Vref- s		

REGISTER 24-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

25.0 HIGH/LOW-VOLTAGE DETECT (HLVD)

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to "High-Level Integration with Programmable High/Low-Voltage Detect (HLVD)" (www.microchip.com/DS39725) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

The High/Low-Voltage Detect (HLVD) module is a programmable circuit that allows the user to specify both the device voltage trip point and the direction of change.

An interrupt flag is set if the device experiences an excursion past the trip point in the direction of change. If the interrupt is enabled, the program execution will branch to the interrupt vector address and the software can then respond to the interrupt. The HLVDIF flag may be set during a POR or BOR event. The firmware should clear the flag before the application uses it for the first time, even if the interrupt was disabled.

The HLVD Control register (see Register 25-1) completely controls the operation of the HLVD module. This allows the circuitry to be "turned off" by the user under software control, which minimizes the current consumption for the device.

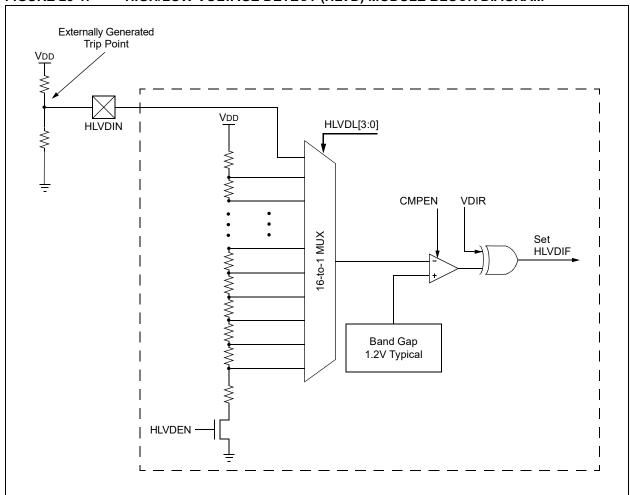


FIGURE 25-1: HIGH/LOW-VOLTAGE DETECT (HLVD) MODULE BLOCK DIAGRAM

R/W-0	U-0	R/W-0	U-0	R/W-0	HS/HC/R-0	HS/HC/R-0	HS/HC/R-0
HLVDEN	_	LSIDL		VDIR	BGVST	IRVST	HLVDEVT ⁽²⁾
bit 15							bit 8
R/S-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
CMPEN ⁽³⁾	0-0			HLVDL3	HLVDL2	HLVDL1	HLVDL0
bit 7				TIEVDES	TILVDLZ	TIEVDET	bit (
							Ditt
Legend:		HS = Hardware	Settable bit	HC = Hardwa	are Clearable bit		
R = Readable	e bit	W = Writable b	it	U = Unimple	mented bit, read	l as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is cle	eared	S = Settable	bit
bit 15	HLVDEN: H	ligh/Low-Voltage	Detect Power	Enable bit			
-	1 = HLVD is						
	0 = HLVD is	s disabled					
bit 14	Unimpleme	ented: Read as 'o	3				
bit 13	LSIDL: HLV	D Stop in Idle Mo	ode bit				
		tinues module op			dle mode		
L:1 40		ues module opera		ode			
bit 12	•	ented: Read as '(
bit 11		ge Change Direc ccurs when voltag		voodo trin noi			
		ccurs when volta					
bit 10		nd Gap Voltage S				,1)	
	1 = Indicate	s that the band g s that the band g	ap voltage is s				
bit 9		rnal Reference V					
	1 = Internal	l reference voltag	e is stable; the	High-Voltage I	Detect logic gene	erates the inter	rupt flag at the
		ed voltage range					
		l reference voltag he specified volta					e the interrup
bit 8		High/Low-Voltage			inupt should not	De ellableu	
Sit 0		vent is true during					
		vent is not true d			e		
bit 7	CMPEN: Hi	gh/Low-Voltage [etect Compa	ator Enable bi	t ⁽³⁾		
	1 = HLVD c	omparator is ena	oled				
		omparator is disa					
bit 6-4	-	ented: Read as '0					
bit 3-0		: High/Low-Volta	-				
	1111 = Exte 1110 = Trip	ernal analog inpu	is used (inpu	t comes from t	he HLVDIN pin)		
	1110 = Trip						
	1100 = Trip						
	•						
	•						
	• 0100 = Trip	Point 11 ⁽¹⁾					
	00xx = Unu						
Note 1: Fo	or the actual tr	ip point, see <mark>Sec</mark>	tion 30.0 "Ele	ctrical Charo	ctoristics"		
					EVT = 0. The vo		

REGISTER 25-1: HLVDCON: HIGH/LOW-VOLTAGE DETECT CONTROL REGISTER

- 2: The HLVDIF flag cannot be cleared by software unless HLVDEVT = 0. The voltage must be monitored so
 - that the HLVD condition (as set by VDIR and HLVDL[3:0]) is not asserted.
 - **3:** CMPEN can only be written when the HLVDEN bit = 1.

26.0 DEADMAN TIMER (DMT)

Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to "Deadman Timer (DMT)" (www.microchip.com/DS70005155) in the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.

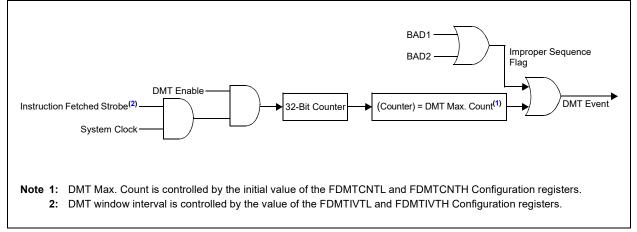
The primary function of the Deadman Timer (DMT) is to interrupt the processor in the event of a software malfunction. The DMT, which works on the system clock, is a free-running instruction fetch timer. The DMT is clocked whenever an instruction fetch occurs until a count match occurs. Instructions are not fetched when the processor is in Sleep mode.

The DMT can be enabled in the Configuration fuse or by software in the DMTCON register by setting the ON bit. The DMT consists of a 32-bit counter with a time-out count match value, as specified by the two 16-bit Configuration Fuse registers: FDMTCNTL and FDMTCNTH.

A DMT is typically used in mission-critical and safetycritical applications, where any single failure of software functionality and sequencing must be detected.

Figure 26-1 shows a block diagram of the Deadman Timer module.





26.1 Deadman Timer Control Registers

REGISTER 26-1: DMTCON: DEADMAN TIMER CONTROL REGISTER

| U-0 |
|-----|-----|-----|-----|-----|-----|-------|
| — | — | — | — | — | — | — |
| | | | | | | bit 8 |
| | | | | | | |
| U-0 |
—	—	—	—	—	_	—
						bit 0
	—					

Legend:

Legena.			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	1 as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **ON:** DMT Module Enable bit⁽¹⁾

1 = Deadman Timer module is enabled

0 = Deadman Timer module is not enabled

bit 14-0 Unimplemented: Read as '0'

Note 1: This bit has control only when DMTDIS = 0 in the FDMT register.

REGISTER 26-2: DMTPRECLR: DEADMAN TIMER PRECLEAR REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
			STE	P1[7:0]				
bit 15							bit 8	
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
—	—	—	_	—	—	—	—	
bit 7							bit 0	
Legend:								
R = Readable	bit	W = Writable I	oit	U = Unimplemented bit, read as '0'				
-n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is unknown			nown		
L								
bit 15-8	STEP1[7:0]:	DMT Preclear E	Enable bits					

DIL 10-0	SIEFI[7.0]. DMI FIECEAI ENABLE DIS						
	01000000 = Enables the Deadman Timer preclear (STEP1) All Other						
	Write Patterns = Sets the BAD1 flag; these bits are cleared when a DMT Reset event occurs. STEP1[7:0] bits are also cleared if the STEP2[7:0] bits are loaded with the correct value in the correct sequence.						
L:1 7 0	Unimplemented, Deed es (o)						

bit 7-0 Unimplemented: Read as '0'

	REGISTER 26-3:	DMTCLR: DEADMAN TIMER CLEAR REGISTER
--	----------------	--------------------------------------

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	—	—	_	—	—	—	—
bit 15							bit 8
R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
			STE	P2[7:0]			
bit 7							bit 0
Legend:							
R = Readable bit		W = Writable	bit	U = Unimpler	nented bit, rea	d as '0'	
-n = Value a	it POR	'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	
bit 15-8	Unimplemer	nted: Read as '	0'				
bit 7-0	STEP2[7:0]:	DMT Clear Tim	ner bits				
	00001000 =	ing of the S⊺	TEP1[7:0] bits	in the correct se	equence. The w		the correct load- s may be verified ing reset.
	All Other	, ,	-	5 1	5		5
	Write Patterns = Sets the BAD2 bit; the value of STEP1[7:0] will remain unchanged and the new value being written to STEP2[7:0] will be captured. These bits are cleared when a DMT Reset event occurs.						

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
_		_	_		_			
bit 15							bit 8	
HC/R-0	HC/R-0	HC/R-0	U-0	U-0	U-0	U-0	R-0	
BAD1	BAD2	DMTEVENT	—	_	—	—	WINOPN	
bit 7							bit 0	
			0	••				
Legend:		HC = Hardware						
R = Readable		W = Writable b	it	U = Unimplem		d as '0'		
-n = Value at	= Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unl				x = Bit is unk	nown		
bit 15-8 bit 7 bit 6	Unimplemented: Read as '0' BAD1: Deadman Timer Bad STEP1[7:0] Value Detect bit 1 = Incorrect STEP1[7:0] value was detected 0 = Incorrect STEP1[7:0] value was not detected BAD2: Deadman Timer Bad STEP2[7:0] Value Detect bit							
	1 = Incorrect 0 = Incorrect	STEP2[7:0] valu STEP2[7:0] valu	e was detecte e was not de	ed				
bit 5	 5 DMTEVENT: Deadman Timer Event bit 1 = Deadman Timer event was detected (counter expired, or bad STEP1[7:0] or STEP2[7:0] value was entered prior to counter increment) 0 = Deadman Timer event was not detected 							
bit 4-1	Unimplemer	nted: Read as '0'						
bit 0	WINOPN: De	adman Timer Cl	ear Window b	bit				
		n Timer clear win						
	0 = Deadman Timer clear window is not open							

REGISTER 26-4: DMTSTAT: DEADMAN TIMER STATUS REGISTER

REGISTER 26-5: DMTCNTL: DEADMAN TIMER COUNT REGISTER LOW

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			COUN	NTER[15:8]			
bit 15							bit 8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
COUNTER[7:0]							
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'							
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unkn			own				

bit 15-0 **COUNTER[15:0]:** Read Current Contents of Lower DMT Counter bits

REGISTER 26-6: DMTCNTH: DEADMAN TIMER COUNT REGISTER HIGH

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			COUN	TER[31:24]			
bit 15							bit 8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			COUN	TER[23:16]			
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit			U = Unimplemented bit, read as '0'				
n = Value at POR '1' = Bit is set			'0' = Bit is cleared x = Bit is		x = Bit is unkr	nown	

bit 15-0 **COUNTER[31:16]:** Read Current Contents of Higher DMT Counter bits

REGISTER 26-7: DMTPSCNTL: DMT POST-CONFIGURE COUNT STATUS REGISTER LOW

R-y	R-y	R-y	R-y	R-y	R-y	R-y	R-y		
PSCNT[15:8]									
bit 15							bit 8		
R-y	R-y	R-y	R-y	R-y	R-y	R-y	R-y		
	PSCNT[7:0]								
bit 7							bit 0		
Legend:		y = Value from	Configuratio	n bit on POR					
R = Readable	R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'								
-n = Value at I	n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown						iown		

bit 15-0 **PSCNT[15:0]:** Lower DMT Instruction Count Value Configuration Status bits This is always the value of the FDMTCNTL Configuration register.

REGISTER 26-8: DMTPSCNTH: DMT POST-CONFIGURE COUNT STATUS REGISTER HIGH

R-y	R-y	R-y	R-y	R-y	R-y	R-y	R-y
			PSCN	T[31:24]			
bit 15							bit 8
R-y	R-y	R-y	R-v	R-v	R-y	R-y	R-y
PSCNT[23:16]							
bit 7							bit 0
Legend:		y = Value from C	Configuration	n bit on POR			
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'							
-n = Value at I	n = Value at POR (1' = Bit is set 0' = Bit is cleared x = Bit is unknown						ו

bit 15-0 **PSCNT[31:16]:** Higher DMT Instruction Count Value Configuration Status bits This is always the value of the FDMTCNTH Configuration register.

x = Bit is unknown

R-y	R-y	R-y	R-y	R-y	R-y	R-y	R-y
			PSIN	NTV[15:8]			
bit 15							bit 8
R-y	R-y	R-y	R-y	R-y	R-y	R-y	R-y
			PSI	NTV[7:0]			
bit 7							bit 0
Legend: y = Value from Configuration bit on POR							
R = Readable b	le bit W = Writable bit U = Unimplemented bit, read as '0'						

'0' = Bit is cleared

REGISTER 26-9: DMTPSINTVL: DMT POST-CONFIGURE INTERVAL STATUS REGISTER LOW

bit 15-0 **PSINTV[15:0]:** Lower DMT Window Interval Configuration Status bits This is always the value of the FDMTIVTL Configuration register.

'1' = Bit is set

REGISTER 26-10: DMTPSINTVH: DMT POST-CONFIGURE INTERVAL STATUS REGISTER HIGH

R-y	R-y	R-y	R-y	R-y	R-y	R-y	R-y		
PSINTV[31:24]									
bit 15							bit 8		
R-y	R-y	R-y	R-y	R-y	R-y	R-y	R-y		
PSINTV[23:16]									
bit 7							bit 0		
Legend:		y = Value from	n Configuratior	n bit on POR					
R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'									
-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown				own					

bit 15-0 **PSINTV[15:0]:** Higher DMT Window Interval Configuration Status bits This is always the value of the FDMTIVTH Configuration register.

-n = Value at POR

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			UPRC	NT[15:8]			
bit 15							bit 8
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
			UPR	CNT[7:0]			
bit 7							bit 0
Legend:							
R = Readable bit W = Writable bit U = Unimplemented bit, read as				d as '0'			
-n = Value at	-n = Value at POR '1' = Bit is set		'0' = Bit is cleared x = Bit is		x = Bit is unkn	iown	
r							

REGISTER 26-11: DMTHOLDREG: DMT HOLD REGISTER⁽¹⁾

bit 15-0 UPRCNT[15:0]: DMTCNTH Register Value When DMTCNTL/DMTCNTH were Last Read bits

Note 1: The DMTHOLDREG register is initialized to '0' on Reset, and is only loaded when the DMTCNTL and DMTCNTH registers are read.

27.0 SPECIAL FEATURES

- Note: This data sheet summarizes the features of the PIC24FJ128GL306 family of devices. It is not intended to be a comprehensive reference source. For more information, refer to the following sections of the "dsPIC33/PIC24 Family Reference Manual". The information in this data sheet supersedes the information in the FRM.
 "Watchdog Timer (WDT)" (www.microchip.com/DS39697)
 "High-Level Device Integration"
 - (www.microchip.com/DS39719) • "Programming and Diagnostics"
 - (www.microchip.com/DS39716)

PIC24FJ128GL306 family devices include several features intended to maximize application flexibility and reliability, and minimize cost through elimination of external components. These are:

- Flexible Configuration
- Watchdog Timer (WDT)
- Code Protection
- JTAG Boundary Scan Interface
- In-Circuit Serial Programming[™] (ICSP[™])
- In-Circuit Emulation

27.1 Configuration Bits

The Configuration bits are stored in the last page location of implemented program memory. These bits can be set or cleared to select various device configurations. There are two types of Configuration bits: system operation bits and code-protect bits. The system operation bits determine the power-on settings for system-level components, such as the oscillator and the Watchdog Timer. The code-protect bits prevent program memory from being read and written.

27.1.1 CONSIDERATIONS FOR CONFIGURING PIC24FJ128GL306 FAMILY DEVICES

In PIC24FJ128GL306 family devices, the Configuration bytes are implemented as volatile memory. This means that configuration data must be programmed each time the device is powered up. Configuration data are stored in the three words at the top of the on-chip program memory space, known as the Flash Configuration Words. Their specific locations are shown in Table 27-1. The configuration data are automatically loaded from the Flash Configuration Words to the proper Configuration registers during device Resets.

Note:	Configuration d	lata a	ire	reloaded	on	all	
	types of device Resets.						

When creating applications for these devices, users should always specifically allocate the location of the Flash Configuration Word for configuration data. This is to make certain that program code is not stored in this address when the code is compiled.

The upper byte of all Flash Configuration Words in program memory should always be '0000 0000'. This makes them appear to be NOP instructions in the remote event that their locations are ever executed by accident. Since Configuration bits are not implemented in the corresponding locations, writing '0's to these locations has no effect on device operation.

TABLE 27-1: CONFIGURATION WORD ADDRESSES
--

Configuration Register	PIC24FJ128GL30X	PIC24FJ64GL30X
FSEC	0x015F00	0x00AF00
FBSLIM	0x015F10	0x00AF10
FSIGN	0x015F14	0x00AF14
FOSCSEL	0x015F18	0x00AF18
FOSC	0x015F1C	0x00AF1C
FWDT	0x015F20	0x00AF20
FPOR	0x015F24	0x00AF24
FICD	0x015F28	0x00AF28
FDMTIVTL	0x015F2C	0x00AF2C
FDMTIVTH	0x015F30	0x00AF30
FDMTCNTL	0x015F34	0x00AF34
FDMTCNTH	0x015F38	0x00AF38
FDMT	0x015F3C	0x00AF3C
FDEVOPT1	0x015F40	0x00AF40

TABLE 27-2: CONFIGURATION REGISTER MAP

Register Name	Bits 23-16	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
FSEC	—	AIVTDIS	—	_	—	C	SS[2:0]		CWRP	GSS	[1:0]	GWRP	_	BSEN	BSS[1:0]	BWRP
FBSLIM	—	_	_	_							BS	LIM[12:0]					
FSIGN	—	r ⁽²⁾	_	_	_	_	_		_	_	_	_	_	_	_	_	_
FOSCSEL	—	_	_	_	_	_	_	r ⁽²⁾	r ⁽²⁾	IESO		PLLM	ODE[3:0]		F	NOSC[2:0]	
FOSC	—	_	_	_	_	_	_	_	—	FCKS	V[1:0]	IOL1WAY	PLLSS	SOSCSEL	OSCIOFNC	POSCM	1D[1:0]
FWDT	—	_	WDTC	LK[1:0]	_	WDTCMX	_	WDT	WIN[1:0]	WINDIS	FWD	ΓEN[1:0]	FWPSA		WDTPS	S[3:0]	
FPOR	—	_	_	_	_	_	_	_	_	—	_		_	DNVPEN	LPCFG	BORE	N[1:0]
FICD	—	_	_	_	—	_	_	—	_	r ⁽¹⁾	_	JTAGEN	_		_	ICS[1:0]
FDMTIVTL	—									DMTIVT[15:0]						
FDMTIVTH	—									DMTIVT[3	1:16]						
FDMTCNTL	—									DMTCNT[15:0]						
FDMTCNTH	_		DMTCNT[31:16]														
FDMT	—	_	_	_	—	_	_	—	_	—	_		—	_	—	_	DMTDIS
FDEVOPT1			—		_		SMB3EN	_		_			ALTI2C1	SOSCHP	TMPRPIN	ALTCMPI	

Legend: — = unimplemented, read as '1'.

Note 1: Bit is reserved, maintain as '1'.

2: Bit is reserved, maintain as '0'.

REGISTER 27-1: FSEC CONFIGURATION REGISTER

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1			
					_					
bit 23							bit 16			
R/PO-1	U-1	U-1	U-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1			
AIVTDIS				CSS2	CSS1	CSS0	CWRP			
bit 15							bit 8			
R/PO-1	R/PO-1	R/PO-1	U-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1			
GSS1	GSS0	GWRP	<u> </u>	BSEN	BSS1	BSS0	BWRP			
bit 7	0000	OWN		BOEN	DOOT	0000	bit 0			
bit i							Sit 0			
Legend:		PO = Progran	n Once bit							
R = Readabl	le bit	W = Writable		U = Unimplem	nented bit, read	d as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea		x = Bit is unkr	nown			
bit 23-16	Unimplemer	nted: Read as '	,							
bit 15	AIVTDIS: Alt	AIVTDIS: Alternate Interrupt Vector Table Disable bit								
	1 = Disables AIVT; AIVTEN bit (INTCON2[8]) is not available									
		AIVT; AIVTEN b	, _	8]) is available						
bit 14-12	Unimplemented: Read as '1'									
bit 11-9		onfiguration Seg		ode Protection L	evel bits					
	111 = No pro 110 = Standa	otection (other th ard security	ian CWRP)							
	10x = Enhar	•								
	0xx = High s	-								
bit 8		figuration Segm			bit					
		ation Segment is ation Segment is								
bit 7-6	•	eneral Segment	•		nits					
bit 7-0		ection (other that	. ,		5113					
	10 = Standa									
	0x = High se	-								
bit 5		eral Segment P	-							
		Segment is not Segment is write		d						
bit 4		nted: Read as '	•							
bit 3	-	Segment (BS) (
Sit O		Segment is ena								
		gment size is de		SLIM[12:0]						
bit 2-1	BSS[1:0]: Bo	oot Segment Co	de Protection	Level bits						
		ection (other tha	in BWRP)							
	10 = Standar 0x = High se	-								
bit 0	-	t Segment Progr	am Write Pro	tection bit						
Situ		gment can be wr								
		gment is write-pr								

x = Bit is unknown

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
—	—	—	—	—	—	_	—	
bit 23							bit 16	
U-1	U-1	U-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	
—	—	—			BSLIM[12:8]			
bit 15							bit 8	
R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	
			BSLI	M[7:0]				
bit 7							bit 0	
Legend:		PO = Prograr	n Once bit					
R = Readable	e bit	W = Writable	bit	U = Unimplemented bit, read as '0'				

REGISTER 27-2: FBSLIM CONFIGURATION REGISTER

'1' = Bit is set

bit 23-13 Unimplemented: Read as '1'

-n = Value at POR

bit 12-0 BSLIM[12:0]: Active Boot Segment Code Flash Page Address Limit (inverted) bits

This bit field contains the last active Boot Segment Page + 1 (i.e., first page address of GS). The value is stored as an inverted page address, such that programming additional '0's can only increase the size of BS. If the BSLIM[12:0] bits are set to all '1's (unprogrammed default), the active Boot Segment size is zero.

'0' = Bit is cleared

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
	—	—	—	—	—	—	—	
bit 23							bit 16	
r-0	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
—	—	—	—	—	—	—	—	
bit 15							bit 8	
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
—	—	—	—	—	—	—	—	
bit 7							bit 0	
Legend:	Legend: PO = Program Once bit			r = Reserved bit				
R = Readable	R = Readable bit W = Writable bit			U = Unimplemented bit, read as '0'				
-n = Value at I	POR	'1' = Bit is set		'0' = Bit is cleared x = Bit is unknow			iown	

REGISTER 27-3: FSIGN CONFIGURATION REGISTER

bit 23-16 Unimplemented: Read as '1'

bit 15 Reserved: Maintain as '0'

bit 14-0 Unimplemented: Read as '1'

	REGISTER 27-4:	FOSCSEL	CONFIGURATION REGISTER
--	----------------	---------	------------------------

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 23							bit 16

U-1	U-1	U-1	U-1	U-1	U-1	r-0	r-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
IESO	PLLMODE3	PLLMODE2	PLLMODE1	PLLMODE0	FNOSC2	FNOSC1	FNOSC0
bit 7							bit 0

Legend:	PO = Program Once bit	r = Reserved bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 23-10	Unimplemented: Read as '1'
bit 9-8	Reserved: Maintain as '0'
bit 7	IESO: Two-Speed Oscillator Start-up Enable bit 1 = Starts up the device with FRC, then automatically switches to the user-selected oscillator when ready 0 = Starts up the device with the user-selected oscillator source
bit 6-3	PLLMODE[3:0]: Frequency Multiplier Select bits 1111 = No PLL is used (PLLEN bit is unavailable) 1110 = 8x PLL is selected 1101 = 6x PLL is selected 1100 = 4x PLL is selected 0111 = 96 MHz PLL is selected (Input Frequency = 48 MHz) 0110 = 96 MHz PLL is selected (Input Frequency = 32 MHz) 0101 = 96 MHz PLL is selected (Input Frequency = 24 MHz) 0100 = 96 MHz PLL is selected (Input Frequency = 20 MHz) 0101 = 96 MHz PLL is selected (Input Frequency = 16 MHz) 0011 = 96 MHz PLL is selected (Input Frequency = 12 MHz) 0010 = 96 MHz PLL is selected (Input Frequency = 8 MHz) 0001 = 96 MHz PLL is selected (Input Frequency = 4 MHz)
bit 2-0	 0000 = 96 MHz PLL is selected (Input Frequency = 4 MHz) FNOSC[2:0]: Oscillator Selection bits 111 = Oscillator with Frequency Divider (OSCFDIV) 110 = Reserved 101 = Low-Power RC Oscillator (LPRC) 100 = Secondary Oscillator (SOSC) 011 = Primary Oscillator with PLL (XTPLL, HSPLL, ECPLL) 010 = Primary Oscillator (XT, HS, EC) 001 = Fast RC Oscillator with PLL (FRCPLL) 000 = Fast RC Oscillator (FRC)

REGISTER 27-5: FOSC CONFIGURATION REGISTER

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
_	—		—	—	—	—	—
bit 23							bit 16
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	_	_	—	—	—	—	—
bit 15							bit 8
R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
FCKSM1	FCKSM0	IOL1WAY	PLLSS	SOSCSEL	OSCIOFNC	POSCMD1	POSCMD0
bit 7							bit 0

Legend:	PO = Program Once bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	1 as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 23-8	Unimplemented: Read as '1'
bit 7-6	FCKSM[1:0]: Clock Switching and Monitor Selection bits
	 1x = Clock switching and the Fail-Safe Clock Monitor are disabled 01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled 00 = Clock switching and the Fail-Safe Clock Monitor are enabled
bit 5	IOL1WAY: Peripheral Pin Select Configuration bit
	 1 = The IOLOCK bit can be set only once (with unlock sequence). 0 = The IOLOCK bit can be set and cleared as needed (with unlock sequence)
bit 4	PLLSS: PLL Secondary Selection Configuration bit
	This Configuration bit only takes effect when the PLL is NOT being used by the system (i.e., not selected as part of the system clock source). Used to generate an independent clock out of REFO. 1 = PLL is fed by the Primary Oscillator 0 = PLL is fed by the on-chip Fast RC (FRC) Oscillator
bit 3	SOSCSEL: SOSC Selection Configuration bit
	1 = Crystal (SOSCI/SOSCO) mode 0 = Digital (SCLKI) Externally Supplied Clock mode
bit 2	OSCIOFNC: CLKO Enable Configuration bit
	 1 = CLKO output signal is active on the OSCO pin (when the Primary Oscillator is disabled or configured for EC mode) 0 = CLKO output is disabled
bit 1-0	POSCMD[1:0]: Primary Oscillator Configuration bits
	 11 = Primary Oscillator mode is disabled 10 = HS Oscillator mode is selected (10 MHz-32 MHz) 01 = XT Oscillator mode is selected (1.5 MHz-10 MHz) 00 = External Clock mode is selected

REGISTER 27-6: FWDT CONFIGURATION REGISTER

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 23							bit 16

U-1	R/PO-1	R/PO-1	U-1	R/PO-1	U-1	R/PO-1	R/PO-1
	WDTCLK1	WDTCLK0		WDTCMX		WDTWIN1	WDTWIN0
bit 15							bit 8

R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
WINDIS	FWDTEN1	FWDTEN0	FWPSA	WDTPS3	WDTPS2	WDTPS1	WDTPS0
bit 7		•					bit 0

Legend:	PO = Program Once bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 23-15	Unimplemented: Read as '1'
bit 14-13	WDTCLK[1:0]: Watchdog Timer Clock Select bits (when WDTCMX = 1)

- 11 = Always uses LPRC
- 10 = Uses FRC when WINDIS = 0, system clock is not LPRC and device is not in Sleep; otherwise, uses LPRC
- 01 = Always uses SOSC
- 00 = Uses peripheral clock when system clock is not LPRC and device is not in Sleep; otherwise, uses LPRC
- bit 12 Unimplemented: Read as '1'
- bit 11 WDTCMX: WDT Clock MUX Control bit
 - 1 = Enables WDT clock MUX, WDT clock is selected by WDTCLK[1:0]
 - 0 = WDT clock is LPRC
- bit 10 Unimplemented: Read as '1'
- bit 9-8 WDTWIN[1:0]: Watchdog Timer Window Width bits
 - 11 = WDT window is 25% of the WDT period
 - 10 = WDT window is 37.5% of the WDT period
 - 01 = WDT window is 50% of the WDT period
 - 00 = WDT window is 75% of the WDT period
- bit 7 WINDIS: Windowed Watchdog Timer Disable bit 1 = Windowed WDT is disabled
 - 0 = Windowed WDT is enabled
- bit 6-5 **FWDTEN[1:0]:** Watchdog Timer Enable bits

11 = WDT is enabled

- 10 = WDT is disabled (control is placed on the SWDTEN bit)
- 01 = WDT is enabled only while device is active and disabled in Sleep; SWDTEN bit is disabled
- 00 = WDT and SWDTEN are disabled

bit 4 **FWPSA:** Watchdog Timer Prescaler bit

- 1 = WDT prescaler ratio of 1:128
- 0 = WDT prescaler ratio of 1:32

REGISTER 27-6: FWDT CONFIGURATION REGISTER (CONTINUED)

bit 3-0 WDTPS[3:0]: Watchdog Timer Postscale Select bits 1111 = 1:32,768 1110 = 1:16,384 1101 = 1:8,192 1100 = 1:4,096 1011 = 1:2,048 1010 = 1:1,024 1001 = 1:512 1000 = 1:256 0111 = 1:128 0110 = 1:64 0101 = 1:32

0100 **= 1:16**

0011 **= 1:8**

0010 **= 1:4**

0001 = 1:2 0000 = 1:1

	_			-			
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
	—	_	_	—	—	_	—
bit 23							bit 16
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
_	—	—	_	—	—	—	—
bit 15							bit 8
U-1	U-1	U-1	U-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
—	—	—	—	DNVPEN	LPCFG	BOREN1	BOREN0
bit 7							bit 0
Legend:		PO = Progran	n Once bit				
R = Readable	e bit	W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at POR		'1' = Bit is set		'0' = Bit is cleared		x = Bit is unknown	
bit 23-4	3-4 Unimplemented: Read as '1'						
bit 3	DNVPEN: Do	wnside Voltage	Protection Er	nable bit			

- $\ensuremath{\mathtt{1}}$ = Downside protection is enabled when BOR is inactive
- 0 = Downside protection is disabled when BOR is inactive
- bit 2 LPCFG: Low-Power Regulator Control bit
 - 1 = Retention feature is not available
 - 0 = Retention feature is available and controlled by RETEN during Sleep

bit 1-0 BOREN[1:0]: Brown-out Reset Enable bits

- 11 = Brown-out Reset is enabled in hardware; SBOREN bit is disabled
- 10 = Brown-out Reset is enabled only while device is active and is disabled in Sleep; SBOREN bit is disabled
- 01 = Brown-out Reset is controlled with the SBOREN bit setting
- 00 = Brown-out Reset is disabled in hardware; SBOREN bit is disabled

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	_
bit 23							bit 16
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
	_	_	_	—	_		_
bit 15							bit 8
r-1	U-1	R/PO-0	U-1	U-1	U-1	R/PO-1	R/PO-1
	_	JTAGEN	_	—	_	ICS1	ICS0
bit 7							bit 0
Legend:		PO = Progran	n Once bit	r = Reserved I	bit		

REGISTER 27-8: FICD CONFIGURATION REGISTER

Legend:	PO = Program Once bit r = Reserved bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 23-8	Unimplemented: Read as '1'
bit 7	Reserved: Maintain as '1'
bit 6	Unimplemented: Read as '1'
bit 5	JTAGEN: JTAG Port Enable bit
	1 = JTAG port is enabled0 = JTAG port is disabled
bit 4-2	Unimplemented: Read as '1'
bit 1-0	ICS[1:0]: ICD Communication Channel Select bits

11 = Communicates on PGC1/PGD1

10 = Communicates on PGC2/PGD2

01 = Communicates on PGC3/PGD3

00 = Reserved; do not use

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 23							bit 16

R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	
			DMTIV	′T[15:8]				
bit 15 bit 8								

R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
			DMTI	VT[7:0]			
bit 7							bit 0

Legend:	PO = Program Once bit	PO = Program Once bit				
R = Readable bit	W = Writable bit	U = Unimplemented bit,	, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 23-16 Unimplemented: Read as '1'

bit 15-0 DMTIVT[15:0]: DMT Window Interval Lower 16 bits

REGISTER 27-10: FDMTIVTH CONFIGURATION REGISTER

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 23							bit 16

R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
DMTIVT[31:24]							
bit 15							bit 8

R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
			DMTIV	T[23:16]			
bit 7							bit 0

Legend:	PO = Program Once bit				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 23-16 Unimplemented: Read as '1'

bit 15-0 DMTIVT[31:16]: DMT Window Interval Higher 16 bits

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
_	_	—		—	—	—	—
bit 23							bit 16
R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
			DMTC	NT[15:8]			
bit 15							bit 8
R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
			DMTC	NT[7:0]			
bit 7							bit 0
Legend:		PO = Progran	n Once bit				
R = Readable	e bit	W = Writable	bit	U = Unimplem	nented bit, read	d as '0'	
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	וown
bit 23-16	Unimplemen	ted: Read as '	,				
bit 15-0	DMTCNT[15:	0]: DMT Instruc	ction Count Tir	ne-out Value Lo	ower 16 bits		

REGISTER 27-11: FDMTCNTL CONFIGURATION REGISTER

REGISTER 27-12: FDMTCNTH CONFIGURATION REGISTER

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 23							bit 16

R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1		
			DMTCN	IT[31:24]					
bit 15							bit 8		
R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1		
	DMTCNT[23:16]								
bit 7							bit 0		

Legend:	PO = Program Once bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 23-16 **Unimplemented:** Read as '1'

bit 15-0 DMTIVT[31:16]: DMT Instruction Count Time-out Value Higher 16 bits

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
—	—					—	—	
bit 23							bit 16	
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1	
	—	—	—			—	—	
bit 15							bit 8	
U-1	U-1	U-1	U-1	U-1	U-1	U-1	R/PO-1	
	—	—	—	—		—	DMTDIS	
bit 7							bit 0	
Legend:		PO = Progran	n Once bit					
R = Readable bit		W = Writable	bit	U = Unimplemented bit, read as '0'				
-n = Value at POR		'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unknown		

REGISTER 27-13: FDMT CONFIGURATION REGISTER

bit 23-1 Unimplemented: Read as '1'

bit 0 DMTDIS: DMT Disable bit

1 = DMT is disabled

0 = DMT is enabled

REGISTER 27-14: FDEVOPT1 CONFIGURATION REGISTER

-									
U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1		
_						—	—		
bit 23	bi						bit 16		
U-1	U-1	U-1 U-1		U-1 R/PO-1		U-1	U-1		
	—				SMB3EN ⁽²⁾	—	—		
bit 15	it 15								
U-1	U-1	U-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	U-1		
	—	_	ALTI2C1	SOSCHP	TMPRPIN	ALTCMPI	_		
bit 7		·	•			•	bit 0		
Legend:	Legend: PO = Program Once bit								
R = Readabl	e bit	W = Writable	bit	U = Unimplen	nented bit, read	l as '0'			
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clea	ared	x = Bit is unkr	nown		
-									
bit 23-11	bit 23-11 Unimplemented: Read as '1'								
bit 10	SMB3EN: SMBus 3.0 Levels Enable bit ⁽²⁾								
	1 = SMBus 3.								
	0 = Normal I²	C input levels							
bit 9-5	Unimplemented: Read as '1'								
bit 4	ALTI2C1: Alte	ernate I2C1 bit							
	1 = SDA1 and SCL1 on RG2 and RG3 0 = ASDA1 and ASCL1 on RB5 and RB4								
1.11.0					0000051	`			
bit 3				alid only when	SOSCSEL = 1)			
		gh-Power mod		e Section 9.10	.3 "Low-Powe	r SOSC Opera	tion" for more		
	 SOSC Low-Power mode is enabled (see Section 9.10.3 "Low-Power SOSC Operation" for more information) 								
bit 2	TMPRPIN: Ta	imper Pin Enat	ole bit						
	1 = TMPRN pin function is disabled								
	0 = TMPRN pin function is enabled								
bit 1	ALTCMPI: Alternate Comparator Input Enable bit								
	1 = C2INC and C3INC are on their standard pin locations								
0 = C2INC and C3INC are on RG7 ⁽¹⁾									
bit 0 Unimplemented: Read as '1'									
Note 1: R	G7 is used for m	nultiple functior	ns, but only one	e use case is al	llowable.				
Note 1: RG7 is used for multiple functions, but only one use case is allowable.									

2: SMBus mode is enabled by the SMEN bit (I2CxCONL[8]).

		Bit															
Address	Name	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FF0000h	DEVID		FAMID[7:0]						DEV	EV[7:0]							
FF0002h	DEVREV		— REV[3:0]														

TABLE 27-3: PIC24FJ CORE DEVICE ID REGISTERS

TABLE 27-4:DEVICE ID BIT FIELDDESCRIPTIONS

Bit Field	Register	Description
FAMID[7:0]	DEVID	Encodes the family ID of the device; FAMID = 0x22.
DEV[7:0]	DEVID	Encodes the individual ID of the device.
REV[3:0]	DEVREV	Encodes the sequential (numerical) revision identifier of the device.

TABLE 27-5: PIC24FJ128GL306 FAMILY DEVICE IDs

Device	DEVID
PIC24FJ128GL306	0x220E
PIC24FJ64GL306	0x2206
PIC24FJ128GL305	0x220C
PIC24FJ64GL305	0x2204
PIC24FJ128GL303	0x220A
PIC24FJ64GL303	0x2202
PIC24FJ128GL302	0x2208
PIC24FJ64GL302	0x2200

27.2 Unique Device Identifier (UDID)

All PIC24FJ128GL306 family devices are individually encoded during final manufacturing with a Unique Device Identifier, or UDID. The UDID cannot be erased by a bulk erase command or any other user-accessible means. This feature allows for manufacturing traceability of Microchip Technology devices in applications where this is a requirement. It may also be used by the application manufacturer for any number of things that may require unique identification, such as:

- · Tracking the device
- Unique serial number
- Unique security key

The UDID comprises five 24-bit program words. When taken together, these fields form a unique 120-bit identifier.

The UDID is stored in five read-only locations, located between 0x801600 and 0x801608 in the device configuration space. Table 27-6 lists the addresses of the Identifier Words and shows their contents.

UDID	Address	Description			
UDID1	0x801600	UDID Word 1			
UDID2	0x801602	UDID Word 2			
UDID3	0x801604	UDID Word 3			
UDID4	0x801606	UDID Word 4			
UDID5	0x801608	UDID Word 5			

TABLE 27-6: UDID ADDRESSES

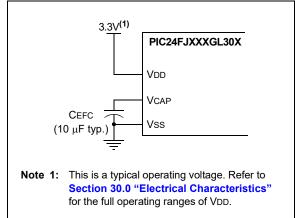
27.3 On-Chip Voltage Regulator

All PIC24FJ128GL306 family devices power their core digital logic at a nominal 1.8V. This may create an issue for designs that are required to operate at a higher typical voltage, such as 3.3V. To simplify system design, all devices in the PIC24FJ128GL306 family incorporate an on-chip regulator that allows the device to run its core logic from VDD.

This regulator is always enabled. It provides a constant voltage (1.8V nominal) to the digital core logic, from a VDD of about 2.1V, all the way up to the device's VDDMAX. It does not have the capability to boost VDD levels. In order to prevent brown-out conditions when the voltage drops too low for the regulator, the Brown-out Reset occurs. Then, the regulator output follows VDD with a typical voltage drop of 300 mV.

A low-ESR capacitor (such as ceramic) must be connected to the VCAP pin (Figure 27-1). This helps to maintain the stability of the regulator. The recommended value for the filter capacitor (CEFC) is provided in Section 30.1 "DC Characteristics".

FIGURE 27-1: CONNECTIONS FOR THE ON-CHIP REGULATOR



27.3.1 ON-CHIP REGULATOR AND POR

The voltage regulator takes approximately 10 µs for it to generate output. During this time, designated as TVREG, code execution is disabled. TVREG is applied every time the device resumes operation after any power-down, including Sleep mode. TVREG is determined by the status of the VREGS bit (RCON[8]) and the WDTWIN[1:0] Configuration bits (FWDT[9:8]). Refer to Section 30.0 "Electrical Characteristics" for more information on TVREG.

Note: For more information, see Section 30.0 "Electrical Characteristics". The information in this data sheet supersedes the information in the FRM.

27.3.2 VOLTAGE REGULATOR STANDBY MODE

The on-chip regulator always consumes a small incremental amount of current over IDD/IPD, including when the device is in Sleep mode, even though the core digital logic does not require power. To provide additional savings in applications where power resources are critical, the regulator can be made to enter Standby mode, on its own, whenever the device goes into Sleep mode. This feature is controlled by the VREGS bit (RCON[8]). Clearing the VREGS bit enables the Standby mode. When waking up from Standby mode, the regulator needs to wait for TVREG to expire before wake-up.

27.3.3 LOW-VOLTAGE RETENTION REGULATOR

When in Sleep mode, PIC24FJ128GL306 family devices may use a separate low-power, low-voltage retention regulator to power critical circuits. This regulator, which operates at 1.2V nominal, maintains power to data RAM and the RTCC, while all other core digital logic is powered down. The low-voltage retention regulator is described in more detail in Section 10.2.4 "Low-Voltage Retention Regulator".

27.4 Watchdog Timer (WDT)

For PIC24FJ128GL306 family devices, the WDT is driven by the LPRC Oscillator, the Secondary Oscillator (SOSC) or the system timer. When the device is in Sleep mode, the LPRC Oscillator will be used. When the WDT is enabled, the clock source is also enabled.

The nominal WDT clock source from LPRC is 32 kHz. This feeds a prescaler that can be configured for either 5-bit (divide-by-32) or 7-bit (divide-by-128) operation. The prescaler is set by the FWPSA Configuration bit. With a 32 kHz input, the prescaler yields a nominal WDT Time-out (TWDT) period of 1 ms in 5-bit mode or 4 ms in 7-bit mode.

A variable postscaler divides down the WDT prescaler output and allows for a wide range of time-out periods. The postscaler is controlled by the WDTPS[3:0] Configuration bits (FWDT[3:0]), which allow the selection of a total of 16 settings, from 1:1 to 1:32,768. Using the prescaler and postscaler time-out periods, ranges from 1 ms to 131 seconds can be achieved.

The WDT, prescaler and postscaler are reset:

- On any device Reset
- On the completion of a clock switch, whether invoked by software (i.e., setting the OSWEN bit after changing the NOSCx bits) or by hardware (i.e., Fail-Safe Clock Monitor)
- When a PWRSAV instruction is executed (i.e., Sleep or Idle mode is entered)
- When the device exits Sleep or Idle mode to resume normal operation
- By a CLRWDT instruction during normal execution

If the WDT is enabled, it will continue to run during Sleep or Idle modes. When the WDT time-out occurs, the device will wake the device and code execution will continue from where the PWRSAV instruction was executed. The corresponding SLEEP or IDLE (RCON[3:2]) bits will need to be cleared in software after the device wakes up. The WDT Time-out Flag bit, WDTO (RCON[4]), is not automatically cleared following a WDT time-out. To detect subsequent WDT events, the flag must be cleared in software.

Note: The CLRWDT and PWRSAV instructions clear the prescaler and postscaler counts when executed.

27.4.1 WINDOWED OPERATION

The Watchdog Timer has an optional Fixed Window mode of operation. In this Windowed mode, CLRWDT instructions can only reset the WDT during the last 1/4 of the programmed WDT period. A CLRWDT instruction executed before that window causes a WDT Reset, similar to a WDT time-out.

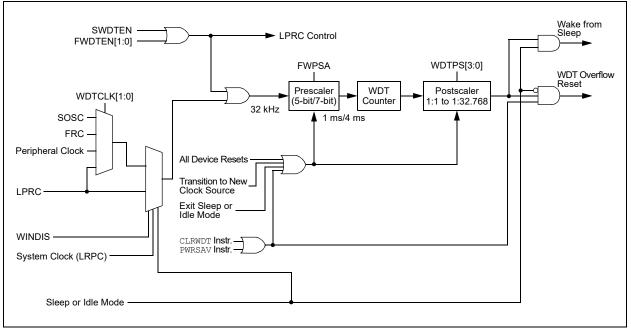
Windowed WDT mode is enabled by programming the WINDIS Configuration bit (FWDT[7]) to '0'.

27.4.2 CONTROL REGISTER

The WDT is enabled or disabled by the FWDTEN[1:0] Configuration bits (FWDT[6:5]). When the Configuration bits, FWDTEN[1:0] = 11, the WDT is always enabled.

The WDT can be optionally controlled in software when the Configuration bits, FWDTEN[1:0] = 10. When FWDTEN[1:0] = 00, the Watchdog Timer is always disabled. The WDT is enabled in software by setting the SWDTEN control bit (RCON[5]). The SWDTEN control bit is cleared on any device Reset. The software WDT option allows the user to enable the WDT for critical code segments and disable the WDT during non-critical code segments for maximum power savings.





27.5 Program Verification and Code Protection

PIC24FJ128GL306 family devices offer basic implementation of CodeGuard[™] Security that supports General Segment (GS) security and Boot Segment (BS) security. This feature helps protect individual intellectual property.

Note:	For more information on usage, con-
	figuration and operation, refer to
	"CodeGuard™ Intermediate Security"
	(www.microchip.com/DS70005182) in the
	"dsPIC33/PIC24 Family Reference
	Manual".

27.6 JTAG Interface

PIC24FJ128GL306 family devices implement a JTAG interface, which supports boundary scan device testing.

27.7 In-Circuit Serial Programming™

PIC24FJ128GL306 family microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock (PGCx) and data (PGDx), and three other lines for power (VDD), ground (VSS) and MCLR. This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

27.8 Customer OTP Memory

PIC24FJ128GL306 family devices provide 256 bytes of One-Time-Programmable (OTP) memory, located at addresses, 801700h through 8017FEh. This memory can be used for persistent storage of application-specific information that will not be erased by reprogramming the device. This includes many types of information, such as (but not limited to):

- · Application checksums
- Code revision information
- Product information
- · Serial numbers
- System manufacturing dates
- Manufacturing lot numbers

Customer OTP memory may be programmed in any mode, including user RTSP mode, but it cannot be erased. Data are not cleared by a chip erase.

Note:	Do not write the OTP memory more than
	once. Writing to the OTP memory more
	than once may result in an ECC Double-Bit
	Error (ECCDBE).

27.9 In-Circuit Debugger

This function allows simple debugging functions when used with MPLAB[®] X IDE. Debugging functionality is controlled through the PGCx (Emulation/Debug Clock) and PGDx (Emulation/Debug Data) pins.

To use the in-circuit debugger function of the device, the design must implement $ICSP^{TM}$ connections to \overline{MCLR} , VDD, Vss and the PGCx/PGDx pin pair, designated by the ICS[1:0] Configuration bits. In addition, when the feature is enabled, some of the resources are not available for general use. These resources include the first 80 bytes of data RAM and two I/O pins. NOTES:

28.0 INSTRUCTION SET SUMMARY

Note: This chapter is a brief summary of the PIC24F Instruction Set Architecture (ISA) and is not intended to be a comprehensive reference source.

The PIC24F instruction set adds many enhancements to the previous PIC[®] MCU instruction sets, while maintaining an easy migration from previous PIC MCU instruction sets. Most instructions are a single program memory word. Only three instructions require two program memory locations.

Each single-word instruction is a 24-bit word divided into an 8-bit opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction. The instruction set is highly orthogonal and is grouped into four basic categories:

- Word or byte-oriented operations
- Bit-oriented operations
- · Literal operations
- Control operations

Table 28-1 shows the general symbols used in describing the instructions. The PIC24F instruction set summary in Table 28-2 lists all the instructions, along with the status flags affected by each instruction.

Most word or byte-oriented W register instructions (including barrel shift instructions) have three operands:

- The first source operand, which is typically a register, 'Wb', without any address modifier
- The second source operand, which is typically a register, 'Ws', with or without an address modifier
- The destination of the result, which is typically a register, 'Wd', with or without an address modifier

However, word or byte-oriented file register instructions have two operands:

- The file register specified by the value, 'f'
- The destination, which could either be the file register, 'f', or the W0 register, which is denoted as 'WREG'

Most bit-oriented instructions (including simple rotate/ shift instructions) have two operands:

- The W register (with or without an address modifier) or file register (specified by the value of 'Ws' or 'f')
- The bit in the W register or file register (specified by a literal value or indirectly by the contents of register, 'Wb')

The literal instructions that involve data movement may use some of the following operands:

- A literal value to be loaded into a W register or file register (specified by the value of 'k')
- The W register or file register where the literal value is to be loaded (specified by 'Wb' or 'f')

However, literal instructions that involve arithmetic or logical operations use some of the following operands:

- The first source operand, which is a register, 'Wb', without any address modifier
- The second source operand, which is a literal value
- The destination of the result (only if not the same as the first source operand), which is typically a register, 'Wd', with or without an address modifier

The control instructions may use some of the following operands:

- · A program memory address
- The mode of the Table Read and Table Write instructions

All instructions are a single word, except for certain double-word instructions, which were made double-word instructions so that all the required information is available in these 48 bits. In the second word, the 8 MSbs are '0's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

Most single-word instructions are executed in a single instruction cycle, unless a conditional test is true or the Program Counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles, with the additional instruction cycle(s) executed as a NOP. Notable exceptions are the BRA (unconditional/computed branch), indirect CALL/GOTO, all Table Reads and Table Writes, and RETURN/RETFIE instructions, which are single-word instructions but take two or three cycles.

Certain instructions that involve skipping over the subsequent instruction require either two or three cycles if the skip is performed, depending on whether the instruction being skipped is a single-word or two-word instruction. Moreover, double-word moves require two cycles. The double-word instructions execute in two instruction cycles.

TABLE 28-1: SYMBOLS USED IN OPCODE DESCRIPTIONS

Field	Description
#text	Means literal defined by "text"
(text)	Means "content of text"
[text]	Means "the location addressed by text"
{ }	Optional field or operation
[n:m]	Register bit field
.b	Byte mode selection
.d	Double-Word mode selection
.S	Shadow register select
.W	Word mode selection (default)
bit4	4-bit Bit Selection field (used in word addressed instructions) $\in \{015\}$
C, DC, N, OV, Z	MCU Status bits: Carry, Digit Carry, Negative, Overflow, Sticky Zero
Expr	Absolute address, label or expression (resolved by the linker)
f	File register address ∈ {0000h1FFFh}
lit1	1-bit unsigned literal $\in \{0,1\}$
lit4	4-bit unsigned literal $\in \{015\}$
lit5	5-bit unsigned literal ∈ {031}
lit8	8-bit unsigned literal ∈ {0255}
lit10	10-bit unsigned literal ∈ {0255} for Byte mode, {01023} for Word mode
lit14	14-bit unsigned literal ∈ {016383}
lit16	16-bit unsigned literal ∈ {065535}
lit23	23-bit unsigned literal ∈ {08388607}; LSb must be '0'
None	Field does not require an entry, may be blank
PC	Program Counter
Slit10	10-bit signed literal ∈ {-512511}
Slit16	16-bit signed literal ∈ {-3276832767}
Slit6	6-bit signed literal ∈ {-1616}
Wb	Base W register ∈ {W0W15}
Wd	Destination W register ∈ { Wd, [Wd], [Wd++], [Wd], [++Wd], [Wd] }
Wdo	Destination W register ∈ { Wnd, [Wnd], [Wnd++], [Wnd], [++Wnd], [Wnd], [Wnd+Wb] }
Wm,Wn	Dividend, Divisor Working register pair (direct addressing)
Wn	One of 16 Working registers ∈ {W0W15}
Wnd	One of 16 destination Working registers ∈ {W0W15}
Wns	One of 16 source Working registers ∈ {W0W15}
WREG	W0 (Working register used in file register instructions)
Ws	Source W register ∈ { Ws, [Ws], [Ws++], [Ws], [++Ws], [Ws] }
Wso	Source W register ∈ { Wns, [Wns], [Wns++], [Wns], [++Wns], [Wns], [Wns+Wb] }

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
ADD	ADD	f	f = f + WREG	1	1	C, DC, N, OV, Z
	ADD	f,WREG	WREG = f + WREG	1	1	C, DC, N, OV, Z
	ADD	#lit10,Wn	Wd = lit10 + Wd	1	1	C, DC, N, OV, Z
	ADD	Wb,Ws,Wd	Wd = Wb + Ws	1	1	C, DC, N, OV, Z
	ADD	Wb,#lit5,Wd	Wd = Wb + lit5	1	1	C, DC, N, OV, Z
ADDC	ADDC	f	f = f + WREG + (C)	1	1	C, DC, N, OV, Z
	ADDC	f,WREG	WREG = f + WREG + (C)	1	1	C, DC, N, OV, Z
	ADDC	#lit10,Wn	Wd = lit10 + Wd + (C)	1	1	C, DC, N, OV, Z
	ADDC	Wb,Ws,Wd	Wd = Wb + Ws + (C)	1	1	C, DC, N, OV, Z
	ADDC	Wb,#lit5,Wd	Wd = Wb + Iit5 + (C)	1	1	C, DC, N, OV, Z
AND	AND	f	f = f .AND. WREG	1	1	N, Z
	AND	f,WREG	WREG = f .AND. WREG	1	1	N, Z
	AND	#lit10,Wn	Wd = lit10 .AND. Wd	1	1	N, Z
	AND	Wb,Ws,Wd	Wd = Wb .AND. Ws	1	1	N, Z
	AND	Wb,#lit5,Wd	Wd = Wb .AND. lit5	1	1	N, Z
ASR	ASR	f	f = Arithmetic Right Shift f	1	1	C, N, OV, Z
	ASR	f,WREG	WREG = Arithmetic Right Shift f	1	1	C, N, OV, Z
	ASR	Ws,Wd	Wd = Arithmetic Right Shift Ws	1	1	C, N, OV, Z
	ASR	Wb,Wns,Wnd	Wnd = Arithmetic Right Shift Wb by Wns	1	1	N, Z
	ASR	Wb,#lit5,Wnd	Wnd = Arithmetic Right Shift Wb by lit5	1	1	N, Z
BCLR	BCLR	f,#bit4	Bit Clear f	1	1	None
	BCLR	Ws,#bit4	Bit Clear Ws	1	1	None
BRA	BRA	C,Expr	Branch if Carry	1	1 (2)	None
-	BRA	GE,Expr	Branch if Greater Than or Equal	1	1 (2)	None
	BRA	GEU, Expr	Branch if Unsigned Greater Than or Equal	1	1 (2)	None
	BRA	GT,Expr	Branch if Greater Than	1	1 (2)	None
	BRA	GTU, Expr	Branch if Unsigned Greater Than	1	1 (2)	None
	BRA	LE,Expr	Branch if Less Than or Equal	1	1 (2)	None
	BRA	LEU, Expr	Branch if Unsigned Less Than or Equal	1	1 (2)	None
	BRA	LT,Expr	Branch if Less Than	1	1 (2)	None
	BRA	LTU, Expr	Branch if Unsigned Less Than	1	1 (2)	None
	BRA	N,Expr	Branch if Negative	1	1 (2)	None
	BRA	NC,Expr	Branch if Not Carry	1	1 (2)	None
	BRA	NN, Expr	Branch if Not Negative	1	1 (2)	None
	BRA	NOV, Expr	Branch if Not Overflow	1	1 (2)	None
	BRA	NZ,Expr	Branch if Not Zero	1	1 (2)	None
	BRA	OV,Expr	Branch if Overflow	1	1 (2)	None
	BRA	Expr	Branch Unconditionally	1	2	None
	BRA	Z,Expr	Branch if Zero	1	1 (2)	None
	BRA	Wn	Computed Branch	1	2	None
BSET	BSET	f,#bit4	Bit Set f	1	1	None
DODI	BSET	Ws,#bit4	Bit Set Ws	1	1	None
BSW	BSW.C	Ws, Wb	Write C bit to Ws[Wb]	1	1	None
	BSW.C	Ws,Wb	Write Z bit to Ws[Wb]	1	1	None
BTG	BSW.Z BTG		Bit Toggle f	1	1	None
510		f,#bit4		1	1	None
BTSC	BTG BTSC	Ws,#bit4 f,#bit4	Bit Toggle Ws Bit Test f, Skip if Clear	1	1 (2 or 3)	None
	BTSC	Ws,#bit4	Bit Test Ws, Skip if Clear	1	(2 or 3) 1 (2 or 3)	None

TABLE 28-2:	INSTRUCTION SET	OVERVIEW
		••••••••

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
BTSS	BTSS	f,#bit4	Bit Test f, Skip if Set	1	1 (2 or 3)	None
	BTSS	Ws,#bit4	Bit Test Ws, Skip if Set	1	1 (2 or 3)	None
BTST	BTST	f,#bit4	Bit Test f	1	1	Z
	BTST.C	Ws,#bit4	Bit Test Ws to C	1	1	С
	BTST.Z	Ws,#bit4	Bit Test Ws to Z	1	1	Z
	BTST.C	Ws,Wb	Bit Test Ws[Wb] to C	1	1	С
	BTST.Z	Ws,Wb	Bit Test Ws[Wb] to Z	1	1	Z
BTSTS	BTSTS	f,#bit4	Bit Test then Set f	1	1	Z
	BTSTS.C	Ws,#bit4	Bit Test Ws to C, then Set	1	1	С
	BTSTS.Z	Ws,#bit4	Bit Test Ws to Z, then Set	1	1	Z
CALL	CALL	lit23	Call Subroutine	2	2	None
	CALL	Wn	Call Indirect Subroutine	1	2	None
CLR	CLR	f	f = 0x0000	1	1	None
	CLR	WREG	WREG = 0x0000	1	1	None
	CLR	Ws	Ws = 0x0000	1	1	None
CLRWDT	CLRWDT		Clear Watchdog Timer	1	1	WDTO, Sleep
COM	СОМ	f	$f = \overline{f}$	1	1	N, Z
	COM	f,WREG	WREG = f	1	1	N, Z
			$Wd = \overline{Ws}$	1	1	N, Z
~~	COM	Ws,Wd		1	1	,
CP	CP	f	Compare f with WREG			C, DC, N, OV, Z
	CP	Wb,#lit5	Compare Wb with lit5	1	1	C, DC, N, OV, Z
	CP	Wb,Ws	Compare Wb with Ws (Wb – Ws)	1	1	C, DC, N, OV, Z
CP0	CP0	f	Compare f with 0x0000	1	1	C, DC, N, OV, Z
	CP0	Ws	Compare Ws with 0x0000	1	1	C, DC, N, OV, Z
CPB	CPB	f	Compare f with WREG, with Borrow	1	1	C, DC, N, OV, Z
	CPB	Wb,#lit5	Compare Wb with lit5, with Borrow	1	1	C, DC, N, OV, Z
	CPB	Wb,Ws	Compare Wb with Ws, with Borrow $(Wb - Ws - \overline{C})$	1	1	C, DC, N, OV, Z
CPSEQ	CPSEQ	Wb,Wn	Compare Wb with Wn, Skip if =	1	1 (2 or 3)	None
CPSGT	CPSGT	Wb,Wn	Compare Wb with Wn, Skip if >	1	1 (2 or 3)	None
CPSLT	CPSLT	Wb,Wn	Compare Wb with Wn, Skip if <	1	1 (2 or 3)	None
CPSNE	CPSNE	Wb,Wn	Compare Wb with Wn, Skip if ≠	1	1 (2 or 3)	None
DAW	DAW.B	Wn	Wn = Decimal Adjust Wn	1	1	С
DEC	DEC	f	f = f -1	1	1	C, DC, N, OV, Z
	DEC	f,WREG	WREG = f –1	1	1	C, DC, N, OV, Z
	DEC	Ws,Wd	Wd = Ws - 1	1	1	C, DC, N, OV, Z
DEC2	DEC2	f	f = f - 2	1	1	C, DC, N, OV, Z
	DEC2	f,WREG	WREG = f – 2	1	1	C, DC, N, OV, Z
	DEC2	Ws,Wd	Wd = Ws - 2	1	1	C, DC, N, OV, Z
DISI	DISI	#lit14	Disable Interrupts for k Instruction Cycles	1	1	None
DIV	DIV.SW	Wm,Wn	Signed 16/16-bit Integer Divide	1	18	N, Z, C, OV
	DIV.SD	Wm,Wn	Signed 32/16-bit Integer Divide	1	18	N, Z, C, OV
	DIV.UW	Wm,Wn	Unsigned 16/16-bit Integer Divide	1	18	N, Z, C, OV
	DIV.UD	Wm,Wn	Unsigned 32/16-bit Integer Divide	1	18	N, Z, C, OV
EXCH	EXCH	Wns,Wnd	Swap Wns with Wnd	1	1	None
FF1L	FF1L	Ws,Wnd	Find First One from Left (MSb) Side	1	1	С
FF1R	FF1R	Ws,Wnd	Find First One from Right (LSb) Side	1	1	С

TABLE 28-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
GOTO	GOTO	Expr	Go to Address	2	2	None
	GOTO	Wn	Go to Indirect	1	2	None
INC	INC	f	f = f + 1	1	1	C, DC, N, OV, Z
	INC	f,WREG	WREG = f + 1	1	1	C, DC, N, OV, Z
	INC	Ws,Wd	Wd = Ws + 1	1	1	C, DC, N, OV, Z
INC2	INC2	f	f = f + 2	1	1	C, DC, N, OV, Z
	INC2	f,WREG	WREG = f + 2	1	1	C, DC, N, OV, Z
	INC2	Ws,Wd	Wd = Ws + 2	1	1	C, DC, N, OV, Z
IOR	IOR	f	f = f .IOR. WREG	1	1	N, Z
	IOR	f,WREG	WREG = f .IOR. WREG	1	1	N, Z
	IOR	#lit10,Wn	Wd = lit10 .IOR. Wd	1	1	N, Z
	IOR		Wd = Wb .IOR. Ws	1	1	N, Z
	IOR		Wd = Wb .IOR. lit5	1	1	N, Z
LNK	LNK		Link Frame Pointer	1	1	None
LSR	LSR	f	f = Logical Right Shift f	1	1	C, N, OV, Z
	LSR		WREG = Logical Right Shift f	f.IOR. WREG 1 1 1 I.OR. Wd 1 1 1 I.OR. Ws 1 1 1 I.OR. lit5 1 1 1 I.OR. Solution 1 1 1 I.OR. lit5 1 1 1 I.Ogical Right Shift Ws Ws 1 1 gical Right Shift Wb by Wns 1 1 1 gical Right Shift Wb by Ilt5 1 1 1 Wn 1 1 1 1 whee Solit10 to Wnd 1 1 1 1 vit Literal to Wn 1 1 1 1	C, N, OV, Z	
				1	1	C, N, OV, Z
			0 0			
			Description Words Cycles Go to Address 2 2 Non Go to Indirect 1 2 Non if =f+1 1 1 C, D WREG = f+1 1 1 C, D Wd = Ws +1 1 1 C, D WREG = f+2 1 1 C, D Wd = Ws +2 1 1 N, Z Wd = Ws +2 1 1 N, Z Wd = Ws -1, OR, WREG 1 1 N, Z Wd = Wb I.OR, WREG 1 1 N, Z Wd = Wb I.OR, WS 1 1 N, Z Wd = Wb I.OR, IIS 1 1 N, Z Wd = Wb I.OR, WS 1 1 C, N Wd = Usgical Right Shift f 1 1 N, Z Wd = Wb I.OR, IIS 1 1 N, Z Wd = Logical Right Shift Wb by Wns 1 1 N, Z Word = Logical Right Shift Wb by Wns 1 1 N, Z <			
MOV						None
						None
					1 1 N 1 1 N 1 1 N 1 1 N 1 1 N	-
-						
MUL						
	MUL.US					
	MUL.UU					None
						None
	GOTOWnINCfINCf,WREGINCWs,WdINC2fINC2f,WREGINC2Ws,WdIORfIORf,WREGIOR#lit10,WnIORWb,Ws,WdIORWb,Hlit5,WdLNK#lit14LSRfLSRWs,WdISRWb,#lit5,WndLSRWb,Hlit5,WndLSRWb,#lit5,WndMOVf,WnMOVf,WnMOVf,WREGMOVf,WREGMOVf,WREGMOVf,WREGMOVf,WREGMOVf,WREGMOVf,WREGMOVwn,fMOVWns,[Wns+Slit10],WndMOVWso,WdoMOVWso,WdoMOVWso,WdoMOVWso,WdoMOVWs,WndMUL.SSWb,Ws,WndMUL.SUWb,Ws,WndMUL.USWb,Ws,Wnd				None	
	MUL	f		1	1	None
NEG	NEG	f	$f = \overline{f} + 1$	1	1	C, DC, N, OV, Z
	NEG	f,WREG	WREG = f + 1	1	1	C, DC, N, OV, Z
	NEG	Ws,Wd	$Wd = \overline{Ws} + 1$	1	1	C, DC, N, OV, 2
NOP	NOP		No Operation	1	1	None
	NOPR		No Operation	1	1	None
POP	POP	f	Pop f from Top-of-Stack (TOS)	1	1	None
	POP	Wdo	Pop from Top-of-Stack (TOS) to Wdo	1	1	None
	POP.D	Wnd	Pop from Top-of-Stack (TOS) to W(nd):W(nd+1)	1	2	None
			Pop Shadow Registers	1	1	All
PUSH		f	Push f to Top-of-Stack (TOS)	1	1	None
			,	1	1	None
			,			None
						None

TABLE 28-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
PWRSAV	PWRSAV	#lit1	Go into Sleep or Idle mode	1	1	WDTO, Sleep
RCALL	RCALL	Expr	Relative Call	1	2	None
	RCALL	Wn	Computed Call	1	2	None
REPEAT	REPEAT	#lit14	Repeat Next Instruction lit14 + 1 Times	1	1	None
	REPEAT	Wn	Repeat Next Instruction (Wn) + 1 Times	1	1	None
RESET	RESET		Software Device Reset	1	1	None
RETFIE	RETFIE		Return from Interrupt	1	3 (2)	None
RETLW	RETLW	#lit10,Wn	Return with Literal in Wn	1	3 (2)	None
RETURN	RETURN		Return from Subroutine	1	3 (2)	None
RLC	RLC	f	f = Rotate Left through Carry f	1	1	C, N, Z
	RLC	f,WREG	WREG = Rotate Left through Carry f	1	1	C, N, Z
	RLC	Ws,Wd	Wd = Rotate Left through Carry Ws	1	1	C, N, Z
RLNC	RLNC	f	f = Rotate Left (No Carry) f	1	1	N, Z
	RLNC	f,WREG	WREG = Rotate Left (No Carry) f	1	1	N, Z
	RLNC	Ws,Wd	Wd = Rotate Left (No Carry) Ws	1	1	N, Z
RRC	RRC	f	f = Rotate Right through Carry f	1	1	C, N, Z
	RRC	f,WREG	WREG = Rotate Right through Carry f	1	1	C, N, Z
	RRC	Ws,Wd	Wd = Rotate Right through Carry Ws	1	1	C, N, Z
RRNC	RRNC	f	f = Rotate Right (No Carry) f	1	1	N, Z
	RRNC	f,WREG	WREG = Rotate Right (No Carry) f	1	1	N, Z
	RRNC	Ws,Wd	Wd = Rotate Right (No Carry) Ws	1	1	N, Z
SE	SE	Ws, Wnd	Wnd = Sign-Extended Ws	1	1	C, N, Z
SETM	SETM	f	f = FFFFh	1	1	None
	SETM	WREG	WREG = FFFFh	1	1	None
	SETM	Ws	Ws = FFFFh	1	1	None
SL	SL	f	f = Left Shift f	1	1	C, N, OV, Z
	SL	f,WREG	WREG = Left Shift f	1	1	C, N, OV, Z
	SL	Ws,Wd	Wd = Left Shift Ws	1	1	C, N, OV, Z
	SL	Wb,Wns,Wnd	Wnd = Left Shift Wb by Wns	1	1	N, Z
	SL	Wb,#lit5,Wnd	Wnd = Left Shift Wb by lit5	1	1	N, Z
SUB	SUB	f	f = f - WREG	1	1	C, DC, N, OV, Z
	SUB	f,WREG	WREG = f – WREG	1	1	C, DC, N, OV, Z
	SUB	#lit10,Wn	Wn = Wn - lit10	1	1	C, DC, N, OV, Z
	SUB	Wb,Ws,Wd	Wd = Wb – Ws	1	1	C, DC, N, OV, Z
	SUB	Wb,#lit5,Wd	Wd = Wb – lit5	1	1	C, DC, N, OV, Z
SUBB	SUBB	f	$f = f - WREG - (\overline{C})$	1	1	C, DC, N, OV, Z
000			$WREG = f - WREG - (\overline{C})$		1	
	SUBB	f,WREG		1		C, DC, N, OV, Z
	SUBB	#lit10,Wn	Wn = Wn - Iit10 - (C)	1	1	C, DC, N, OV, Z
	SUBB	Wb,Ws,Wd	Wd = Wb - Ws - (C)	1	1	C, DC, N, OV, Z
	SUBB	Wb,#lit5,Wd	$Wd = Wb - lit5 - (\overline{C})$	1	1	C, DC, N, OV, Z
SUBR	SUBR	f	f = WREG – f	1	1	C, DC, N, OV, Z
	SUBR	f,WREG	WREG = WREG – f	1	1	C, DC, N, OV, Z
	SUBR	Wb,Ws,Wd	Wd = Ws – Wb	1	1	C, DC, N, OV, Z
	SUBR	Wb,#lit5,Wd	Wd = lit5 – Wb	1	1	C, DC, N, OV, Z
SUBBR	SUBBR	f	$f = WREG - f - (\overline{C})$	1	1	C, DC, N, OV, Z
	SUBBR	f,WREG	WREG = WREG – f – (\overline{C})	1	1	C, DC, N, OV, Z
	SUBBR	Wb,Ws,Wd	$Wd = Ws - Wb - (\overline{C})$	1	1	C, DC, N, OV, Z
	SUBBR	Wb,#lit5,Wd	$Wd = lit5 - Wb - (\overline{C})$	1	1	C, DC, N, OV, Z
SWAP	SWAP.b	Wn	Wn = Nibble Swap Wn	1	1	None
	SWAP	Wn	Wn = Byte Swap Wn	1	1	None

TABLE 28-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
TBLRDH	TBLRDH	Ws,Wd	Read Prog[23:16] to Wd[7:0]	1	2	None
TBLRDL	TBLRDL	Ws,Wd	Read Prog[15:0] to Wd	1	2	None
TBLWTH	TBLWTH	Ws,Wd	Write Ws[7:0] to Prog[23:16]	1	2	None
TBLWTL	TBLWTL	Ws,Wd	Write Ws to Prog[15:0]	1	2	None
ULNK	ULNK		Unlink Frame Pointer	1	1	None
XOR	XOR	f	f = f .XOR. WREG	1	1	N, Z
	XOR	f,WREG	WREG = f .XOR. WREG	1	1	N, Z
	XOR	#lit10,Wn	Wd = lit10 .XOR. Wd	1	1	N, Z
	XOR	Wb,Ws,Wd	Wd = Wb .XOR. Ws	1	1	N, Z
	XOR	Wb,#lit5,Wd	Wd = Wb .XOR. lit5	1	1	N, Z
ZE	ZE	Ws,Wnd	Wnd = Zero-Extend Ws	1	1	C, Z, N

TABLE 28-2: INSTRUCTION SET OVERVIEW (CONTINUED)

NOTES:

29.0 DEVELOPMENT SUPPORT

Move a design from concept to production in record time with Microchip's award-winning development tools. Microchip tools work together to provide state of the art debugging for any project with easy-to-use Graphical User Interfaces (GUIs) in our free MPLAB[®] X and Atmel Studio Integrated Development Environments (IDEs), and our code generation tools. Providing the ultimate ease-of-use experience, Microchip's line of programmers, debuggers and emulators work seamlessly with our software tools. Microchip development boards help evaluate the best silicon device for an application, while our line of third party tools round out our comprehensive development tool solutions.

Microchip's MPLAB X and Atmel Studio ecosystems provide a variety of embedded design tools to consider, which support multiple devices, such as PIC^{\circledast} MCUs, AVR^{\circledast} MCUs, SAM MCUs and $dsPIC^{\circledast}$ DSCs. MPLAB X tools are compatible with Windows[®], Linux[®] and Mac[®] operating systems while Atmel Studio tools are compatible with Windows.

Go to the following website for more information and details:

https://www.microchip.com/development-tools/

NOTES:

30.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of the PIC24FJ128GL306 family electrical characteristics. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC24FJ128GL306 family are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these, or any other conditions above the parameters indicated in the operation listings of this specification, is not implied.

Absolute Maximum Ratings^(†)

Ambient temperature under bias	40°C to +125°C
Storage temperature	
Voltage on VDD with respect to Vss	
Voltage on any general purpose digital or analog pin (not 5.5V tolerant) with respect to Vss	
Voltage on any general purpose digital or analog pin (5.5V tolerant, including MCLR) with r	
When $V_{DD} = 0V$:	•
When $V_{DD} \ge 2.0V$:	
Voltage on AVDD with respect to Vss	
Voltage on AVss with respect to Vss	(
Maximum current out of Vss pin:	
+85°C	300 mA
+125°C	
Maximum current into VDD pin (Note 1):	
+85°C	300 mA
+125°C	
Maximum output current sunk by any I/O pin:	
RB15. RC15	
All other I/Os	
Maximum output current sourced by any I/O pin:	
RB15, RC15	
All other I/Os	
Maximum current sunk by group of I/Os between two Vss Pins (Note 2):	
+85°C	
+125°C	
Maximum current sourced by group of I/Os between two VDD pins (Note 2):	
+85°C	300 mA
+125°C	
	-
Note 1: Maximum allowable current is a function of device maximum power dissipation (· · · · ·
2: Only on the 28-lead and 36-lead packages can AVDD/AVss be considered for gr	ouping of I/Os.

NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

30.1 DC Characteristics

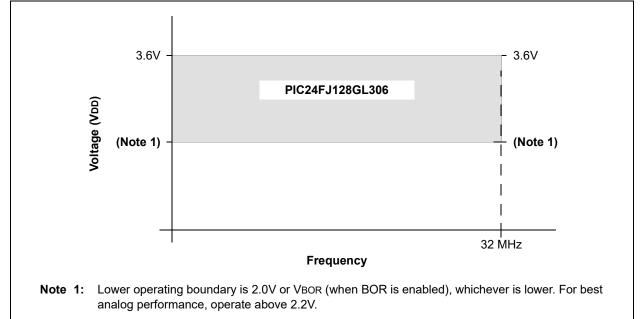


FIGURE 30-1: PIC24FJ128GL306 FAMILY VOLTAGE-FREQUENCY GRAPH (INDUSTRIAL)

TABLE 30-1: THERMAL OPERATING CONDITIONS

Rating	Symbol	Min	Тур	Max	Unit
PIC24FJ128GL306:					
Operating Junction Temperature Range	TJ	-40	—	+135	°C
Operating Ambient Temperature Range	TA	-40	—	+125	°C
Power Dissipation: Internal Chip Power Dissipation: $P_{INT} = V_{DD} x (IDD - \Sigma IOH)$ I/O Pin Power Dissipation:	PD	PINT + PI/O		W	
$PI/O = \Sigma (\{VDD - VOH\} x IOH) + \Sigma (VOL x IOL)$ Maximum Allowed Power Dissipation	PDMAX	(TJ – TA)/θJA			W

TABLE 30-2: THERMAL PACKAGING CHARACTERISTICS

Characteristic	Symbol	Тур	Мах	Unit	Notes
Package Thermal Resistance, 6x6 mm 28-Pin QFN	θJA	38.4		°C/W	(Note 1)
Package Thermal Resistance, 4x4x0.6 mm 28-Pin UQFN	θJA	38.7	_	°C/W	(Note 1)
Package Thermal Resistance, 7.50 mm 28-Pin SOIC	θJA	79.0	—	°C/W	(Note 1)
Package Thermal Resistance, 5.30 mm 28-Pin SSOP	θJA	67.1	_	°C/W	(Note 1)
Package Thermal Resistance, 5x5 mm 36-Pin UQFN	θJA	35.4	_	°C/W	(Note 1)
Package Thermal Resistance, 6x6x0.5 mm 48-Pin UQFN	θJA	28.3	—	°C/W	(Note 1)
Package Thermal Resistance, 7x7x1 mm 48-Pin TQFP	θJA	71.0	_	°C/W	(Note 1)
Package Thermal Resistance, 9x9x0.9 mm 64-Pin QFN	θJA	23.0	_	°C/W	(Note 1)
Package Thermal Resistance, 10x10x1 mm 64-Pin TQFP	θJA	68.9	—	°C/W	(Note 1)

Note 1: Junction to ambient thermal resistance; Theta-JA (θ JA) numbers are achieved by package simulations.

TABLE 30-3: TEMPERATURE AND VOLTAGE SPECIFICATIONS

-	Dperating Conditions:2.0V to 3.6V (unless otherwise stated) Dperating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended										
Param No.	Symbol	Characteristic	Min	Тур	yp Max U		Conditions				
Operati	ng Volta	ge									
DC10	Vdd	Supply Voltage	2.0		3.6	V	BOR is disabled				
			VBOR	_	3.6	V	BOR is enabled				
DC16	VPOR	VDD Start Voltage to Ensure Internal Power-on Reset Signal	Vss	_	—	V	(Note 1)				
DC17A	SVDD	Recommended VDD Rise Rate to Ensure Internal Power-on Reset Signal	1V/20 ms	_	1V/10 µS	sec	(Notes 1 and 3)				
DC17B	VBOR	Brown-out Reset Voltage on VDD Transition, High-to-Low	1.95	2.1	2.2	V	(Note 2)				

Note 1: If the VPOR or SVDD parameters are not met, or the application experiences slow power-down VDD ramp rates, it is recommended to enable and use BOR.

2: On a rising VDD power-up sequence, application firmware execution begins at the higher of the VPORREL or VBOR level (when BOREN = 1).

3: VDD rise times outside this window may not internally reset the processor and are not parametrically tested.

TABLE 30-4: OPERATING CURRENT (IDD)

Operating Conditions: Operating temperature		$-40^{\circ}C \le TA$	2.0V to 3.6V (unless otherwise stated) -40°C \leq TA \leq +85°C for Industrial -40°C \leq TA \leq +125°C for Extended							
Parameter No.	Typical ⁽¹⁾			Operating Temperature	VDD	Conditions				
Operating C	urrent (IDD)	(3)		· · · ·						
DC19	208.8	350	μA	40°C to 1425°C	2.0V	0.5 MIPS,				
	215.4	350	μA	40°C to +125°C	3.3V	Fosc = 1 MHz				
DC20	362.3	550	μA	-40°C to +125°C	2.0V	1 MIPS,				
	366.4	550	μA	-40 C 10 + 125 C	3.3V	Fosc = 2 MHz				
DC23	1.3	1.6	mA	-40°C to +125°C	2.0V	4 MIPS,				
	1.35	1.6	mA	-40 C 10 + 125 C	3.3V	Fosc = 8 MHz				
DC24	5	6.2	mA	-40°C to +125°C	2.0V	16 MIPS,				
	5.1	6.2	mA	-40 C 10 +125 C	3.3V	Fosc = 32 MHz				
DC31	41.5	130	μA	-40°C to +85°C	2.0V					
	47.4	130	μA	-40 C 10 +65 C	3.3V	LPRC (16 KIPS),				
	55.5	310	μA	40°C to 1125°C	2.0V	Fosc = 32 kHz				
	61.9	310	μA	40°C to +125°C	3.3V					
DC32	1.34	1.7	mA	-40°C to +125°C	2.0V	FRC (4 MIPS),				
	1.35	1.7	mA		3.3V	Fosc = 8 MHz				

Note 1: Data in the "Typical" column are at 3.3V, +25°C unless otherwise stated. Typical parameters are for design guidance only and are not tested.

- **2:** Data in "Max" column are production tested.
- 3: Base IDD current is measured with:
 - Oscillator is configured in EC mode without PLL (FNOSC[2:0] (FOSCSEL[2:0]) = 010, PLLMODE[3:0] (FOSCSEL[6:3]) = 1111 and POSCMOD[1:0] (FOSC[1:0]) = 00)
 - OSCI pin is driven with external square wave, with levels from 0.3V to VDD 0.3V
 - OSCO is configured as an I/O in the Configuration Words (OSCIOFCN (FOSC[2]) = 0)
 - FSCM is disabled (FCKSM[1:0] (FOSC[7:6]) = 11)
 - Secondary Oscillator circuit is disabled (SOSCSEL (FOSC[3]) = 0)
 - Main and low-power BOR circuits are disabled (BOREN[1:0] (FPOR[1:0]) = 00 and LPBOREN (FPOR[3]) = 0)
 - Watchdog Timer is disabled (FWDTEN[1:0] (FWDT[6:5]) = 00)
 - All I/O pins (except OSCI) are configured as outputs and driving low
 - No peripheral modules are operating or being clocked (defined PMDx bits are all ones)
 - JTAG is disabled (JTAGEN (FICD[5]) = 0)
 - NOP instructions are executed

Operating Conditions: Operating temperature		2.0V to 3.6V -40°C ≤ TA ≤ -40°C ≤ TA ≤	+85°C for Inc			
Parameter No.	Typical ⁽¹⁾	Max ⁽²⁾	Units	Operating Temperature	Vdd	Conditions
Idle Current (lidle) ⁽³⁾					
DC40	110	250	μA	40°C to 105°C	2.0V	
	121.3	250	μA	40°C to +85°C	3.3V	1 MIPS,
	130.2	325	μA	-40°C to +125°C	2.0V	Fosc = 2 MHz
	130.2	325	μA	-40 C to +125 C	3.3V	
DC43	329.7	500	μA	-40°C to +85°C	2.0V	
	357.5	500	μA		3.3V	4 MIPS,
	350	600	μA	-40°C to +125°C	2.0V	Fosc = 8 MHz
	370.9	600	μA	-40 C 10 + 125 C	3.3V	
DC47	1.2	1.8	mA	-40°C to +85°C	2.0V	
	1.3	1.8	mA		3.3V	16 MIPS,
	1.22	1.9	mA	-40°C to +125°C	2.0V	Fosc = 32 MHz
	1.31	1.9	mA	-40 C 10 + 125 C	3.3V	
DC50	369.6	550	μA	-40°C to +85°C	2.0V	
	375.1	550	μA		3.3V	FRC (4 MIPS),
	382.9	650	μA	-40°C to +125°C	2.0V	Fosc = 8 MHz
	388.9	650	μA		3.3V	
DC51	37.5	110	μA	-40°C to +85°C	2.0V	
	43.3	110	μA		3.3V	LPRC (16 KIPS),
	50.8	300	μA	40°C to +125°C	2.0V	Fosc = 32 kHz
	57.1	300	μA	40°C to +125°C	3.3V	

TABLE 30-5: IDLE CURRENT (IIDLE)

Note 1: Data in the "Typical" column are at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

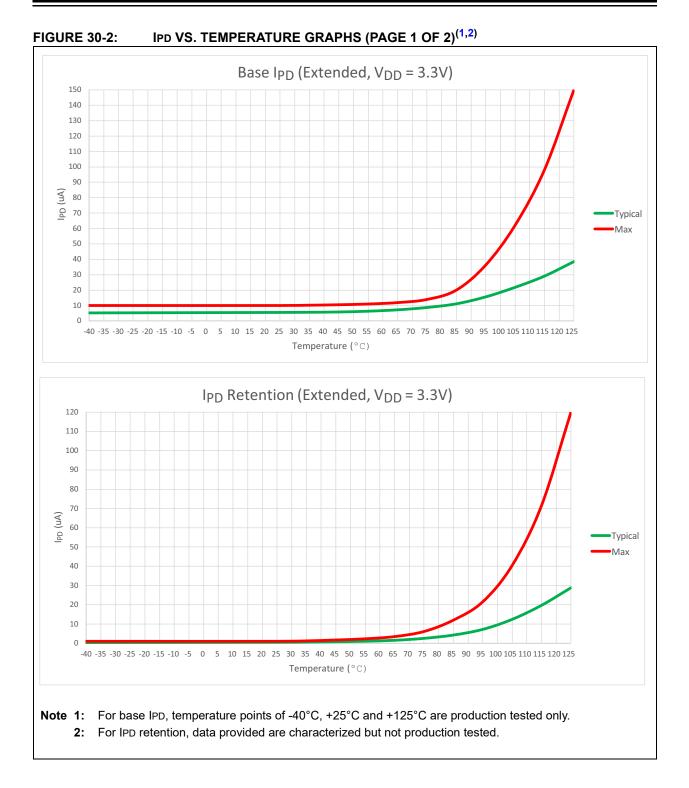
- 2: Data in "Max" column are production tested.
- 3: Base IIDLE current is measured with:
 - Oscillator is configured in EC mode without PLL (FNOSC[2:0] (FOSCSEL[2:0]) = 010, PLLMODE[3:0] (FOSCSEL[6:3]) = 1111 and POSCMOD[1:0] (FOSC[1:0]) = 00)
 - + OSCI pin is driven with external square wave, with levels from 0.3V to $\mathsf{VDD}-0.3\mathsf{V}$
 - OSCO is configured as an I/O in Configuration Words (OSCIOFCN (FOSC[2]) = 0)
 - FSCM is disabled (FCKSM[1:0] (FOSC[7:6]) = 11)
 - Secondary Oscillator circuit is disabled (SOSCSEL (FOSC[3]) = 0)
 - Main and low-power BOR circuits are disabled (BOREN[1:0] (FPOR[1:0]) = 00 and LPBOREN (FPOR[3]) = 0)
 - Watchdog Timer is disabled (FWDTEN[1:0] (FWDT[6:5]) = 00)
 - All I/O pins (except OSCI) are configured as outputs and driving low
 - No peripheral modules are operating or being clocked (defined PMDx bits are all ones)
 - JTAG is disabled (JTAGEN (FICD[5]) = 0)
 - pwrsav #1 (IDLE) instruction is executed

TABLE 30-6: POWER-DOWN CURRENT (IPD)

Operating (Operating te		-40°C ≤	Ta ≤ +85°C	otherwise stated for Industrial C for Extended)					
Parameter No.	Typical ⁽¹⁾	Max ⁽²⁾	Units	Operating Temperature	Vdd	Conditions				
Power-Dov	vn Current ^{(\$}	5, <mark>6</mark>)								
DC60	3.47	10	μA	-40°C						
	4.31	10	μA	+25°C	2.0V					
	9.93	20	μA	+85°C						
	38.79	150	μA	+125°C		Sleep ⁽³⁾				
	3.72	10	μA	-40°C						
	4.6	10	μA	+25°C	2 2)/					
	10.27	20	μA	+85°C	3.3V					
	39.45	150	μA	+125°C						
DC61	272.7	Note 7	nA	-40°C						
	450	Note 7	nA	+25°C	2.0V					
	4.5	Note 7	μA	+85°C	2.00					
	28.7	Note 7	μA	+125°C		– Low-Voltage Retention Sleep ⁽⁴⁾				
	336	Note 7	nA	-40°C						
	460	Note 7	nA	+25°C	0.01/					
	4.5	Note 7	μA	+85°C	3.3V					
	29	Note 7	μA	+125°C						

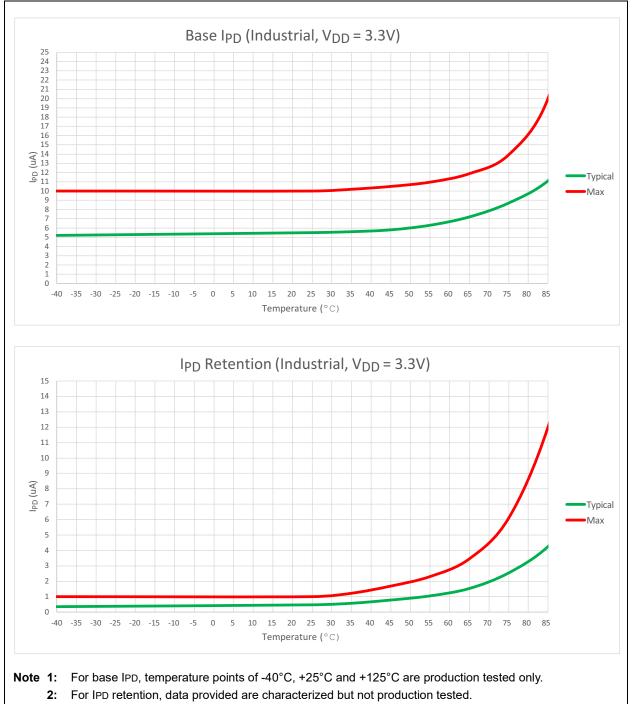
Note 1: Data in the "Typical" column are at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

- 2: Data in "Max" column are production tested.
- 3: The retention low-voltage regulator is disabled; RETEN (RCON[12]) = 0, LPCFG (FPOR[2]) = 1.
- 4: The retention low-voltage regulator is enabled; RETEN (RCON[12]) = 1, LPCFG (FPOR[2]) = 0.
- 5: Base IPD current is measured with:
 - Oscillator is configured in FRC mode without PLL (FNOSC[2:0] (FOSCSEL[2:0]) = 000, PLLMODE[3:0] (FOSCSEL[6:3]) = 1111 and POSCMOD[1:0] (FOSC[1:0]) = 11)
 - OSCO is configured as an I/O in Configuration Words (OSCIOFCN (FOSC[2]) = 0)
 - FSCM is disabled (FCKSM[1:0] (FOSC[7:6]) = 11)
 - Secondary Oscillator circuit is disabled (SOSCSEL (FOSC[3]) = 0)
 - Main and low-power BOR circuits are disabled (BOREN[1:0] (FPOR[1:0]) = 00 and LPBOREN (FPOR[3]) = 0)
 - Watchdog Timer is disabled (FWDTEN[1:0] (FWDT[6:5]) = 00)
 - All I/O pins are configured as outputs and driving low
 - No peripheral modules are operating or being clocked (defined PMDx bits are all ones)
 - JTAG is disabled (JTAGEN (FICD[5]) = 0)
 - pwrsav #0 (SLEEP) instruction is executed
- 6: These currents are measured on the device containing the most memory in this family.
- 7: For design guidance, please refer to Figure 30-2 and Figure 30-3.



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Operating Co Operating terr	perature	2.0V to 3.6V -40°C ≤ TA ≤ -40°C ≤ TA ≤	+85°C for Ir					
Parameter No.	Typical ⁽¹⁾	Max Units		Operating Temperature	VDD	Conditions		
Incremental (Current Brow	wn-out Rese	t (∆BOR) ⁽²⁾					
DC70	1.3	5	μA	-40°C to +85°C	2.0V			
	2	5	μA	40 C 10 +65 C	3.3V	∆BOR ⁽²⁾		
	1.5	10	μA	-40°C to +125°C	2.0V			
	2.1	10	μA	-40 C 10 + 125 C	3.3V			
Incremental (Current Wate	chdog Timer	' (∆WDT) ⁽²⁾					
DC71	0.27	1	μA	40°C to +85°C	2.0V			
	0.35	1	μA	-40 C 10 +65 C	3.3V	_∆WDT ⁽²⁾		
	0.55	5	μA	40°C to +125°C	2.0V			
	0.6	5	μA	-40 C 10 + 125 C	3.3V			
Incremental (Current High	n/Low-Voltag	e Detect (Δ	HLVD) ⁽²⁾				
DC72	1.9	5	μA	40°C to +85°C	2.0V			
	2.6	5	μA	-40 C 10 705 C	3.3V			
	2.6	10	μA	40°C to +125°C	2.0V			
	3.3	10	μA	-40 0 10 1 125 0	3.3V			
Incremental (Current ADC	(∆ADC) ⁽²⁾				-		
DC73	379.6	700	μA	40°C to +85°C	2.0V			
	522.7	700	μA	-40 C 10 705 C	3.3V	$\Delta ADC^{(2)}$ with internal RC clock		
	398.6	750	μA	40°C to +125°C	2.0V			
	522	750	μA	-40 0 10 1 120 0	3.3V			
Incremental	Current LCD	(∆LCD) ⁽²⁾						
DC74	1.3	12	μA	40°C to +125°C	2.0V	LCD (low-power resistor ladder)		
	1.7	12	μA		3.3V			
DC75	7.8	25	μA	40°C to +125°C	2.0V	LCD (medium power resistor		
	12.2	25	μA	-40 0 10 1 120 0	3.3V	ladder)		
DC76	64.3	140	μA	40°C to +125°C	2.0V	LCD (high-power resistor ladder)		
	105.1	140	μA		3.3V			
DC77	10.2	25 ⁽⁴⁾	μA	40°C to +85°C	2.0V	LCD + Charge Pump (low-power		
	10.2	25 ⁽⁴⁾	μA	10 0 10 .00 0	3.3V	resistor ladder)		
DC78	11.5	45 ⁽⁴⁾	μA	40°C to +125°C	2.0V	LCD + Charge Pump (low-power		
	13.8	45 ⁽⁴⁾	μA		3.3V	resistor ladder)		
DC79	40.1	70 ⁽⁴⁾	μA	40°C to +85°C	2.0V	LCD + Charge Pump (medium		
ŀ	39.2	70 ⁽⁴⁾	μA		3.3V	power resistor ladder)		

TABLE 30-7: \triangle CURRENT (BOR, WDT, HLVD, ADC, LCD, DMT, RTCC)⁽³⁾

Note 1: Data in the "Typical" column are at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Incremental current while the module is enabled and running.

3: The ∆ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current. The current includes the selected clock source enabled for WDT and RTCC.

4: These parameters are characterized but not tested in manufacturing.

Operating Co Operating tem		2.0V to 3.6V (unless otherwise stated) -40°C \leq TA \leq +85°C for Industrial -40°C \leq TA \leq +125°C for Extended						
Parameter No.	Typical ⁽¹⁾ Max Units Temperature			VDD	Conditions			
DC80	43.1	85 ⁽⁴⁾	μA	-40°C to +125°C	2.0V	LCD + Charge Pump (medium		
	42	85 ⁽⁴⁾	μA	40 C 10 + 125 C	3.3V	power resistor ladder)		
DC81	299.2	420 ⁽⁴⁾	μA	-40°C to +85°C	2.0V	LCD + Charge Pump		
	252.8	420 ⁽⁴⁾	μA	-40 C 10 +65 C	3.3V	(high-power resistor ladder)		
DC82	295.5	420 ⁽⁴⁾	μA	-40°C to +125°C	2.0V	LCD + Charge Pump		
	237.6	420 ⁽⁴⁾	μA	-40 C 10 + 125 C	3.3V	(high-power resistor ladder)		
Incremental	Current DM	Г (Δ DMT) ⁽²⁾						
DC83	177.2	1000	nA	-40°C to +85°C	2.0V			
	234.1	1000	nA	-40 C 10 +65 C	3.3V			
	575	1500	nA	-40°C to +125°C	2.0V			
	750	1500	nA	-40 C t0 +125 C	3.3V			
Incremental	Current Rea	I-Time Clock	and Calen	dar (∆RTCC) ⁽²⁾				
DC84	786.4	_	nA	40°C to +125°C	2.0V	∆RTCC (with SOSC enabled in		
	894.6	—	nA	-40 C t0 +125 C	3.3V	Low-Power mode) ⁽²⁾		
DC85	500	1000	nA	-40°C to +85°C	2.0V	△RTCC (with LPRC enabled) ⁽²⁾		
	550	1000	nA	-+0 C 10 +03 C	3.3V			
	570	1300	nA	-40°C to +125°C	2.0V			
	600	1300	nA	-40 0 10 +123 0	3.3V			

TABLE 30-7: Δ CURRENT (BOR, WDT, HLVD, ADC, LCD, DMT, RTCC)⁽³⁾ (CONTINUED)

Note 1: Data in the "Typical" column are at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Incremental current while the module is enabled and running.

3: The Δ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current. The current includes the selected clock source enabled for WDT and RTCC.

4: These parameters are characterized but not tested in manufacturing.

TABLE 30-8: I/O PIN INPUT SPECIFICATIONS
--

	Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended									
Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions			
	VIL	Input Low Voltage ⁽³⁾								
DI10		I/O Pins with ST Buffer	Vss	_	0.2 Vdd	V				
DI11		I/O Pins with TTL Buffer	Vss	_	0.15 Vdd	V				
DI15		MCLR	Vss	_	0.2 Vdd	V				
DI16		OSCI (EC mode)	Vss	_	0.2 Vdd	V				
DI18		I/O Pins with I ² C Buffer	Vss	_	0.3 VDD	V				
DI19		I/O Pins with SMBus Buffer	Vss	_	0.8	V	SMBus is enabled			
	Vih	Input High Voltage ⁽³⁾								
DI20		I/O Pins with ST Buffer: with Analog Functions, Digital Only	0.8 Vdd 0.8 Vdd	_	Vdd 5.5	V V				
DI21		I/O Pins with TTL Buffer: with Analog Functions, Digital Only	0.25 Vdd + 0.8 0.25 Vdd + 0.8		Vdd 5.5	V V				
DI25		MCLR	0.8 VDD	_	Vdd	V				
DI26		OSCI (EC mode)	0.7 Vdd	_	Vdd	V				
DI28		I/O Pins with I ² C Buffer: with Analog Functions, Digital Only	0.7 Vdd 0.7 Vdd	_	Vdd 5.5	V V				
DI29		I/O Pins with SMBus Buffer: with Analog Functions, Digital Only	1.35 1.35	_	Vdd 5.5	V V				
DI30	ICNPU	CNx Pull-up Current	100	_	450	μA	VDD = 3.3V, VPIN = VSS			
DI30A	ICNPD	CNx Pull-Down Current	150	_	550	μA	Vdd = 3.3V, Vpin = Vdd			
DI50	lıL	Input Leakage Current ⁽²⁾ I/O Ports	_	_	±1	μA	$Vss \leq VPIN \leq VDD,$ pin at high-impedance			
DI51		Analog Input Pins	—	_	±1	μA	$Vss \le VPIN \le VDD,$ pin at high-impedance			
DI55		MCLR	—	—	±1	μA	$Vss \leq V \text{PIN} \leq V \text{DD}$			
DI56		OSCI/CLKI	—	—	±1	μA	$\label{eq:VSS} \begin{split} &V{\sf SS} \leq V{\sf PIN} \leq V{\sf DD}, \\ & {\sf EC}, \; {\sf XT} \; {\sf and} \; {\sf HS} \; {\sf modes} \end{split}$			

Note 1: Data in the "Typ" column are at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: Negative current is defined as current sourced by the pin.

3: Refer to Table 1-1 for I/O pin buffer types.

TABLE 30-9: I/O PIN OUTPUT SPECIFICATIONS

-	Dperating Conditions:2.0V to 3.6V (unless otherwise stated) Dperating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended										
Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions				
	Vol	Output Low Voltage									
DO10		I/O Ports	—	—	0.35	V	IOL = 6 mA, VDD = 3.6V				
			—	—	0.7	V	IOL = 18 mA, VDD = 3.6V				
			—	—	0.4	V	IOL = 5.0 mA, VDD = 2V				
DO16		RB15, RC15	—	—	0.35	V	IOL = 9 mA, VDD = 3.6V				
			_	—	0.35	V	IOL = 6 mA, VDD = 2V				
	Vон	Output High Voltage									
DO20		I/O Ports	3.2	—	—	V	ІОН = -6.0 mA, VDD = 3.6V				
			2.7	—	—	V	Іон = -18 mA, VDD = 3.6V				
			1.75	—	—	V	ІОН = -1.0 mA, VDD = 2V				
			0.9	—	—	V	Іон = -10 mA, VDD = 2V				
DO26		RB15, RC15	3.25	—	_	V	ІОН = -6.0 mA, VDD = 3.6V				
			1.75	—	_	V	Іон = -1.0 mA, Vdd = 2V				

Note 1: Data in the "Typ" column are at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

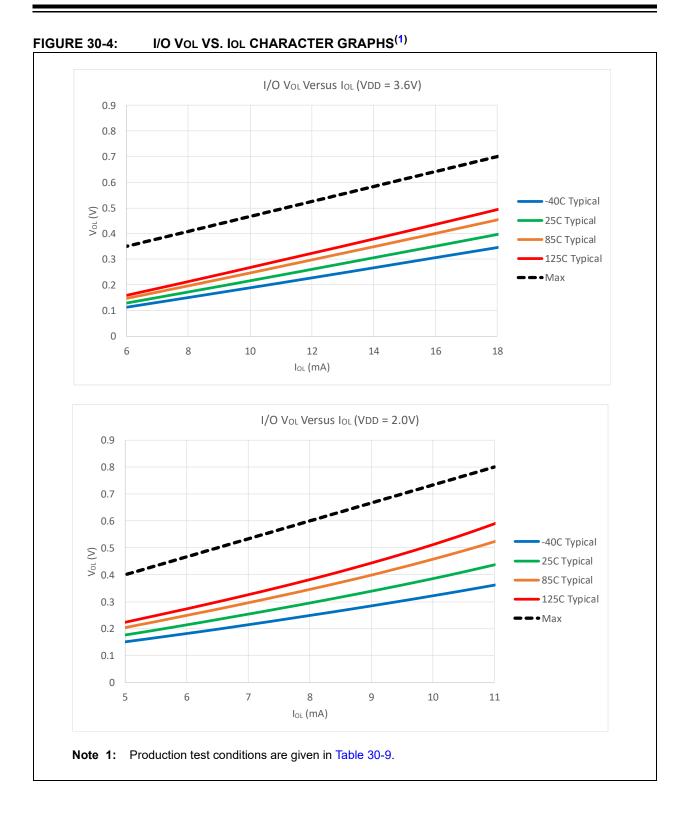
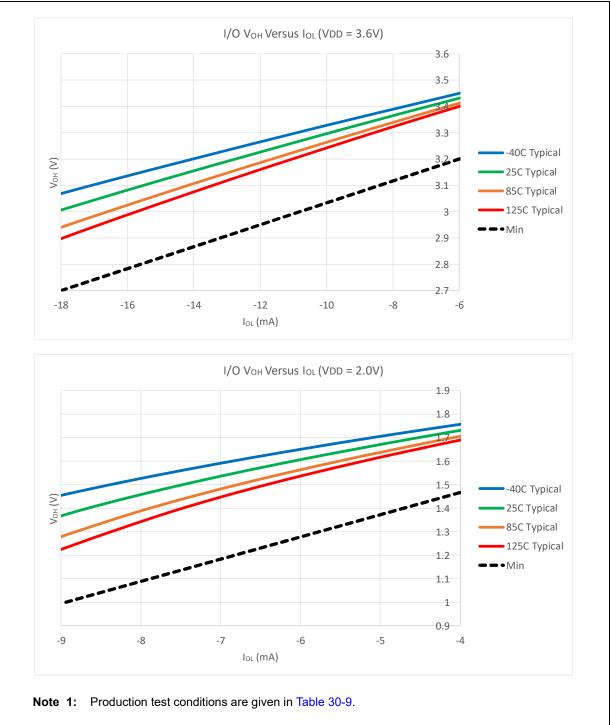
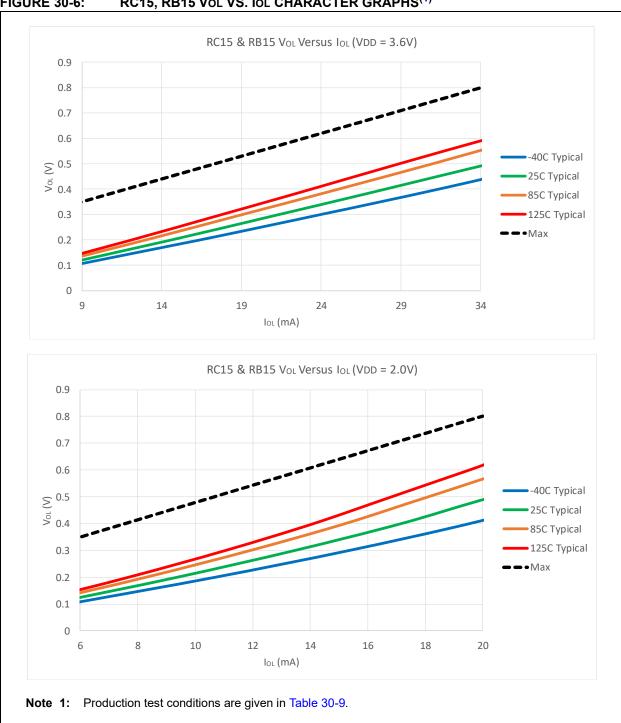
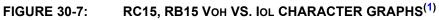


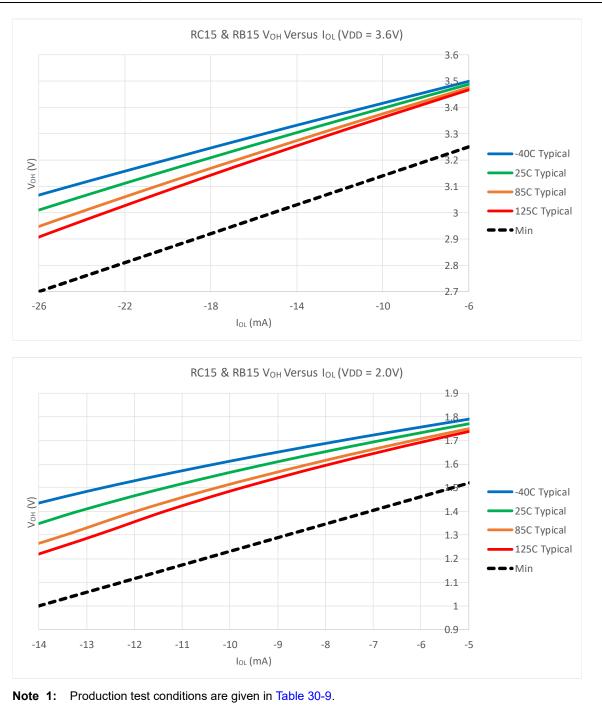
FIGURE 30-5: I/O VOH VS. IOL CHARACTER GRAPHS⁽¹⁾





RC15, RB15 VOL VS. IOL CHARACTER GRAPHS⁽¹⁾ FIGURE 30-6:





•	Deperating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended									
Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Мах	Units	Conditions			
		Program Flash Memory								
D130	Eр	Cell Endurance	10000	—	_	E/W	-40°C to +125°C			
D131	Vpr	VDD for Read	2.0	—	3.6	V				
D132B		VDD for Self-Timed Write	2.0		3.6	V				
D133A	Tiw	Self-Timed Word Write Cycle Time	_	20	—	μs				
		Self-Timed Row Write Cycle Time	—	1.5	—	ms				
D133B	TIE	Self-Timed Page Erase Time	20	—	40	ms				
D134	TRETD	Characteristic Retention	20	—	—	Year	If no other specifications are violated			

TABLE 30-10: PROGRAM MEMORY

Note 1: Data in the "Typ" column are at 3.3V, +25°C unless otherwise stated.

TABLE 30-11: INTERNAL VOLTAGE REGULATOR SPECIFICATIONS

Operatin	$\begin{array}{llllllllllllllllllllllllllllllllllll$										
Param No.	Symbol Characteristics Min I Ivo Max Units			Units	Comments						
DVR	TVREG	Voltage Regulator Start-up Time		10		μs	VREGS = 0 with any POR or BOR				
DVR10	Vbg	Internal Band Gap Reference	1.14	1.2	1.26	V					
DVR11	Tbg	Band Gap Reference Start-up Time	_	1	_	ms					
DVR20	VRGOUT	Regulator Output Voltage	1.6	1.8	2.0	V	Vdd > 1.9V				
DVR21	Cefc	External Filter Capacitor Value	10	_	_	μF	Series resistance < 3Ω recommended; < 5Ω required				
DVR30	Vlvr	Low-Voltage Regulator Output Voltage	0.9	_	1.2	V	RETEN = 1, LPCFG = 0				

TABLE 30-12: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS

Operati	$\begin{array}{llllllllllllllllllllllllllllllllllll$									
Param No.	Symbol	Charac	teristic	Min	Тур	Max	Units	Conditions		
DC18	Vhlvd	HLVD Voltage on VDD	HLVDL[3:0] = 0100 ⁽¹⁾	3.39	—	_	V			
Transition	Transition	HLVDL[3:0] = 0101	3.24	—	—	V				
		HLVDL[3:0] = 0110	2.93	—	3.39	V				
			HLVDL[3:0] = 0111	2.73	—	3.17	V			
			HLVDL[3:0] = 1000	2.62		3.06	V			
			HLVDL[3:0] = 1001	2.39	—	2.8	V			
			HLVDL[3:0] = 1010	2.29		2.68	V			
			HLVDL[3:0] = 1011	2.18		2.56	V			
			HLVDL[3:0] = 1100	2.08		2.45	V			
			HLVDL[3:0] = 1101	1.98		2.34	V			
			HLVDL[3:0] = 1110	1.88		2.23	V			
DC101	VTHL	HLVD Voltage on HLVDIN Pin Transition	HLVDL[3:0] = 1111	_	1.20	—	V			
DC105	TONLVD	HLVD Module Enable T	īme		5	—	μs	From POR or HLVDEN = 1		

Note 1: Trip points for values of HLVD[3:0], from '0000' to '0011', are not implemented.

TABLE 30-13: COMPARATOR DC SPECIFICATIONS

$\begin{array}{llllllllllllllllllllllllllllllllllll$							
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Comments
D300	VIOFF	Input Offset Voltage		12	50	mV	(Note 1)
D301	VICM	Input Common-Mode Voltage	0		Vdd	V	(Note 1)
D302	CMRR	Common-Mode Rejection Ratio	55			dB	(Note 1)
D306	IQCMP	AVDD Quiescent Current per Comparator		27		μA	Comparator is enabled
D307	TRESP	Response Time	_	300		ns	(Note 2)
D308	TMC2OV	Comparator Mode Change to Valid Output	_		10	μs	
D309	IDD	Operating Supply Current	_	30	—	μA	AVDD = 3.3V

Note 1: Parameters are characterized but not tested.

2: Measured with one input at VDD/2 and the other transitioning from Vss to VDD, 40 mV step, 15 mV overdrive.

TABLE 30-14: COMPARATOR VOLTAGE REFERENCE DC SPECIFICATIONS

$\begin{array}{llllllllllllllllllllllllllllllllllll$								
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Comments	
VR310	TSET	Settling Time	_	_	10	μs	(Note 1)	
VRD311	CVRAA	Absolute Accuracy	-20	_	+80	mV		
VRD312	CVRur	Unit Resistor Value (R)	_	4.5	_	kΩ		

Note 1: Measures the interval while CVR[4:0] transitions from '11111' to '00000'.

30.2 AC Characteristics and Timing Parameters

The information contained in this section defines the PIC24FJ128GL306 family AC characteristics and timing parameters.

TABLE 30-15: TEMPERATURE AND VOLTAGE SPECIFICATIONS - AC

	Operating Conditions:	2.0V to 3.6V (unless otherwise stated)			
AC CHARACTERISTICS	Operating temperature	-40°C \leq TA \leq +85°C for Industrial			
AC CHARACTERISTICS		-40°C \leq TA \leq +125°C for Extended			
	Operating voltage VDD range as described in Section 30.1 "DC Charact				

FIGURE 30-8: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

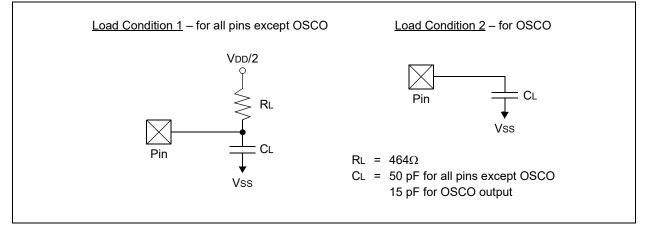


TABLE 30-16: CAPACITIVE LOADING REQUIREMENTS ON OUTPUT PINS

Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions
DO50	Cosco	OSCO/CLKO Pin	_	—	15	pF	In XT and HS modes when the External Clock is used to drive OSCI
DO56	Сю	All I/O Pins and OSCO	_		50	pF	EC mode
DO58	Св	SCLx, SDAx		_	400	pF	In I ² C mode

Note 1: Data in the "Typ" column are at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

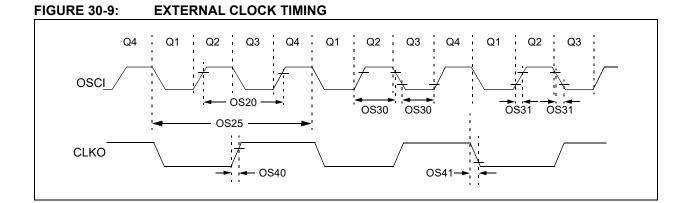


TABLE 30-17: EXTERNAL CLOCK TIMING REQUIREMENTS

Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended								
Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Мах	Units	Conditions	
OS10	Fosc	External CLKI Frequency (External clocks allowed only in EC mode)	DC 4		32 48	MHz MHz	EC ECPLL (Note 2)	
		Oscillator Frequency	3.5 4 10 12 31		10 8 32 24 33	MHz MHz MHz MHz kHz	XT XTPLL HS HSPLL SOSC	
OS20	Tosc	Tosc = 1/Fosc	—	_		—	See Parameter OS10 for FOSC value	
OS25	Тсү	Instruction Cycle Time ⁽³⁾	62.5	_	DC	ns		
OS30	TosL, TosH	External Clock in (OSCI) High or Low Time	0.45 x Tosc	_	—	ns	EC	
OS31	TosR, TosF	External Clock in (OSCI) Rise or Fall Time	—	_	20	ns	EC	
OS40	TckR	CLKO Rise Time ⁽⁴⁾	—	15	30	ns		
OS41	TckF	CLKO Fall Time ⁽⁴⁾	—	15	30	ns		

Note 1: Data in the "Typ" column are at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

- 2: Represents input to the system clock prescaler. PLL dividers and postscalers must still be configured so that the system clock frequency does not exceed the maximum frequency shown in Figure 30-1.
- 3: Instruction cycle period (TCY) equals two times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type, under standard operating conditions, with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "Min." values with an External Clock applied to the OSCI/CLKI pin. When an External Clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.
- 4: Measurements are taken in EC mode. The CLKO signal is measured on the OSCO pin. CLKO is low for the Q1-Q2 period (1/2 Tcy) and high for the Q3-Q4 period (1/2 Tcy).

TABLE 30-18: AC SPECIFICATIONS FOR PHASE-LOCKED LOOP (PLL) MODE

-	Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended								
Sym	Characteristic		Тур	Мах	Units	Conditions			
Fin	Input Frequency Range			24	MHz				
Fmin	Minimum Output Frequency from the Frequency Multiplier	_	—	16	MHz	4 MHz FIN with 4x feedback ratio, 2 MHz FIN with 8x feedback ratio			
Fmax	Maximum Output Frequency from the Frequency Multiplier	96	—	—	MHz	4 MHz FIN with 24x net multiplication ratio, 24 MHz FIN with 4x net multiplication ratio			
FSLEW	Maximum Step Function of FIN at which the PLL will be Ensured to Maintain Lock		—	+4	%	Full input range of FIN			
TLOCK	Lock Time for VCO		—	24	μs	With the specified minimum, TREF, and a lock timer count of one cycle, this is the maximum VCO lock time supported			
JFM8	Cumulative Jitter of Frequency Multiplier Over Voltage and Temperature during Any Eight Consecutive Cycles of the PLL Output		—	±0.12	%	4 MHz FIN with 4x feedback ratio			

TABLE 30-19: INTERNAL RC ACCURACY

	Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended								
Param No.	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions			
F20	FRC Accuracy @ 8 MHz	-1.5	+0.15	1.5	%	$2.0V \le VDD \le 3.6V, -20^{\circ}C \le TA \le +85^{\circ}C$ (Note 2)			
		-2	_	2	%	$2.0V \leq V \text{DD} \leq 3.6V, \ \text{-40}^\circ\text{C} \leq T \text{A} \leq \text{-20}^\circ\text{C}$			
			—	2	%	$\begin{array}{l} 2.0V \leq V \text{DD} \leq 3.6 \text{V}, \ \textbf{+85^{\circ}C} \leq \text{TA} \leq \textbf{+125^{\circ}C} \\ \textbf{(Note 2)} \end{array}$			
F20A	FRC Accuracy @ 8 MHz with Enabled Self-Tune Feature	-0.20	+0.05	-0.20	%	$-20^{\circ}C \le TA \le +85^{\circ}C$			
F21	LPRC @ 32 kHz	-20		20	%	VCAP Output Voltage = 1.8V			
F22	OSCTUN Step-Size	_	0.1	_	%/bit				
F23	TLOCK FRC Self-Tune Lock Time ⁽³⁾		5	8	ms				

Note 1: Data in the "Typ" column are at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: To achieve this accuracy, physical stress applied to the microcontroller package (ex., by flexing the PCB) must be kept to a minimum.

3: Time from reference clock stable, and in range, to FRC tuned within range specified by F20 (with self-tune).



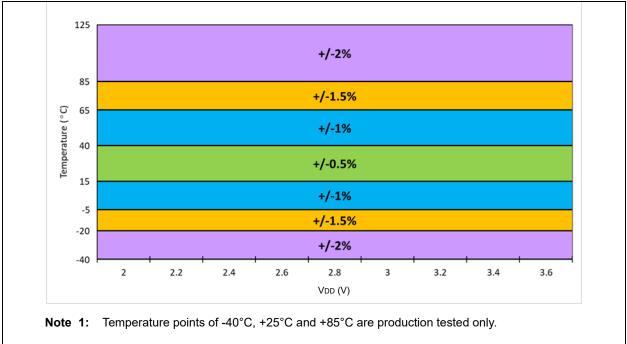
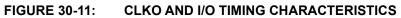


TABLE 30-20: RC OSCILLATOR START-UP TIME

	Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended										
Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions				
FR0	TFRC	FRC Oscillator Start-up Time		2		μs					
FR1	TLPRC	Low-Power RC Oscillator Start-up Time	—	50	_	μs					

Note 1: Data in the "Typ" column are at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.



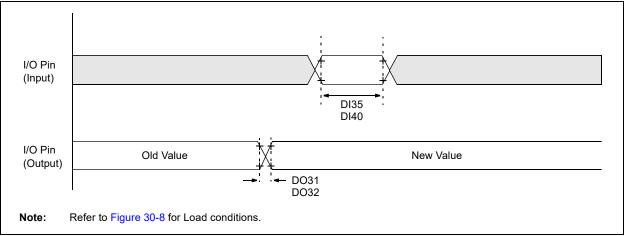


TABLE 30-21: CLKO AND I/O TIMING REQUIREMENTS

	Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended										
Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Мах	Units	Conditions				
DO31	TIOR	Port Output Rise Time	—	10	25	ns					
DO32	TIOF	Port Output Fall Time	_	10	25	ns					
DI35	TINP	INTx Pin High or Low Time (input)	1	—	_	Тсү					
DI40	Trbp	CNx High or Low Time (input)	1	—	_	Тсү					

Note 1: Data in the "Typ" column are at 3.3V, +25°C unless otherwise stated.

TABLE 30-22: RESET AND BROWN-OUT RESET REQUIREMENTS

	Dperating Conditions:2.0V to 3.6V (unless otherwise stated) Dperating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended											
Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Мах	Units	Conditions					
SY10	TMCL	MCLR Pulse Width (Low)	2	_	_	μs						
SY12	TPOR	Power-on Reset Delay	_	2		μs						
SY13	Tioz	I/O High-Impedance from MCLR Low or Watchdog Timer Reset	Lesser of: (3 Tcy + 2) or 700	_	(3 Tcy + 2)	μs						
SY25	TBOR	Brown-out Reset Pulse Width	1	_	—	μs	$VDD \leq VBOR$					
SY45	TRST	Internal State Reset Time	—	50	—	μs						
SY71	TWAKEUP	Wake-up Time from Sleep Mode	_	7	_	μs	VREGS (RCON[8]) = 1, <u>RETEN</u> (RCON[12]) = 0, <u>LPCFG</u> (FPOR[2]) = 1					
			_	35	_	μs	VREGS (RCON[8]) = 0, <u>RETEN</u> (RCON[12]) = 0, <u>LPCFG</u> (FPOR[2]) = 1					
			—	210	_	μs	VREGS (RCON[8]) = 1, <u>RETEN</u> (RCON[12]) = 1, <u>LPCFG</u> (FPOR[2]) = 0					
			_	325	—	μs	VREGS (RCON[8]) = 0, <u>RETEN</u> (RCON[12]) = 1, <u>LPCFG</u> (FPOR[2]) = 0					

Note 1: Data in the "Typ" column are at 3.3V, +25°C unless otherwise stated.



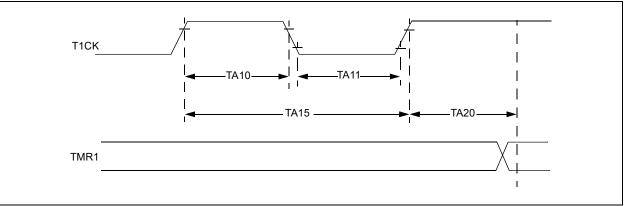
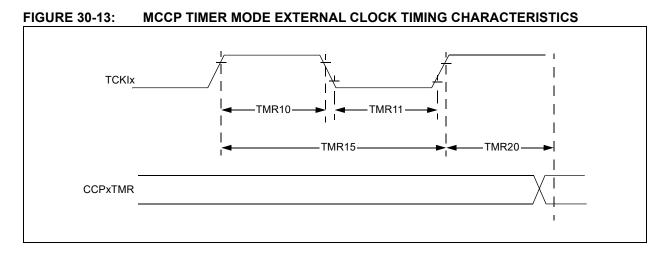


TABLE 30-23: TIMER1 EXTERNAL CLOCK TIMING CHARACTERISTICS

	Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended										
Param. No.	Symbol	Characte	ristics ⁽¹⁾	Min	Max	Units	Conditions				
TA10	Тскн	T1CK High Time	Synchronous	1	_	Тсү	Must also meet Parameter TA15				
			Asynchronous	10	_	ns					
TA11	TCKL	T1CK Low Time	Synchronous	1	_	Тсү	Must also meet Parameter TA15				
			Asynchronous	10	_	ns					
TA15	Тскр	T1CK Input	Synchronous	2	_	Тсү					
		Period	Asynchronous	20	_	ns					
TA20	TCKEXTMRL	Delay from External T1CK Clock Edge to Timer Increment		_	3	Тсү	Synchronous mode				

Note 1: These parameters are characterized but not tested in manufacturing.



• •	Conditions: temperature	$-40^{\circ}C \le TA \le +88$	less otherwise state 5°C for Industrial 25°C for Extended	d)			
Param. No.	Symbol	Characte	eristics ⁽¹⁾	Min	Max	Units	Conditions
TMR10	Тскн	TCKIx High Time	Synchronous	1		Тсү	Must also meet Parameter TMR15
			Asynchronous	10	_	ns	
TMR11	TCKL	TCKIx Low Time	Synchronous	1	_	Тсү	Must also meet Parameter TMR15
			Asynchronous	10		ns	
TMR15	Тскр	TCKIx Input Period	Synchronous	2		Тсү	
			Asynchronous	20	_	ns	
TMR20	TCKEXTMRL	Delay from Externa to Timer Increment	_	1	Тсү		

TABLE 30-24: MCCP TIMER MODE TIMING REQUIREMENTS

Note 1: These parameters are characterized but not tested in manufacturing.

FIGURE 30-14: MCCP INPUT CAPTURE x MODE TIMING CHARACTERISTICS

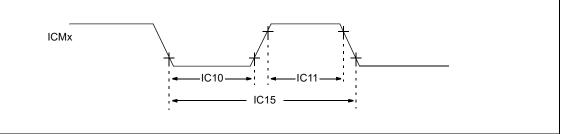


TABLE 30-25: MCCP INPUT CAPTURE x MODE TIMING REQUIREMENTS

-											
Param. No.	Symbol	Characteristics ⁽¹⁾	Characteristics ⁽¹⁾ Min Max Units Conditions								
IC10	TICL	ICMx Input Low Time	25		ns	Must also meet Parameter IC15					
IC11	Тісн	ICMx Input High Time	25	—	ns	Must also meet Parameter IC15					
IC15	TICP	ICMx Input Period	Mx Input Period 50 — ns								

Note 1: These parameters are characterized but not tested in manufacturing.

FIGURE 30-15: MCCP PWM MODE TIMING CHARACTERISTICS

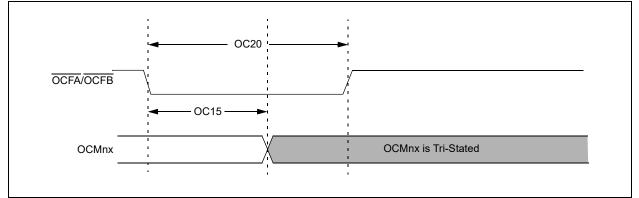


TABLE 30-26: MCCP PWM MODE TIMING REQUIREMENTS

Operating Co Operating ten	nperature -4	0V to 3.6V (unless otherwise stated) $0^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $0^{\circ}C \le TA \le +125^{\circ}C$ for Extended			
Param No.	Symbol	Characteristics ⁽¹⁾	Min	Мах	Units
OC15	Tfd	Fault Input to PWM I/O Change	_	30	ns
OC20 TFLT		Fault Input Pulse Width	10	_	ns

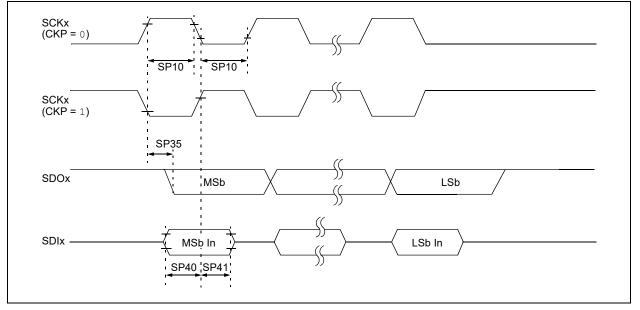
Note 1: These parameters are characterized but not tested in manufacturing.

TABLE 30-27: SPIX MAXIMUM DATA/CLOCK RATE SUMMARY

Operating temperature $-40^{\circ}C \le TA \le +8$	2.0V to 3.6V (unless otherwise stated) -40°C \leq TA \leq +85°C for Industrial -40°C \leq TA \leq +125°C for Extended							
Mode	(CKE	СКР	SMP	Maximum Data Rate Typ. ⁽¹⁾			
Master Transmit Only (Half-Duplex)		0,1	0,1	0,1	25 MHz			
Master Transmit/Receive (Full-Duplex)		0.1	0.1	0	11 MHz			
		0,1 0,1		1	21 MHz			
Slave Transmit/Receive (Full-Duplex)		0,1	0,1	0,1	11 MHz			

Note 1: These parameters are characterized but not tested in manufacturing.

FIGURE 30-16: SPIX MODULE MASTER MODE (CKE = 0) TIMING CHARACTERISTICS



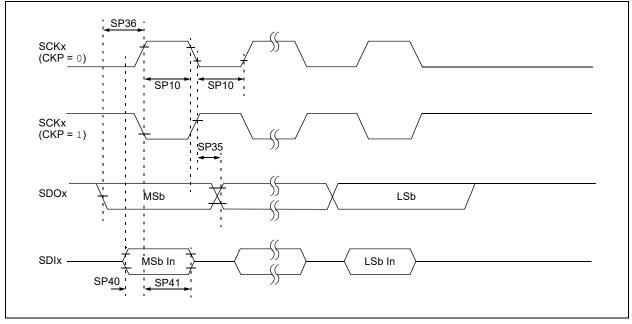


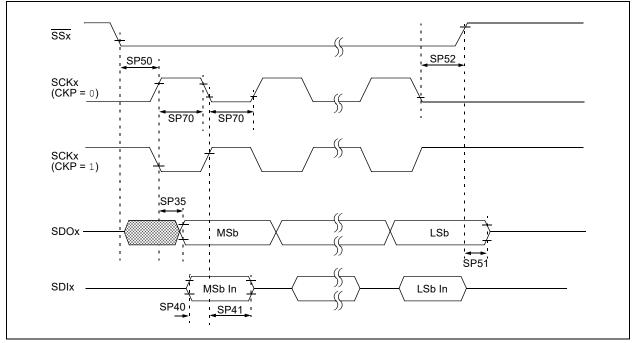
FIGURE 30-17: SPIX MODULE MASTER MODE (CKE = 1) TIMING CHARACTERISTICS

TABLE 30-28: SPIX MODULE MASTER MODE TIMING REQUIREMENTS

	perating Conditions:2.0V to 3.6V (unless otherwise stated)perating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended									
Param. No.	Symbol	Symbol Characteristics ⁽¹⁾		Мах	Units					
SP10	TscL, TscH	SCKx Output Low or High Time	20	_	ns					
SP35	TscH2DoV, TscL2DoV	SDOx Data Output Valid After SCKx Edge	—	7	ns					
SP36	TDOV2sc, TDOV2scL	SDOx Data Output Setup to First SCKx Edge	7	—	ns					
SP40	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge	7	—	ns					
SP41	TscH2DIL, TscL2DIL	Hold Time of SDIx Data Input to SCKx Edge	7	—	ns					

Note 1: These parameters are characterized but not tested in manufacturing.

FIGURE 30-18: SPIX MODULE SLAVE MODE (CKE = 0) TIMING CHARACTERISTICS



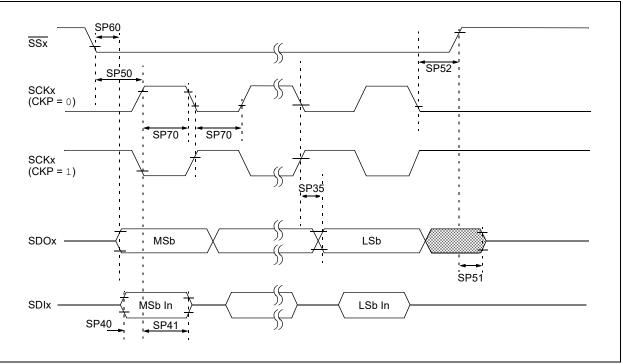
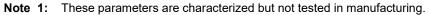
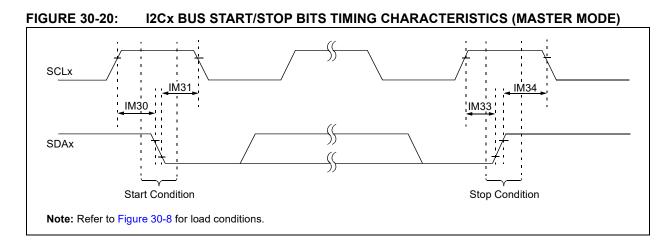


FIGURE 30-19: SPIX MODULE SLAVE MODE (CKE = 1) TIMING CHARACTERISTICS

TABLE 30-29: SPIx MODULE SLAVE MODE TIMING REQUIREMENTS

Operating Conditions: Operating temperature		2.0V to 3.6V (unless otherwise stated) ·40°C ≤ TA ≤ +85°C for Industrial ·40°C ≤ TA ≤ +125°C for Extended							
Param.No. Symbol		Characteristics ⁽¹⁾	Min	Max	Units				
SP70	TscL, TscH	SCKx Input Low Time or High Time	45	—	ns				
SP35	TscH2doV, TscL2doV	SDOx Data Output Valid After SCKx Edge	—	10	ns				
SP40	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge	0	_	ns				
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	7	_	ns				
SP50	TssL2scH, TssL2scL	$\overline{SSx} \downarrow$ to SCKx \downarrow or SCKx \uparrow Input	40	_	ns				
SP51	TssH2doZ	SSx ↑ to SDOx Output High-Impedance	2.5	12	ns				
SP52	TscH2ssH, TscL2ssH	SSx ↑ After SCKx Edge	10	_	ns				
SP60	TssL2doV	SDOx Data Output Valid After SSx Edge	_	12.5	ns				







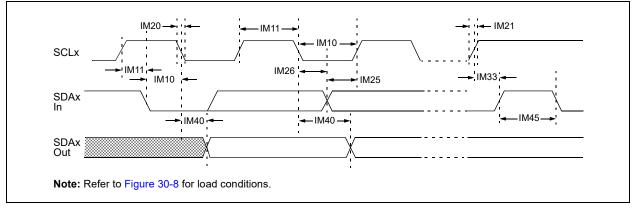
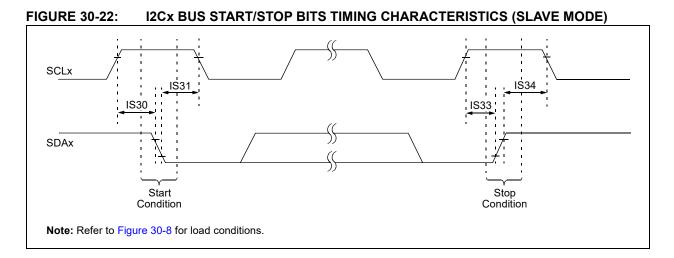


TABLE 30-30: I2Cx BUS DATA TIMING REQUIREMENTS (MASTER MODE)

	ing Cond ing tempe	erature -40°C	3.6V (unless o ≤ TA ≤ +85°C fo ≤ TA ≤ +125°C f				
Param No.	Symbol	Charact	eristics	Min. ⁽¹⁾	Max.	Units	Conditions
IM10	TLO:SCL	Clock Low Time	100 kHz mode	TCY * (BRG + 2)		μs	
			400 kHz mode	TCY * (BRG + 2)		μs	
			1 MHz mode	TCY * (BRG + 2)		μs	
IM11	THI:SCL	Clock High Time	100 kHz mode	TCY * (BRG + 2)		μs	
			400 kHz mode	TCY * (BRG + 2)		μs	
			1 MHz mode	TCY * (BRG + 2)		μs	
IM20	TF:SCL	SDAx and SCLx	100 kHz mode		300	ns	
		Fall Time	400 kHz mode	20 + 0.1 Св	300	ns	
			1 MHz mode		100	ns	
IM21	TR:SCL	SDAx and SCLx	100 kHz mode		1000	ns	
		Rise Time	400 kHz mode	20 + 0.1 Св	300	ns	
			1 MHz mode	_	300	ns	
IM25	TSU:DAT	Data Input	100 kHz mode	250		ns	
		Setup Time	400 kHz mode	100		ns	
			1 MHz mode	100		ns	-
IM26		Data Input	100 kHz mode	0		μs	
		Hold Time	400 kHz mode	0	0.9	μs	-
			1 MHz mode	0	0.3	μs	-
IM30	TSU:STA	Start Condition	100 kHz mode	Tcy * (BRG + 2)		μs	Only relevant for Repeated
		Setup Time	400 kHz mode	TCY * (BRG + 2)		μs	Start condition
			1 MHz mode	TCY * (BRG + 2)		μs	-
IM31	THD:STA	Start Condition	100 kHz mode	TCY * (BRG + 2)		μs	After this period, the first clock
		Hold Time	400 kHz mode	TCY * (BRG + 2)		μs	pulse is generated
			1 MHz mode	Tcy * (BRG + 2)		μs	-
IM33	Tsu:sto	Stop Condition	100 kHz mode	TCY * (BRG + 2)		μs	
		Setup Time	400 kHz mode	TCY * (BRG + 2)		μs	-
			1 MHz mode	TCY * (BRG + 2)		μs	-
IM34	THD:STO	Stop Condition	100 kHz mode	TCY * (BRG + 2)		ns	
		Hold Time	400 kHz mode	TCY * (BRG + 2)		ns	-
			1 MHz mode	TCY * (BRG + 2)		ns	-
IM40	TAA:SCL	Output Valid	100 kHz mode		3500	ns	
		from Clock	400 kHz mode		1000	ns	1
			1 MHz mode		350	ns	-
IM45	TBF:SDA	Bus Free Time	100 kHz mode	4.7	_	μs	The amount of time the bus
			400 kHz mode	1.3		μs	must be free before a new
			1 MHz mode	0.5	_	μs	transmission can start
IM50	Св	Bus Capacitive	100 kHz mode		400	pF	
		Loading	400 kHz mode		400	pF	-
		-	1 MHz mode		10	pF	-
IM51	TPGD	Pulse Gobbler D		52	312	ns	

Note 1: BRG is the value of the I²C Baud Rate Generator.





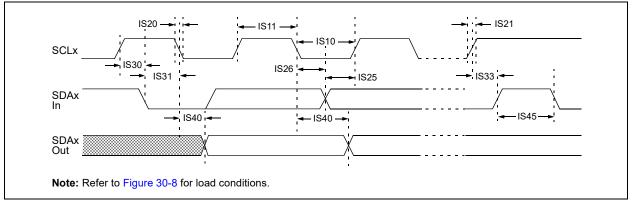


TABLE 30-31: I2Cx BUS DATA TIMING REQUIREMENTS (SLAVE MODE)

	i ng Condi ing tempe	rature -40°C ≤	3.6V (unless oth TA ≤ +85°C for TA ≤ +125°C fo	Industrial	ed)		
Param No.	Symbol	Charact	eristics	Min.	Max.	Units	Conditions
IS10	TLO:SCL	Clock Low Time	100 kHz mode	4.7	-	μs	CPU clock must be minimum 800 kHz
			400 kHz mode	1.3		μs	CPU clock must be minimum 3.2 MHz
			1 MHz mode	0.5		μs	
IS11	THI:SCL	Clock High Time	100 kHz mode	4.0		μs	CPU clock must be minimum 800 kHz
			400 kHz mode	0.6		μs	CPU clock must be minimum 3.2 MHz
			1 MHz mode	0.5	_	μs	
IS20	TF:SCL	SDAx and SCLx	100 kHz mode	_	300	ns	
		Fall Time	400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode	_	100	ns	
IS21	TR:SCL	SDAx and SCLx	100 kHz mode	_	1000	ns	
		Rise Time	400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode	_	300	ns	
IS25	TSU:DAT	Data Input	100 kHz mode	250		ns	
		Setup Time	400 kHz mode	100		ns	1
			1 MHz mode	100		ns	1
IS26	THD:DAT	Data Input Hold Time	100 kHz mode	0		ns	
			400 kHz mode	0	0.9	μs	1
			1 MHz mode	0	0.3	μs	1
IS30	TSU:STA	Start Condition	100 kHz mode	4700	_	ns	Only relevant for Repeated Start
		Setup Time	400 kHz mode	600		ns	condition
			1 MHz mode	250		ns	1
IS31	THD:STA	Start Condition	100 kHz mode	4000		ns	After this period, the first clock pulse is
		Hold Time	400 kHz mode	600	_	ns	generated
			1 MHz mode	250	_	ns	1
IS33	Tsu:sto	Stop Condition	100 kHz mode	4000		ns	
		Setup Time	400 kHz mode	600		ns	
			1 MHz mode	600		ns	
IS34	THD:STO	Stop Condition	100 kHz mode	4000		ns	
		Hold Time	400 kHz mode	600		ns	
			1 MHz mode	250		ns	
IS40	TAA:SCL	Output Valid	100 kHz mode	0	3500	ns	
		from Clock	400 kHz mode	0	1000	ns	1
			1 MHz mode	0	350	ns	1
IS45	TBF:SDA	Bus Free Time	100 kHz mode	4.7		μs	The amount of time the bus must be
			400 kHz mode	1.3		μs	free before a new transmission can
			1 MHz mode	0.5	—	μs	start
IS50	Св	Bus Capacitive	100 kHz mode	—	400	pF	
		Loading	400 kHz mode	—	400	pF	1
			1 MHz mode	_	10	pF	1

TABLE 30-32: A/D MODULE SPECIFICATIONS

	ng Conditi ng tempera		S°C for Indust	rial)		
Param No.	Symbol	Characteristic	Min.	Тур	Max.	Units	Conditions
			Devid	ce Supp	ly		
AD01	AVDD	Module VDD Supply	Greater of: VDD – 0.3 or 2.2		Lesser of: VDD + 0.3 or 3.6	V	
AD02	AVss	Module Vss Supply	Vss - 0.3	_	Vss + 0.3	V	
			Refere	nce Inp	uts		
AD05	VREFH	Reference Voltage High	AVss + 1.7	_	AVdd	V	
AD06	Vrefl	Reference Voltage Low	AVss		AVDD – 1.7	V	
AD07	Vref	Absolute Reference Voltage	AVss – 0.3	—	AVDD + 0.3	V	
			Anal	og Input	ts		
AD10	VINH-VINL	Full-Scale Input Span	VREFL	_	VREFH	V	(Note 2)
AD11	VIN	Absolute Input Voltage	AVss - 0.3	_	AVDD + 0.3	V	
AD12	Vinl	Absolute VINL Input Voltage	AVss – 0.3	_	AVDD/3	V	
AD13		Leakage Current	_	±1.0	±610	nA	VINL = AVSS = VREFL = 0V, AVDD = VREFH = $3V$, Source Impedance = $2.5 \text{ k}\Omega$
AD17	RIN	Recommended Impedance of Analog Voltage Source	_		2.5k	Ω	10-bit
	•		A/D	Accurac	у		
AD20B	Nr	Resolution		12	_	bits	
AD21B	INL	Integral Nonlinearity	_	±1	< ±2	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V, Conversion Rate = 125 ksps
AD22B	DNL	Differential Nonlinearity	_	±0.5	< ±1 ⁽³⁾	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V, Conversion Rate = 125 ksps
AD23B	Gerr	Gain Error	_	±0.6	-2 to +5	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V, Conversion Rate = 125 ksps
AD24B	EOFF	Offset Error	_	±0.5	-2 to +4	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V, Conversion Rate = 125 ksps
AD25B		Monotonicity ⁽¹⁾		_	_		Guaranteed

Note 1: The A/D conversion result never decreases with an increase in the input voltage.

2: Measurements are taken with the external VREF+ and VREF- used as the A/D voltage reference.

3: Code 2047 can have a DNL error of ≥1 LSb to <1.5 LSb and code 3071 can have a DNL error of ≥1 LSb to <2.5 LSb.

TABLE 30-33: A/D CONVERSION TIMING REQUIREMENTS⁽¹⁾

-	Operating Conditions:2.0V to 3.6V (unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended								
Param No.	Symbol	Characteristic	Min.	Тур	Max.	Units	Conditions		
	Clock Parameters								
AD50	TAD	A/D Clock Period	178	_		ns			
AD51	tRC	A/D Internal RC Oscillator Period	—	269.18	_	ns			
	•	(Conversio	on Rate					
AD55	tCONV	SAR Conversion Time, 12-Bit Mode	—	16	_	Tad			
AD55A		SAR Conversion Time, 10-Bit Mode	—	14	_	TAD			
AD56	FCNV	Throughput Rate	_	_	400	ksps	AVDD > 2.7V, 10-bit mode		
			—		350	ksps	AVDD > 2.7V, 12-bit mode		

Note 1: Because the sample caps will eventually lose charge, clock rates below 10 kHz can affect linearity performance, especially at elevated temperatures.

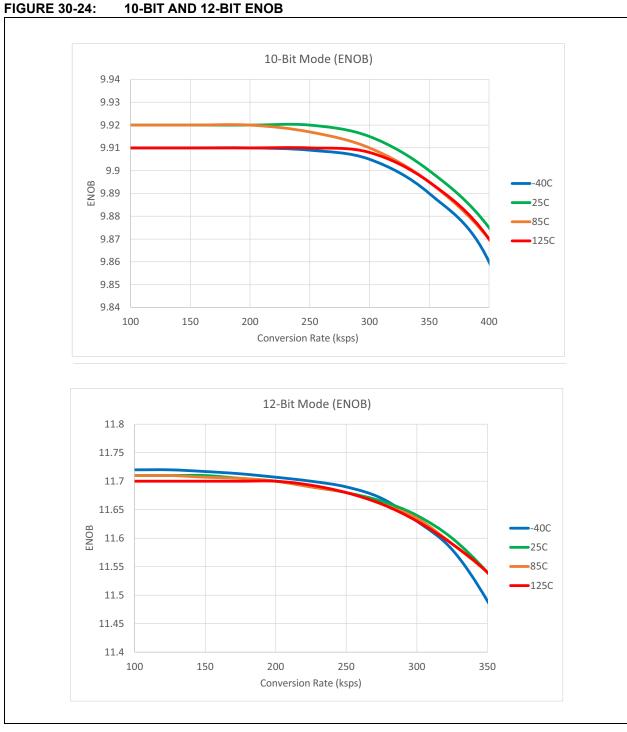
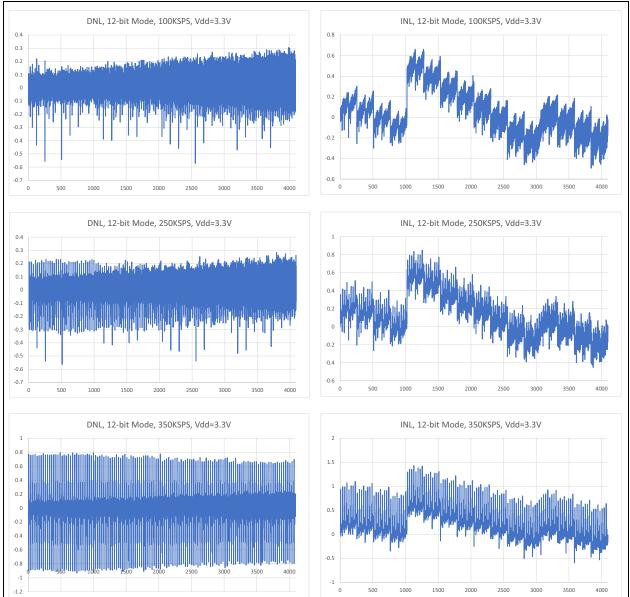


FIGURE 30-25: 12-BIT INL DNL PLOTS



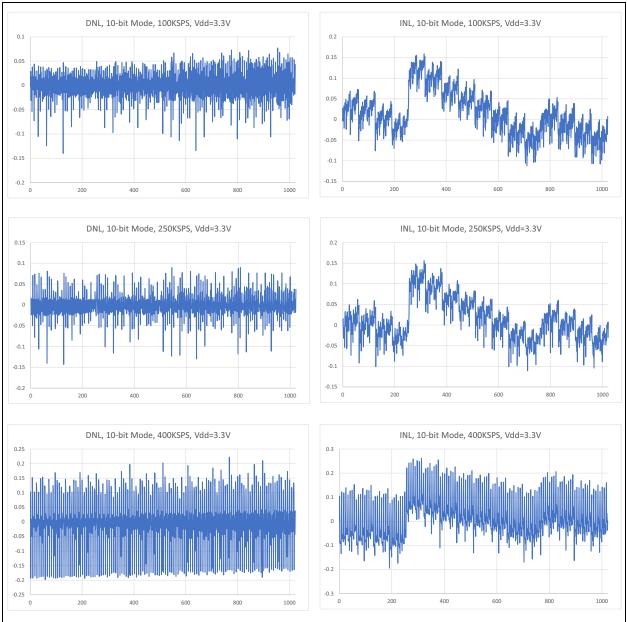
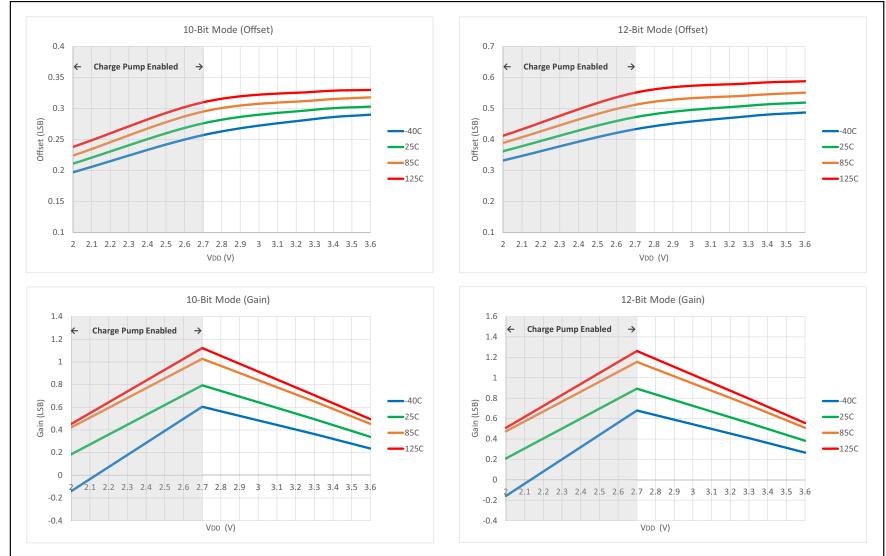


FIGURE 30-26: 10-BIT INL DNL PLOTS

FIGURE 30-27: GAIN AND OFFSET VOLTAGES



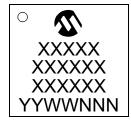
31.0 PACKAGING INFORMATION

31.1 Package Marking Information

28-Lead QFN (6x6 mm)



28-Lead UQFN (4x4x0.6 mm)



28-Lead SOIC (7.50 mm)



28-Lead SSOP (5.30 mm)

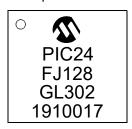




GL302

1910017





Example



Example



Legend	: XXX Y YY WW NNN	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code
	be carried	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for customer-specific information.

31.1 Package Marking Information (Continued)

36-Lead UQFN (5x5 mm)



48-Lead UQFN (6x6 mm)



48-Lead TQFP (7x7x1.0 mm)



64-Lead QFN (9x9x0.9 mm)



MICROCHIP

XXXXXXXXXXX

XXXXXXXXXXX

XXXXXXXXXX





64-Lead TQFP (10x10x1 mm)



Example

Example

Example

Ο

 $\langle M \rangle$

24FJ128

GL303

1910017

24FJ128

Ο



Example



Example

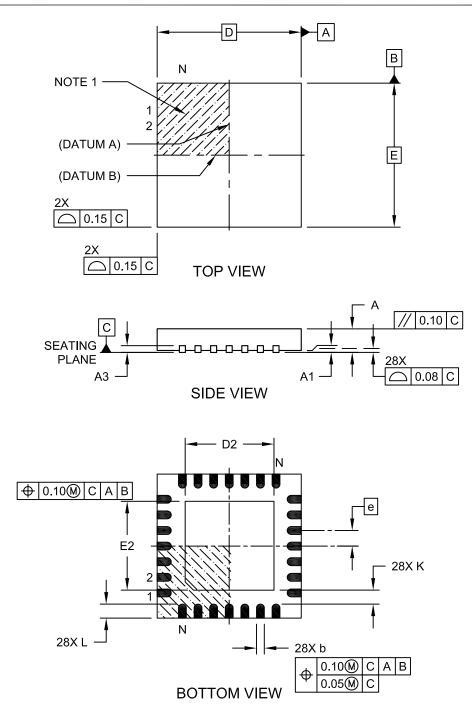


31.2 Package Details

The following sections give the technical details of the packages.

28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

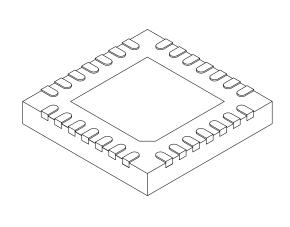
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-105C Sheet 1 of 2

28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	М	MILLIMETERS		
Dimensior	Limits	MIN	NOM	MAX	
Number of Pins	Ν		28		
Pitch	е		0.65 BSC		
Overall Height	Α	0.80	0.90	1.00	
Standoff	A1	0.00	0.02	0.05	
Terminal Thickness	A3	0.20 REF			
Overall Width	Е	6.00 BSC			
Exposed Pad Width	E2	3.65	3.70	4.20	
Overall Length	D		6.00 BSC		
Exposed Pad Length	D2	3.65	3.70	4.20	
Terminal Width	b	0.23	0.30	0.35	
Terminal Length	L	0.50	0.55	0.70	
Terminal-to-Exposed Pad	K	0.20	-	-	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated

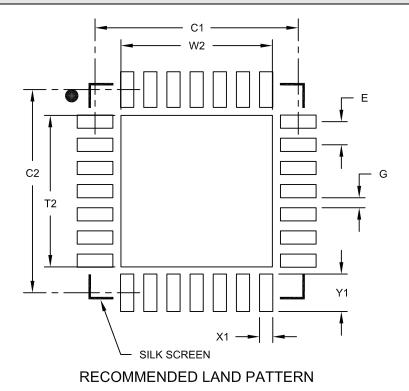
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-105C Sheet 2 of 2

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIM	ETERS
Dimens	Dimension Limits		NOM	MAX
Contact Pitch	E	0.65 BSC		
Optional Center Pad Width	W2			4.25
Optional Center Pad Length	T2			4.25
Contact Pad Spacing	C1		5.70	
Contact Pad Spacing	C2		5.70	
Contact Pad Width (X28)	X1			0.37
Contact Pad Length (X28)	Y1			1.00
Distance Between Pads	G	0.20		

Notes:

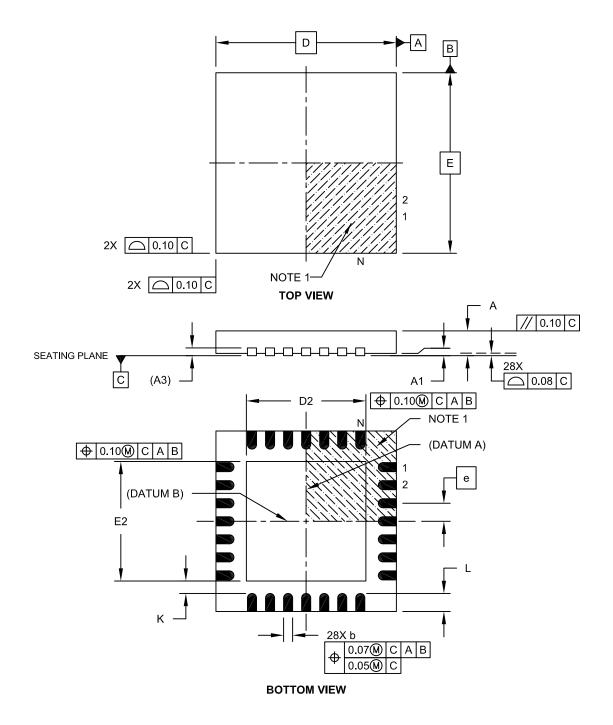
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2105A

28-Lead Plastic Ultra Thin Quad Flat, No Lead Package (MV) – 4x4x0.5 mm Body [UQFN]

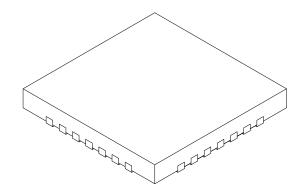
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-152A Sheet 1 of 2

28-Lead Plastic Ultra Thin Quad Flat, No Lead Package (MV) – 4x4x0.5 mm Body [UQFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	s MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX
Number of Pins	N		28	
Pitch	е	0.40 BSC		
Overall Height	А	0.45	0.50	0.55
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3	0.127 REF		
Overall Width	Е	4.00 BSC		
Exposed Pad Width	E2	2.55	2.65	2.75
Overall Length	D		4.00 BSC	
Exposed Pad Length	D2	2.55	2.65	2.75
Contact Width	b	0.15	0.20	0.25
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated.

3. Dimensioning and tolerancing per ASME Y14.5M.

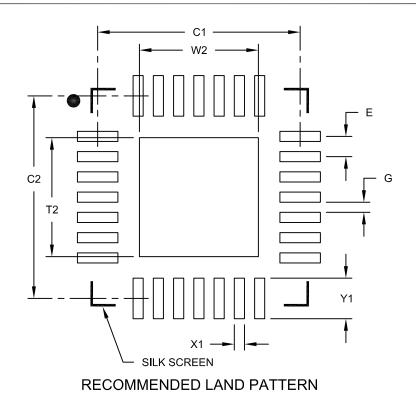
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-152A Sheet 2 of 2

28-Lead Ultra Thin Plastic Quad Flat, No Lead Package (MV) - 4x4 mm Body [UQFN] With 0.40 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimensior	Dimension Limits		NOM	MAX
Contact Pitch	E	E 0.40 BSC		
Optional Center Pad Width	W2			2.35
Optional Center Pad Length	T2			2.35
Contact Pad Spacing	C1		4.00	
Contact Pad Spacing	C2		4.00	
Contact Pad Width (X28)	X1			0.20
Contact Pad Length (X28)	Y1			0.80
Distance Between Pads	G	0.20		

Notes:

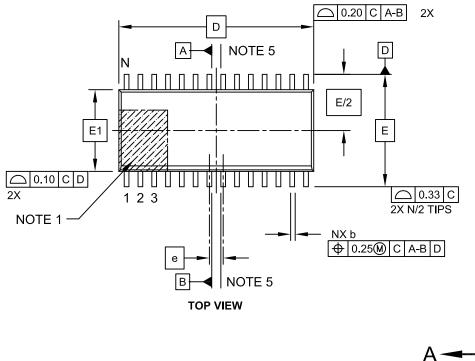
1. Dimensioning and tolerancing per ASME Y14.5M

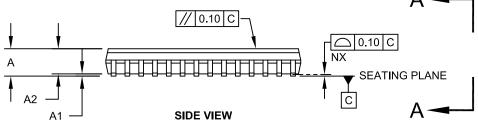
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

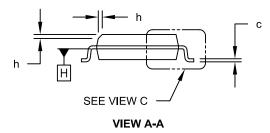
Microchip Technology Drawing No. C04-2152A

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



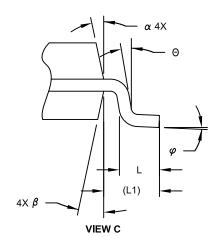


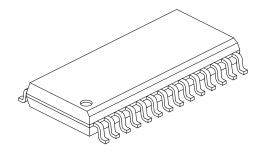


Microchip Technology Drawing C04-052C Sheet 1 of 2

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging





	Units	N	ILLIMETER	S	
Dimension	Limits	MIN	NOM	MAX	
Number of Pins	Ν		28		
Pitch	е		1.27 BSC		
Overall Height	Α	-	-	2.65	
Molded Package Thickness	A2	2.05	-	-	
Standoff §	A1	0.10	-	0.30	
Overall Width	E	10.30 BSC			
Molded Package Width	E1	7.50 BSC			
Overall Length	D	17.90 BSC			
Chamfer (Optional)	h	0.25	-	0.75	
Foot Length	L	0.40	-	1.27	
Footprint	L1		1.40 REF		
Lead Angle	Θ	0°	-	-	
Foot Angle	φ	0°	-	8°	
Lead Thickness	С	0.18	-	0.33	
Lead Width	b	0.31	-	0.51	
Mold Draft Angle Top	α	5°	-	15°	
Mold Draft Angle Bottom	β	5°	-	15°	

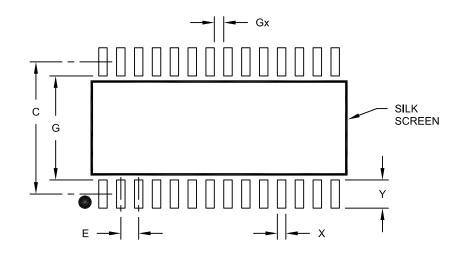
Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic
- Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.
- 5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing C04-052C Sheet 2 of 2

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units	MILLIMETERS		
Dimension	Dimension Limits		NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Spacing	С		9.40	
Contact Pad Width (X28)	X			0.60
Contact Pad Length (X28)	Y			2.00
Distance Between Pads	Gx	0.67		
Distance Between Pads	G	7.40		

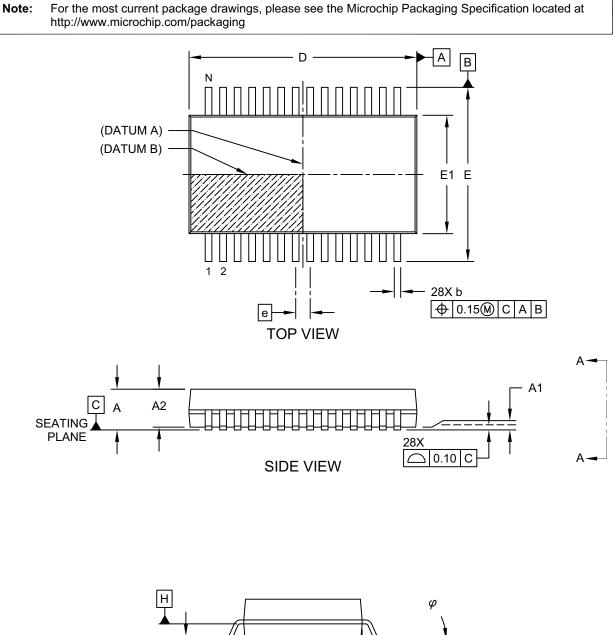
Notes:

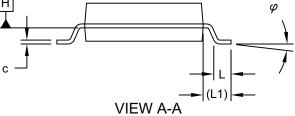
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2052A

28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

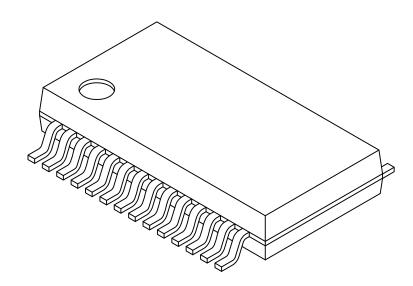




Microchip Technology Drawing C04-073 Rev C Sheet 1 of 2

28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units			S	
Dimension	Limits	MIN	NOM	MAX	
Number of Pins	N		28		
Pitch	е	0.65 BSC			
Overall Height	A	-	-	2.00	
Molded Package Thickness	A2	1.65	1.75	1.85	
Standoff	A1	0.05	-	-	
Overall Width	E	7.40	7.80	8.20	
Molded Package Width	E1	5.00	5.30	5.60	
Overall Length	D	9.90	10.20	10.50	
Foot Length	L	0.55	0.75	0.95	
Footprint	L1	1.25 REF			
Lead Thickness	С	0.09	-	0.25	
Foot Angle	φ	0°	4°	8°	
Lead Width	b	0.22	-	0.38	

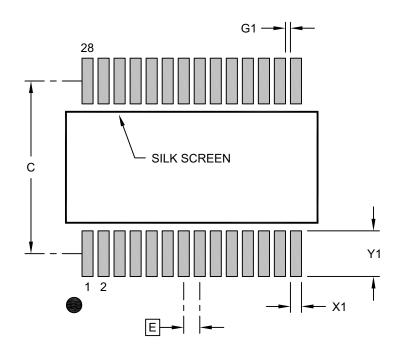
Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20mm per side.
- 3. Dimensioning and tolerancing per ASME Y14.5M
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073 Rev C Sheet 2 of 2

28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units			S
Dimension	Dimension Limits		NOM	MAX
Contact Pitch	E		0.65 BSC	
Contact Pad Spacing	С		7.00	
Contact Pad Width (X28)	X1			0.45
Contact Pad Length (X28)	Y1			1.85
Contact Pad to Center Pad (X26)	G1	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

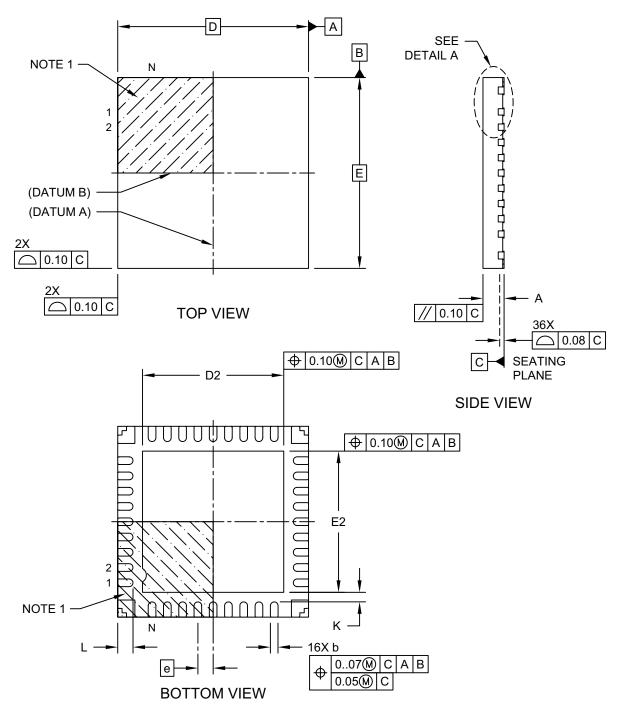
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-2073 Rev B

36-Lead Ultra Thin Plastic Quad Flat, No Lead Package (M5) - 5x5 mm Body [UQFN] With Corner Anchors

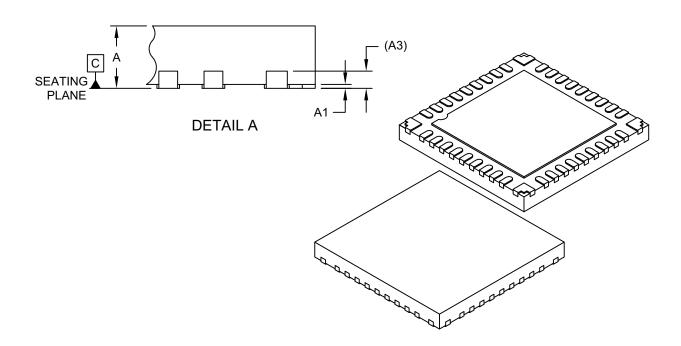
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-436–M5 Rev B Sheet 1 of 2

36-Lead Ultra Thin Plastic Quad Flat, No Lead Package (M5) - 5x5 mm Body [UQFN] With Corner Anchors

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units			S
Dimension	Limits	MIN	NOM	MAX
Number of Terminals	Ν		36	
Pitch	е		0.40 BSC	
Overall Height	Α	0.50	0.55	0.60
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.152 REF		
Overall Length	D	5.00 BSC		
Exposed Pad Length	D2	3.60	3.70	3.80
Overall Width	Е		5.00 BSC	
Exposed Pad Width	E2	3.60	3.70	3.80
Terminal Width	b	0.15	0.20	0.25
Terminal Length	L	0.30	0.40	0.50
Terminal-to-Exposed-Pad	K		0.25 REF	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated

3. Dimensioning and tolerancing per ASME Y14.5M

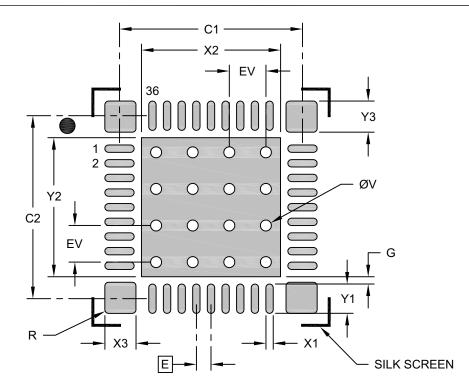
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-436–M5 Rev B Sheet 2 of 2

36-Lead Ultra Thin Plastic Quad Flat, No Lead Package (M5) - 5x5 mm Body [UQFN] With Corner Anchors

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units	N	AILLIMETER:	S
Dimension	Limits	MIN	NOM	MAX
Contact Pitch	E		0.40 BSC	
Center Pad Width	X2			3.80
Center Pad Length	Y2			3.80
Contact Pad Spacing	C1		5.00	
Contact Pad Spacing	C2		5.00	
Contact Pad Width (X36)	X1			0.20
Contact Pad Length (X36	Y1			0.80
Corner Pad Width (X4)	X3			0.85
Corner Pad Length (X4)	Y3			0.85
Corner Pad Radius	R		0.10	
Contact Pad to Center Pad (X36)	G	0.20		
Thermal Via Diameter	V		0.30	
Thermal Via Pitch	EV		1.00	

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

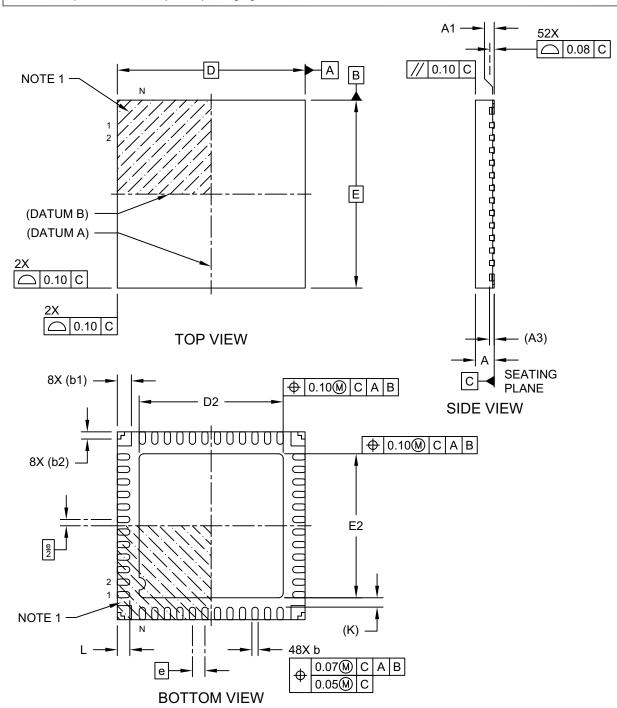
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-2436-M5 Rev B

48-Lead Ultra Thin Plastic Quad Flat, No Lead Package (M4) - 6x6 mm Body [UQFN] With Corner Anchors and 4.6x4.6 mm Exposed Pad

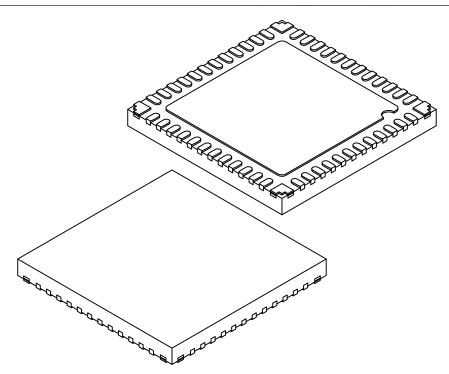
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-442A-M4 Sheet 1 of 2

48-Lead Ultra Thin Plastic Quad Flat, No Lead Package (M4) - 6x6 mm Body [UQFN] With Corner Anchors and 4.6x4.6 mm Exposed Pad

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	N	IILLIMETER	S
Dimension	Limits	MIN	NOM	MAX
Number of Terminals	Ν		48	
Pitch	е		0.40 BSC	
Overall Height	Α	0.50	0.55	0.60
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3		0.15 REF	
Overall Length	D		6.00 BSC	
Exposed Pad Length	D2	4.50	4.60	4.70
Overall Width	Е		6.00 BSC	
Exposed Pad Width	E2	4.50	4.60	4.70
Terminal Width	b	0.15	0.20	0.25
Corner Anchor Pad	b1		0.45 REF	
Corner Anchor Pad, Metal-free Zone	b2		0.23 REF	
Terminal Length	L	0.35	0.40	0.45
Terminal-to-Exposed-Pad	K		0.30 REF	

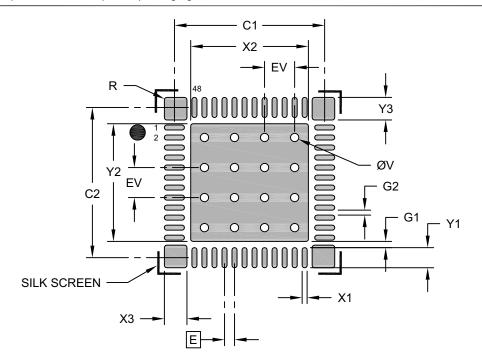
Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-442A-M4 Sheet 2 of 2

48-Lead Ultra Thin Plastic Quad Flat, No Lead Package (M4) - 6x6 mm Body [UQFN] With Corner Anchors and 4.6x4.6 mm Exposed Pad

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		Ν	/ILLIMETER	S
Dimension	Limits	MIN	NOM	MAX
Contact Pitch	E		0.40 BSC	
Center Pad Width	X2			4.70
Center Pad Length	Y2			4.70
Contact Pad Spacing	C1		6.00	
Contact Pad Spacing	C2		6.00	
Contact Pad Width (X48)	X1			0.20
Contact Pad Length (X48)	Y1			0.80
Corner Anchor Pad Width (X4)	X3			0.90
Corner Anchor Pad Length (X4)	Y3			0.90
Pad Corner Radius (X 20)	R			0.10
Contact Pad to Center Pad (X48)	G1	0.25		
Contact Pad to Contact Pad	G2	0.20		
Thermal Via Diameter	V		0.33	
Thermal Via Pitch	EV		1.20	

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

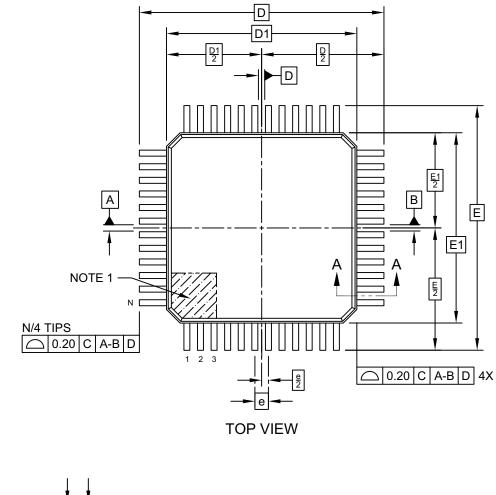
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

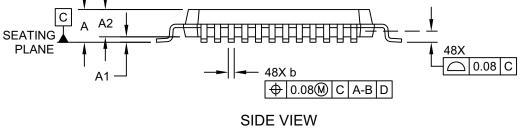
2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-2442A-M4

48-Lead Plastic Thin Quad Flatpack (PT) - 7x7x1.0 mm Body [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

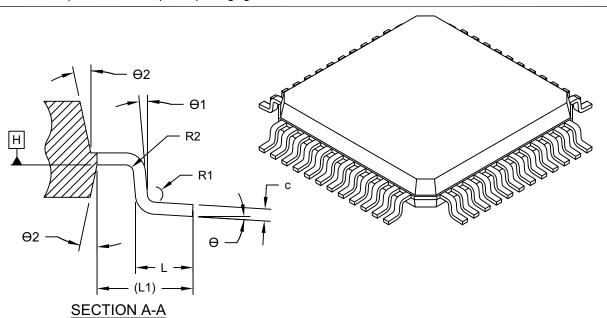




Microchip Technology Drawing C04-300-PT Rev D Sheet 1 of 2

48-Lead Plastic Thin Quad Flatpack (PT) - 7x7x1.0 mm Body [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	1	MILLIMETER	S
Di	imension Limits	MIN	NOM	MAX
Number of Terminals	N		48	
Pitch	е		0.50 BSC	
Overall Height	А	-	-	1.20
Standoff	A1	0.05	-	0.15
Molded Package Thickness	A2	0.95	1.00	1.05
Overall Length	D		9.00 BSC	
Molded Package Length	D1		7.00 BSC	
Overall Width	E	9.00 BSC		
Molded Package Width	E1		7.00 BSC	
Terminal Width	b	0.17	0.22	0.27
Terminal Thickness	С	0.09	-	0.16
Terminal Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Lead Bend Radius	R1	0.08	-	-
Lead Bend Radius	R2	0.08	-	0.20
Foot Angle	θ	0°	3.5°	7°
Lead Angle	θ1	0°	-	-
Mold Draft Angle	Θ2	11°	12°	13°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Dimensioning and tolerancing per ASME Y14.5M

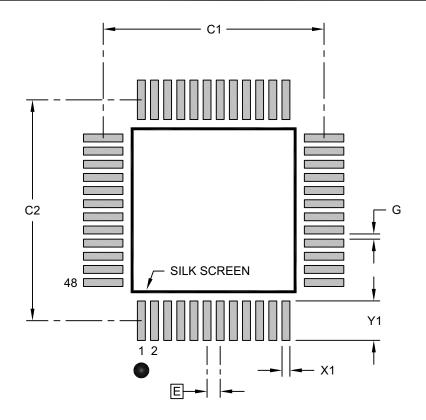
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-300-PT Rev D Sheet 2 of 2

48-Lead Plastic Thin Quad Flatpack (PT) - 7x7x1.0 mm Body [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units	Ν	ILLIMETER	S
Dimension	Limits	MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Contact Pad Spacing	C1		8.40	
Contact Pad Spacing	C2		8.40	
Contact Pad Width (X48)	X1			0.30
Contact Pad Length (X48)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

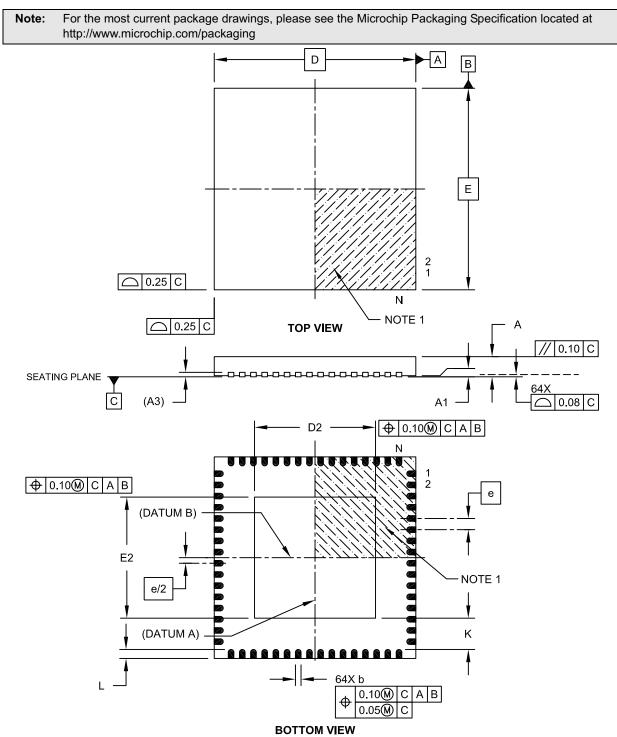
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-2300-PT Rev D

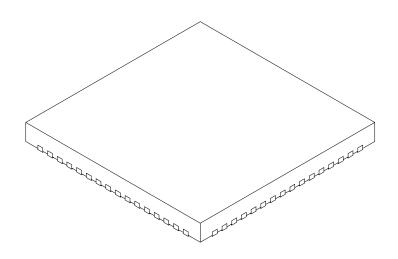
64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body with 5.40 x 5.40 Exposed Pad [QFN]



Microchip Technology Drawing C04-154A Sheet 1 of 2

64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body with 5.40 x 5.40 Exposed Pad [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	Ν	ILLIMETER	S
Dimension	Limits	MIN	NOM	MAX
Number of Pins	Ν		64	
Pitch	е		0.50 BSC	
Overall Height	Α	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	
Overall Width	Е		9.00 BSC	
Exposed Pad Width	E2	5.30	5.40	5.50
Overall Length	D		9.00 BSC	
Exposed Pad Length	D2	5.30	5.40	5.50
Contact Width	b	0.20	0.25	0.30
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	К	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated.

3. Dimensioning and tolerancing per ASME Y14.5M.

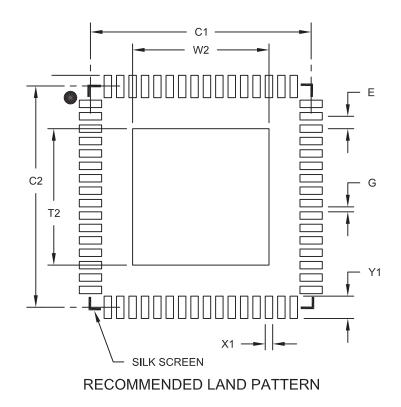
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-154A Sheet 2 of 2

64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body [QFN] With 0.40 mm Contact Length and 5.40x5.40mm Exposed Pad

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		ľ	<i>ILLIMETER</i>	S
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Optional Center Pad Width	W2			5.50
Optional Center Pad Length	T2			5.50
Contact Pad Spacing	C1		8.90	
Contact Pad Spacing	C2		8.90	
Contact Pad Width (X64)	X1			0.30
Contact Pad Length (X64)	Y1			0.85
Distance Between Pads	G	0.20		

Notes:

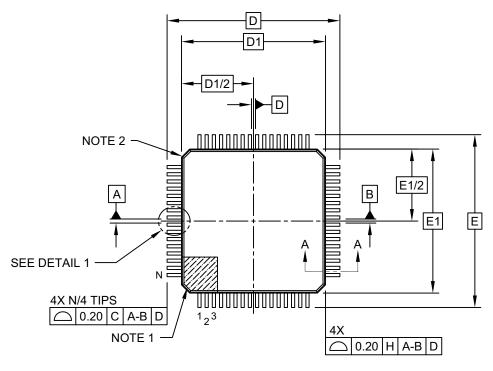
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

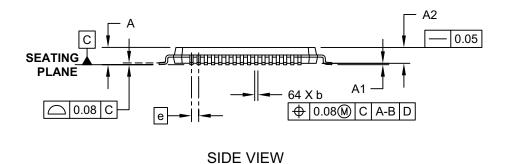
Microchip Technology Drawing No. C04-2154A

64-Lead Plastic Thin Quad Flatpack (PT)-10x10x1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



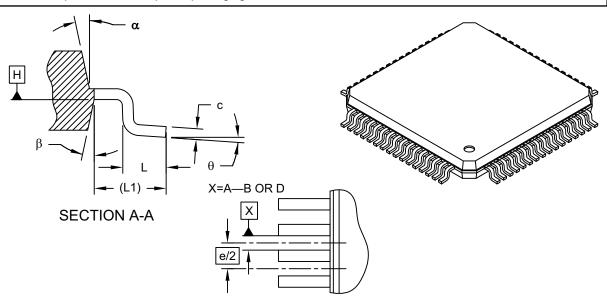




Microchip Technology Drawing C04-085C Sheet 1 of 2

64-Lead Plastic Thin Quad Flatpack (PT)-10x10x1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



DETAIL 1

	Units	MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX
Number of Leads	Ν		64	
Lead Pitch	е		0.50 BSC	
Overall Height	А	-	-	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	-	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1	1.00 REF		
Foot Angle	¢	0°	3.5°	7°
Overall Width	E	12.00 BSC		
Overall Length	D		12.00 BSC	
Molded Package Width	E1		10.00 BSC	
Molded Package Length	D1	10.00 BSC		
Lead Thickness	С	0.09	-	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Chamfers at corners are optional; size may vary.

3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25mm per side.

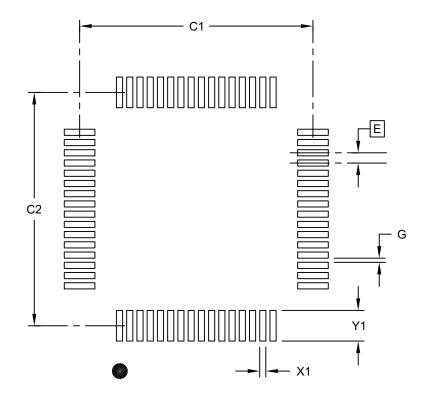
- 4. Dimensioning and tolerancing per ASME Y14.5M
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-085C Sheet 2 of 2

64-Lead Plastic Thin Quad Flatpack (PT)-10x10x1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units	Units MILLIMETERS		S
Dimension	Limits	MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X28)	X1			0.30
Contact Pad Length (X28)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-2085B Sheet 1 of 1

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (March 2019)

Original data sheet for the PIC24FJ128GL306 family of devices.

Revision B (July 2020)

This revision incorporates the following updates:

- · Registers:
 - Updates Register 7-1, Register 18-8, Register 18-9, Register 18-10, Register 18-11, Register 25-1 and Register 27-8.
- · Tables:
 - Updates Table 8-2, Table 8-3, Table 8-4, Table 8-5, Table 10-1, Table 30-4, Table 30-8, Table 30-12, Table 30-17, Table 30-18, Table 30-19, Table 30-32 and Table 30-33.
 - Adds Table 30-27.
- Figures:
 - Updates Figure 9-1, Figure 18-1 and Figure 25-1.
 - Adds Figure 30-2, Figure 30-24, Figure 30-25, Figure 30-26 and Figure 30-27.
- · Sections:
 - Updates Analog Features, Peripheral Features, Section 6.4 "Error Correcting Code (ECC)" and Section 29.0 "Development Support".
 - Adds Section 7.4 "Low-Power BOR (LPBOR)", Section 9.5 "Fail-Safe Clock Monitoring", Section 9.8 "Primary Oscillator (PRI or POSC)" and Section 9.9 "Low-Power RC (LPRC) Oscillator".
 - Adds -40°C to +125°C Extended temperature information to Section 30.0 "Electrical Characteristics".

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Product Group Pin Count — Tape and Reel F		 Examples: a) PIC24FJ128GL306-I/PT: PIC24F General Purpose Device, 64-Pin, Industrial Temp., TQFP Package. b) PIC24FJ128GL302-I/ML: PIC24F General Purpose Device, 28-Pin, Industrial Temp., QFN Package
Architecture	24 = 16-Bit Modified Harvard without DSP	
Flash Memory Family	FJ = Flash Program Memory	
Pin Count	02 = 28-pin (QFN, UQFN, SOIC, SSOP) 03 = 36-pin (UQFN) 05 = 48-pin (UQFN, TQFP) 06 = 64-pin (QFN, TQFP)	
Temperature Range	I = -40° C to $+85^{\circ}$ C (Industrial) E = -40° C to $+125^{\circ}$ C (Extended)	
Package	ML = 28-Lead (6x6 mm) QFN (Plastic Quad Flat) MV = 28-Lead (4x4x.5 mm) UQFN (Plastic Ultra Thin Quad Flat) SO = 28-Lead (7.50 mm) SOIC (Plastic Small Outline) SS = 28-Lead (5.30 mm) SOIP (Plastic Shrink Small Outline) M5 = 36-Lead (5x5 mm) UQFN (Ultra Thin Plastic Quad Flat) M4 = 48-Lead (6x6 mm) UQFN (Ultra Thin Plastic Quad Flat) PT = 48-Lead (7x7x1 mm) TQFP (Thin Quad Flatpack) MR = 64-Lead (9x9x.9 mm) QFN (Plastic Quad Flat) PT = 64-Lead (10x10x1 mm) TQFP (Plastic Thin Quad Flatpack)	
Pattern	QTP, SQTP, Code or Special Requirements (blank otherwise) ES = Engineering Sample	

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 PIC24FJ64GL302-E/SO
 PIC24FJ64GL302-E/SS

 PIC24FJ64GL305-E/M4
 PIC24FJ64GL305-E/PT
 PIC24FJ64GL306-E/MR
 PIC24FJ64GL306-E/PT

 PIC24FJ128GL306-E/PT
 PIC24FJ128GL305-E/PT
 PIC24FJ128GL302-E/ML
 PIC24FJ128GL306-E/MR

 PIC24FJ128GL302-E/MV
 PIC24FJ128GL302-E/SS
 PIC24FJ128GL305-E/M4
 PIC24FJ128GL305-E/MR